https://www.fpgamall.com

# THE DATASHEET OF FPGA

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

# Virtex-II Platform FPGAs: Complete Data Sheet

DS031 (v4.0) April 7, 2014 **Product Specification**

## Module 1: Introduction and Overview

**7 pages**

- Summary of Features
- General Description
- Architecture
- Device/Package Combinations and Maximum I/O
- Ordering Examples

## Module 2: Functional Description

**40 pages**

- Detailed Description
  - Input/Output Blocks (IOBs)
  - Digitally Controlled Impedance (DCI)
  - Configurable Logic Blocks (CLBs)
  - 18-Kb Block SelectRAM™ Resources
  - 18-Bit x 18-Bit Multipliers
  - Global Clock Multiplexer Buffers
  - Digital Clock Manager (DCM)
- Routing
- Creating a Design
- Configuration

## Module 3: DC and Switching Characteristics

**44 pages**

- Electrical Characteristics
- Performance Characteristics
- Switching Characteristics
- Pin-to-Pin Output Parameter Guidelines
- Pin-to-Pin Input Parameter Guidelines
- DCM Timing Parameters
- Source-Synchronous Switching Characteristics

## Module 4: Pinout Information

**227 pages**

- Pin Definitions
- Pinout Tables
  - CS144/CSG144 Chip-Scale BGA Package
  - FG256/FGG256 Fine-Pitch BGA Package
  - FG456/FGG456 Fine-Pitch BGA Package
  - FG676/FGG676 Fine-Pitch BGA Package
  - BG575/BGG575 Standard BGA Package
  - BG728/BGG728 Standard BGA Package
  - FF896 Flip-Chip Fine-Pitch BGA Package
  - FF1152 Flip-Chip Fine-Pitch BGA Package
  - FF1517 Flip-Chip Fine-Pitch BGA Package
  - BF957Flip-Chip BGA Package

IMPORTANT NOTE: *Page, figure, and table numbers begin at 1 for each module, and each module has its own Revision History at the end. Use the PDF "Bookmarks" pane for easy navigation in this volume.*

© 2000–2014 Xilinx, Inc. All rights reserved. XILINX, the Xilinx logo, the Brand Window, and other designated brands included herein are trademarks of Xilinx, Inc. All other trademarks are the property of their respective owners.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

# Virtex-II Platform FPGAs: Introduction and Overview

DS031-1 (v4.0) April 7, 2014 **Product Specification**

## Summary of Virtex-II™ Features

- Industry First Platform FPGA Solution
- IP-Immersion Architecture
  - Densities from 40K to 8M system gates
  - 420 MHz internal clock speed (Advance Data)
  - 840+ Mb/s I/O (Advance Data)
- SelectRAM™ Memory Hierarchy
  - 3 Mb of dual-port RAM in 18 Kbit block SelectRAM resources
  - Up to 1.5 Mb of distributed SelectRAM resources
- High-Performance Interfaces to External Memory
  - DRAM interfaces
    - SDR / DDR SDRAM
    - Network FCRAM
    - Reduced Latency DRAM
  - SRAM interfaces
    - SDR / DDR SRAM
    - QDR™ SRAM
  - CAM interfaces
- Arithmetic Functions
  - Dedicated 18-bit x 18-bit multiplier blocks
  - Fast look-ahead carry logic chains
- Flexible Logic Resources
  - Up to 93,184 internal registers / latches with Clock Enable
  - Up to 93,184 look-up tables (LUTs) or cascadable 16-bit shift registers
  - Wide multiplexers and wide-input function support
  - Horizontal cascade chain and sum-of-products support
  - Internal 3-state bussing
- High-Performance Clock Management Circuitry
  - Up to 12 DCM (Digital Clock Manager) modules
    - Precise clock de-skew
    - Flexible frequency synthesis
    - High-resolution phase shifting
  - 16 global clock multiplexer buffers
- Active Interconnect Technology
  - Fourth generation segmented routing structure
  - Predictable, fast routing delay, independent of fanout
- SelectIO™-Ultra Technology
  - Up to 1,108 user I/Os
  - 19 single-ended and six differential standards
  - Programmable sink current (2 mA to 24 mA) per I/O
  - Digitally Controlled Impedance (DCI) I/O: on-chip termination resistors for single-ended I/O standards
  - PCI-X compatible (133 MHz and 66 MHz) at 3.3V
  - PCI compliant (66 MHz and 33 MHz) at 3.3V
  - CardBus compliant (33 MHz) at 3.3V
  - Differential Signaling
    - 840 Mb/s Low-Voltage Differential Signaling I/O (LVDS) with current mode drivers
    - Bus LVDS I/O
    - Lightning Data Transport (LDT) I/O with current driver buffers
    - Low-Voltage Positive Emitter-Coupled Logic (LVPECL) I/O
    - Built-in DDR input and output registers
  - Proprietary high-performance SelectLink Technology
    - High-bandwidth data path
    - Double Data Rate (DDR) link
    - Web-based HDL generation methodology
- Supported by Xilinx Foundation™ and Alliance Series™ Development Systems
  - Integrated VHDL and Verilog design flows
  - Compilation of 10M system gates designs
  - Internet Team Design (ITD) tool
- SRAM-Based In-System Configuration
  - Fast SelectMAP configuration
  - Triple Data Encryption Standard (DES) security option (Bitstream Encryption)
  - IEEE 1532 support
  - Partial reconfiguration
  - Unlimited reprogrammability
  - Readback capability
- 0.15 µm 8-Layer Metal Process with 0.12 µm High-Speed Transistors
- 1.5V ($V_{CCINT}$) Core Power Supply, Dedicated 3.3V $V_{CCAUX}$ Auxiliary and $V_{CCO}$ I/O Power Supplies
- IEEE 1149.1 Compatible Boundary-Scan Logic Support
- Flip-Chip and Wire-Bond Ball Grid Array (BGA) Packages in Three Standard Fine Pitches (0.80 mm, 1.00 mm, and 1.27 mm)
- Wire-Bond BGA Devices Available in Pb-Free Packaging (www.xilinx.com/pbfree)
- 100% Factory Tested

© 2000–2014 Xilinx, Inc. All rights reserved. XILINX, the Xilinx logo, the Brand Window, and other designated brands included herein are trademarks of Xilinx, Inc. All other trademarks are the property of their respective owners.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 1:* **Virtex-II Field-Programmable Gate Array Family Members**

| Device | System Gates | CLB (1 CLB = 4 slices = Max 128 bits) | | | Multiplier Blocks | SelectRAM Blocks | | DCMs | Max I/O Pads(1) |
|---|---|---|---|---|---|---|---|---|---|
| | | Array Row x Col. | Slices | Maximum Distributed RAM Kbits | | 18 Kbit Blocks | Max RAM (Kbits) | | |
| XC2V40 | 40K | 8 x 8 | 256 | 8 | 4 | 4 | 72 | 4 | 88 |
| XC2V80 | 80K | 16 x 8 | 512 | 16 | 8 | 8 | 144 | 4 | 120 |
| XC2V250 | 250K | 24 x 16 | 1,536 | 48 | 24 | 24 | 432 | 8 | 200 |
| XC2V500 | 500K | 32 x 24 | 3,072 | 96 | 32 | 32 | 576 | 8 | 264 |
| XC2V1000 | 1M | 40 x 32 | 5,120 | 160 | 40 | 40 | 720 | 8 | 432 |
| XC2V1500 | 1.5M | 48 x 40 | 7,680 | 240 | 48 | 48 | 864 | 8 | 528 |
| XC2V2000 | 2M | 56 x 48 | 10,752 | 336 | 56 | 56 | 1,008 | 8 | 624 |
| XC2V3000 | 3M | 64 x 56 | 14,336 | 448 | 96 | 96 | 1,728 | 12 | 720 |
| XC2V4000 | 4M | 80 x 72 | 23,040 | 720 | 120 | 120 | 2,160 | 12 | 912 |
| XC2V6000 | 6M | 96 x 88 | 33,792 | 1,056 | 144 | 144 | 2,592 | 12 | 1,104 |
| XC2V8000 | 8M | 112 x 104 | 46,592 | 1,456 | 168 | 168 | 3,024 | 12 | 1,108 |

**Notes:**
1. See details in Table 2, "Maximum Number of User I/O Pads".

## General Description

The Virtex-II family is a platform FPGA developed for high performance from low-density to high-density designs that are based on IP cores and customized modules. The family delivers complete solutions for telecommunication, wireless, networking, video, and DSP applications, including PCI, LVDS, and DDR interfaces.

The leading-edge 0.15 µm / 0.12 µm CMOS 8-layer metal process and the Virtex-II architecture are optimized for high speed with low power consumption. Combining a wide variety of flexible features and a large range of densities up to 10 million system gates, the Virtex-II family enhances programmable logic design capabilities and is a powerful alternative to mask-programmed gates arrays. As shown in Table 1, the Virtex-II family comprises 11 members, ranging from 40K to 8M system gates.

### Packaging

Offerings include ball grid array (BGA) packages with 0.80 mm, 1.00 mm, and 1.27 mm pitches. In addition to traditional wire-bond interconnects, flip-chip interconnect is used in some of the BGA offerings. The use of flip-chip interconnect offers more I/Os than is possible in wire-bond versions of the similar packages. Flip-chip construction offers the combination of high pin count with high thermal capacity.

Wire-bond packages CS, FG, and BG are optionally availabe in Pb-free versions CSG, FGG, and BGG. See Virtex-II Ordering Examples, page 6.

Table 2 shows the maximum number of user I/Os available. The Virtex-II device/package combination table (Table 6 at the end of this section) details the maximum number of I/Os for each device and package using wire-bond or flip-chip technology.

*Table 2:* **Maximum Number of User I/O Pads**

| Device | Wire-Bond | Flip-Chip |
|---|---|---|
| XC2V40 | 88 | - |
| XC2V80 | 120 | - |
| XC2V250 | 200 | - |
| XC2V500 | 264 | - |
| XC2V1000 | 328 | 432 |
| XC2V1500 | 392 | 528 |
| XC2V2000 | - | 624 |
| XC2V3000 | 516 | 720 |
| XC2V4000 | - | 912 |
| XC2V6000 | - | 1,104 |
| XC2V8000 | - | 1,108 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Architecture

## Virtex-II Array Overview

Virtex-II devices are user-programmable gate arrays with various configurable elements. The Virtex-II architecture is optimized for high-density and high-performance logic designs. As shown in Figure 1, the programmable device is comprised of input/output blocks (IOBs) and internal configurable logic blocks (CLBs).

Programmable I/O blocks provide the interface between package pins and the internal configurable logic. Most popular and leading-edge I/O standards are supported by the programmable IOBs.

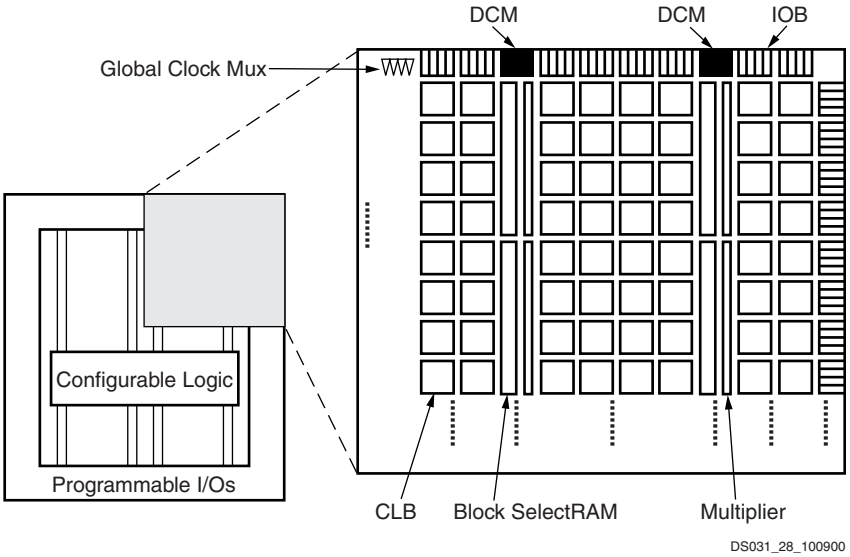



*Figure 1:* **Virtex-II Architecture Overview**

The internal configurable logic includes four major elements organized in a regular array.

- Configurable Logic Blocks (CLBs) provide functional elements for combinatorial and synchronous logic, including basic storage elements. BUFTs (3-state buffers) associated with each CLB element drive dedicated segmentable horizontal routing resources.
- Block SelectRAM memory modules provide large 18 Kbit storage elements of dual-port RAM.
- Multiplier blocks are 18-bit x 18-bit dedicated multipliers.
- DCM (Digital Clock Manager) blocks provide self-calibrating, fully digital solutions for clock distribution delay compensation, clock multiplication and division, coarse- and fine-grained clock phase shifting.

A new generation of programmable routing resources called Active Interconnect Technology interconnects all of these elements. The general routing matrix (GRM) is an array of routing switches. Each programmable element is tied to a switch matrix, allowing multiple connections to the general routing matrix. The overall programmable interconnection is hierarchical and designed to support high-speed designs.

All programmable elements, including the routing resources, are controlled by values stored in static memory cells. These values are loaded in the memory cells during configuration and can be reloaded to change the functions of the programmable elements.

## Virtex-II Features

This section briefly describes Virtex-II features.

### *Input/Output Blocks (IOBs)*

IOBs are programmable and can be categorized as follows:

- Input block with an optional single-data-rate or double-data-rate (DDR) register
- Output block with an optional single-data-rate or DDR register, and an optional 3-state buffer, to be driven directly or through a single or DDR register
- Bidirectional block (any combination of input and output configurations)

These registers are either edge-triggered D-type flip-flops or level-sensitive latches.

IOBs support the following single-ended I/O standards:

- LVTTL, LVCMOS (3.3V, 2.5V, 1.8V, and 1.5V)
- PCI-X compatible (133 MHz and 66 MHz) at 3.3V
- PCI compliant (66 MHz and 33 MHz) at 3.3V
- CardBus compliant (33 MHz) at 3.3V
- GTL and GTLP

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


- HSTL (Class I, II, III, and IV)
- SSTL (3.3V and 2.5V, Class I and II)
- AGP-2X

The digitally controlled impedance (DCI) I/O feature automatically provides on-chip termination for each I/O element.

The IOB elements also support the following differential signaling I/O standards:

- LVDS
- BLVDS (Bus LVDS)
- ULVDS
- LDT
- LVPECL

Two adjacent pads are used for each differential pair. Two or four IOB blocks connect to one switch matrix to access the routing resources.

### *Configurable Logic Blocks (CLBs)*

CLB resources include four slices and two 3-state buffers. Each slice is equivalent and contains:

- Two function generators (F & G)
- Two storage elements
- Arithmetic logic gates
- Large multiplexers
- Wide function capability
- Fast carry look-ahead chain
- Horizontal cascade chain (OR gate)

The function generators F & G are configurable as 4-input look-up tables (LUTs), as 16-bit shift registers, or as 16-bit distributed SelectRAM memory.

In addition, the two storage elements are either edge-triggered D-type flip-flops or level-sensitive latches.

Each CLB has internal fast interconnect and connects to a switch matrix to access general routing resources.

### *Block SelectRAM Memory*

The block SelectRAM memory resources are 18 Kb of dual-port RAM, programmable from 16K x 1 bit to 512 x 36 bits, in various depth and width configurations. Each port is totally synchronous and independent, offering three "read-during-write" modes. Block SelectRAM memory is cascadable to implement large embedded storage blocks. Supported memory configurations for dual-port and single-port modes are shown in Table 3.

*Table 3:* **Dual-Port And Single-Port Configurations**

| | |
|---|---|
| 16K x 1 bit | 2K x 9 bits |
| 8K x 2 bits | 1K x 18 bits |
| 4K x 4 bits | 512 x 36 bits |

A multiplier block is associated with each SelectRAM memory block. The multiplier block is a dedicated 18 x 18-bit multiplier and is optimized for operations based on the block SelectRAM content on one port. The 18 x 18 multiplier can be used independently of the block SelectRAM resource. Read/multiply/accumulate operations and DSP filter structures are extremely efficient.

Both the SelectRAM memory and the multiplier resource are connected to four switch matrices to access the general routing resources.

### *Global Clocking*

The DCM and global clock multiplexer buffers provide a complete solution for designing high-speed clocking schemes.

Up to 12 DCM blocks are available. To generate de-skewed internal or external clocks, each DCM can be used to eliminate clock distribution delay. The DCM also provides 90-, 180-, and 270-degree phase-shifted versions of its output clocks. Fine-grained phase shifting offers high-resolution phase adjustments in increments of 1/256 of the clock period. Very flexible frequency synthesis provides a clock output frequency equal to any M/D ratio of the input clock frequency, where M and D are two integers. For the exact timing parameters, see Virtex-II Electrical Characteristics.

Virtex-II devices have 16 global clock MUX buffers, with up to eight clock nets per quadrant. Each global clock MUX buffer can select one of the two clock inputs and switch glitch-free from one clock to the other. Each DCM block is able to drive up to four of the 16 global clock MUX buffers.

### *Routing Resources*

The IOB, CLB, block SelectRAM, multiplier, and DCM elements all use the same interconnect scheme and the same access to the global routing matrix. Timing models are shared, greatly improving the predictability of the performance of high-speed designs.

There are a total of 16 global clock lines, with eight available per quadrant. In addition, 24 vertical and horizontal long lines per row or column as well as massive secondary and local routing resources provide fast interconnect. Virtex-II buffered interconnects are relatively unaffected by net fanout and the interconnect layout is designed to minimize crosstalk.

Horizontal and vertical routing resources for each row or column include:

- 24 long lines
- 120 hex lines
- 40 double lines
- 16 direct connect lines (total in all four directions)

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### Boundary Scan

Boundary scan instructions and associated data registers support a standard methodology for accessing and configuring Virtex-II devices that complies with IEEE standards 1149.1 — 1993 and 1532. A system mode and a test mode are implemented. In system mode, a Virtex-II device performs its intended mission even while executing non-test boundary-scan instructions. In test mode, boundary-scan test instructions control the I/O pins for testing purposes. The Virtex-II Test Access Port (TAP) supports BYPASS, PRELOAD, SAMPLE, IDCODE, and USERCODE non-test instructions. The EXTEST, INTEST, and HIGHZ test instructions are also supported.

### Configuration

Virtex-II devices are configured by loading data into internal configuration memory, using the following five modes:

- Slave-serial mode
- Master-serial mode
- Slave SelectMAP mode
- Master SelectMAP mode
- Boundary-Scan mode (IEEE 1532)

A Data Encryption Standard (DES) decryptor is available on-chip to secure the bitstreams. One or two triple-DES key sets can be used to optionally encrypt the configuration information.

### Readback and Integrated Logic Analyzer

Configuration data stored in Virtex-II configuration memory can be read back for verification. Along with the configuration data, the contents of all flip-flops/latches, distributed SelectRAM, and block SelectRAM memory resources can be read back. This capability is useful for real-time debugging.

The Integrated Logic Analyzer (ILA) core and software provides a complete solution for accessing and verifying Virtex-II devices.

## Virtex-II Device/Package Combinations and Maximum I/O

Wire-bond and flip-chip packages are available. Table 4 and Table 5 show the maximum possible number of user I/Os in wire-bond and flip-chip packages, respectively. Table 6 shows the number of available user I/Os for all device/package combinations.

- CS denotes wire-bond chip-scale ball grid array (BGA) (0.80 mm pitch).
- CSG denotes Pb-free wire-bond chip-scale ball grid array (BGA) (0.80 mm pitch).
- FG denotes wire-bond fine-pitch BGA (1.00 mm pitch).
- FGG denotes Pb-free wire-bond fine-pitch BGA (1.00 mm pitch).
- BG denotes standard BGA (1.27 mm pitch).
- BGG denotes Pb-free standard BGA (1.27 mm pitch).
- FF denotes flip-chip fine-pitch BGA (1.00 mm pitch).
- BF denotes flip-chip BGA (1.27 mm pitch).

The number of I/Os per package include all user I/Os except the 15 control pins (CCLK, DONE, M0, M1, M2, PROG_B, PWRDWN_B, TCK, TDI, TDO, TMS, HSWAP_EN, DXN, DXP, and RSVD) and VBATT.

*Table 4:* **Wire-Bond Packages Information**

| Package[1] | CS144/ CSG144 | FG256/ FGG256 | FG456/ FGG456 | FG676/ FGG676 | BG575/ BGG575 | BG728/ BGG728 |
|---|---|---|---|---|---|---|
| Pitch (mm) | 0.80 | 1.00 | 1.00 | 1.00 | 1.27 | 1.27 |
| Size (mm) | 12 x 12 | 17 x 17 | 23 x 23 | 27 x 27 | 31 x 31 | 35 x 35 |
| I/Os | 92 | 172 | 324 | 484 | 408 | 516 |

**Notes:**
1. Wire-bond packages include FGG*nnn* Pb-free versions. See Virtex-II Ordering Examples (Module 1).

*Table 5:* **Flip-Chip Packages Information**

| Package | FF896 | FF1152 | FF1517 | BF957 |
|---|---|---|---|---|
| Pitch (mm) | 1.00 | 1.00 | 1.00 | 1.27 |
| Size (mm) | 31 x 31 | 35 x 35 | 40 x 40 | 40 x 40 |
| I/Os | 624 | 824 | 1,108 | 684 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **Virtex-II Device/Package Combinations and Maximum Number of Available I/Os (Advance Information)**

| Package(1,2) | Available I/Os | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | XC2V 40 | XC2V 80 | XC2V 250 | XC2V 500 | XC2V 1000 | XC2V 1500 | XC2V 2000 | XC2V 3000 | XC2V 4000 | XC2V 6000 | XC2V 8000 |
| CS144/CSG144 | 88 | 92 | 92 | - | - | - | - | - | - | - | - |
| FG256/FGG256 | 88 | 120 | 172 | 172 | 172 | - | - | - | - | - | - |
| FG456/FGG456 | - | - | 200 | 264 | 324 | - | - | - | - | - | - |
| FG676/FGG676 | - | - | - | - | - | 392 | 456 | 484 | - | - | - |
| FF896 | - | - | - | - | 432 | 528 | 624 | - | - | - | - |
| FF1152 | - | - | - | - | - | - | - | 720 | 824 | 824 | 824 |
| FF1517 | - | - | - | - | - | - | - | - | 912 | 1,104 | 1,108 |
| BG575/BGG575 | - | - | - | - | 328 | 392 | 408 | - | - | - | - |
| BG728/BGG728 | - | - | - | - | - | - | - | 516 | - | - | - |
| BF957 | - | - | - | - | - | - | 624 | 684 | 684 | 684 | - |

**Notes:**
1. All devices in a particular package are pinout (footprint) compatible. In addition, the FG456/FGG456 and FG676/FGG676 packages are compatible, as are the FF896 and FF1152 packages.
2. Wire-bond packages CS144, FG256, FG456, FG676, BG575, and BG728 are also available in Pb-free versions CSG144, FGG256, FGG456, FGG676, BGG575, and BGG728. See Virtex-II Ordering Examples for details on how to order.

## Virtex-II Ordering Examples

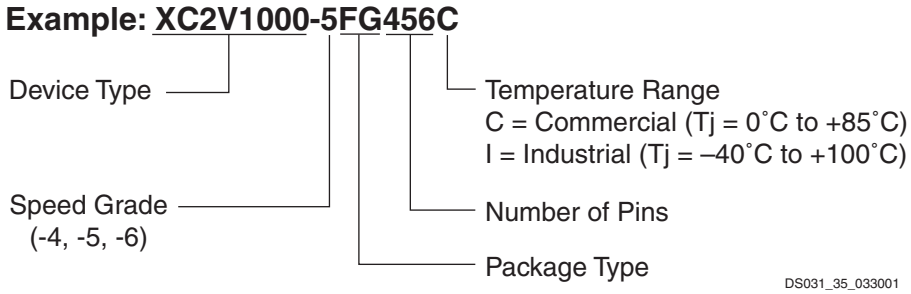



*Figure 2:* **Virtex-II Ordering Example. Regular Package**

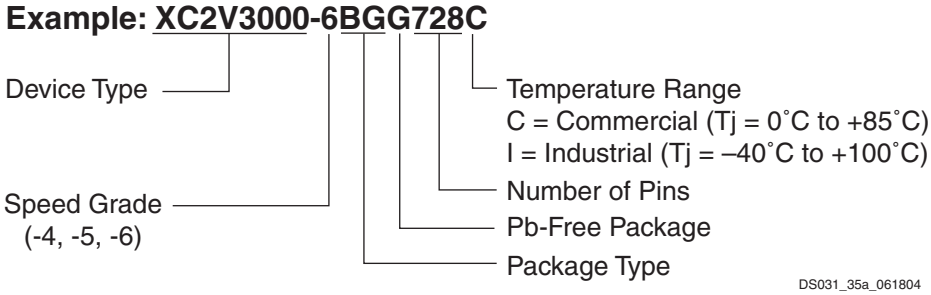



*Figure 3:* **Virtex-II Ordering Example. Pb-Free Package**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Revision History

This section records the change history for this module of the data sheet.

| Date | Version | Revision |
|---|---|---|
| 11/07/2000 | 1.0 | Early access draft. |
| 12/06/2000 | 1.1 | Initial release. |
| 01/15/2001 | 1.2 | Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections. |
| 01/25/2001 | 1.3 | The data sheet was divided into four modules (per the current style standard). |
| 04/02/2001 | 1.5 | Skipped v1.4 to sync up modules. Reverted to traditional double-column format. |
| 07/30/2001 | 1.6 | Made minor changes to items listed under Summary of Virtex-II™ Features. |
| 10/02/2001 | 1.7 | Minor edits. |
| 07/16/2002 | 1.8 | Updated Virtex-II Device/Package Combinations shown in Table 6. |
| 09/26/2002 | 1.9 | Updated Table 2 and Table 6 to reflect supported Virtex-II Device/Package Combinations. |
| 08/01/2003 | 2.0 | All Virtex-II devices and speed grades now Production. See Table 13, Module 3. |
| 03/29/2004 | 2.0.1 | Recompiled for backward compatibility with Acrobat 4 and above. No content changes. |
| 06/24/2004 | 3.3 | Added references to available Pb-free wire-bond packages. (Revision number advanced to level of complete data sheet.) |
| 03/01/2005 | 3.4 | *No changes in Module 1 for this revision.* |
| 11/05/2007 | 3.5 | Updated copyright notice and legal disclaimer. |
| 04/07/2014 | 4.0 | This product is obsolete/discontinued per **XCN11003** and **XCN12026**. |

## Notice of Disclaimer

THE XILINX HARDWARE FPGA AND CPLD DEVICES REFERRED TO HEREIN (“PRODUCTS”) ARE SUBJECT TO THE TERMS AND CONDITIONS OF THE XILINX LIMITED WARRANTY WHICH CAN BE VIEWED AT http://www.xilinx.com/warranty.htm. THIS LIMITED WARRANTY DOES NOT EXTEND TO ANY USE OF PRODUCTS IN AN APPLICATION OR ENVIRONMENT THAT IS NOT WITHIN THE SPECIFICATIONS STATED IN THE XILINX DATA SHEET. ALL SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, OR ANY OTHER APPLICATION THAT INVOKES THE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR PROPERTY OR ENVIRONMENTAL DAMAGE (“CRITICAL APPLICATIONS”). USE OF PRODUCTS IN CRITICAL APPLICATIONS IS AT THE SOLE RISK OF CUSTOMER, SUBJECT TO APPLICABLE LAWS AND REGULATIONS.

## Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA



# Detailed Description

## Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in Figure 1.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.

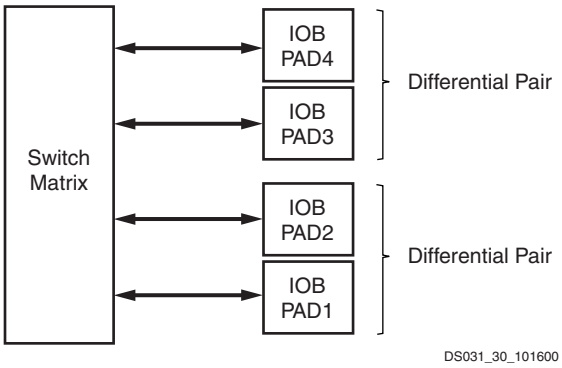



*Figure 1:* **Virtex-II Input/Output Tile**

Note: Differential I/Os must use the same clock.

### *Supported I/O Standards*

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage ($V_{CCINT}$ = 1.5V), output driver supply voltage ($V_{CCO}$) is dependent on the I/O standard (see Table 1 and Table 2). An auxiliary supply voltage ($V_{CCAUX}$ = 3.3 V) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see DC Input and Output Levels in Module 3.

All of the user IOBs have fixed-clamp diodes to $V_{CCO}$ and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the “5V Tolerant I/Os“ Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See Digitally Controlled Impedance (DCI), page 8.

*Table 1:* **Supported Single-Ended I/O Standards**

| IOSTANDARD Attribute | Output $V_{CCO}$ | Input $V_{CCO}$ | Input $V_{REF}$ | Board Termination Voltage ($V_{TT}$) |
|---|---|---|---|---|
| LVTTL | 3.3 | 3.3 | N/R(3) | N/R |
| LVCMOS33 | 3.3 | 3.3 | N/R | N/R |
| LVCMOS25 | 2.5 | 2.5 | N/R | N/R |
| LVCMOS18 | 1.8 | 1.8 | N/R | N/R |
| LVCMOS15 | 1.5 | 1.5 | N/R | N/R |
| PCI33_3 | 3.3 | 3.3 | N/R | N/R |
| PCI66_3 | 3.3 | 3.3 | N/R | N/R |
| PCI-X | 3.3 | 3.3 | N/R | N/R |
| GTL | Note (1) | Note (1) | 0.8 | 1.2 |
| GTLP | Note (1) | Note (1) | 1.0 | 1.5 |
| HSTL_I | 1.5 | N/R | 0.75 | 0.75 |
| HSTL_II | 1.5 | N/R | 0.75 | 0.75 |
| HSTL_III | 1.5 | N/R | 0.9 | 1.5 |
| HSTL_IV | 1.5 | N/R | 0.9 | 1.5 |
| HSTL_I_18 | 1.8 | N/R | 0.9 | 0.9 |
| HSTL_II_18 | 1.8 | N/R | 0.9 | 0.9 |
| HSTL_III _18 | 1.8 | N/R | 1.1 | 1.8 |
| HSTL_IV_18 | 1.8 | N/R | 1.1 | 1.8 |
| SSTL18_I(2) | 1.8 | N/R | 0.9 | 0.9 |
| SSTL18_II | 1.8 | N/R | 0.9 | 0.9 |
| SSTL2_I | 2.5 | N/R | 1.25 | 1.25 |
| SSTL2_II | 2.5 | N/R | 1.25 | 1.25 |
| SSTL3_I | 3.3 | N/R | 1.5 | 1.5 |
| SSTL3_II | 3.3 | N/R | 1.5 | 1.5 |
| AGP-2X/AGP | 3.3 | N/R | 1.32 | N/R |

**Notes:**
1. $V_{CCO}$ of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect $V_{CCO}$ to 1.5V.
2. SSTL18_I is not a JEDEC-supported standard.
3. N/R = no requirement.

© 2000–2014 Xilinx, Inc. All rights reserved. XILINX, the Xilinx logo, the Brand Window, and other designated brands included herein are trademarks of Xilinx, Inc. All other trademarks are the property of their respective owners.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 2:* **Supported Differential Signal I/O Standards**

| I/O Standard | Output $V_{CCO}$ | Input $V_{CCO}$ | Input $V_{REF}$ | Output $V_{OD}$ |
|---|---|---|---|---|
| LVPECL_33 | 3.3 | N/R(1) | N/R | 0.490 - 1.220 |
| LDT_25 | 2.5 | N/R | N/R | 0.500 - 0.700 |
| LVDS_33 | 3.3 | N/R | N/R | 0.250 - 0.400 |
| LVDS_25 | 2.5 | N/R | N/R | 0.250 - 0.400 |
| LVDSEXT_33 | 3.3 | N/R | N/R | 0.440 - 0.820 |
| LVDSEXT_25 | 2.5 | N/R | N/R | 0.440 - 0.820 |
| BLVDS_25 | 2.5 | N/R | N/R | 0.250 - 0.450 |
| ULVDS_25 | 2.5 | N/R | N/R | 0.500 - 0.700 |

**Notes:**
1. N/R = no requirement.

*Table 3:* **Supported DCI I/O Standards**

| I/O Standard | Output $V_{CCO}$ | Input $V_{CCO}$ | Input $V_{REF}$ | Termination Type |
|---|---|---|---|---|
| LVDCI_33(1) | 3.3 | 3.3 | N/R(4) | Series |
| LVDCI_DV2_33(1) | 3.3 | 3.3 | N/R | Series |
| LVDCI_25(1) | 2.5 | 2.5 | N/R | Series |
| LVDCI_DV2_25(1) | 2.5 | 2.5 | N/R | Series |
| LVDCI_18(1) | 1.8 | 1.8 | N/R | Series |
| LVDCI_DV2_18(1) | 1.8 | 1.8 | N/R | Series |
| LVDCI_15(1) | 1.5 | 1.5 | N/R | Series |
| LVDCI_DV2_15(1) | 1.5 | 1.5 | N/R | Series |
| GTL_DCI | 1.2 | 1.2 | 0.8 | Single |
| GTLP_DCI | 1.5 | 1.5 | 1.0 | Single |
| HSTL_I_DCI | 1.5 | 1.5 | 0.75 | Split |
| HSTL_II_DCI | 1.5 | 1.5 | 0.75 | Split |
| HSTL_III_DCI | 1.5 | 1.5 | 0.9 | Single |
| HSTL_IV_DCI | 1.5 | 1.5 | 0.9 | Single |
| HSTL_I_DCI_18 | 1.8 | 1.8 | 0.9 | Split |
| HSTL_II_DCI_18 | 1.8 | 1.8 | 0.9 | Split |
| HSTL_III_DCI_18 | 1.8 | 1.8 | 1.1 | Single |
| HSTL_IV_DCI_18 | 1.8 | 1.8 | 1.1 | Single |
| SSTL18_I_DCI(3) | 1.8 | 1.8 | 0.9 | Split |
| SSTL18_II_DCI | 1.8 | 1.8 | 0.9 | Split |
| SSTL2_I_DCI(2) | 2.5 | 2.5 | 1.25 | Split |
| SSTL2_II_DCI(2) | 2.5 | 2.5 | 1.25 | Split |
| SSTL3_I_DCI(2) | 3.3 | 3.3 | 1.5 | Split |
| SSTL3_II_DCI(2) | 3.3 | 3.3 | 1.5 | Split |
| LVDS_25_DCI | 2.5 | 2.5 | N/R | Split |
| LVDSEXT_25_DCI | 2.5 | 2.5 | N/R | Split |

**Notes:**
1. LVDCI_XX and LVDCI_DV2_XX are LVCMOS controlled impedance buffers, matching the reference resistors or half of the reference resistors.
2. These are SSTL compatible.
3. SSTL18_I is not a JEDEC-supported standard.
4. N/R = no requirement.

### *Logic Resources*

IOB blocks include six storage elements, as shown in Figure 2.

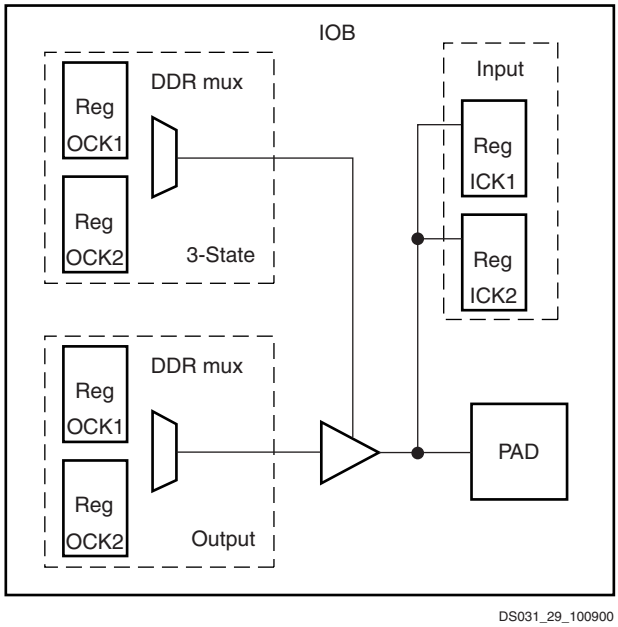



*Figure 2:* **Virtex-II IOB Block**

Each storage element can be configured either as an edge-triggered D-type flip-flop or as a level-sensitive latch. On the input, output, and 3-state path, one or two DDR registers can be used.

Double data rate is directly accomplished by the two registers on each path, clocked by the rising edges (or falling edges) from two different clock nets. The two clock signals are generated by the DCM and must be 180 degrees out of phase, as shown in Figure 3. There are two input, output, and 3-state data signals, each being alternately clocked out.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

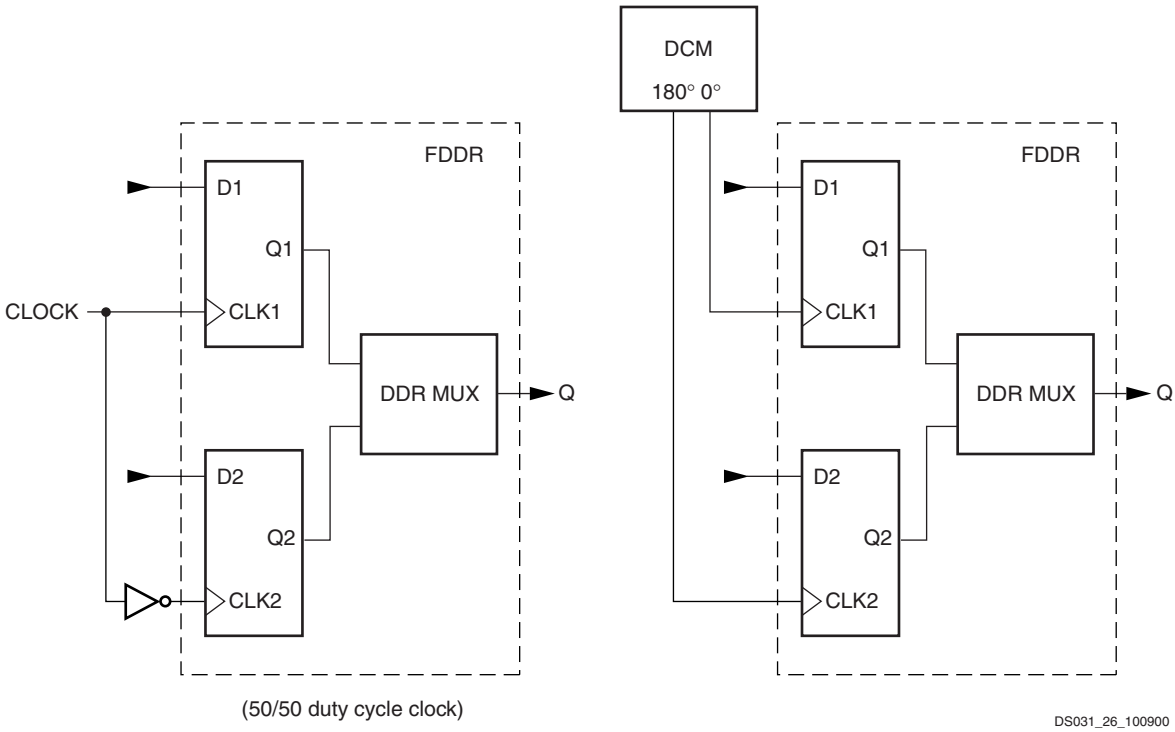




*Figure 3:* **Double Data Rate Registers**

The DDR mechanism shown in Figure 3 can be used to mirror a copy of the clock on the output. This is useful for propagating a clock along the data that has an identical delay. It is also useful for multiple clock generation, where there is a unique clock driver for every clock load. Virtex-II devices can produce many copies of a clock with very little skew.

Each group of two registers has a clock enable signal (ICE for the input registers, OCE for the output registers, and TCE for the 3-state registers). The clock enable signals are active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

Each IOB block has common synchronous or asynchronous set and reset (SR and REV signals).

SR forces the storage element into the state specified by the SRHIGH or SRLOW attribute. SRHIGH forces a logic “1”. SRLOW forces a logic “0”. When SR is used, a second input (REV) forces the storage element into the opposite state. The reset condition predominates over the set condition. The initial state after configuration or global initialization state is defined by a separate INIT0 and INIT1 attribute. By default, the SRLOW attribute forces INIT0, and the SRHIGH attribute forces INIT1.

For each storage element, the SRHIGH, SRLOW, INIT0, and INIT1 attributes are independent. Synchronous or asynchronous set / reset is consistent in an IOB block.

All the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Each register or latch (independent of all other registers or latches) (see Figure 4) can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset overrides a set, and an asynchronous clear overrides a preset.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

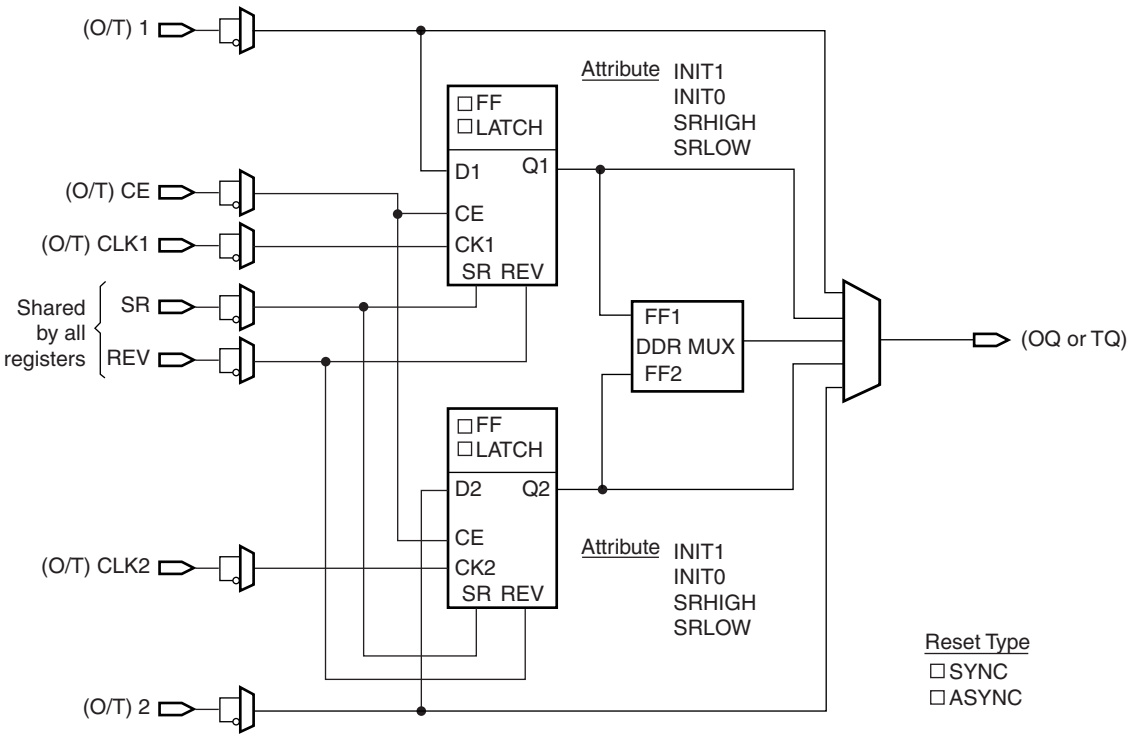




*Figure 4:* **Register / Latch Configuration in an IOB Block**

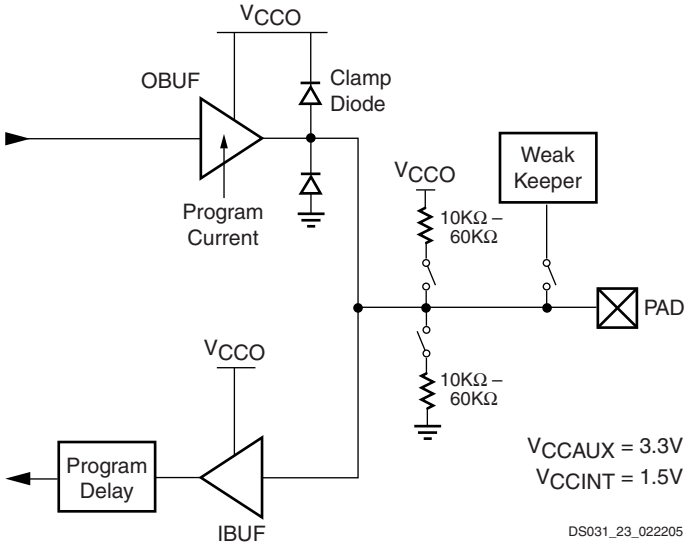



*Figure 5:* **LVTTL, LVCMOS or PCI SelectI/O-Ultra Standards**

### *Input/Output Individual Options*

Each device pad has optional pull-up and pull-down in all SelectI/O-Ultra configurations. Each device pad has optional weak-keeper in LVTTL, LVCMOS, and PCI SelectI/O-Ultra configurations, as illustrated in Figure 5. Values of the optional pull-up and pull-down resistors are in the range 10 - 60 KΩ, which is the specification for $V_{CCO}$ when operating at 3.3V (from 3.0 to 3.6V only). The clamp diode is always present, even when power is not.

The optional weak-keeper circuit is connected to each user I/O pad. When selected, the circuit monitors the voltage on the pad and weakly drives the pin High or Low. If the pin is connected to a multiple-source signal, the weak-keeper holds the signal in its last state if all drivers are disabled. Maintaining a valid logic level in this way eliminates bus chatter. An enabled pull-up or pull-down overrides the weak-keeper circuit.

LVTTL sinks and sources current up to 24 mA. The current is programmable for LVTTL and LVCMOS SelectI/O-Ultra standards (see Table 4). Drive-strength and slew-rate controls for each output driver, minimize bus transients. For LVDCI and LVDCI_DV2 standards, drive strength and slew-rate controls are not available.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 4:* **LVTTL and LVCMOS Programmable Currents (Sink and Source)**

| SelectI/O-Ultra | Programmable Current (Worst-Case Guaranteed Minimum) | | | | | | |
|---|---|---|---|---|---|---|---|
| LVTTL | 2 mA | 4 mA | 6 mA | 8 mA | 12 mA | 16 mA | 24 mA |
| LVCMOS33 | 2 mA | 4 mA | 6 mA | 8 mA | 12 mA | 16 mA | 24 mA |
| LVCMOS25 | 2 mA | 4 mA | 6 mA | 8 mA | 12 mA | 16 mA | 24 mA |
| LVCMOS18 | 2 mA | 4 mA | 6 mA | 8 mA | 12 mA | 16 mA | n/a |
| LVCMOS15 | 2 mA | 4 mA | 6 mA | 8 mA | 12 mA | 16 mA | n/a |

Figure 6 shows the SSTL2, SSTL3, and HSTL configurations. HSTL can sink current up to 48 mA. (HSTL IV)

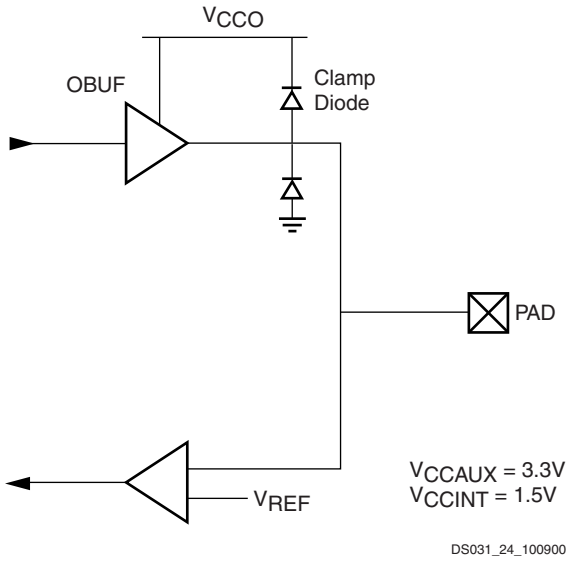



*Figure 6:* **SSTL or HSTL SelectI/O-Ultra Standards**

All pads are protected against damage from electrostatic discharge (ESD) and from over-voltage transients. Virtex-II uses two memory cells to control the configuration of an I/O as an input. This is to reduce the probability of an I/O configured as an input from flipping to an output when subjected to a single event upset (SEU) in space applications.

Prior to configuration, all outputs not involved in configuration are forced into their high-impedance state. The pull-down resistors and the weak-keeper circuits are inactive. The dedicated pin HSWAP_EN controls the pull-up resistors prior to configuration. By default, HSWAP_EN is set high, which disables the pull-up resistors on user I/O pins. When HSWAP_EN is set low, the pull-up resistors are activated on user I/O pins.

All Virtex-II IOBs support IEEE 1149.1 compatible Boundary-Scan testing.

### *Input Path*

The Virtex-II IOB input path routes input signals directly to internal logic and / or through an optional input flip-flop or latch, or through the DDR input registers. An optional delay element at the D-input of the storage element eliminates pad-to-pad hold time. The delay is matched to the internal clock-distribution delay of the Virtex-II device, and when used, assures that the pad-to-pad hold time is zero.

Each input buffer can be configured to conform to any of the low-voltage signaling standards supported. In some of these standards the input buffer utilizes a user-supplied threshold voltage, $V_{REF}$. The need to supply $V_{REF}$ imposes constraints on which standards can be used in the same bank. See I/O banking description.

### *Output Path*

The output path includes a 3-state output buffer that drives the output signal onto the pad. The output and / or the 3-state signal can be routed to the buffer directly from the internal logic or through an output / 3-state flip-flop or latch, or through the DDR output / 3-state registers.

Each output driver can be individually programmed for a wide range of low-voltage signaling standards. In most signaling standards, the output High voltage depends on an externally supplied $V_{CCO}$ voltage. The need to supply $V_{CCO}$ imposes constraints on which standards can be used in the same bank. See I/O banking description.

### *I/O Banking*

Some of the I/O standards described above require $V_{CCO}$ and $V_{REF}$ voltages. These voltages are externally supplied and connected to device pins that serve groups of IOB blocks, called banks. Consequently, restrictions exist about which I/O standards can be combined within a given bank.

Eight I/O banks result from dividing each edge of the FPGA into two banks, as shown in Figure 7 and Figure 8. Each bank has multiple $V_{CCO}$ pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

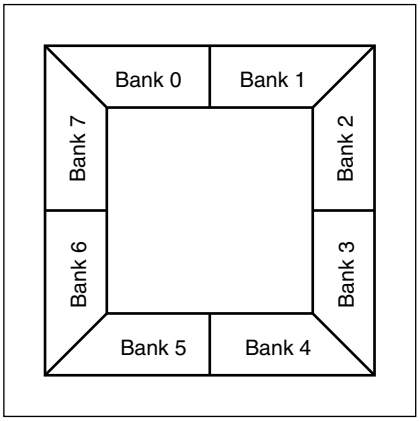




*Figure 7:* **Virtex-II I/O Banks: Top View for Wire-Bond Packages (CS/CSG, FG/FGG, & BG/BGG)**

Some input standards require a user-supplied threshold voltage ($V_{REF}$), and certain user-I/O pins are automatically configured as $V_{REF}$ inputs. Approximately one in six of the I/O pins in the bank assume this role.

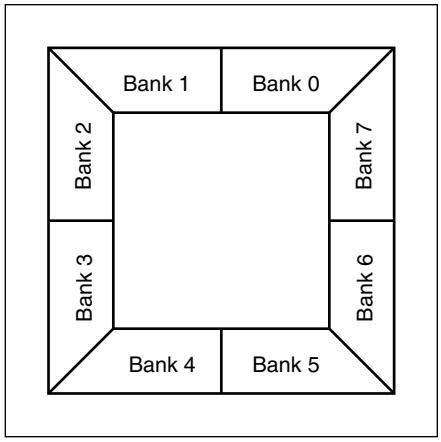



*Figure 8:* **Virtex-II I/O Banks: Top View for Flip-Chip Packages (FF & BF)**

$V_{REF}$ pins within a bank are interconnected internally, and consequently only one $V_{REF}$ voltage can be used within each bank. However, for correct operation, all $V_{REF}$ pins in the bank must be connected to the external reference voltage source.

The $V_{CCO}$ and the $V_{REF}$ pins for each bank appear in the device pinout tables. Within a given package, the number of $V_{REF}$ and $V_{CCO}$ pins can vary depending on the size of device. In larger devices, more I/O pins convert to $V_{REF}$ pins. Since these are always a superset of the $V_{REF}$ pins used for smaller devices, it is possible to design a PCB that permits migration to a larger device if necessary.

All $V_{REF}$ pins for the largest device anticipated must be connected to the $V_{REF}$ voltage and not used for I/O. In smaller devices, some $V_{CCO}$ pins used in larger devices do not connect within the package. These unconnected pins can be left unconnected externally, or, if necessary, they can be connected to $V_{CCO}$ to permit migration to a larger device.

### *Rules for Combining I/O Standards in the Same Bank*

The following rules must be obeyed to combine different input, output, and bi-directional standards in the same bank:

1. **Combining output standards only.** Output standards with the same output $V_{CCO}$ requirement can be combined in the same bank.
   *Compatible example:*
   SSTL2_I and LVDS_25_DCI outputs
   *Incompatible example:*
   SSTL2_I (output $V_{CCO}$ = 2.5V) and LVCMOS33 (output $V_{CCO}$ = 3.3V) outputs
2. **Combining input standards only.** Input standards with the same input $V_{CCO}$ and input $V_{REF}$ requirements can be combined in the same bank.
   *Compatible example:*
   LVCMOS15 and HSTL_IV inputs
   *Incompatible example:*
   LVCMOS15 (input $V_{CCO}$ = 1.5V) and LVCMOS18 (input $V_{CCO}$ = 1.8V) inputs
   *Incompatible example:*
   HSTL_I_DCI_18 ($V_{REF}$ = 0.9V) and HSTL_IV_DCI_18 ($V_{REF}$ = 1.1V) inputs
3. **Combining input standards and output standards.** Input standards and output standards with the same input $V_{CCO}$ and output $V_{CCO}$ requirement can be combined in the same bank.
   *Compatible example:*
   LVDS_25 output and HSTL_I input
   *Incompatible example:*
   LVDS_25 output (output $V_{CCO}$ = 2.5V) and HSTL_I_DCI_18 input (input $V_{CCO}$ = 1.8V)
4. **Combining bi-directional standards with input or output standards.** When combining bi-directional I/O with other standards, make sure the bi-directional standard can meet rules 1 through 3 above.
5. **Additional rules for combining DCI I/O standards.**
   a. No more than one Single Termination type (input or output) is allowed in the same bank.
      *Incompatible example:*
      HSTL_IV_DCI input and HSTL_III_DCI input
   b. No more than one Split Termination type (input or output) is allowed in the same bank.
      *Incompatible example:*
      HSTL_I_DCI input and HSTL_II_DCI input

The implementation tools will enforce these design rules.

Table 5 summarizes all standards and voltage supplies.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 5:* **Summary of Voltage Supply Requirements for All Input and Output Standards**

| I/O Standard | $V_{CCO}$ | | $V_{REF}$ | Termination Type | |
|---|---|---|---|---|---|
| | Output | Input | Input | Output | Input |
| LVDS_33 | 3.3 | N/R | N/R[1] | N/R | N/R |
| LVDSEXT_33 | | | N/R | N/R | N/R |
| LVPECL_33 | | | N/R | N/R | N/R |
| SSTL3_I | | | 1.5 | N/R | N/R |
| SSTL3_II | | | 1.5 | N/R | N/R |
| AGP | | | 1.32 | N/R | N/R |
| LVTTL | | 3.3 | N/R | N/R | N/R |
| LVCMOS33 | | | N/R | N/R | N/R |
| LVDCI_33 | | | N/R | Series | N/R |
| LVDCI_DV2_33 | | | N/R | Series | N/R |
| PCI33_3 | | | N/R | N/R | N/R |
| PCI66_3 | | | N/R | N/R | N/R |
| PCIX | | | N/R | N/R | N/R |
| SSTL3_I_DCI | | | 1.5 | N/R | Split |
| SSTL3_II_DCI | | | 1.5 | Split | Split |
| LVDS_25 | 2.5 | N/R | N/R | N/R | N/R |
| LVDSEXT_25 | | | N/R | N/R | N/R |
| LDT_25 | | | N/R | N/R | N/R |
| ULVDS_25 | | | N/R | N/R | N/R |
| BLVDS_25 | | | N/R | N/R | N/R |
| SSTL2_I | | | 1.25 | N/R | N/R |
| SSTL2_II | | | 1.25 | N/R | N/R |
| LVCMOS25 | | 2.5 | N/R | N/R | N/R |
| LVDCI_25 | | | N/R | Series | N/R |
| LVDCI_DV2_25 | | | N/R | Series | N/R |
| LVDS_25_DCI | | | N/R | N/R | Split |
| LVDSEXT_25_DCI | | | N/R | N/R | Split |
| SSTL2_I_DCI | | | 1.25 | N/R | Split |
| SSTL2_II_DCI | | | 1.25 | Split | Split |

*Table 5:* **Summary of Voltage Supply Requirements for All Input and Output Standards *(Continued)***

| I/O Standard | $V_{CCO}$ | | $V_{REF}$ | Termination Type | |
|---|---|---|---|---|---|
| | Output | Input | Input | Output | Input |
| HSTL_III_18 | 1.8 | N/R | 1.1 | N/R | N/R |
| HSTL_IV_18 | | | 1.1 | N/R | N/R |
| HSTL_I_18 | | | 0.9 | N/R | N/R |
| HSTL_II_18 | | | 0.9 | N/R | N/R |
| SSTL18_I | | | 0.9 | N/R | N/R |
| SSTL18_II | | | 0.9 | N/R | N/R |
| LVCMOS18 | | 1.8 | N/R | N/R | N/R |
| LVDCI_18 | | | N/R | Series | N/R |
| LVDCI_DV2_18 | | | N/R | Series | N/R |
| HSTL_III_DCI_18 | | | 1.1 | N/R | Single |
| HSTL_IV_DCI_18 | | | 1.1 | Single | Single |
| HSTL_I_DCI_18 | | | 0.9 | N/R | Split |
| HSTL_II_DCI_18 | | | 0.9 | Split | Split |
| SSTL18_I_DCI | | | 0.9 | N/R | Split |
| SSTL18_II_DCI | | | 0.9 | Split | Split |
| HSTL_III | 1.5 | N/R | 0.9 | N/R | N/R |
| HSTL_IV | | | 0.9 | N/R | N/R |
| HSTL_I | | | 0.75 | N/R | N/R |
| HSTL_II | | | 0.75 | N/R | N/R |
| LVCMOS15 | | 1.5 | N/R | N/R | N/R |
| LVDCI_15 | | | N/R | Series | N/R |
| LVDCI_DV2_15 | | | N/R | Series | N/R |
| GTLP_DCI | | | 1 | Single | Single |
| HSTL_III_DCI | | | 0.9 | N/R | Single |
| HSTL_IV_DCI | | | 0.9 | Single | Single |
| HSTL_I_DCI | | | 0.75 | N/R | Split |
| HSTL_II_DCI | | | 0.75 | Split | Split |
| GTL_DCI | 1.2 | 1.2 | 0.8 | Single | Single |
| GTLP | N/R | N/R | 1 | N/R | N/R |
| GTL | | | 0.8 | N/R | N/R |

**Notes:**
1. N/R = no requirement.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Digitally Controlled Impedance (DCI)

Today's chip output signals with fast edge rates require termination to prevent reflections and maintain signal integrity. High pin count packages (especially ball grid arrays) can not accommodate external termination resistors.

Virtex-II XCITE DCI provides controlled impedance drivers and on-chip termination for single-ended and differential I/Os. This eliminates the need for external resistors, and improves signal integrity. The DCI feature can be used on any IOB by selecting one of the DCI I/O standards.

When applied to inputs, DCI provides input parallel termination. When applied to outputs, DCI provides controlled impedance drivers (series termination) or output parallel termination.

DCI operates independently on each I/O bank. When a DCI I/O standard is used in a particular I/O bank, external reference resistors must be connected to two dual-function pins on the bank. These resistors, voltage reference of N transistor (VRN) and the voltage reference of P transistor (VRP) are shown in Figure 9.

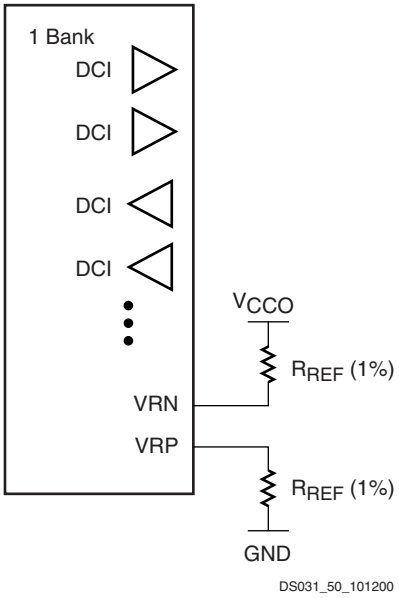



*Figure 9:* **DCI in a Virtex-II Bank**

When used with a terminated I/O standard, the value of resistors are specified by the standard (typically 50Ω). When used with a controlled impedance driver, the resistors set the output impedance of the driver within the specified range (25Ω to 100Ω). For all series and parallel terminations listed in Table 6 and Table 7, the reference resistors must have the same value for any given bank. One percent resistors are recommended.

The DCI system adjusts the I/O impedance to match the two external reference resistors, or half of the reference resistors, and compensates for impedance changes due to voltage and/or temperature fluctuations. The adjustment is done by turning parallel transistors in the IOB on or off.

### *Controlled Impedance Drivers (Series Term.)*

DCI can be used to provide a buffer with a controlled output impedance. It is desirable for this output impedance to match the transmission line impedance ($Z_0$). Virtex-II input buffers also support LVDCI and LVDCI_DV2 I/O standards.

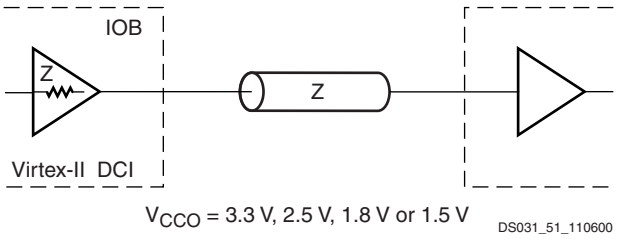



*Figure 10:* **Internal Series Termination**

*Table 6:* **SelectI/O-Ultra Controlled Impedance Buffers**

| $V_{CCO}$ | DCI | DCI Half Impedance |
|---|---|---|
| 3.3 V | LVDCI_33 | LVDCI_DV2_33 |
| 2.5 V | LVDCI_25 | LVDCI_DV2_25 |
| 1.8 V | LVDCI_18 | LVDCI_DV2_18 |
| 1.5 V | LVDCI_15 | LVDCI_DV2_15 |

### *Controlled Impedance Drivers (Parallel)*

DCI also provides on-chip termination for SSTL3, SSTL2, HSTL (Class I, II, III, or IV), and GTL/GTLP receivers or transmitters on bidirectional lines.

Table 7 and Table 8 list the on-chip parallel terminations available in Virtex-II devices. $V_{CCO}$ must be set according to Table 3. Note that there is a $V_{CCO}$ requirement for GTL_DCI and GTLP_DCI, due to the on-chip termination resistor.

*Table 7:* **SelectI/O-Ultra Buffers With On-Chip Parallel Termination**

| I/O Standard Description | IOSTANDARD Attribute | |
|---|---|---|
| | External Termination | On-Chip Termination |
| SSTL3 Class I | SSTL3_I | SSTL3_I_DCI(1) |
| SSTL3 Class II | SSTL3_II | SSTL3_II_DCI(1) |
| SSTL2 Class I | SSTL2_I | SSTL2_I_DCI(1) |
| SSTL2 Class II | SSTL2_II | SSTL2_II_DCI(1) |
| HSTL Class I | HSTL_I | HSTL_I_DCI |
| HSTL Class II | HSTL_II | HSTL_II_DCI |
| HSTL Class III | HSTL_III | HSTL_III_DCI |
| HSTL Class IV | HSTL_IV | HSTL_IV_DCI |
| GTL | GTL | GTL_DCI |
| GTLP | GTLP | GTLP_DCI |

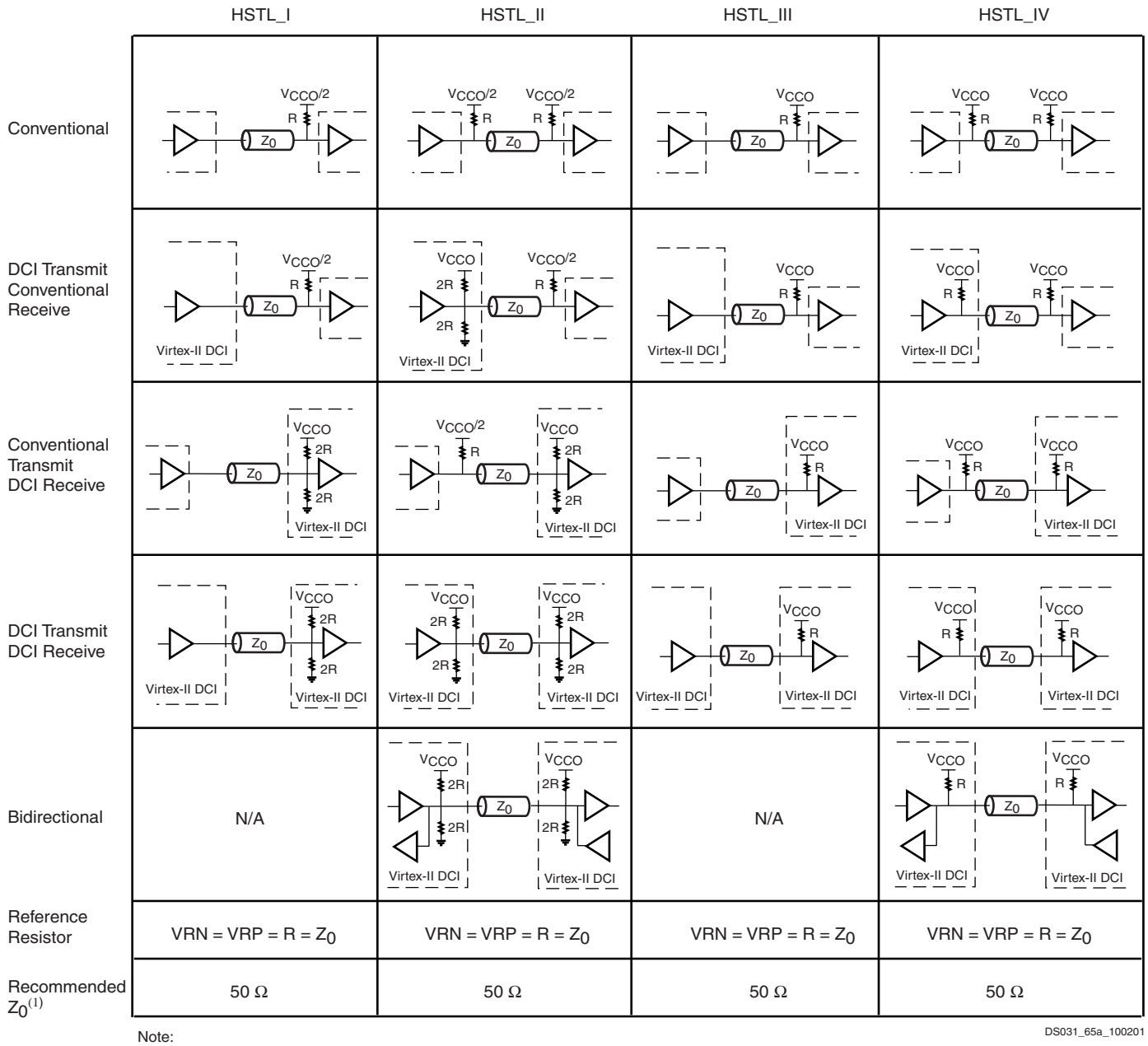
**Notes:**
1. SSTL-compatible

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **SelectI/O-Ultra Differential Buffers With On-Chip Termination**

| I/O Standard Description | IOSTANDARD Attribute | |
|---|---|---|
| | External Termination | On-Chip Termination |
| LVDS 2.5V | LVDS_25 | LVDS_25_DCI |
| LVDS Extended 2.5V | LVDSEXT_25 | LVDSEXT_25_DCI |

Figure 11 provides examples illustrating the use of the HSTL_I_DCI, HSTL_II_DCI, HSTL_III_DCI, and HSTL_IV_DCI I/O standards. For a complete list, see the **Virtex-II Platform FPGA User Guide**.

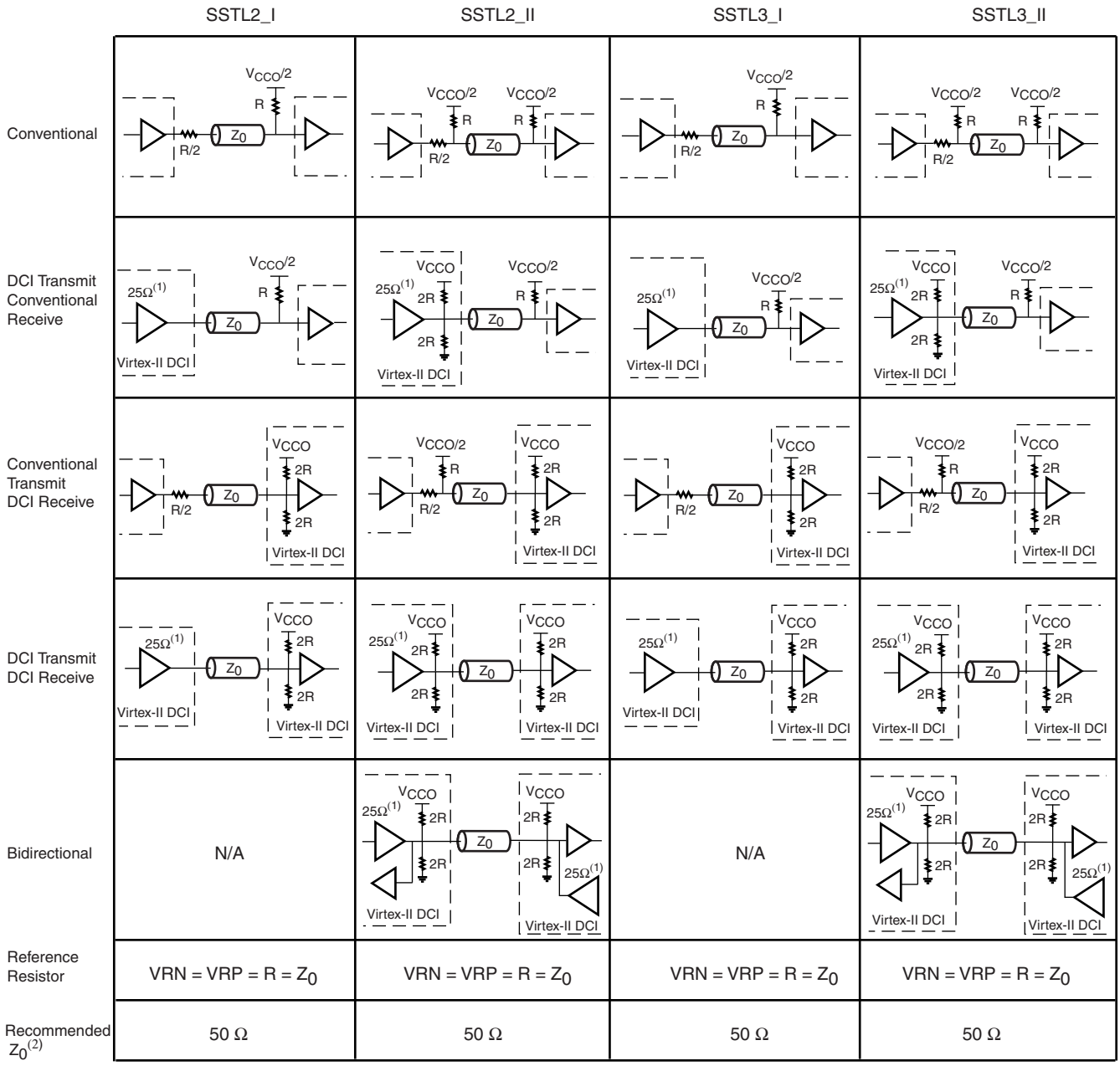



Note:
1. $Z_0$ is the recommended PCB trace impedance.

*Figure 11:* **HSTL DCI Usage Examples**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Figure 12 provides examples illustrating the use of the SSTL2_I_DCI, SSTL2_II_DCI, SSTL3_I_DCI, and SSTL3_II_DCI I/O standards. For a complete list, see the **Virtex-II Platform FPGA User Guide**.




Notes:
1. The SSTL-compatible 25Ω series resistor is accounted for in the DCI buffer, and it is not DCI controlled.
2. $Z_0$ is the recommended PCB trace impedance.

DS031_65b_112502

*Figure 12:* **SSTL DCI Usage Examples**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Figure 13 provides examples illustrating the use of the LVDS_DCI and LVDSEXT_DCI I/O standards. For a complete list, see the **Virtex-II Platform FPGA User Guide**.

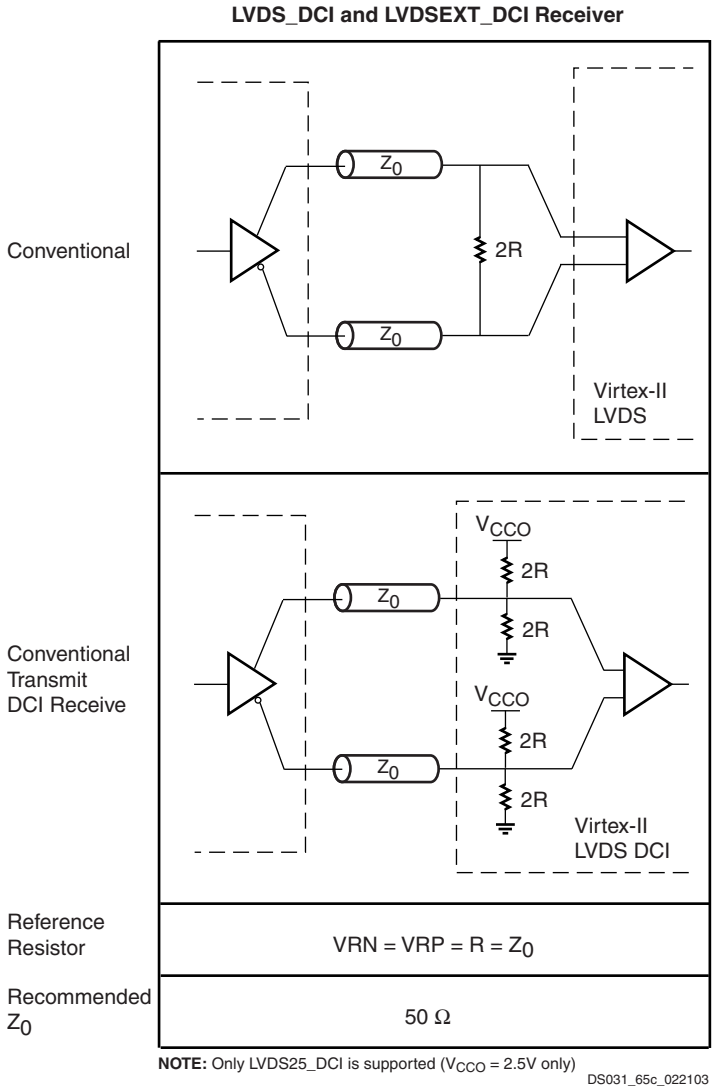



*Figure 13:* **LVDS DCI Usage Examples**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Configurable Logic Blocks (CLBs)

The Virtex-II configurable logic blocks (CLB) are organized in an array and are used to build combinatorial and synchronous logic designs. Each CLB element is tied to a switch matrix to access the general routing matrix, as shown in Figure 14. A CLB element comprises 4 similar slices, with fast local feedback within the CLB. The four slices are split in two columns of two slices with two independent carry logic chains and one common shift chain.

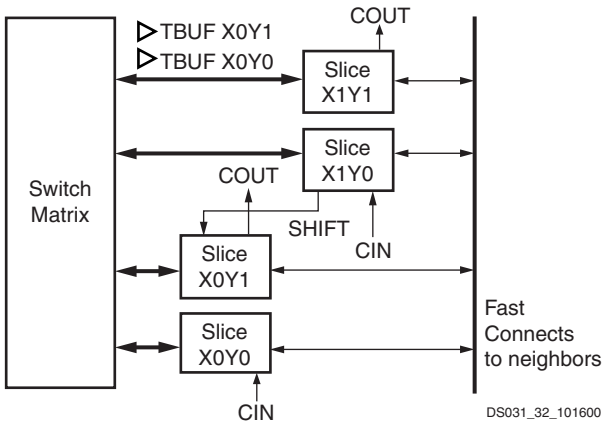



*Figure 14:* **Virtex-II CLB Element**

### *Slice Description*

Each slice includes two 4-input function generators, carry logic, arithmetic logic gates, wide function multiplexers and two storage elements. As shown in Figure 15, each 4-input function generator is programmable as a 4-input LUT, 16 bits of distributed SelectRAM memory, or a 16-bit variable-tap shift register element.

The output from the function generator in each slice drives both the slice output and the D input of the storage element. Figure 16 shows a more detailed view of a single slice.

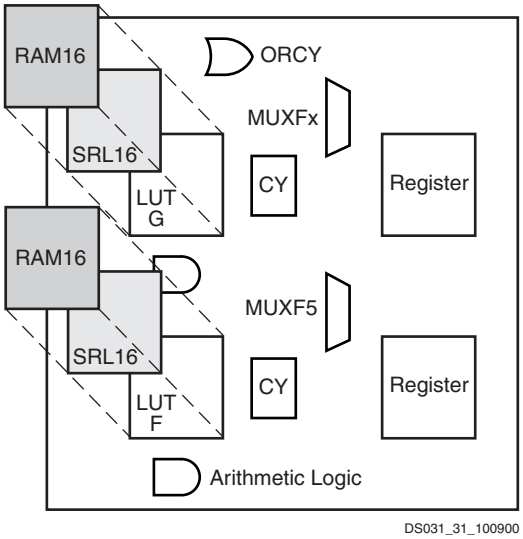



*Figure 15:* **Virtex-II Slice Configuration**

### *Configurations*

#### Look-Up Table

Virtex-II function generators are implemented as 4-input look-up tables (LUTs). Four independent inputs are provided to each of the two function generators in a slice (F and G). These function generators are each capable of implementing any arbitrarily defined boolean function of four inputs. The propagation delay is therefore independent of the function implemented. Signals from the function generators can exit the slice (X or Y output), can input the XOR dedicated gate (see arithmetic logic), or input the carry-logic multiplexer (see fast look-ahead carry logic), or feed the D input of the storage element, or go to the MUXF5 (not shown in Figure 16).

In addition to the basic LUTs, the Virtex-II slice contains logic (MUXF5 and MUXFX multiplexers) that combines function generators to provide any function of five, six, seven, or eight inputs. The MUXFX are either MUXF6, MUXF7 or MUXF8 according to the slice considered in the CLB. Selected functions up to nine inputs (MUXF5 multiplexer) can be implemented in one slice. The MUXFX can also be a MUXF6, MUXF7, or MUXF8 multiplexers to map any functions of six, seven, or eight inputs and selected wide logic functions.

#### Register/Latch

The storage elements in a Virtex-II slice can be configured either as edge-triggered D-type flip-flops or as level-sensitive latches. The D input can be directly driven by the X or Y output via the DX or DY input, or by the slice inputs bypassing the function generators via the BX or BY input. The clock enable signal (CE) is active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

In addition to clock (CK) and clock enable (CE) signals, each slice has set and reset signals (SR and BY slice inputs). SR forces the storage element into the state specified by the attribute SRHIGH or SRLOW. SRHIGH forces a logic “1” when SR is asserted. SRLOW forces a logic “0”. When SR is used, a second input (BY) forces the storage element into the opposite state. The reset condition is predominant over the set condition. (See Figure 17.)

The initial state after configuration or global initial state is defined by a separate INIT0 and INIT1 attribute. By default, setting the SRLOW attribute sets INIT0, and setting the SRHIGH attribute sets INIT1. For each slice, set and reset can be set to be synchronous or asynchronous. Virtex-II devices also have the ability to set INIT0 and INIT1 independent of SRHIGH and SRLOW.

The control signals clock (CLK), clock enable (CE) and set/reset (SR) are common to both storage elements in one slice. All of the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

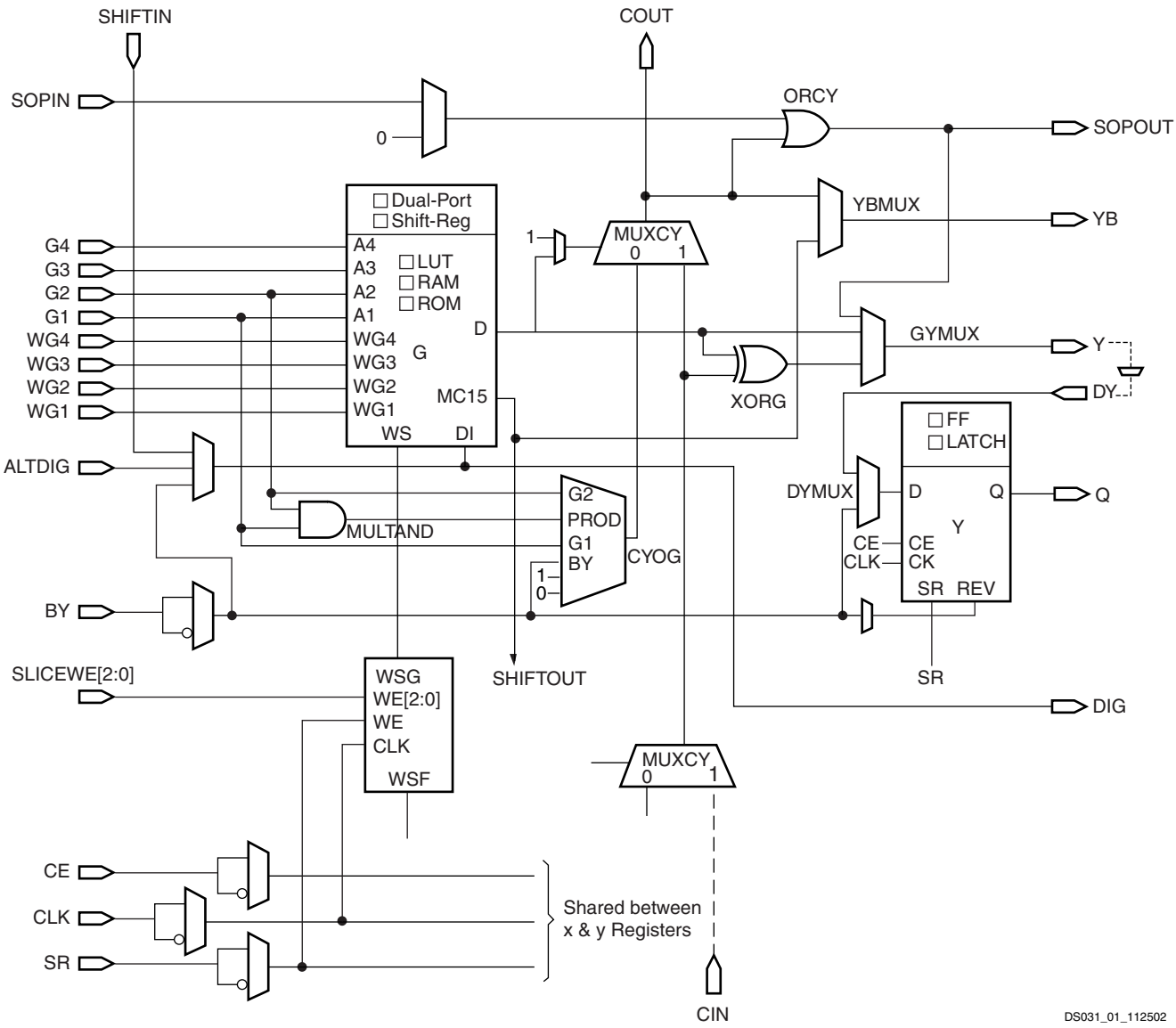




*Figure 16:* **Virtex-II Slice (Top Half)**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

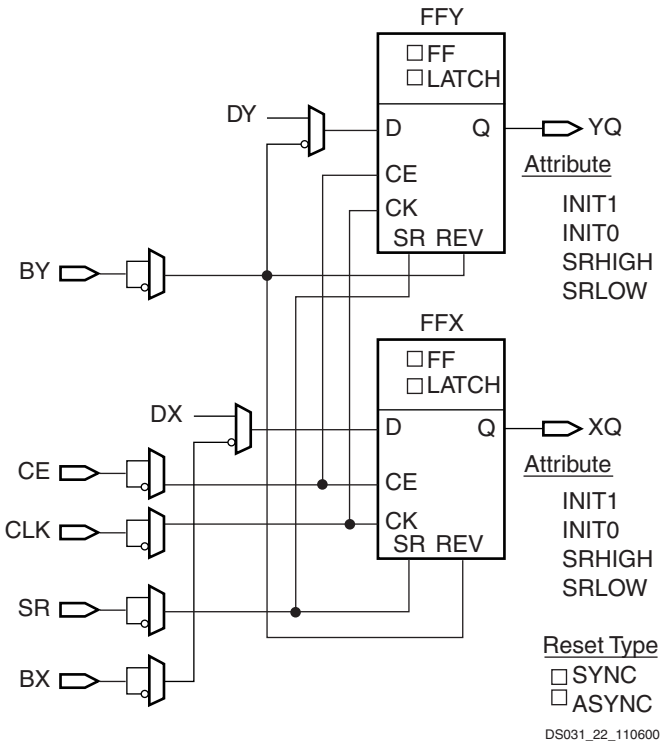




*Figure 17:* **Register / Latch Configuration in a Slice**

The set and reset functionality of a register or a latch can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset has precedence over a set, and an asynchronous clear has precedence over a preset.

### Distributed SelectRAM Memory

Each function generator (LUT) can implement a 16 x 1-bit synchronous RAM resource called a distributed SelectRAM element. The SelectRAM elements are configurable within a CLB to implement the following:

- Single-Port 16 x 8 bit RAM
- Single-Port 32 x 4 bit RAM
- Single-Port 64 x 2 bit RAM
- Single-Port 128 x 1 bit RAM
- Dual-Port 16 x 4 bit RAM
- Dual-Port 32 x 2 bit RAM
- Dual-Port 64 x 1 bit RAM

Distributed SelectRAM memory modules are synchronous (write) resources. The combinatorial read access time is extremely fast, while the synchronous write simplifies high-speed designs. A synchronous read can be implemented with a storage element in the same slice. The distributed SelectRAM memory and the storage element share the same clock input. A Write Enable (WE) input is active High, and is driven by the SR input.

Table 9 shows the number of LUTs (2 per slice) occupied by each distributed SelectRAM configuration.

*Table 9:* **Distributed SelectRAM Configurations**

| RAM | Number of LUTs |
|---|---|
| 16 x 1S | 1 |
| 16 x 1D | 2 |
| 32 x 1S | 2 |
| 32 x 1D | 4 |
| 64 x 1S | 4 |
| 64 x 1D | 8 |
| 128 x 1S | 8 |

**Notes:**
1. S = single-port configuration; D = dual-port configuration

For single-port configurations, distributed SelectRAM memory has one address port for synchronous writes and asynchronous reads.

For dual-port configurations, distributed SelectRAM memory has one port for synchronous writes and asynchronous reads and another port for asynchronous reads. The function generator (LUT) has separated read address inputs (A1, A2, A3, A4) and write address inputs (WG1/WF1, WG2/WF2, WG3/WF3, WG4/WF4).

In single-port mode, read and write addresses share the same address bus. In dual-port mode, one function generator (R/W port) is connected with shared read and write addresses. The second function generator has the A inputs (read) connected to the second read-only port address and the W inputs (write) shared with the first read/write port address.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

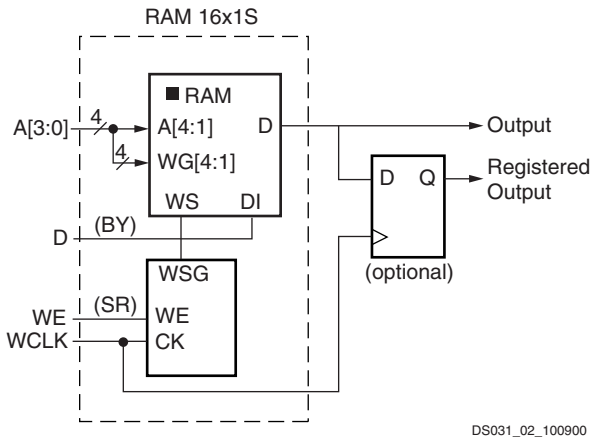



*Figure 18:* **Distributed SelectRAM (RAM16x1S)**

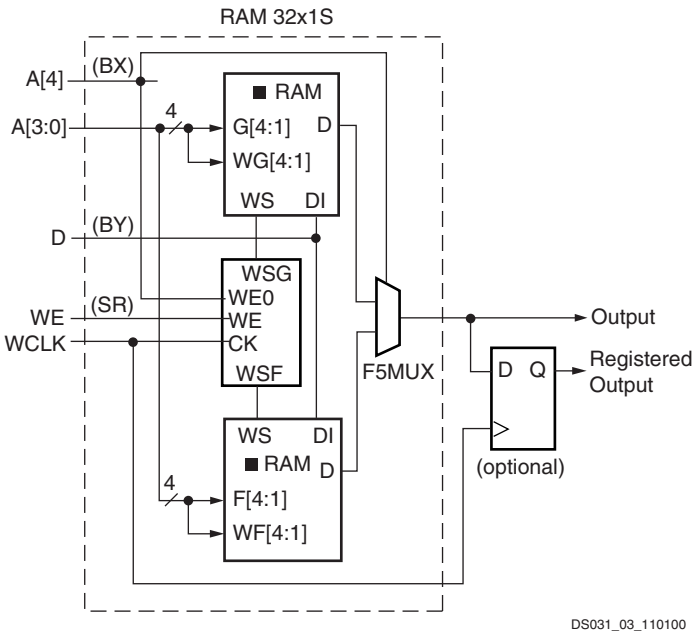



*Figure 19:* **Single-Port Distributed SelectRAM (RAM32x1S)**

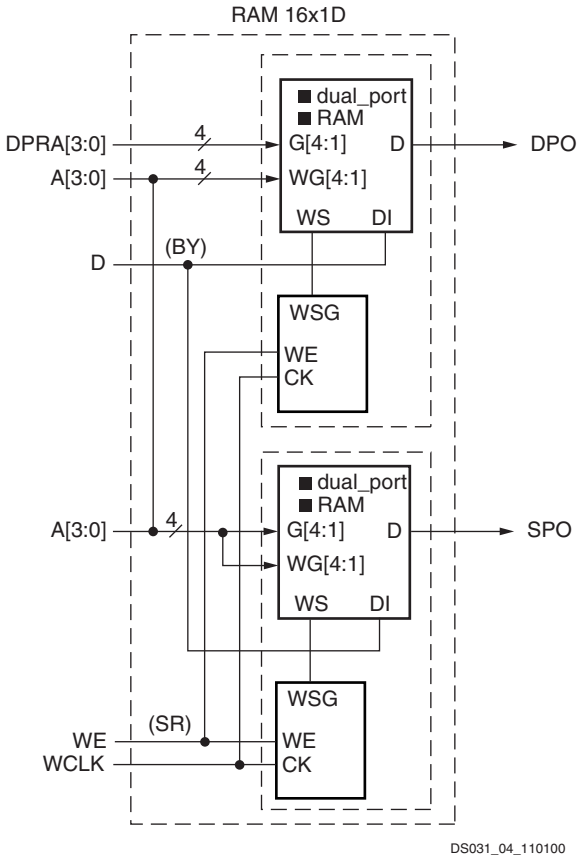



*Figure 20:* **Dual-Port Distributed SelectRAM (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

*Table 10:* **ROM Configuration**

| ROM | Number of LUTs |
|---|---|
| 16 x 1 | 1 |
| 32 x 1 | 2 |
| 64 x 1 | 4 |
| 128 x 1 | 8 (1 CLB) |
| 256 x 1 | 16 (2 CLBs) |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### Shift Registers

Each function generator can also be configured as a 16-bit shift register. The write operation is synchronous with a clock input (CLK) and an optional clock enable, as shown in Figure 21. A dynamic read access is performed through the 4-bit address bus, A[3:0]. The configurable 16-bit shift register cannot be set or reset. The read is asynchronous, however the storage element or flip-flop is available to implement a synchronous read. The storage element should always be used with a constant address. For example, when building an 8-bit shift register and configuring the addresses to point to the 7th bit, the 8th bit can be the flip-flop. The overall system performance is improved by using the superior clock-to-out of the flip-flops.

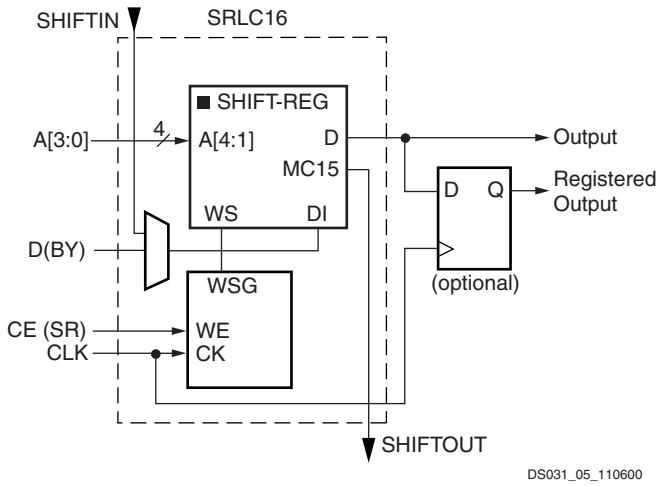



*Figure 21:* **Shift Register Configurations**

An additional dedicated connection between shift registers allows connecting the last bit of one shift register to the first bit of the next, without using the ordinary LUT output. (See Figure 22.) Longer shift registers can be built with dynamic access to any bit in the chain. The shift register chaining and the MUXF5, MUXF6, and MUXF7 multiplexers allow up to a 128-bit shift register with addressable access to be implemented in one CLB.

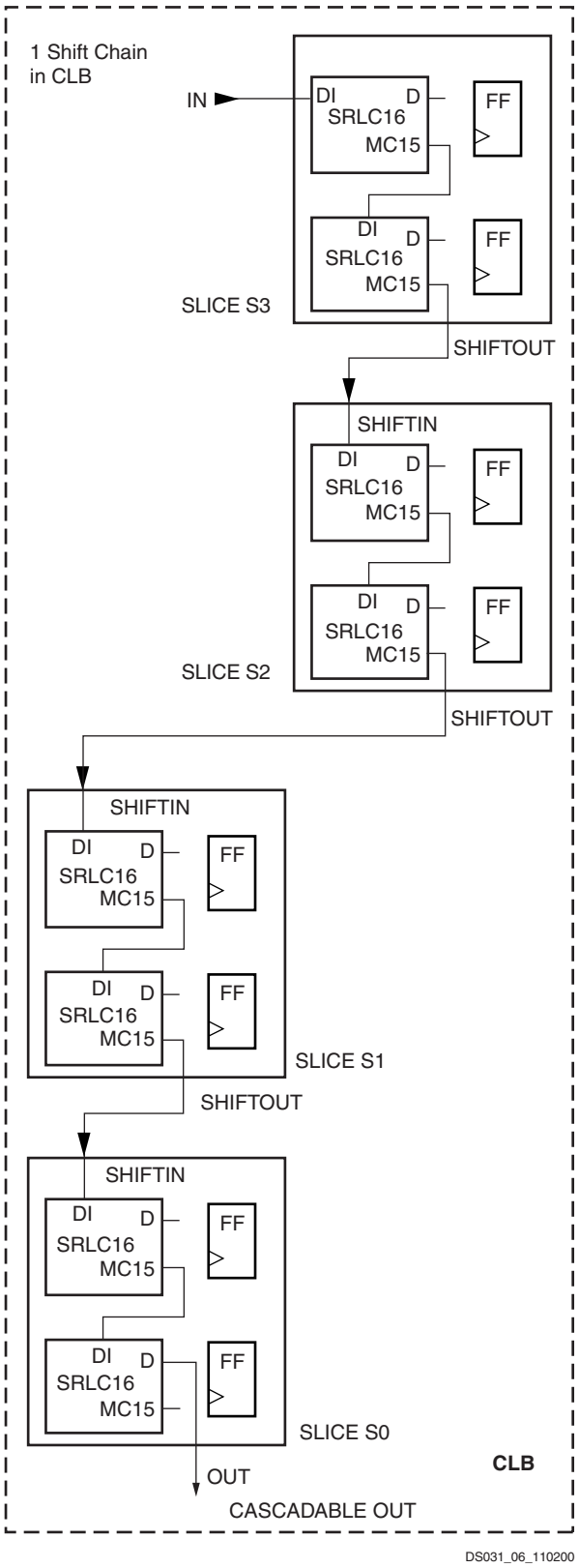



*Figure 22:* **Cascadable Shift Register**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### Multiplexers

Virtex-II function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in Figure 23. Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

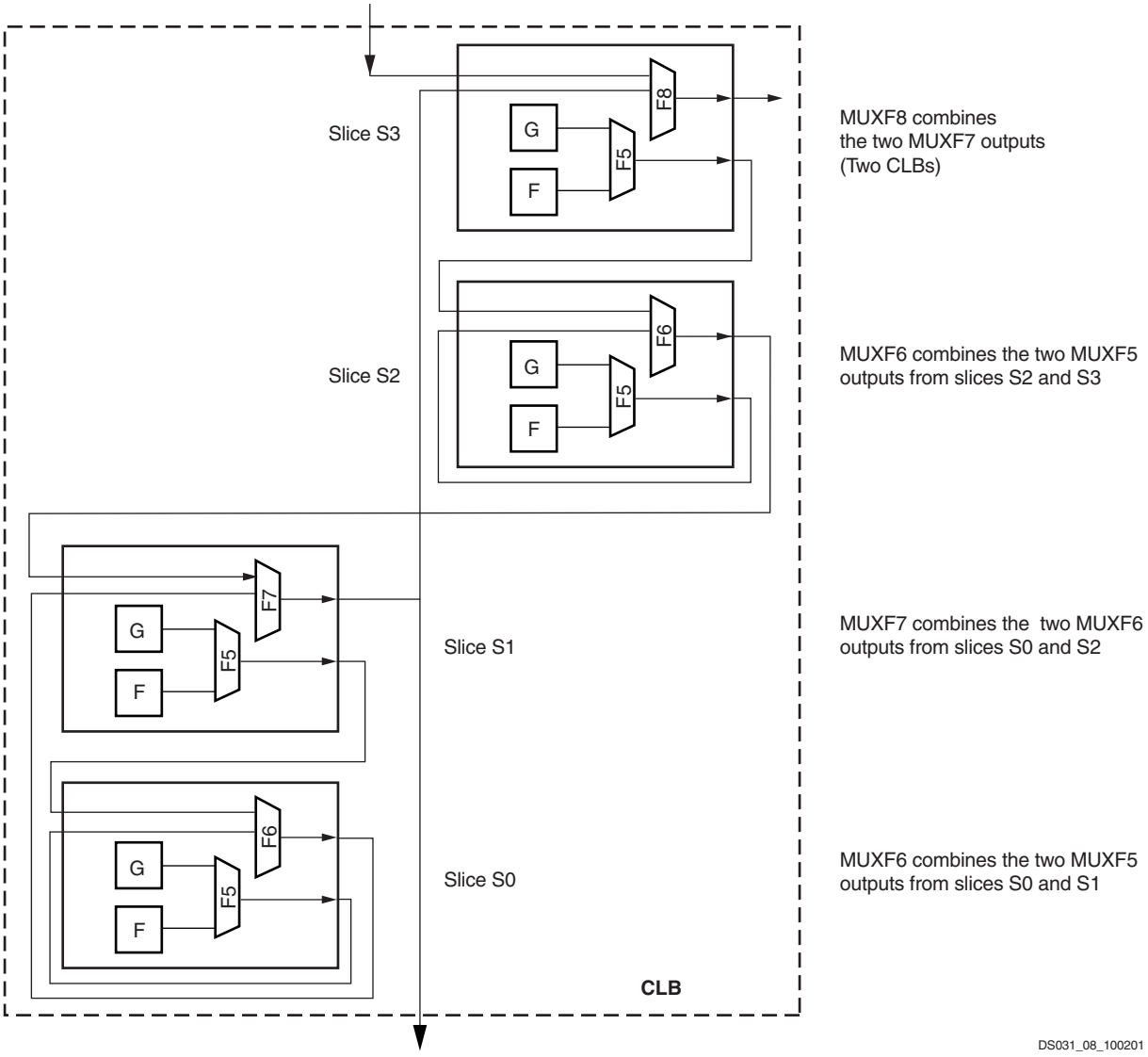



*Figure 23:* **MUXF5 and MUXFX multiplexers**

### Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II CLB has two separate carry chains, as shown in the Figure 24.

The height of the carry chains is two bits per slice. The carry chain in the Virtex-II device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also be used to cascade function generators for implementing wide logic functions.

### Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in Figure 16) improves the efficiency of multiplier implementation.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

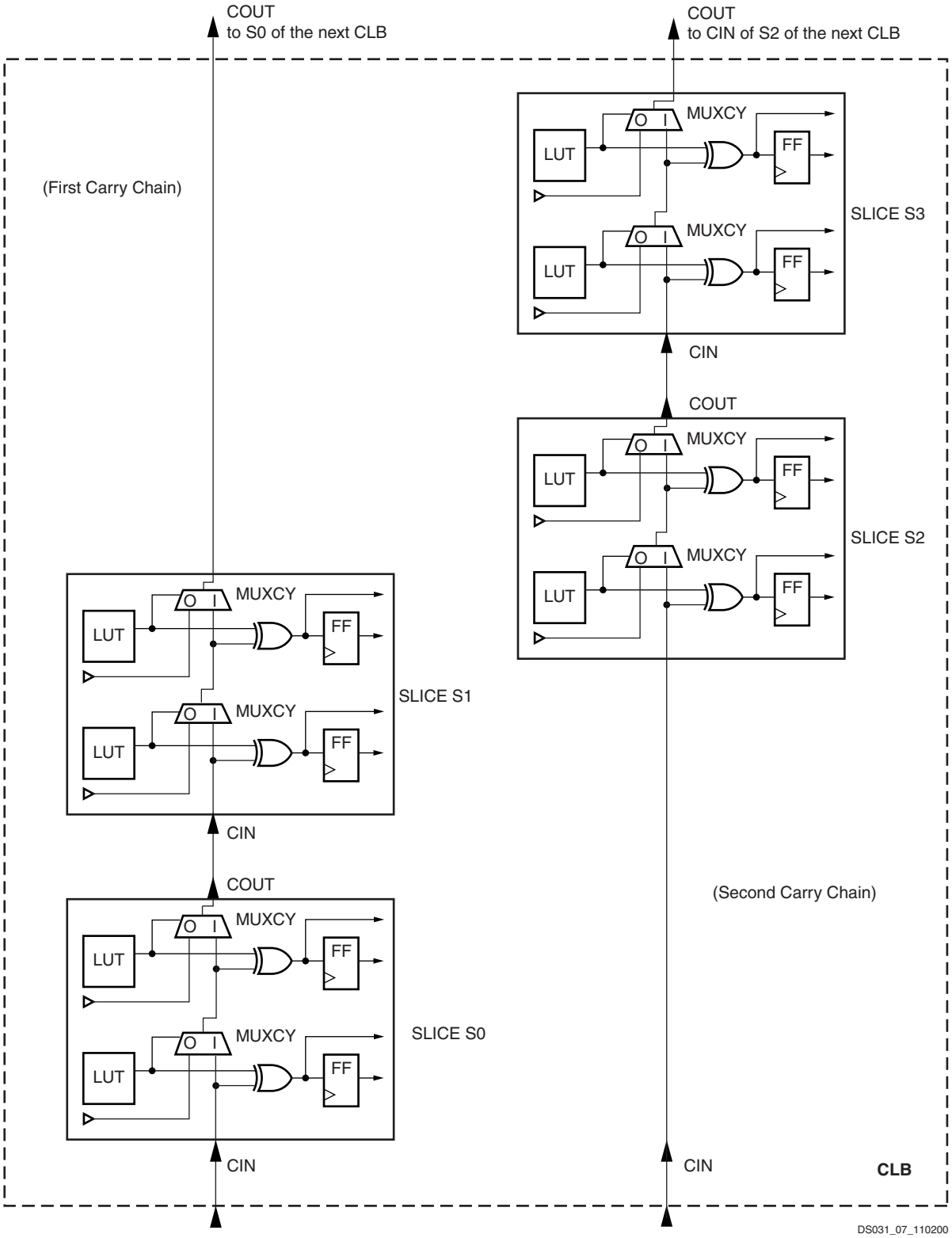




*Figure 24:* **Fast Carry Logic Path**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### Sum of Products

Each Virtex-II slice has a dedicated OR gate named ORCY, ORing together outputs from the slices carryout and the ORCY from an adjacent slice. The ORCY gate with the dedicated Sum of Products (SOP) chain are designed for implementing large, flexible SOP chains. One input of each ORCY is connected through the fast SOP chain to the output of the previous ORCY in the same slice row. The second input is connected to the output of the top MUXCY in the same slice, as shown in Figure 25.

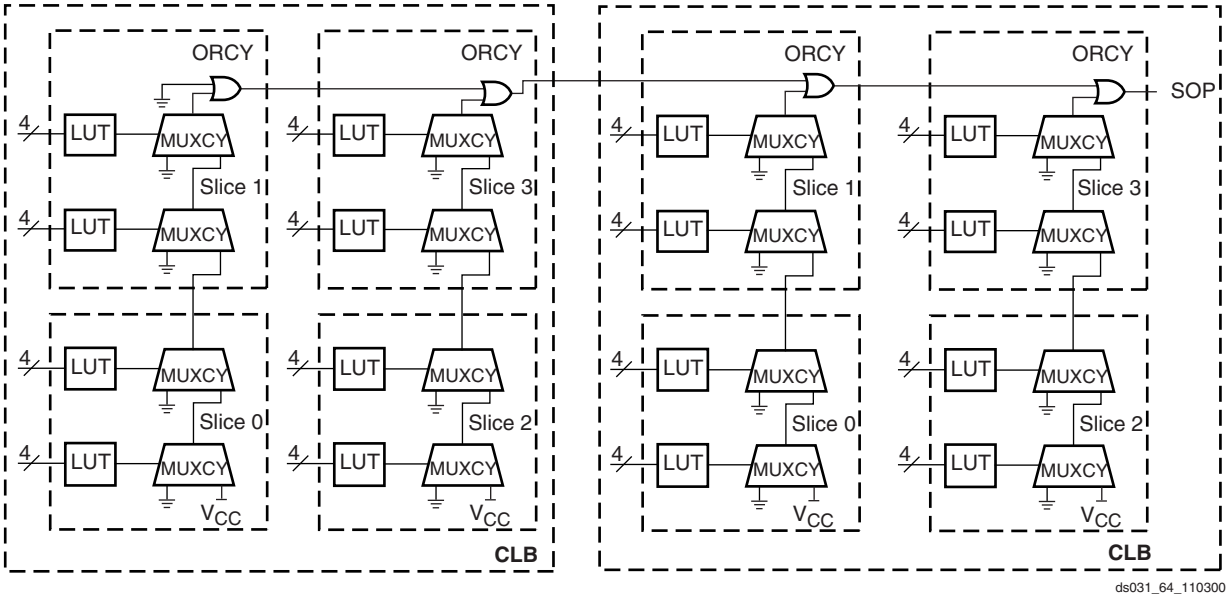



*Figure 25:* **Horizontal Cascade Chain**

LUTs and MUXCYs can implement large AND gates or other combinatorial logic functions. Figure 26 illustrates LUT and MUXCY resources configured as a 16-input AND gate.

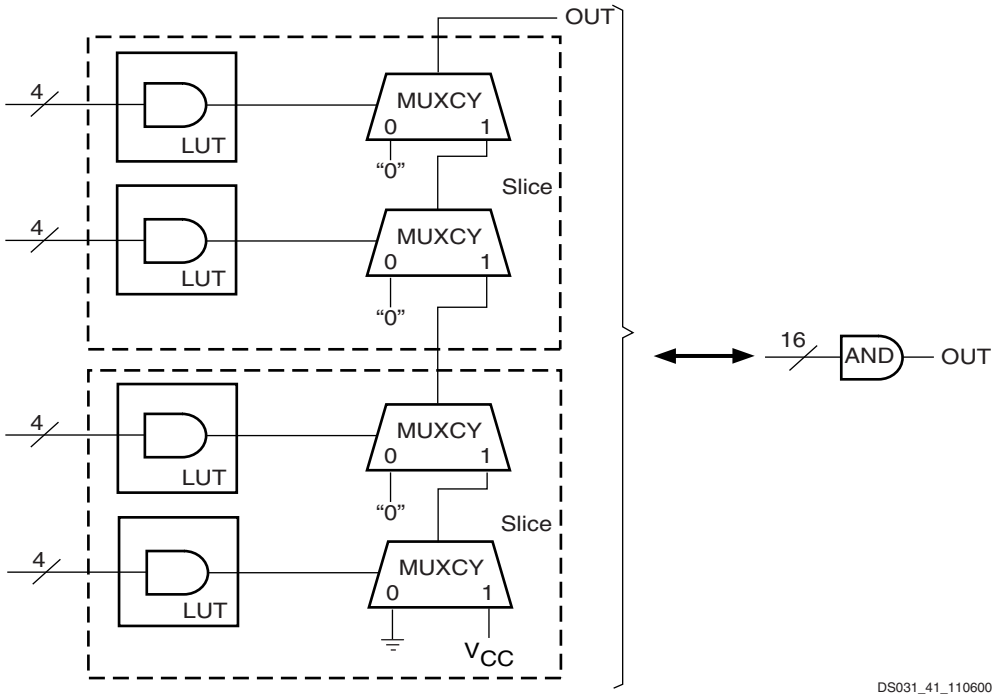



*Figure 26:* **Wide-Input AND Gate (16 Inputs)**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### 3-State Buffers

#### Introduction

Each Virtex-II CLB contains two 3-state drivers (TBUFs) that can drive on-chip busses. Each 3-state buffer has its own 3-state control pin and its own input pin.

Each of the four slices have access to the two 3-state buffers through the switch matrix, as shown in Figure 27. TBUFs in neighboring CLBs can access slice outputs by direct connects. The outputs of the 3-state buffers drive horizontal routing resources used to implement 3-state busses.

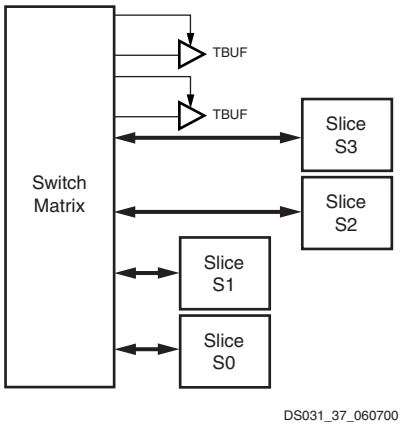



*Figure 27:* **Virtex-II 3-State Buffers**

The 3-state buffer logic is implemented using AND-OR logic rather than 3-state drivers, so that timing is more predictable and less load dependant especially with larger devices.

#### Locations / Organization

Four horizontal routing resources per CLB are provided for on-chip 3-state busses. Each 3-state buffer has access alternately to two horizontal lines, which can be partitioned as shown in Figure 28. The switch matrices corresponding to SelectRAM memory and multiplier or I/O blocks are skipped.

#### Number of 3-State Buffers

Table 11 shows the number of 3-state buffers available in each Virtex-II device. The number of 3-state buffers is twice the number of CLB elements.

*Table 11:* **Virtex-II 3-State Buffers**

| Device | 3-State Buffers per Row | Total Number of 3-State Buffers |
|---|---|---|
| XC2V40 | 16 | 128 |
| XC2V80 | 16 | 256 |
| XC2V250 | 32 | 768 |
| XC2V500 | 48 | 1,536 |
| XC2V1000 | 64 | 2,560 |
| XC2V1500 | 80 | 3,840 |
| XC2V2000 | 96 | 5,376 |
| XC2V3000 | 112 | 7,168 |
| XC2V4000 | 144 | 11,520 |
| XC2V6000 | 176 | 16,896 |
| XC2V8000 | 208 | 23,296 |

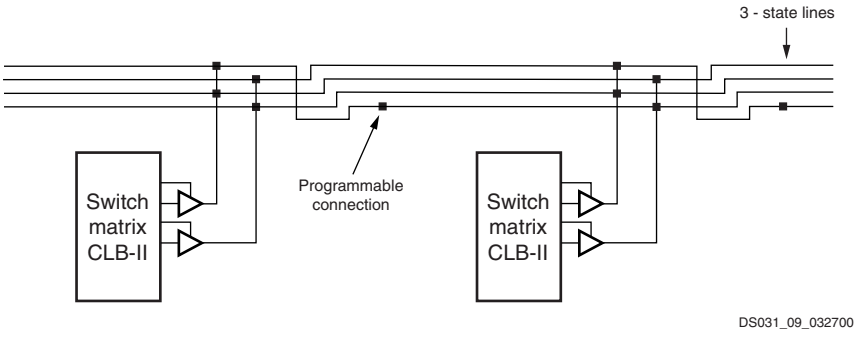



*Figure 28:* **3-State Buffer Connection to Horizontal Lines**

### CLB/Slice Configurations

Table 12 summarizes the logic resources in one CLB. All of the CLBs are identical and each CLB or slice can be implemented in one of the configurations listed. Table 13 shows the available resources in all CLBs.

*Table 12:* **Logic Resources in One CLB**

| Slices | LUTs | Flip-Flops | MULT_ANDs | Arithmetic & Carry-Chains | SOP Chains | Distributed SelectRAM | Shift Registers | TBUF |
|---|---|---|---|---|---|---|---|---|
| 4 | 8 | 8 | 8 | 2 | 2 | 128 bits | 128 bits | 2 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **Virtex-II Logic Resources Available in All CLBs**

| Device | CLB Array: Row x Column | Number of Slices | Number of LUTs | Max Distributed SelectRAM or Shift Register (bits) | Number of Flip-Flops | Number of Carry-Chains(1) | Number of SOP Chains(1) |
|---|---|---|---|---|---|---|---|
| XC2V40 | 8 x 8 | 256 | 512 | 8,192 | 512 | 16 | 16 |
| XC2V80 | 16 x 8 | 512 | 1,024 | 16,384 | 1,024 | 16 | 32 |
| XC2V250 | 24 x 16 | 1,536 | 3,072 | 49,152 | 3,072 | 32 | 48 |
| XC2V500 | 32 x 24 | 3,072 | 6,144 | 98,304 | 6,144 | 48 | 64 |
| XC2V1000 | 40 x 32 | 5,120 | 10,240 | 163,840 | 10,240 | 64 | 80 |
| XC2V1500 | 48 x 40 | 7,680 | 15,360 | 245,760 | 15,360 | 80 | 96 |
| XC2V2000 | 56 x 48 | 10,752 | 21,504 | 344,064 | 21,504 | 96 | 112 |
| XC2V3000 | 64 x 56 | 14,336 | 28,672 | 458,752 | 28,672 | 112 | 128 |
| XC2V4000 | 80 x 72 | 23,040 | 46,080 | 737,280 | 46,080 | 144 | 160 |
| XC2V6000 | 96 x 88 | 33,792 | 67,584 | 1,081,344 | 67,584 | 176 | 192 |
| XC2V8000 | 112 x 104 | 46,592 | 93,184 | 1,490,944 | 93,184 | 208 | 224 |

**Notes:**
1. The carry-chains and SOP chains can be split or cascaded.

## 18 Kbit Block SelectRAM Resources

### *Introduction*

Virtex-II devices incorporate large amounts of 18 Kbit block SelectRAM. These complement the distributed SelectRAM resources that provide shallow RAM structures implemented in CLBs. Each Virtex-II block SelectRAM is an 18 Kbit true dual-port RAM with two independently clocked and independently controlled synchronous ports that access a common storage area. Both ports are functionally identical. CLK, EN, WE, and SSR polarities are defined through configuration.

Each port has the following types of inputs: Clock and Clock Enable, Write Enable, Set/Reset, and Address, as well as separate Data/parity data inputs (for write) and Data/parity data outputs (for read).

Operation is synchronous; the block SelectRAM behaves like a register. Control, address and data inputs must (and need only) be valid during the set-up time window prior to a rising (or falling, a configuration option) clock edge. Data outputs change as a result of the same clock edge.

### *Configuration*

The Virtex-II block SelectRAM supports various configurations, including single- and dual-port RAM and various data/address aspect ratios. Supported memory configurations for single- and dual-port modes are shown in Table 14.

*Table 14:* **Dual- and Single-Port Configurations**

| | |
|---|---|
| 16K x 1 bit | 2K x 9 bits |
| 8K x 2 bits | 1K x 18 bits |
| 4K x 4 bits | 512 x 36 bits |

#### Single-Port Configuration

As a single-port RAM, the block SelectRAM has access to the 18 Kbit memory locations in any of the 2K x 9-bit, 1K x 18-bit, or 512 x 36-bit configurations and to 16 Kbit memory locations in any of the 16K x 1-bit, 8K x 2-bit, or 4K x 4-bit configurations. The advantage of the 9-bit, 18-bit and 36-bit widths is the ability to store a parity bit for each eight bits. Parity bits must be generated or checked externally in user logic. In such cases, the width is viewed as 8 + 1, 16 + 2, or 32 + 4. These extra parity bits are stored and behave exactly as the other bits, including the timing parameters. Video applications can use the 9-bit ratio of Virtex-II block SelectRAM memory to advantage.

Each block SelectRAM cell is a fully synchronous memory as illustrated in Figure 29. Input data bus and output data bus widths are identical.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

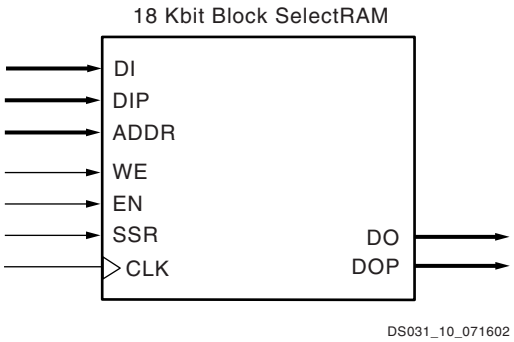




*Figure 29:* **18 Kbit Block SelectRAM Memory in Single-Port Mode**

### Dual-Port Configuration

As a dual-port RAM, each port of block SelectRAM has access to a common 18 Kbit memory resource. These are fully synchronous ports with independent control signals for each port. The data widths of the two ports can be configured independently, providing built-in bus-width conversion.

Table 15 illustrates the different configurations available on ports A and B.

If both ports are configured in either 2K x 9-bit, 1K x 18-bit, or 512 x 36-bit configurations, the 18 Kbit block is accessible from port A or B. If both ports are configured in either 16K x 1-bit, 8K x 2-bit. or 4K x 4-bit configurations, the 16 K-bit block is accessible from Port A or Port B. All other configurations result in one port having access to an 18 Kbit memory block and the other port having access to a 16 K-bit subset of the memory block equal to 16 Kbits.

*Table 15:* **Dual-Port Mode Configurations**

| | | | | | | |
|---|---|---|---|---|---|---|
| Port A | 16K x 1 | 16K x 1 | 16K x 1 | 16K x 1 | 16K x 1 | 16K x 1 |
| Port B | 16K x 1 | 8K x 2 | 4K x 4 | 2K x 9 | 1K x 18 | 512 x 36 |
| Port A | 8K x 2 | 8K x 2 | 8K x 2 | 8K x 2 | 8K x 2 | |
| Port B | 8K x 2 | 4K x 4 | 2K x 9 | 1K x 18 | 512 x 36 | |
| Port A | 4K x 4 | 4K x 4 | 4K x 4 | 4K x 4 | | |
| Port B | 4K x 4 | 2K x 9 | 1K x 18 | 512 x 36 | | |
| Port A | 2K x 9 | 2K x 9 | 2K x 9 | | | |
| Port B | 2K x 9 | 1K x 18 | 512 x 36 | | | |
| Port A | 1K x 18 | 1K x 18 | | | | |
| Port B | 1K x 18 | 512 x 36 | | | | |
| Port A | 512 x 36 | | | | | |
| Port B | 512 x 36 | | | | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Each block SelectRAM cell is a fully synchronous memory, as illustrated in Figure 30. The two ports have independent inputs and outputs and are independently clocked.

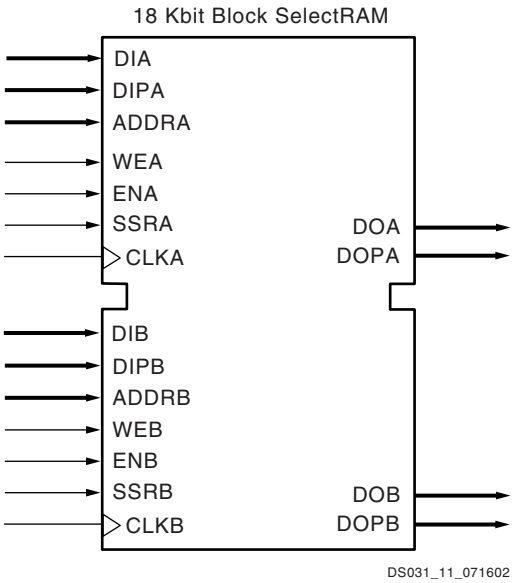



*Figure 30:* **18 Kbit Block SelectRAM in Dual-Port Mode**

### Port Aspect Ratios

Table 16 shows the depth and the width aspect ratios for the 18 Kbit block SelectRAM. Virtex-II block SelectRAM also includes dedicated routing resources to provide an efficient interface with CLBs, block SelectRAM, and multipliers.

*Table 16:* **18 Kbit Block SelectRAM Port Aspect Ratio**

| Width | Depth | Address Bus | Data Bus | Parity Bus |
|---|---|---|---|---|
| 1 | 16,384 | ADDR[13:0] | DATA[0] | N/A |
| 2 | 8,192 | ADDR[12:0] | DATA[1:0] | N/A |
| 4 | 4,096 | ADDR[11:0] | DATA[3:0] | N/A |
| 9 | 2,048 | ADDR[10:0] | DATA[7:0] | Parity[0] |
| 18 | 1,024 | ADDR[9:0] | DATA[15:0] | Parity[1:0] |
| 36 | 512 | ADDR[8:0] | DATA[31:0] | Parity[3:0] |

### *Read/Write Operations*

The Virtex-II block SelectRAM read operation is fully synchronous. An address is presented, and the read operation is enabled by control signals WEA and WEB in addition to ENA or ENB. Then, depending on clock polarity, a rising or falling clock edge causes the stored data to be loaded into output registers.

The write operation is also fully synchronous. Data and address are presented, and the write operation is enabled by control signals WEA or WEB in addition to ENA or ENB. Then, again depending on the clock input mode, a rising or falling clock edge causes the data to be loaded into the memory cell addressed.

A write operation performs a simultaneous read operation. Three different options are available, selected by configuration:

1. **"WRITE_FIRST"**

   The "WRITE_FIRST" option is a transparent mode. The same clock edge that writes the data input (DI) into the memory also transfers DI into the output registers DO as shown in Figure 31.

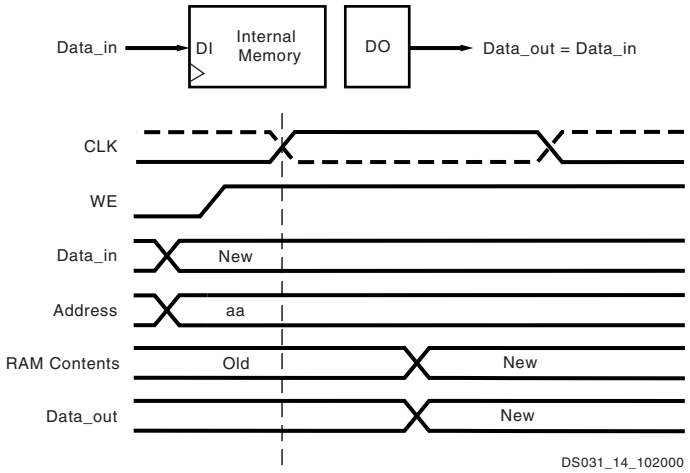



*Figure 31:* **WRITE_FIRST Mode**

2. **"READ_FIRST"**

   The "READ_FIRST" option is a read-before-write mode.

   The same clock edge that writes data input (DI) into the memory also transfers the prior content of the memory cell addressed into the data output registers DO, as shown in Figure 32.

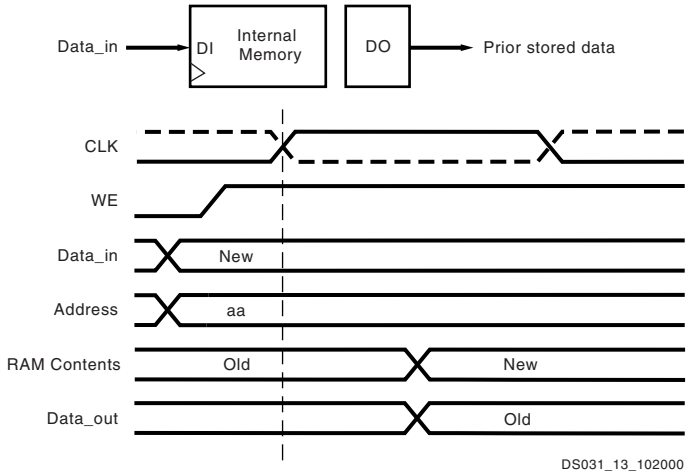



*Figure 32:* **READ_FIRST Mode**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


**3. "NO_CHANGE"**

The "NO_CHANGE" option maintains the content of the output registers, regardless of the write operation. The clock edge during the write mode has no effect on the content of the data output register DO. When the port is configured as "NO_CHANGE", only a read operation loads a new value in the output register DO, as shown in Figure 33.

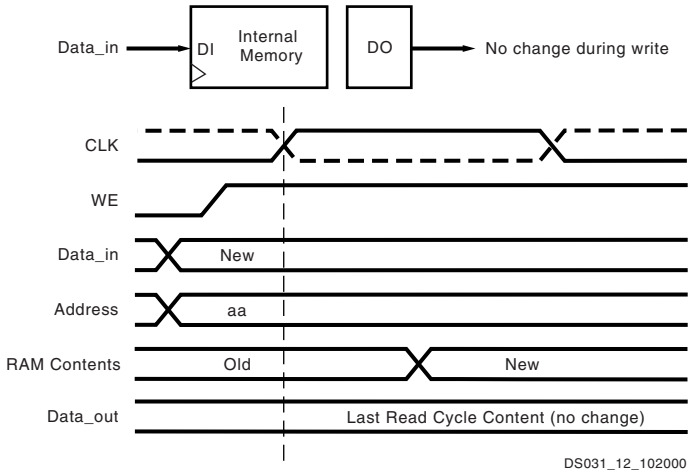



*Figure 33:* **NO_CHANGE Mode**

### *Control Pins and Attributes*

Virtex-II SelectRAM memory has two independent ports with the control signals described in Table 17. All control inputs including the clock have an optional inversion.

*Table 17:* **Control Functions**

| Control Signal | Function |
|---|---|
| CLK | Read and Write Clock |
| EN | Enable affects Read, Write, Set, Reset |
| WE | Write Enable |
| SSR | Set DO register to SRVAL (attribute) |

Initial memory content is determined by the INIT_xx attributes. Separate attributes determine the output register value after device configuration (INIT) and SSR is asserted (SRVAL). Both attributes (INIT_B and SRVAL) are available for each port when a block SelectRAM resource is configured as dual-port RAM.

### *Locations*

Virtex-II SelectRAM memory blocks are located in either four or six columns. The number of blocks per column depends of the device array size and is equivalent to the number of CLBs in a column divided by four. Column locations are shown in Table 18.

*Table 18:* **SelectRAM Memory Floor Plan**

| Device | Columns | SelectRAM Blocks | |
|---|---|---|---|
| | | Per Column | Total |
| XC2V40 | 2 | 2 | 4 |
| XC2V80 | 2 | 4 | 8 |
| XC2V250 | 4 | 6 | 24 |
| XC2V500 | 4 | 8 | 32 |
| XC2V1000 | 4 | 10 | 40 |
| XC2V1500 | 4 | 12 | 48 |
| XC2V2000 | 4 | 14 | 56 |
| XC2V3000 | 6 | 16 | 96 |
| XC2V4000 | 6 | 20 | 120 |
| XC2V6000 | 6 | 24 | 144 |
| XC2V8000 | 6 | 28 | 168 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

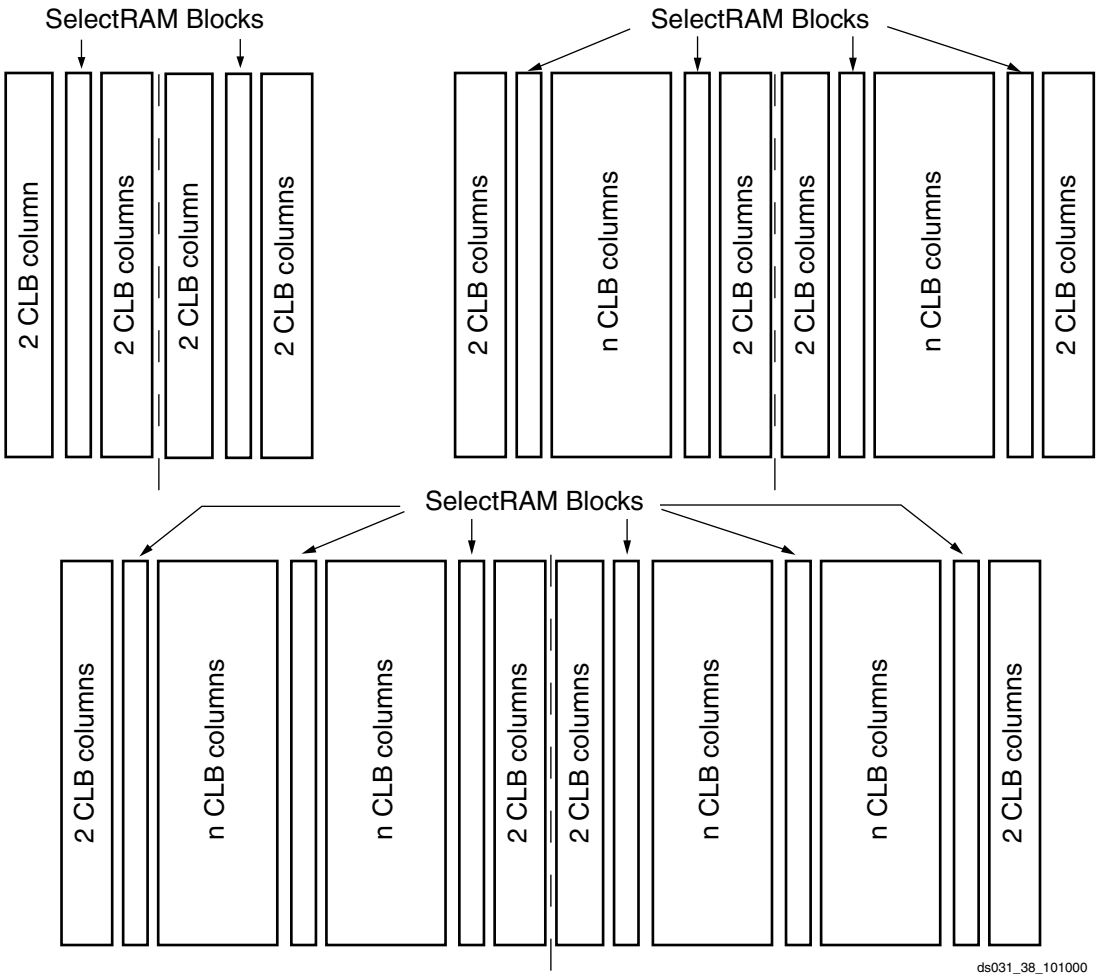




*Figure 34:* **Block SelectRAM (2-column, 4-column, and 6-column)**

### *Total Amount of SelectRAM Memory*

Table 19 shows the amount of block SelectRAM memory available for each Virtex-II device. The 18 Kbit SelectRAM blocks are cascadable to implement deeper or wider single- or dual-port memory resources.

*Table 19:* **Virtex-II SelectRAM Memory Available**

| Device | Total SelectRAM Memory | | |
|---|---|---|---|
| | Blocks | in Kbits | in Bits |
| XC2V40 | 4 | 72 | 73,728 |
| XC2V80 | 8 | 144 | 147,456 |
| XC2V250 | 24 | 432 | 442,368 |
| XC2V500 | 32 | 576 | 589,824 |
| XC2V1000 | 40 | 720 | 737,280 |
| XC2V1500 | 48 | 864 | 884,736 |
| XC2V2000 | 56 | 1,008 | 1,032,192 |
| XC2V3000 | 96 | 1,728 | 1,769,472 |
| XC2V4000 | 120 | 2,160 | 2,211,840 |
| XC2V6000 | 144 | 2,592 | 2,654,208 |
| XC2V8000 | 168 | 3,024 | 3,096,576 |

## 18-Bit x 18-Bit Multipliers

### *Introduction*

A Virtex-II multiplier block is an 18-bit by 18-bit 2's complement signed multiplier. Virtex-II devices incorporate many embedded multiplier blocks. These multipliers can be associated with an 18 Kbit block SelectRAM resource or can be used independently. They are optimized for high-speed operations and have a lower power consumption compared to an 18-bit x 18-bit multiplier in slices.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Each SelectRAM memory and multiplier block is tied to four switch matrices, as shown in Figure 35.

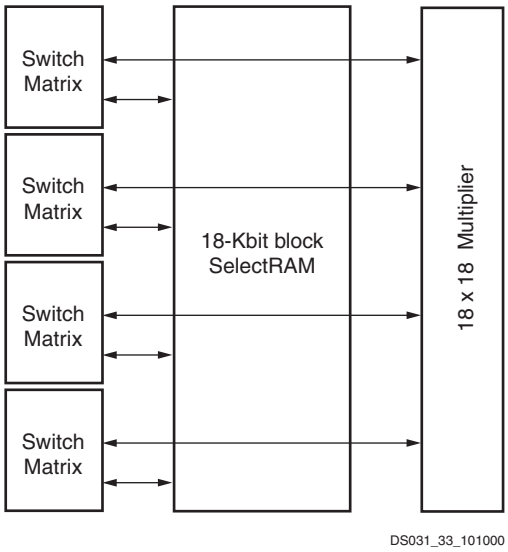



*Figure 35:* **SelectRAM and Multiplier Blocks**

### *Association With Block SelectRAM Memory*

The interconnect is designed to allow SelectRAM memory and multiplier blocks to be used at the same time, but some interconnect is shared between the SelectRAM and the multiplier. Thus, SelectRAM memory can be used only up to 18 bits wide when the multiplier is used, because the multiplier shares inputs with the upper data bits of the SelectRAM memory.

This sharing of the interconnect is optimized for an 18-bit-wide block SelectRAM resource feeding the multiplier. The use of SelectRAM memory and the multiplier with an accumulator in LUTs allows for implementation of a digital signal processor (DSP) multiplier-accumulator (MAC) function, which is commonly used in finite and infinite impulse response (FIR and IIR) digital filters.

## Configuration

The multiplier block is an 18-bit by 18-bit signed multiplier (2's complement). Both A and B are 18-bit-wide inputs, and the output is 36 bits. Figure 36 shows a multiplier block.

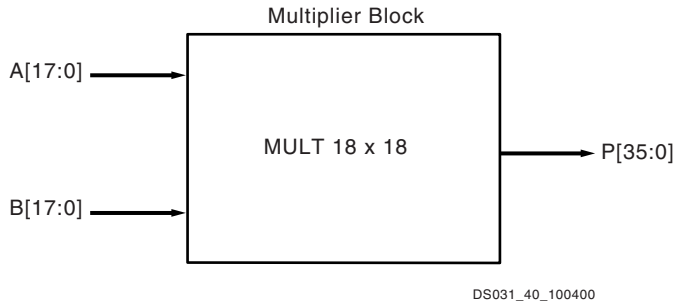



*Figure 36:* **Multiplier Block**

### *Locations / Organization*

Multiplier organization is identical to the 18 Kbit SelectRAM organization, because each multiplier is associated with an 18 Kbit block SelectRAM resource.

In addition to the built-in multiplier blocks, the CLB elements have dedicated logic to implement efficient multipliers in logic. (Refer to Configurable Logic Blocks (CLBs)).

*Table 20:* **Multiplier Floor Plan**

| Device | Columns | Multipliers | |
|---|---|---|---|
| | | Per Column | Total |
| XC2V40 | 2 | 2 | 4 |
| XC2V80 | 2 | 4 | 8 |
| XC2V250 | 4 | 6 | 24 |
| XC2V500 | 4 | 8 | 32 |
| XC2V1000 | 4 | 10 | 40 |
| XC2V1500 | 4 | 12 | 48 |
| XC2V2000 | 4 | 14 | 56 |
| XC2V3000 | 6 | 16 | 96 |
| XC2V4000 | 6 | 20 | 120 |
| XC2V6000 | 6 | 24 | 144 |
| XC2V8000 | 6 | 28 | 168 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

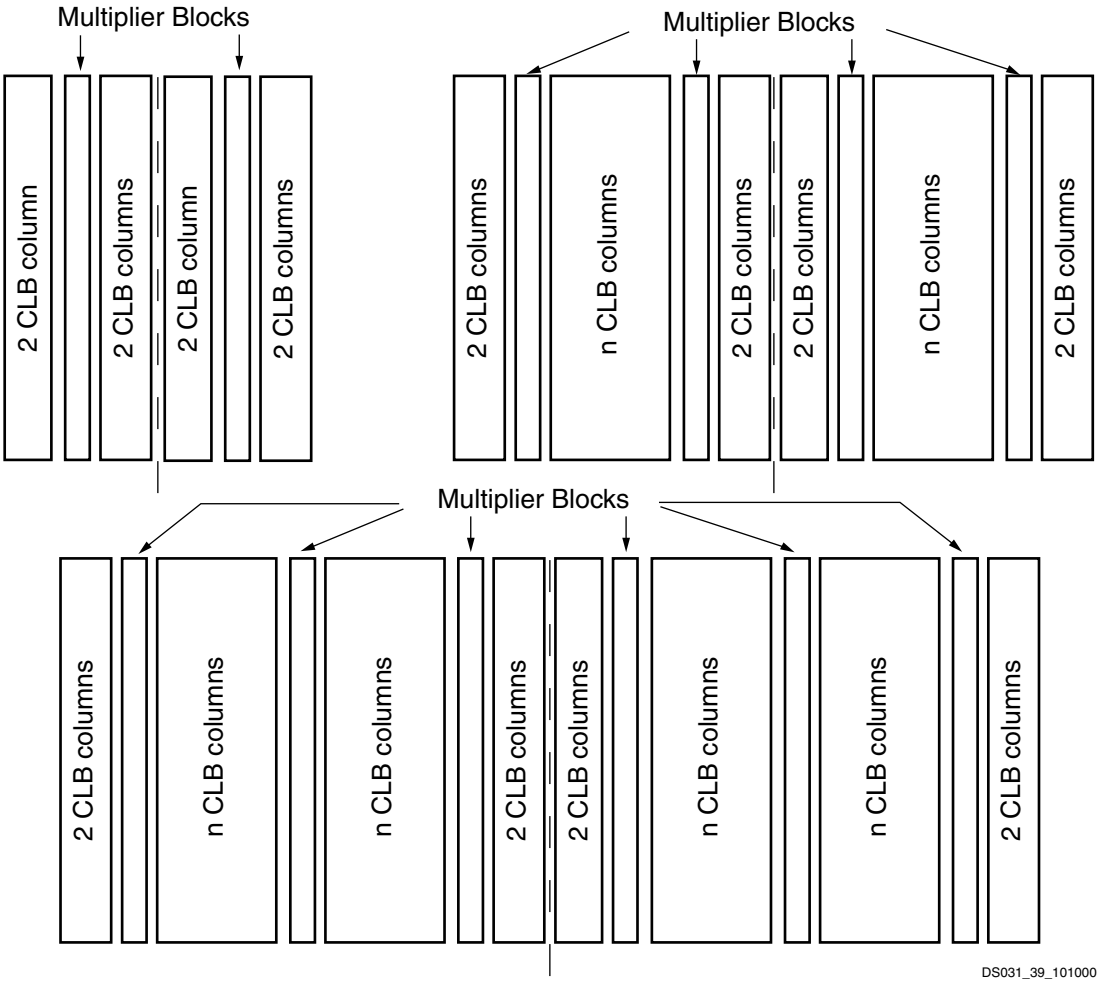




*Figure 37:* **Multipliers (2-column, 4-column, and 6-column)**

## Global Clock Multiplexer Buffers

Virtex-II devices have 16 clock input pins that can also be used as regular user I/Os. Eight clock pads are on the top edge of the device, in the middle of the array, and eight are on the bottom edge, as illustrated in Figure 38.

The global clock multiplexer buffer represents the input to dedicated low-skew clock tree distribution in Virtex-II devices. Like the clock pads, eight global clock multiplexer buffers are on the top edge of the device and eight are on the bottom edge.

Each global clock buffer can either be driven by the clock pad to distribute a clock directly to the device, or driven by the Digital Clock Manager (DCM), discussed in Digital Clock Manager (DCM), page 29. Each global clock buffer can also be driven by local interconnects. The DCM has clock output(s) that can be connected to global clock buffer inputs, as shown in Figure 39.

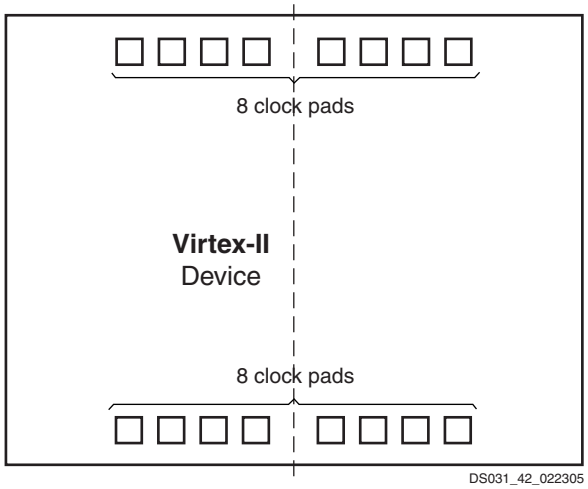



*Figure 38:* **Virtex-II Clock Pads**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

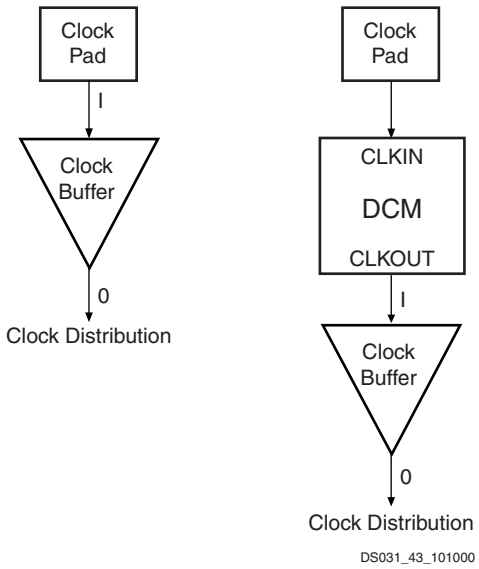




*Figure 39:* **Virtex-II Clock Distribution Configurations**

Global clock buffers are used to distribute the clock to some or all synchronous logic elements (such as registers in CLBs and IOBs, and SelectRAM blocks.

Eight global clocks can be used in each quadrant of the Virtex-II device. Designers should consider the clock distribution detail of the device prior to pin-locking and floorplanning (see the Virtex-II *User Guide*).

Figure 40 shows clock distribution in Virtex-II devices.

In each quadrant, up to eight clocks are organized in clock rows. A clock row supports up to 16 CLB rows (eight up and eight down). For the largest devices a new clock row is added, as necessary.

To reduce power consumption, any unused clock branches remain static.

Global clocks are driven by dedicated clock buffers (BUFG), which can also be used to gate the clock (BUFGCE) or to multiplex between two independent clock inputs (BUFGMUX).

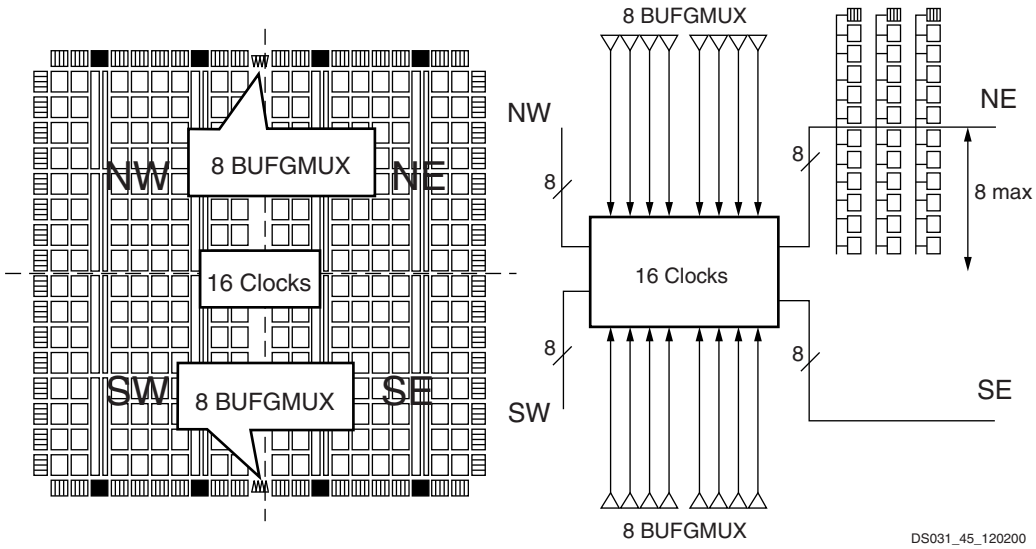



*Figure 40:* **Virtex-II Clock Distribution**

The most common configuration option of this element is as a buffer. A BUFG function in this (global buffer) mode, is shown in Figure 41.

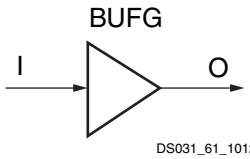



*Figure 41:* **Virtex-II BUFG Function**

The Virtex-II global clock buffer BUFG can also be configured as a clock enable/disable circuit (Figure 42), as well as a two-input clock multiplexer (Figure 43). A functional description of these two options is provided below. Each of them can be used in either of two modes, selected by configuration: rising clock edge or falling clock edge.

This section describes the rising clock edge option. For the opposite option, falling clock edge, just change all "rising" references to "falling" and all "High" references to "Low", except for the description of the CE or S levels. The rising clock edge option uses the BUFGCE and BUFGMUX primitives. The falling clock edge option uses the BUFGCE_1 and BUFGMUX_1 primitives.

### *BUFGCE*

If the CE input is active (High) prior to the incoming rising clock edge, this Low-to-High-to-Low clock pulse passes through the clock buffer. Any level change of CE during the incoming clock High time has no effect.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

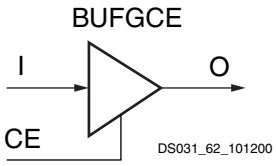




*Figure 42:* **Virtex-II BUFGCE Function**

If the CE input is inactive (Low) prior to the incoming rising clock edge, the following clock pulse does not pass through the clock buffer, and the output stays Low. Any level change of CE during the incoming clock High time has no effect. CE must not change during a short setup window just prior to the rising clock edge on the BUFGCE input I. Violating this setup time requirement can result in an undefined runt pulse output.

### *BUFGMUX*

BUFGMUX can switch between two unrelated, even asynchronous clocks. Basically, a Low on S selects the I0 input, a High on S selects the I1 input. Switching from one clock to the other is done in such a way that the output High and Low time is never shorter than the shortest High or Low time of either input clock. As long as the presently selected clock is High, any level change of S has no effect .

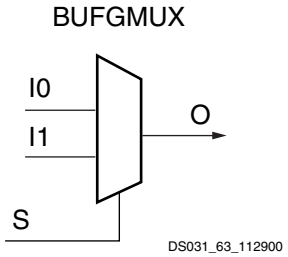



*Figure 43:* **Virtex-II BUFGMUX Function**

If the presently selected clock is Low while S changes, or if it goes Low after S has changed, the output is kept Low until the other ("to-be-selected") clock has made a transition from High to Low. At that instant, the new clock starts driving the output.

The two clock inputs can be asynchronous with regard to each other, and the S input can change at any time, except for a short setup time prior to the rising edge of the presently selected clock (I0 or I1). Violating this setup time requirement can result in an undefined runt pulse output.

All Virtex-II devices have 16 global clock multiplexer buffers.

Figure 44 shows a switchover from I0 to I1.

- The current clock is CLK0.
- S is activated High.
- If CLK0 is currently High, the multiplexer waits for CLK0 to go Low.
- Once CLK0 is Low, the multiplexer output stays Low until CLK1 transitions High to Low.
- When CLK1 transitions from High to Low, the output switches to CLK1.
- No glitches or short pulses can appear on the output.

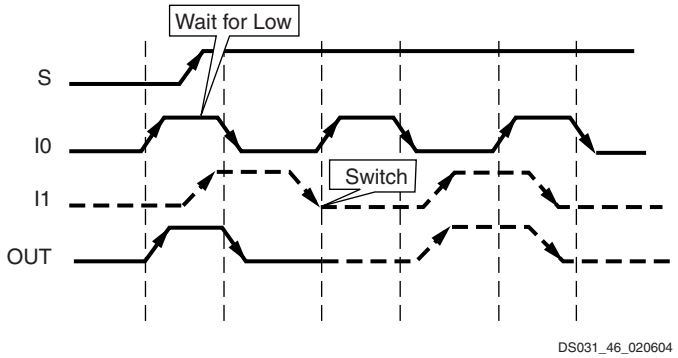



*Figure 44:* **Clock Multiplexer Waveform Diagram**

## Local Clocking

In addition to global clocks, there are local clock resources in the Virtex-II devices. There are more than 72 local clocks in the Virtex-II family. These resources can be used for many different applications, including but not limited to memory interfaces. For example, even using only the left and right I/O banks, Virtex-II FPGAs can support up to 50 local clocks for DDR SDRAM. These interfaces can operate beyond 200 MHz on Virtex-II devices.

## Digital Clock Manager (DCM)

The Virtex-II DCM offers a wide range of powerful clock management features.

- **Clock De-skew**: The DCM generates new system clocks (either internally or externally to the FPGA), which are phase-aligned to the input clock, thus eliminating clock distribution delays.
- **Frequency Synthesis**: The DCM generates a wide range of output clock frequencies, performing very flexible clock multiplication and division.
- **Phase Shifting**: The DCM provides both coarse phase shifting and fine-grained phase shifting with dynamic phase shift control.

The DCM utilizes fully digital delay lines allowing robust high-precision control of clock phase and frequency. It also utilizes fully digital feedback systems, operating dynamically to compensate for temperature and voltage variations during operation.

Up to four of the nine DCM clock outputs can drive inputs to global clock buffers or global clock multiplexer buffers simultaneously (see Figure 45). All DCM clock outputs can simultaneously drive general routing resources, including routes to output buffers.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

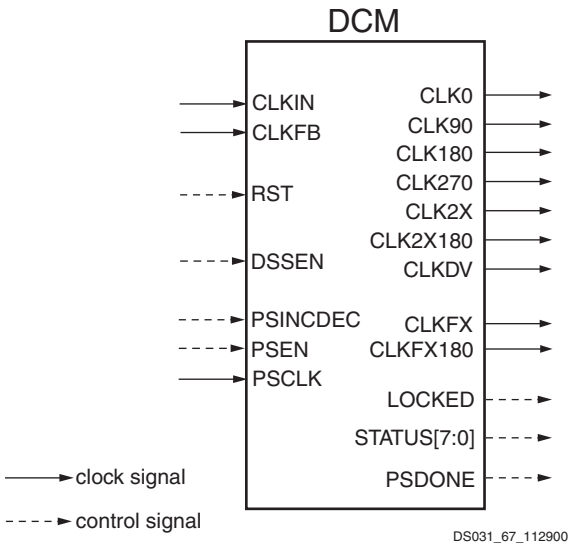




*Figure 45:* **Digital Clock Manager**

The DCM can be configured to delay the completion of the Virtex-II configuration process until after the DCM has achieved lock. This guarantees that the chip does not begin operating until after the system clocks generated by the DCM have stabilized.

The DCM has the following general control signals:

- RST input pin: resets the entire DCM
- LOCKED output pin: asserted High when all enabled DCM circuits have locked.
- STATUS output pins (active High): shown in Table 21.

*Table 21:* **DCM Status Pins**

| Status Pin | Function |
|---|---|
| 0 | Phase Shift Overflow |
| 1 | CLKIN Stopped |
| 2 | CLKFX Stopped |
| 3 | N/A |
| 4 | N/A |
| 5 | N/A |
| 6 | N/A |
| 7 | N/A |

### Clock De-Skew

The DCM de-skews the output clocks relative to the input clock by automatically adjusting a digital delay line. Additional delay is introduced so that clock edges arrive at internal registers and block RAMs simultaneously with the clock edges arriving at the input clock pad. Alternatively, external clocks, which are also de-skewed relative to the input clock, can be generated for board-level routing. All DCM output clocks are phase-aligned to CLK0 and, therefore, are also phase-aligned to the input clock.

To achieve clock de-skew, the CLKFB input must be connected, and its source must be either CLK0 or CLK2X. Note that CLKFB must always be connected, unless only the CLKFX or CLKFX180 outputs are used and de-skew is not required.

### Frequency Synthesis

The DCM provides flexible methods for generating new clock frequencies. Each method has a different operating frequency range and different AC characteristics. The CLK2X and CLK2X180 outputs double the clock frequency. The CLKDV output creates divided output clocks with division options of 1.5, 2, 2.5, 3, 3.5, 4, 4.5, 5, 5.5, 6, 6.5, 7, 7.5, 8, 9, 10, 11, 12, 13, 14, 15, and 16.

The CLKFX and CLKFX180 outputs can be used to produce clocks at the following frequency:

$$FREQ_{CLKFX} = (M/D) * FREQ_{CLKIN}$$

where M and D are two integers. Specifications for M and D are provided under DCM Timing Parameters in Module 3. By default, M=4 and D=1, which results in a clock output frequency four times faster than the clock input frequency (CLKIN).

CLK2X180 is phase shifted 180 degrees relative to CLK2X. CLKFX180 is phase shifted 180 degrees relative to CLKFX. All frequency synthesis outputs automatically have 50/50 duty cycles (with the exception of the CLKDV output when performing a non-integer divide in high-frequency mode).

Note that CLK2X and CLK2X180 are not available in high-frequency mode.

### Phase Shifting

The DCM provides additional control over clock skew through either coarse or fine-grained phase shifting. The CLK0, CLK90, CLK180, and CLK270 outputs are each phase shifted by ¼ of the input clock period relative to each other, providing coarse phase control. Note that CLK90 and CLK270 are not available in high-frequency mode.

Fine-phase adjustment affects all nine DCM output clocks. When activated, the phase shift between the rising edges of CLKIN and CLKFB is a specified fraction of the input clock period.

In variable mode, the PHASE_SHIFT value can also be dynamically incremented or decremented as determined by PSINCDEC synchronously to PSCLK, when the PSEN input is active. Figure 46 illustrates the effects of fine-phase shifting. For more information on DCM features, see the Virtex-II *User Guide*.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

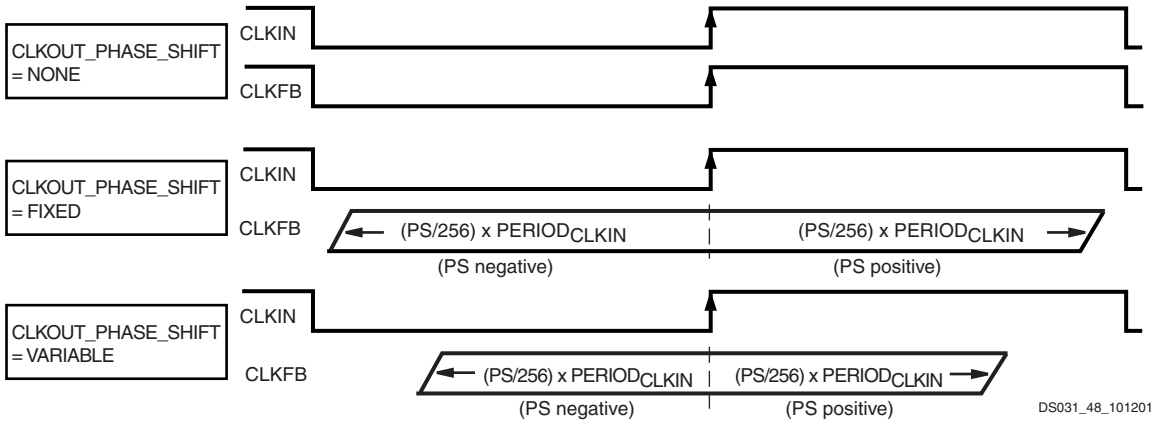




*Figure 46:* **Fine-Phase Shifting Effects**

Table 22 lists fine-phase shifting control pins, when used in variable mode.

*Table 22:* **Fine-Phase Shifting Control Pins**

| Control Pin | Direction | Function |
|---|---|---|
| PSINCDEC | in | Increment or decrement |
| PSEN | in | Enable ± phase shift |
| PSCLK | in | Clock for phase shift |
| PSDONE | out | Active when completed |

Two separate components of the phase shift range must be understood:

- PHASE_SHIFT attribute range
- FINE_SHIFT_RANGE DCM timing parameter range

The PHASE_SHIFT attribute is the numerator in the following equation:

Phase Shift (ns) = (PHASE_SHIFT/256) * $PERIOD_{CLKIN}$

The full range of this attribute is always -255 to +255, but its practical range varies with CLKIN frequency, as constrained by the FINE_SHIFT_RANGE component, which represents the total delay achievable by the phase shift delay line. Total delay is a function of the number of delay taps used in the circuit. Across process, voltage, and temperature, this absolute range is guaranteed to be as specified under DCM Timing Parameters in Module 3.

Absolute range (fixed mode) = ± FINE_SHIFT_RANGE

Absolute range (variable mode) = ± FINE_SHIFT_RANGE/2

The reason for the difference between fixed and variable modes is as follows. For variable mode to allow symmetric, dynamic sweeps from -255/256 to +255/256, the DCM sets the "zero phase skew" point as the middle of the delay line, thus dividing the total delay line range in half. In fixed mode, since the PHASE_SHIFT value never changes after configuration, the entire delay line is available for insertion into either the CLKIN or CLKFB path (to create either positive or negative skew).

Taking both of these components into consideration, the following are some usage examples:

- If $PERIOD_{CLKIN}$ = 2 * FINE_SHIFT_RANGE, then PHASE_SHIFT in fixed mode is limited to ± 128, and in variable mode it is limited to ± 64.
- If $PERIOD_{CLKIN}$ = FINE_SHIFT_RANGE, then PHASE_SHIFT in fixed mode is limited to ± 255, and in variable mode it is limited to ± 128.
- If $PERIOD_{CLKIN} \leq 0.5$ * FINE_SHIFT_RANGE, then PHASE_SHIFT is limited to ± 255 in either mode.

### *Operating Modes*

The frequency ranges of DCM input and output clocks depend on the operating mode specified, either low-frequency mode or high-frequency mode, according to Table 23. (For actual values, see Virtex-II Switching Characteristics in Module 3). The CLK2X, CLK2X180, CLK90, and CLK270 outputs are not available in high-frequency mode.

High or low-frequency mode is selected by an attribute.

*Table 23:* **DCM Frequency Ranges**

| Output Clock | Low-Frequency Mode | | High-Frequency Mode | |
|---|---|---|---|---|
| | CLKIN Input | CLK Output | CLKIN Input | CLK Output |
| CLK0, CLK180 | CLKIN_FREQ_DLL_LF | CLKOUT_FREQ_1X_LF | CLKIN_FREQ_DLL_HF | CLKOUT_FREQ_1X_HF |
| CLK90, CLK270 | CLKIN_FREQ_DLL_LF | CLKOUT_FREQ_1X_LF | NA | NA |
| CLK2X, CLK2X180 | CLKIN_FREQ_DLL_LF | CLKOUT_FREQ_2X_LF | NA | NA |
| CLKDV | CLKIN_FREQ_DLL_LF | CLKOUT_FREQ_DV_LF | CLKIN_FREQ_DLL_HF | CLKOUT_FREQ_DV_HF |
| CLKFX, CLKFX180 | CLKIN_FREQ_FX_LF | CLKOUT_FREQ_FX_LF | CLKIN_FREQ_FX_HF | CLKOUT_FREQ_FX_HF |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Routing

## DCM Locations/Organization

Virtex-II DCMs are placed on the top and bottom of each block RAM and multiplier column. The number of DCMs depends on the device size, as shown in Table 24.

*Table 24:* **DCM Organization**

| Device | Columns | DCMs |
|---|---|---|
| XC2V40 | 2 | 4 |
| XC2V80 | 2 | 4 |
| XC2V250 | 4 | 8 |
| XC2V500 | 4 | 8 |
| XC2V1000 | 4 | 8 |
| XC2V1500 | 4 | 8 |
| XC2V2000 | 4 | 8 |
| XC2V3000 | 6 | 12 |
| XC2V4000 | 6 | 12 |
| XC2V6000 | 6 | 12 |
| XC2V8000 | 6 | 12 |

## Active Interconnect Technology

Local and global Virtex-II routing resources are optimized for speed and timing predictability, as well as to facilitate IP cores implementation. Virtex-II Active Interconnect Technology is a fully buffered programmable routing matrix. All routing resources are segmented to offer the advantages of a hierarchical solution. Virtex-II logic features like CLBs, IOBs, block RAM, multipliers, and DCMs are all connected to an identical switch matrix for access to global routing resources, as shown in Figure 47.

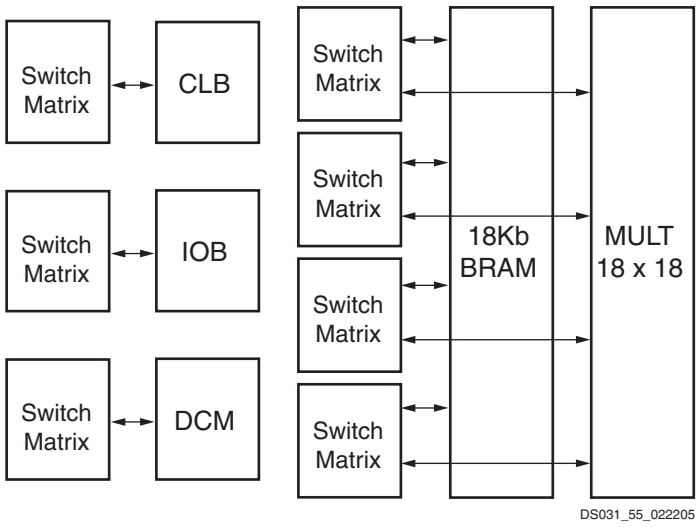



*Figure 47:* **Active Interconnect Technology**

Each Virtex-II device can be represented as an array of switch matrixes with logic blocks attached, as illustrated in Figure 48.

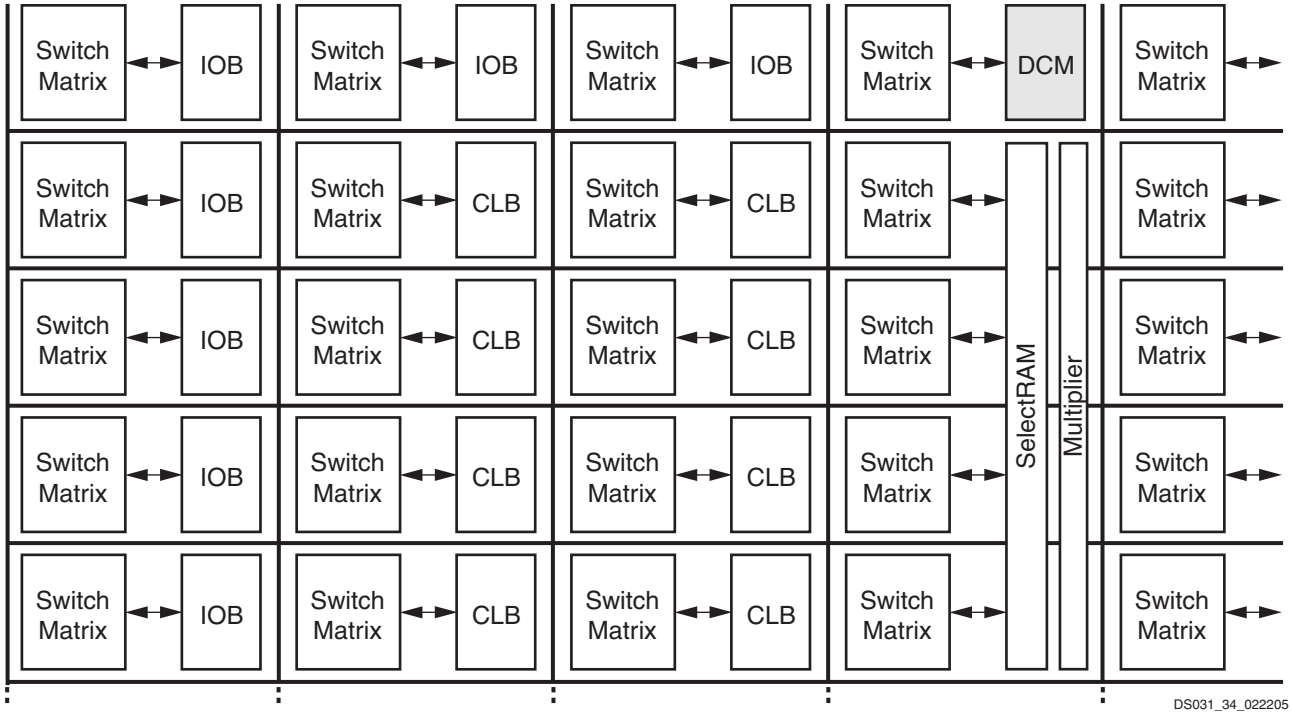



*Figure 48:* **Routing Resources**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Place-and-route software takes advantage of this regular array to deliver optimum system performance and fast compile times. The segmented routing resources are essential to guarantee IP cores portability and to efficiently handle an incremental design flow that is based on modular implementations. Total design time is reduced due to fewer and shorter design iterations.

## Hierarchical Routing Resources

Most Virtex-II signals are routed using the global routing resources, which are located in horizontal and vertical routing channels between each switch matrix.

As shown in Figure 49, Virtex-II has fully buffered programmable interconnections, with a number of resources counted between any two adjacent switch matrix rows or columns. Fanout has minimal impact on the performance of each net.

- The long lines are bidirectional wires that distribute signals across the device. Vertical and horizontal long lines span the full height and width of the device.
- The hex lines route signals to every third or sixth block away in all four directions. Organized in a staggered pattern, hex lines can only be driven from one end. Hex-line signals can be accessed either at the endpoints or at the midpoint (three blocks from the source).
- The double lines route signals to every first or second block away in all four directions. Organized in a staggered pattern, double lines can be driven only at their endpoints. Double-line signals can be accessed either at the endpoints or at the midpoint (one block from the source).
- The direct connect lines route signals to neighboring blocks: vertically, horizontally, and diagonally.
- The fast connect lines are the internal CLB local interconnections from LUT outputs to LUT inputs.

## Dedicated Routing

In addition to the global and local routing resources, dedicated signals are available.

- There are eight global clock nets per quadrant (see Global Clock Multiplexer Buffers).
- Horizontal routing resources are provided for on-chip 3-state busses. Four partitionable bus lines are provided per CLB row, permitting multiple busses within a row. (See 3-State Buffers.)
- Two dedicated carry-chain resources per slice column (two per CLB column) propagate carry-chain MUXCY output signals vertically to the adjacent slice. (See CLB/Slice Configurations.)
- One dedicated SOP chain per slice row (two per CLB row) propagate ORCY output logic signals horizontally to the adjacent slice. (See Sum of Products.)
- One dedicated shift-chain per CLB connects the output of LUTs in shift-register mode to the input of the next LUT in shift-register mode (vertically) inside the CLB. (See Shift Registers, page 16.)

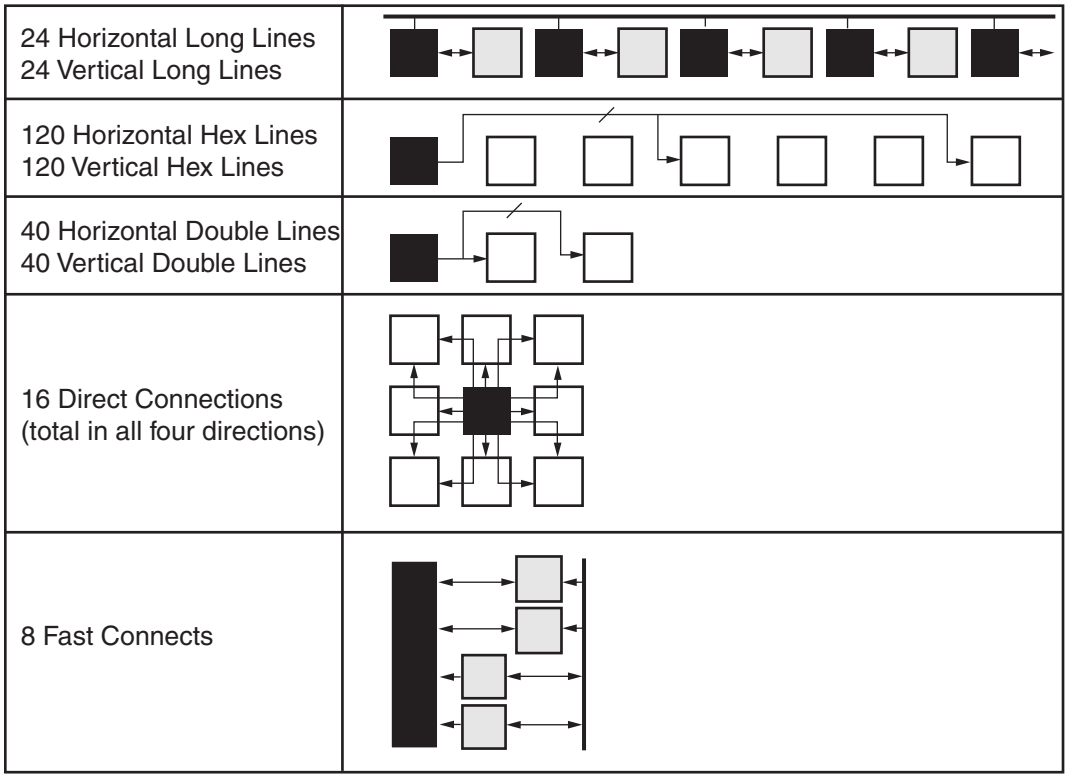



*Figure 49:* **Hierarchical Routing Resources**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Creating a Design

Creating Virtex-II designs is easy with Xilinx Integrated Synthesis Environment (ISE) development systems, which support advanced design capabilities, including ProActive Timing Closure, integrated logic analysis, and the fastest place and route runtimes in the industry. ISE solutions enable designers to get the performance they need, quickly and easily.

As a result of the ongoing cooperative development efforts between Xilinx and EDA Alliance partners, designers can take advantage of the benefits provided by EDA technologies in the programmable logic design process. Xilinx development systems are available in a number of easy to use configurations, collectively known as the ISE Series.

## ISE Alliance

The ISE Alliance solution is designed to plug and play within an existing design environment. Built using industry standard data formats and netlists, these stable, flexible products enable Alliance EDA partners to deliver their best design automation capabilities to Xilinx customers, along with the time to market benefits of ProActive Timing Closure.

## ISE Foundation

The ISE Foundation solution delivers the benefits of true HDL-based design in a seamlessly integrated design environment. An intuitive project navigator, as well as powerful HDL design and two HDL synthesis tools, ensure that high-quality results are achieved quickly and easily. The ISE Foundation product includes:

- State Diagram entry using Xilinx StateCAD
- Automatic HDL Testbench generation using Xilinx HDLBencher
- HDL Simulation using ModelSim XE

## Design Flow

Virtex-II design flow proceeds as follows:

- Design Entry
- Synthesis
- Implementation
- Verification

Most programmable logic designers iterate through these steps several times in the process of completing a design.

### *Design Entry*

All Xilinx ISE development systems support the mainstream EDA design entry capabilities, ranging from schematic design to advanced HDL design methodologies. Given the high densities of the Virtex-II family, designs are created most efficiently using HDLs. To further improve their time to market, many Xilinx customers employ incremental, modular, and Intellectual Property (IP) design techniques. When properly used, these techniques further accelerate the logic design process.

To enable designers to leverage existing investments in EDA tools, and to ensure high performance design flows, Xilinx jointly develops tools with leading EDA vendors, including:

- Aldec®
- Cadence®
- Exemplar®
- Mentor Graphics®
- Model Technology®
- Synopsys®
- Synplicity®

Complete information on Alliance Series partners and their associated design flows is available at www.xilinx.com on the Xilinx Alliance Series web page.

The ISE Foundation product offers schematic entry and HDL design capabilities as part of an integrated design solution - enabling one-stop shopping. These capabilities are powerful, easy to use, and they support the full portfolio of Xilinx programmable logic devices. HDL design capabilities include a color-coded HDL editor with integrated language templates, state diagram entry, and Core generation capabilities.

### *Synthesis*

The ISE Alliance product is engineered to support advanced design flows with the industry's best synthesis tools. Advanced design methodologies include:

- Physical Synthesis
- Incremental synthesis
- RTL floorplanning
- Direct physical mapping

The ISE Foundation product seamlessly integrates synthesis capabilities purchased directly from Exemplar, Synopsys, and Synplicity. In addition, it includes the capabilities of Xilinx Synthesis Technology.

A benefit of having two seamlessly integrated synthesis engines within an ISE design flow is the ability to apply alternative sets of optimization techniques on designs, helping to ensure that designers can meet even the toughest timing requirements.

### *Design Implementation*

The ISE Series development systems include Xilinx timing-driven implementation tools, frequently called “place and route” or “fitting” software. This robust suite of tools enables the creation of an intuitive, flexible, tightly integrated design flow that efficiently bridges “logical” and “physical” design domains. This simplifies the task of defining a design, including its behavior, timing requirements, and optional layout (or floorplanning), as well as simplifying the task of analyzing reports generated during the implementation process.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


The Virtex-II implementation process is comprised of Synthesis, translation, mapping, place and route, and configuration file generation. While the tools can be run individually, many designers choose to run the entire implementation process with the click of a button. To assist those who prefer to script their design flows, Xilinx provides Xflow, an automated single command line process.

### *Design Verification*

In addition to conventional design verification using static timing analysis or simulation techniques, Xilinx offers powerful in-circuit debugging techniques using ChipScope ILA (Integrated Logic Analysis). The reconfigurable nature of Xilinx FPGAs means that designs can be verified in real time without the need for extensive sets of software simulation vectors.

For simulation, the system extracts post-layout timing information from the design database, and back-annotates this information into the netlist for use by the simulator. The back annotation features a variety of patented Xilinx techniques, resulting in the industry's most powerful simulation flows. Alternatively, timing-critical portions of a design can be verified using the Xilinx static timing analyzer or a third party static timing analysis tool like Synopsys Prime Time™, by exporting timing data in the STAMP data format.

For in-circuit debugging, ChipScope ILA enables designers to analyze the real-time behavior of a device while operating at full system speeds. Logic analysis commands and captured data are transferred between the ChipScope software and ILA cores within the Virtex-II FPGA, using industry standard JTAG protocols. These JTAG transactions are driven over an optional download cable (MultiLINX or JTAG), connecting the Virtex device in the target system to a PC or workstation.

ChipScope ILA was designed to look and feel like a logic analyzer, making it easy to begin debugging a design immediately. Modifications to the desired logic analysis can be downloaded directly into the system in a matter of minutes.

## Other Unique Features of Virtex-II Design Flow

Xilinx design flows feature a number of unique capabilities. Among these are efficient incremental HDL design flows; a robust capability that is enabled by Xilinx exclusive hierarchical floorplanning capabilities. Another powerful design capability only available in the Xilinx design flow is "Modular Design", part of the Xilinx suite of team design tools, which enables autonomous design, implementation, and verification of design modules.

### *Incremental Synthesis*

Xilinx unique hierarchical floorplanning capabilities enable designers to create a programmable logic design by isolating design changes within one hierarchical "logic block", and perform synthesis, verification and implementation processes on that specific logic block. By preserving the logic in unchanged portions of a design, Xilinx incremental design makes the high-density design process more efficient.

Xilinx hierarchical floorplanning capabilities can be specified using the high-level floorplanner or a preferred RTL floorplanner (see the Xilinx web site for a list of supported EDA partners). When used in conjunction with one of the EDA partners' floorplanners, higher performance results can be achieved, as many synthesis tools use this more predictable detailed physical implementation information to establish more aggressive and accurate timing estimates when performing their logic optimizations.

### *Modular Design*

Xilinx innovative modular design capabilities take the incremental design process one step further by enabling the designer to delegate responsibility for completing the design, synthesis, verification, and implementation of a hierarchical "logic block" to an arbitrary number of designers - assigning a specific region within the target FPGA for exclusive use by each of the team members.

This team design capability enables an autonomous approach to design modules, changing the hand-off point to the lead designer or integrator from "my module works in simulation" to "my module works in the FPGA". This unique design methodology also leverages the Xilinx hierarchical floorplanning capabilities and enables the Xilinx (or EDA partner) floorplanner to manage the efficient implementation of very high-density FPGAs.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Configuration

Virtex-II devices are configured by loading application specific configuration data into the internal configuration memory. Configuration is carried out using a subset of the device pins, some of which are dedicated, while others can be re-used as general purpose inputs and outputs once configuration is complete.

Depending on the system design, several configuration modes are supported, selectable via mode pins. The mode pins M2, M1 and M0 are dedicated pins. The M2, M1, and M0 mode pins should be set at a constant DC voltage level, either through pull-up or pull-down resistors, or tied directly to ground or $V_{CCAUX}$. The mode pins should not be toggled during and after configuration.

An additional pin, HSWAP_EN is used in conjunction with the mode pins to select whether user I/O pins have pull-ups during configuration. By default, HSWAP_EN is tied High (internal pull-up) which shuts off the pull-ups on the user I/O pins during configuration. When HSWAP_EN is tied Low, user I/Os have pull-ups during configuration. Other dedicated pins are CCLK (the configuration clock pin), DONE, PROG_B, and the Boundary-Scan pins: TDI, TDO, TMS, and TCK. Depending on the configuration mode chosen, CCLK can be an output generated by the FPGA, or an input accepting an externally generated clock. The configuration pins and Boundary-Scan pins are independent of the $V_{CCO}$. The auxiliary power supply ($V_{CCAUX}$) of 3.3V is used for these pins. All configuration pins are LVTTL 12 mA. (See Virtex-II DC Characteristics in Module 3.)

A persist option is available which can be used to force the configuration pins to retain their configuration function even after device configuration is complete. If the persist option is not selected then the configuration pins with the exception of CCLK, PROG_B, and DONE can be used as user I/O in normal operation. The persist option does not apply to the Boundary-Scan related pins. The persist feature is valuable in applications which employ partial reconfiguration or reconfiguration on the fly.

## Configuration Modes

Virtex-II supports the following five configuration modes:

- Slave-Serial Mode
- Master-Serial Mode
- Slave SelectMAP Mode
- Master SelectMAP Mode
- Boundary-Scan (JTAG, IEEE 1532) Mode

A detailed description of configuration modes is provided in the Virtex-II *User Guide*.

### *Slave-Serial Mode*

In slave-serial mode, the FPGA receives configuration data in bit-serial form from a serial PROM or other serial source of configuration data. The CCLK pin on the FPGA is an input in this mode. The serial bitstream must be setup at the DIN input pin a short time before each rising edge of the externally generated CCLK.

Multiple FPGAs can be daisy-chained for configuration from a single source. After a particular FPGA has been configured, the data for the next device is routed internally to the DOUT pin. The data on the DOUT pin changes on the falling edge of CCLK.

Slave-serial mode is selected by applying <111> to the mode pins (M2, M1, M0). A weak pull-up on the mode pins makes slave serial the default mode if the pins are left unconnected.

### *Master-Serial Mode*

In master-serial mode, the CCLK pin is an output pin. It is the Virtex-II FPGA device that drives the configuration clock on the CCLK pin to a Xilinx Serial PROM which in turn feeds bit-serial data to the DIN input. The FPGA accepts this data on each rising CCLK edge. After the FPGA has been loaded, the data for the next device in a daisy-chain is presented on the DOUT pin after the falling CCLK edge.

The interface is identical to slave serial except that an internal oscillator is used to generate the configuration clock (CCLK). A wide range of frequencies can be selected for CCLK which always starts at a slow default frequency. Configuration bits then switch CCLK to a higher frequency for the remainder of the configuration.

### *Slave SelectMAP Mode*

The SelectMAP mode is the fastest configuration option. Byte-wide data is written into the Virtex-II FPGA device with a BUSY flag controlling the flow of data. An external data source provides a byte stream, CCLK, an active Low Chip Select (CS_B) signal and a Write signal (RDWR_B). If BUSY is asserted (High) by the FPGA, the data must be held until BUSY goes Low. Data can also be read using the SelectMAP mode. If RDWR_B is asserted, configuration data is read out of the FPGA as part of a readback operation.

After configuration, the pins of the SelectMAP port can be used as additional user I/O. Alternatively, the port can be retained to permit high-speed 8-bit readback using the persist option.

Multiple Virtex-II FPGAs can be configured using the SelectMAP mode, and be made to start-up simultaneously. To configure multiple devices in this way, wire the individual CCLK, Data, RDWR_B, and BUSY pins of all the devices in parallel. The individual devices are loaded separately by deasserting the CS_B pin of each device in turn and writing the appropriate data.

### *Master SelectMAP Mode*

This mode is a master version of the SelectMAP mode. The device is configured byte-wide on a CCLK supplied by the

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Virtex-II FPGA device. Timing is similar to the Slave Serial-MAP mode except that CCLK is supplied by the Virtex-II FPGA.

### *Boundary-Scan (JTAG, IEEE 1532) Mode*

In Boundary-Scan mode, dedicated pins are used for configuring the Virtex-II device. The configuration is done entirely through the IEEE 1149.1 Test Access Port (TAP). Virtex-II device configuration using Boundary-Scan is compatible with the IEEE 1149.1-1993 standard and the new IEEE 1532 standard for In-System Configurable (ISC) devices. The IEEE 1532 standard is backward compliant with the IEEE 1149.1-1993 TAP and state machine. The IEEE Standard 1532 for In-System Configurable (ISC) devices is intended to be programmed, reprogrammed, or tested on the board via a physical and logical protocol.

Configuration through the Boundary-Scan port is always available, independent of the mode selection. Selecting the Boundary-Scan mode simply turns off the other modes.

*Table 25:* **Virtex-II Configuration Mode Pin Settings**

| Configuration Mode(1) | M2 | M1 | M0 | CCLK Direction | Data Width | Serial $D_{OUT}$(2) |
|---|---|---|---|---|---|---|
| Master Serial | 0 | 0 | 0 | Out | 1 | Yes |
| Slave Serial | 1 | 1 | 1 | In | 1 | Yes |
| Master SelectMAP | 0 | 1 | 1 | Out | 8 | No |
| Slave SelectMAP | 1 | 1 | 0 | In | 8 | No |
| Boundary-Scan | 1 | 0 | 1 | N/A | 1 | No |

**Notes:**
1. The HSWAP_EN pin controls the pull-ups. Setting M2, M1, and M0 selects the configuration mode, while the HSWAP_EN pin controls whether or not the pull-ups are used.
2. Daisy chaining is possible only in modes where Serial $D_{OUT}$ is used. For example, in SelectMAP modes, the first device does NOT support daisy chaining of downstream devices.

Table 26 lists the total number of bits required to configure each device.

*Table 26:* **Virtex-II Bitstream Lengths**

| Device | # of Configuration Bits |
|---|---|
| XC2V40 | 338,976 |
| XC2V80 | 598,816 |
| XC2V250 | 1,593,632 |
| XC2V500 | 2,560,544 |
| XC2V1000 | 4,082,592 |
| XC2V1500 | 5,170,208 |
| XC2V2000 | 6,812,960 |
| XC2V3000 | 10,494,368 |
| XC2V4000 | 15,659,936 |
| XC2V6000 | 21,849,504 |
| XC2V8000 | 26,194,208 |

## Configuration Sequence

The configuration of Virtex-II devices is a three-phase process after Power On Reset or POR. POR occurs when $V_{CCINT}$ is greater than 1.2V, $V_{CCAUX}$ is greater than 2.5V, and $V_{CCO}$ (bank 4) is greater than 1.5V. Once the POR voltages have been reached, the three-phase process begins.

First, the configuration memory is cleared. Next, configuration data is loaded into the memory, and finally, the logic is activated by a start-up process.

Configuration is automatically initiated on power-up unless it is delayed by the user. The INIT_B pin can be held Low using an open-drain driver. An open-drain is required since INIT_B is a bidirectional open-drain pin that is held Low by a Virtex-II FPGA device while the configuration memory is being cleared. Extending the time that the pin is Low causes the configuration sequencer to wait. Thus, configuration is delayed by preventing entry into the phase where data is loaded.

The configuration process can also be initiated by asserting the PROG_B pin. The end of the memory-clearing phase is signaled by the INIT_B pin going High, and the completion of the entire process is signaled by the DONE pin going High. The Global Set/Reset (GSR) signal is pulsed after the last frame of configuration data is written but before the start-up sequence. The GSR signal resets all flip-flops on the device.

The default start-up sequence is that one CCLK cycle after DONE goes High, the global 3-state signal (GTS) is released. This permits device outputs to turn on as necessary. One CCLK cycle later, the Global Write Enable (GWE) signal is released. This permits the internal storage ele-

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


ments to begin changing state in response to the logic and the user clock.

The relative timing of these events can be changed via configuration options in software. In addition, the GTS and GWE events can be made dependent on the DONE pins of multiple devices all going High, forcing the devices to start synchronously. The sequence can also be paused at any stage, until lock has been achieved on any or all DCMs, as well as the DCI.

### Readback

In this mode, configuration data from the Virtex-II FPGA device can be read back. Readback is supported only in the SelectMAP (master and slave) and Boundary-Scan mode.

Along with the configuration data, it is possible to read back the contents of all registers, distributed SelectRAM, and block RAM resources. This capability is used for real-time debugging. For more detailed configuration information, see the Virtex-II *Platform FPGA User Guide.*

### Bitstream Encryption

Virtex-II devices have an on-chip decryptor using one or two sets of three keys for triple-key Data Encryption Standard (DES) operation. Xilinx software tools offer an optional encryption of the configuration data (bitstream) with a triple-key DES determined by the designer.

The keys are stored in the FPGA by JTAG instruction and retained by a battery connected to the $V_{BATT}$ pin, when the device is not powered. Virtex-II devices can be configured with the corresponding encrypted bitstream, using any of the configuration modes described previously.

A detailed description of how to use bitstream encryption is provided in the *Virtex-II Platform FPGA User Guide*. For devices that support this feature, please contact your sales representative for specific ordering part number.

### Partial Reconfiguration

Partial reconfiguration of Virtex-II devices can be accomplished in either Slave SelectMAP mode or Boundary-Scan mode. Instead of resetting the chip and doing a full configuration, new data is loaded into a specified area of the chip, while the rest of the chip remains in operation. Data is loaded on a column basis, with the smallest load unit being a configuration “frame” of the bitstream (device size dependent).

Partial reconfiguration is useful for applications that require different designs to be loaded into the same area of a chip, or that require the ability to change portions of a design without having to reset or reconfigure the entire chip.

## Revision History

This section records the change history for this module of the data sheet.

| Date | Version | Revision |
|---|---|---|
| 11/07/2000 | 1.0 | Early access draft. |
| 12/06/2000 | 1.1 | Initial release. |
| 01/15/2001 | 1.2 | Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections. |
| 01/25/2001 | 1.3 | The data sheet was divided into four modules (per the current style standard). A note was added to Table 1. |
| 04/02/2001 | 1.5 | • Under Input/Output Individual Options, the range of values for optional pull-up and pull-down resistors was changed to 10 - 60 KΩ from 50 - 100 KΩ.<br>• Skipped v1.4 to sync up modules. Reverted to traditional double-column format. |
| 07/30/2001 | 1.6 | • Added Table 6.<br>• Changed definition of multiply and divide integer ranges under Digital Clock Manager (DCM).<br>• Made numerous minor edits throughout this module. |
| 10/02/2001 | 1.7 | • Updated descriptions under Digitally Controlled Impedance (DCI), Global Clock Multiplexer Buffers, Digital Clock Manager (DCM), and Creating a Design. |
| 10/12/2001 | 1.8 | • Made clarifying edits under Digital Clock Manager (DCM). |
| 11/29/2001 | 1.9 | • Changed bitstream lengths for each device in Table 26. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


| Date | Version | Revision |
|---|---|---|
| 07/16/2002 | 2.0 | • Updated compatible input standards listed in Table 6. |
| 09/26/2002 | 2.1 | • Changed number of resources available to the XC2V40 device in Table 13.<br>• Clarified Power On Reset information under Configuration Sequence. |
| 12/06/2002 | 2.1.1 | • Cosmetic edits. |
| 05/07/2003 | 2.1.2 | • Added qualification note to Figure 13, page 11.<br>• Corrected sentence in section Input/Output Individual Options, page 4, to read “The optional weak-keeper circuit is connected to each *user I/O pad*.”<br>• Corrected typographical errors in Table 3 for names of HSTL_[x]_DCI_18 standards. |
| 06/19/2003 | 2.2 | • Removed Compatible Output Standards and Compatible Input Standards tables.<br>• Added new Table 5, Summary of Voltage Supply Requirements for All Input and Output Standards. This table replaces deleted I/O standards tables.<br>• Added section Rules for Combining I/O Standards in the Same Bank, page 6. |
| 08/01/2003 | 3.0 | All Virtex-II devices and speed grades now Production. See Table 13, Module 3. |
| 10/14/2003 | 3.1 | • Added section Local Clocking, page 29.<br>• Table 1, page 1:<br>- Added SSTL18_I and SSTL18_II.<br>- Corrected names of 1.8V HSTL_I-IV standards to “HSTL_I-IV_18”.<br>- Corrected Input $V_{REF}$ for HSTL_III-IV_18 from 1.08V to 1.1V.<br>- Changed “N/A” to “N/R” (no requirement).<br>• Table 2, page 2:<br>- Changed “N/A” to “N/R” (no requirement).<br>• Table 3, page 2:<br>- Added SSTL18_I_DCI, SSTL18_II_DCI, LVDS_33_DCI, LVDSEXT_33_DCI, LVDS_25_DCI, and LVDSEXT_25_DCI.<br>- Corrected Input $V_{REF}$ for HSTL_III-IV_18 from 1.08V to 1.1V.<br>• Sections Slave-Serial Mode and Master-Serial Mode, page 36: Changed "rising" to "falling" edge with respect to DOUT.<br>• Added verbiage to section Bitstream Encryption, page 38: “For devices that support this feature, please contact your sales representative for specific ordering part number.” |
| 03/29/2004 | 3.2 | • Table 2, page 2, and Table 5, page 7: Removed LVDS_33_DCI and LVDSEXT_33_DCI from tables.<br>• Table 26, page 37: Updated bitstream lengths.<br>• Section BUFGMUX, page 29: Corrected the definition of the "presently selected clock" to be I0 or I1. Corrected signal names in Figure 44 and associated text from CLK0 and CLK1 to I0 and I1.<br>• Recompiled for backward compatibility with Acrobat 4 and above. |
| 06/24/2004 | 3.3 | • Table 1, page 1: Added example to Footnote (1) regarding $V_{CCO}$ rules for GTL and GTLP.<br>• Added reference to Pb-free package types in Figure 7, page 6. |
| 03/01/2005 | 3.4 | • Reassigned heading hierarchies for better agreement with content.<br>• Table 2: Corrected $V_{OD}$ output voltages.<br>• Table 26: Updated bitstream lengths. |
| 11/05/2007 | 3.5 | • Updated copyright statement and legal disclaimer.<br>• Boundary-Scan (JTAG, IEEE 1532) Mode, page 37: Updated IEEE 1149.1 compliance statement. |
| 04/07/2014 | 4.0 | This product is obsolete/discontinued per **XCN11003** and **XCN12026**. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Notice of Disclaimer

THE XILINX HARDWARE FPGA AND CPLD DEVICES REFERRED TO HEREIN (“PRODUCTS”) ARE SUBJECT TO THE TERMS AND CONDITIONS OF THE XILINX LIMITED WARRANTY WHICH CAN BE VIEWED AT http://www.xilinx.com/warranty.htm. THIS LIMITED WARRANTY DOES NOT EXTEND TO ANY USE OF PRODUCTS IN AN APPLICATION OR ENVIRONMENT THAT IS NOT WITHIN THE SPECIFICATIONS STATED IN THE XILINX DATA SHEET. ALL SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, OR ANY OTHER APPLICATION THAT INVOKES THE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR PROPERTY OR ENVIRONMENTAL DAMAGE (“CRITICAL APPLICATIONS”). USE OF PRODUCTS IN CRITICAL APPLICATIONS IS AT THE SOLE RISK OF CUSTOMER, SUBJECT TO APPLICABLE LAWS AND REGULATIONS.

## Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

# Virtex-II Platform FPGAs: DC and Switching Characteristics

DS031-3 (v4.0) April 7, 2014 **Product Specification**

## Virtex-II Electrical Characteristics

Virtex-II™ devices are provided in -6, -5, and -4 speed grades, with -6 having the highest performance.

Virtex-II DC and AC characteristics are specified for both commercial and industrial grades. Except the operating temperature range or unless otherwise noted, all the DC and AC electrical parameters are the same for a particular speed grade (that is, the timing characteristics of a -4 speed grade industrial device are the same as for a -4 speed grade commercial device). However, only selected speed grades and/or devices might be available in the industrial range.

All supply voltage and junction temperature specifications are representative of worst-case conditions. The parameters included are common to popular designs and typical applications. Contact Xilinx for design considerations requiring more detailed information.

All specifications are subject to change without notice.

## Virtex-II DC Characteristics

*Table 1:* **Absolute Maximum Ratings**

| Symbol | Description[1] | | | Units |
|---|---|---|---|---|
| $V_{CCINT}$ | Internal supply voltage relative to GND | | –0.5 to 1.65 | V |
| $V_{CCAUX}$ | Auxiliary supply voltage relative to GND | | –0.5 to 4.0 | V |
| $V_{CCO}$ | Output drivers supply voltage relative to GND | | –0.5 to 4.0 | V |
| $V_{BATT}$ | Key memory battery backup supply | | –0.5 to 4.0 | V |
| $V_{REF}$ | Input reference voltage | | –0.5 to $V_{CCO}$ + 0.5 | V |
| $V_{IN}$[3] | Input voltage relative to GND (user and dedicated I/Os) | | –0.5 to $V_{CCO}$ + 0.5 | V |
| $V_{TS}$ | Voltage applied to 3-state output (user and dedicated I/Os) | | –0.5 to 4.0 | V |
| $T_{STG}$ | Storage temperature (ambient) | | –65 to +150 | °C |
| $T_{SOL}$ | Maximum soldering temperature[2] | All regular FF/BF flip-chip and FG/BG/CS wire-bond packages | +220 | °C |
| | | Pb-free FGG456, FGG676, BGG575, and BGG728 wire-bond packages | +250 | °C |
| | | Pb-free FGG256 and CSG144 wire-bond packages | +260 | °C |
| $T_J$ | Maximum junction temperature[2] | | +125 | °C |

**Notes:**
1. Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
2. For soldering guidelines and thermal considerations, see the **Device Packaging and Thermal Characteristics Guide** information on the Xilinx website.
3. Inputs configured as PCI are fully PCI compliant. This statement takes precedence over any specification that would imply that the device is not PCI compliant.

© 2000–2014 Xilinx, Inc. All rights reserved. XILINX, the Xilinx logo, the Brand Window, and other designated brands included herein are trademarks of Xilinx, Inc. All other trademarks are the property of their respective owners.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 2:* **Recommended Operating Conditions**

| Symbol | Description | Temperature Range and Grade | | Min | Max | Units |
|---|---|---|---|---|---|---|
| $V_{CCINT}$ | Internal supply voltage relative to GND | $T_J$ = 0 °C to +85°C | Commercial | 1.425 | 1.575 | V |
| | | $T_J$ = –40°C to +100°C | Industrial | 1.425 | 1.575 | V |
| $V_{CCAUX}$ | Auxiliary supply voltage relative to GND | $T_J$ = 0 °C to +85°C | Commercial | 3.135 | 3.465 | V |
| | | $T_J$ = –40°C to +100°C | Industrial | 3.135 | 3.465 | V |
| $V_{CCO}$ | Supply voltage relative to GND | $T_J$ = 0 °C to +85°C | Commercial | 1.2 | 3.6 | V |
| | | $T_J$ = –40°C to +100°C | Industrial | 1.2 | 3.6 | V |
| $V_{BATT}$(1) | Battery voltage relative to GND | $T_J$ = 0 °C to +85°C | Commercial | 1.0 | 3.6 | V |
| | | $T_J$ = –40°C to +100°C | Industrial | 1.0 | 3.6 | V |

**Notes:**
1. If battery is not used, connect $V_{BATT}$ to GND or $V_{CCAUX}$.
2. Recommended maximum voltage droop for $V_{CCAUX}$ is 10 mV/ms.
3. The thresholds for Power On Reset are $V_{CCINT}$ > 1.2V, $V_{CCAUX}$ > 2.5V, and $V_{CCO}$ (Bank 4) > 1.5 V.
4. Limit the noise at the power supply to be within 200 mV peak-to-peak.
5. For power bypassing guidelines, see XAPP623 at www.xilinx.com.

*Table 3:* **DC Characteristics Over Recommended Operating Conditions**

| Symbol | Description | Device | Min | Max | Units |
|---|---|---|---|---|---|
| $V_{DRINT}$ | Data retention $V_{CCINT}$ voltage | All | 1.2 | | V |
| $V_{DRI}$ | Data retention $V_{CCAUX}$ voltage | All | 2.5 | | V |
| $I_{REF}$ | $V_{REF}$ current per pin | All | –10 | +10 | µA |
| $I_L$ | Input leakage current | All | –10 | +10 | µA |
| $C_{IN}$ | Input capacitance | All | | 10 | pF |
| $I_{RPU}$ | Pad pull-up (when selected) @ $V_{IN}$ = 0 V, $V_{CCO}$ = 3.3 V (sample tested) | All | Note (1) | 250 | µA |
| $I_{RPD}$ | Pad pull-down (when selected) @ $V_{IN}$ = 3.6 V (sample tested) | All | Note (1) | 250 | µA |
| $I_{BATT}$ | Battery supply current | All | (Note 2) | | nA |

**Notes:**
1. Internal pull-up and pull-down resistors guarantee valid logic levels at unconnected input pins. These pull-up and pull-down resistors do not guarantee valid logic levels when input pins are connected to other circuits.
2. Battery supply current ($I_{BATT}$):

| | Device Unpowered | Device Powered | Units |
|---|---|---|---|
| 25°C: | < 50 | < 10 | nA |
| 85°C: | N/A | < 10 | nA |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 4:* **Quiescent Supply Current**

| Symbol | Description | Device | Min | Typical | Max | Units |
|---|---|---|---|---|---|---|
| $I_{CCINTQ}$ | Quiescent $V_{CCINT}$ supply current | XC2V40 | | 3 | 125 | mA |
| | | XC2V80 | | 5 | 125 | |
| | | XC2V250 | | 8 | 150 | |
| | | XC2V500 | | 10 | 200 | |
| | | XC2V1000 | | 12 | 250 | |
| | | XC2V1500 | | 15 | 350 | |
| | | XC2V2000 | | 20 | 400 | |
| | | XC2V3000 | | 27 | 500 | |
| | | XC2V4000 | | 35 | 650 | |
| | | XC2V6000 | | 45 | 800 | |
| | | XC2V8000 | | 60 | 1100 | |
| $I_{CCOQ}$ | Quiescent $V_{CCO}$ supply current(1,2) | XC2V40 | | 1 | 2 | mA |
| | | XC2V80 | | 1 | 2 | |
| | | XC2V250 | | 1 | 2 | |
| | | XC2V500 | | 1 | 2 | |
| | | XC2V1000 | | 1 | 2 | |
| | | XC2V1500 | | 2 | 4 | |
| | | XC2V2000 | | 2 | 4 | |
| | | XC2V3000 | | 2 | 4 | |
| | | XC2V4000 | | 2 | 4 | |
| | | XC2V6000 | | 2 | 4 | |
| | | XC2V8000 | | 2 | 4 | |
| $I_{CCAUXQ}$ | Quiescent $V_{CCAUX}$ supply current(1,2) | XC2V40 | | 5 | 25 | mA |
| | | XC2V80 | | 5 | 25 | |
| | | XC2V250 | | 5 | 25 | |
| | | XC2V500 | | 5 | 25 | |
| | | XC2V1000 | | 5 | 25 | |
| | | XC2V1500 | | 7.5 | 50 | |
| | | XC2V2000 | | 7.5 | 50 | |
| | | XC2V3000 | | 10 | 75 | |
| | | XC2V4000 | | 10 | 75 | |
| | | XC2V6000 | | 12.5 | 100 | |
| | | XC2V8000 | | 12.5 | 100 | |

**Notes:**
1. With no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
2. If DCI or differential signaling is used, more accurate values can be obtained by using the Power Estimator or XPOWER™.
3. Data are retained even if $V_{CCO}$ drops to 0 V.
4. Values specified for quiescent supply current parameters are Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.25.

## Power-On Power Supply Requirements

Xilinx FPGAs require a certain amount of supply current during power-on to insure proper device operation. The actual current consumed depends on the power-on ramp rate of the power supply.

The $V_{CCINT}$, $V_{CCAUX}$, and $V_{CCO}$ power supplies shall each ramp on, monotonically, no faster than 200 µs and no slower than 50 ms. Ramp on is defined as: 0 $V_{DC}$ to minimum supply voltages.

Table 5 shows the minimum current required by Virtex-II devices for proper power on and configuration.

Power supplies can be turned on in any sequence.(1)

If any $V_{CCO}$ bank powers up before $V_{CCAUX}$, then each bank draws up to 300 mA, worst case, until the $V_{CCAUX}$ powers up.(2) This does not harm the device. If the current is limited to the minimum value above, or larger, the device powers on properly after all three supplies have passed through their power-on reset threshold voltages.

Once initialized and configured, use the power calculator to estimate current drain on these supplies.

**Notes:**
1. If the $V_{CCINT}$ ramp rate is longer than 10 ms, then $V_{CCINT}$ must be applied before $V_{CCO}$ and $V_{CCAUX}$. The device will not be damaged if this requirement is violated, but configuration will probably fail.
2. The 300 mA is transient current (peak); it eventually disappears even if $V_{CCAUX}$ does not power up.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 5:* **Minimum Power On Current Required for Virtex-II Devices**

| | Device (mA) | | | | | | | |
|---|---|---|---|---|---|---|---|---|
| | XC2V40, XC2V80, XC2V250, XC2V500 | XC2V1000 | XC2V1500 | XC2V2000 | XC2V3000 | XC2V4000 | XC2V6000 | XC2V8000 |
| $I_{CCINTMIN}$ | 200 | 250 | 350 | 400 | 500 | 650 | 800 | 1100 |
| $I_{CCAUXMIN}$ | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 |
| $I_{CCOMIN}$ | 50 | 50 | 100 | 100 | 100 | 100 | 100 | 100 |

**Notes:**
1. Values specified for power on current parameters are Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.25.
2. $I_{CCOMIN}$ values listed here apply to the entire device (all banks).

## General Power Supply Requirements

Proper decoupling of all FPGA power supplies is sessential. Consult Xilinx Application Note **XAPP623** for detailed information on power distribution system design.

$V_{CCAUX}$ powers critical resources in the FPGA. Thus, $V_{CCAUX}$ is especially susceptible to power supply noise.

Changes in $V_{CCAUX}$ voltage outside of 200 mV peak to peak should take place at a rate no faster than 10 mV per millisecond. Techniques to help reduce jitter and period distortion are provided in Xilinx Answer Record 13756, available at **www.support.xilinx.com**.

$V_{CCAUX}$ can share a power plane with 3.3V $V_{CCO}$, but only if $V_{CCO}$ does not have excessive noise. Using simultaneously switching output (SSO) limits are essential for keeping power supply noise to a minimum. Refer to **XAPP689**, "Managing Ground Bounce in Large FPGAs," to determine the number of simultaneously switching outputs allowed per bank at the package level.

## DC Input and Output Levels

Values for $V_{IL}$ and $V_{IH}$ are recommended input voltages. Values for $I_{OL}$ and $I_{OH}$ are guaranteed over the recommended operating conditions at the $V_{OL}$ and $V_{OH}$ test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at minimum $V_{CCO}$ with the respective $V_{OL}$ and $V_{OH}$ voltage levels shown. Other standards are sample tested.

*Table 6:* **DC Input and Output Levels**

| Input/Output | $V_{IL}$ | | $V_{IH}$ | | $V_{OL}$ | $V_{OH}$ | $I_{OL}$ | $I_{OH}$ |
|---|---|---|---|---|---|---|---|---|
| Standard | V, Min | V, Max | V, Min | V, Max | V, Max | V, Min | mA | mA |
| LVTTL(1) | – 0.5 | 0.8 | 2.0 | 3.6 | 0.4 | 2.4 | 24 | – 24 |
| LVCMOS33 | – 0.5 | 0.8 | 2.0 | 3.6 | 0.4 | $V_{CCO}$ – 0.4 | 24 | – 24 |
| LVCMOS25 | – 0.5 | 0.7 | 1.7 | 2.7 | 0.4 | $V_{CCO}$ – 0.4 | 24 | – 24 |
| LVCMOS18 | – 0.5 | 35% $V_{CCO}$ | 65% $V_{CCO}$ | 1.95 | 0.4 | $V_{CCO}$ – 0.4 | 16 | – 16 |
| LVCMOS15 | – 0.5 | 35% $V_{CCO}$ | 65% $V_{CCO}$ | 1.7 | 0.4 | $V_{CCO}$ – 0.4 | 16 | – 16 |
| PCI33_3 | – 0.5 | 30% $V_{CCO}$ | 50% $V_{CCO}$ | $V_{CCO}$ + 0.5 | 10% $V_{CCO}$ | 90% $V_{CCO}$ | Note 2 | Note 2 |
| PCI66_3 | – 0.5 | 30% $V_{CCO}$ | 50% $V_{CCO}$ | $V_{CCO}$ + 0.5 | 10% $V_{CCO}$ | 90% $V_{CCO}$ | Note 2 | Note 2 |
| PCI–X | – 0.5 | Note 2 | Note 2 | Note 2 | Note 2 | Note 2 | Note 2 | Note 2 |
| GTLP | – 0.5 | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | $V_{CCO}$ + 0.5 | 0.6 | n/a | 36 | n/a |
| GTL | – 0.5 | $V_{REF}$ – 0.05 | $V_{REF}$ + 0.05 | $V_{CCO}$ + 0.5 | 0.4 | n/a | 40 | n/a |
| HSTL I | – 0.5 | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | $V_{CCO}$ + 0.5 | 0.4 | $V_{CCO}$ – 0.4 | 8 | – 8 |
| HSTL II | – 0.5 | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | $V_{CCO}$ + 0.5 | 0.4 | $V_{CCO}$ – 0.4 | 16 | – 16 |
| HSTL III | – 0.5 | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | $V_{CCO}$ + 0.5 | 0.4 | $V_{CCO}$ – 0.4 | 24 | – 8 |
| HSTL IV | – 0.5 | $V_{REF}$ – 0.1 | $V_{REF}$ + 0.1 | $V_{CCO}$ + 0.5 | 0.4 | $V_{CCO}$ – 0.4 | 48 | – 8 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **DC Input and Output Levels *(Continued)***

| Input/Output Standard | $V_{IL}$ | | $V_{IH}$ | | $V_{OL}$ | $V_{OH}$ | $I_{OL}$ | $I_{OH}$ |
|---|---|---|---|---|---|---|---|---|
| | V, Min | V, Max | V, Min | V, Max | V, Max | V, Min | mA | mA |
| SSTL3 I | – 0.5 | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | $V_{CCO}$ + 0.5 | $V_{REF}$ – 0.6 | $V_{REF}$ + 0.6 | 8 | – 8 |
| SSTL3 II | – 0.5 | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | $V_{CCO}$ + 0.5 | $V_{REF}$ – 0.8 | $V_{REF}$ + 0.8 | 16 | – 16 |
| SSTL2 I | – 0.5 | $V_{REF}$ – 0.15 | $V_{REF}$ + 0.15 | $V_{CCO}$ + 0.5 | $V_{REF}$ – 0.65 | $V_{REF}$ + 0.65 | 7.6 | – 7.6 |
| SSTL2 II | – 0.5 | $V_{REF}$ – 0.15 | $V_{REF}$ + 0.15 | $V_{CCO}$ + 0.5 | $V_{REF}$ – 0.80 | $V_{REF}$ + 0.80 | 15.2 | – 15.2 |
| AGP | – 0.5 | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | $V_{CCO}$ + 0.5 | 10% $V_{CCO}$ | 90% $V_{CCO}$ | Note 2 | Note 2 |

**Notes:**
1. $V_{OL}$ and $V_{OH}$ for lower drive currents are sample tested. The DONE pin is always LVTTL 12 mA.
2. Tested according to the relevant specifications.
3. LVTTL and LVCMOS inputs have approximately 100 mV of hysteresis.

## LDT Differential Signal DC Specifications (LDT_25)

*Table 7:* **LDT DC Specifications**

| DC Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| Differential Output Voltage | $V_{OD}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 500 | 600 | 700 | mV |
| Change in $V_{OD}$ Magnitude | $\Delta V_{OD}$ | | –15 | | 15 | mV |
| Output Common Mode Voltage | $V_{OCM}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 560 | 600 | 640 | mV |
| Change in $V_{OS}$ Magnitude | $\Delta V_{OCM}$ | | –15 | | 15 | mV |
| Input Differential Voltage | $V_{ID}$ | | 200 | 600 | 1000 | mV |
| Change in $V_{ID}$ Magnitude | $\Delta V_{ID}$ | | –15 | | 15 | mV |
| Input Common Mode Voltage | $V_{ICM}$ | | 500 | 600 | 700 | mV |
| Change in $V_{ICM}$ Magnitude | $\Delta V_{ICM}$ | | –15 | | 15 | mV |

## LVDS DC Specifications (LVDS_33 & LVDS_25)

*Table 8:* **LVDS DC Specifications**

| DC Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| Supply Voltage | $V_{CCO}$ | | | 3.3 or 2.5 | | V |
| Output High Voltage for Q and $\overline{Q}$ | $V_{OH}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | | | 1.575 | V |
| Output Low Voltage for Q and $\overline{Q}$ | $V_{OL}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 0.925 | | | V |
| Differential Output Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High | $V_{ODIFF}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 250 | 350 | 400 | mV |
| Output Common-Mode Voltage | $V_{OCM}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 1.125 | 1.2 | 1.375 | V |
| Differential Input Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High | $V_{IDIFF}$ | Common-mode input voltage = 1.25 V | 100 | 350 | N/A | mV |
| Input Common-Mode Voltage | $V_{ICM}$ | Differential input voltage = ±350 mV | 0.2 | 1.25 | $V_{CCO}$ – 0.5 | V |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Extended LVDS DC Specifications (LVDSEXT_33 & LVDSEXT_25)

*Table 9:* **Extended LVDS DC Specifications**

| DC Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| Supply Voltage | $V_{CCO}$ | | | 3.3 or 2.5 | | V |
| Output High voltage for Q and $\overline{Q}$ | $V_{OH}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | | | 1.785 | V |
| Output Low voltage for Q and $\overline{Q}$ | $V_{OL}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 0.705 | | | V |
| Differential output voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High | $V_{ODIFF}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 440 | | 820 | mV |
| Output common-mode voltage | $V_{OCM}$ | $R_T$ = 100 Ω across Q and $\overline{Q}$ signals | 1.125 | 1.200 | 1.375 | V |
| Differential input voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High | $V_{IDIFF}$ | Common-mode input voltage = 1.25 V | 100 | 350 | N/A | mV |
| Input common-mode voltage | $V_{ICM}$ | Differential input voltage = ±350 mV | 0.2 | 1.25 | $V_{CCO}$ – 0.5 | V |

## LVPECL DC Specifications

These values are valid when driving a 100 Ω differential load only, i.e., a 100 Ω resistor between the two receiver pins. The $V_{OH}$ levels are 200 mV below standard LVPECL levels and are compatible with devices tolerant of lower common-mode ranges. Table 10 summarizes the DC output specifications of LVPECL. For more information on using LVPECL, see the *Virtex-II User Guide*.

*Table 10:* **LVPECL DC Specifications**

| DC Parameter | Min | Max | Min | Max | Min | Max | Units |
|---|---|---|---|---|---|---|---|
| $V_{CCO}$ | 3.0 | | 3.3 | | 3.6 | | V |
| $V_{OH}$ | 1.8 | 2.11 | 1.92 | 2.28 | 2.13 | 2.41 | V |
| $V_{OL}$ | 0.96 | 1.27 | 1.06 | 1.43 | 1.30 | 1.57 | V |
| $V_{IH}$ | 1.49 | 2.72 | 1.49 | 2.72 | 1.49 | 2.72 | V |
| $V_{IL}$ | 0.86 | 2.125 | 0.86 | 2.125 | 0.86 | 2.125 | V |
| Differential Input Voltage | 0.3 | – | 0.3 | – | 0.3 | – | V |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Virtex-II Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II devices. The numbers reported here are worst-case values; they have all been fully characterized. Note that these values are subject to the same guidelines as Virtex-II Switching Characteristics, page 9 (speed files).

Table 11 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

*Table 11:* **Pin-to-Pin Performance**

| Description | Device Used & Speed Grade | Pin-to-Pin (with I/O delays) | Units |
|---|---|---|---|
| **Basic Functions** | | | |
| 16-bit Address Decoder | XC2V1000 -5 | 6.3 | ns |
| 32-bit Address Decoder | XC2V1000 -5 | 7.7 | ns |
| 64-bit Address Decoder | XC2V1000 -5 | 9.3 | ns |
| 4:1 MUX | XC2V1000 -5 | 5.7 | ns |
| 8:1 MUX | XC2V1000 -5 | 6.5 | ns |
| 16:1 MUX | XC2V1000 -5 | 6.7 | ns |
| 32:1 MUX | XC2V1000 -5 | 8.7 | ns |
| Combinatorial (pad to LUT to pad) | XC2V1000 -5 | 5.0 | ns |
| **Memory** | | | |
| **Block RAM** | | | |
| Pad to setup | | 1.6 | ns |
| Clock to Pad | | 9.5 | ns |
| **Distributed RAM** | | | |
| Pad to setup | XC2V1000 -5 | 2.7 | ns |
| Clock to Pad | XC2V1000 -5 | 5.1 (no clk skew) | ns |

Table 12 shows internal (register-to-register) performance. Values are reported in MHz.

*Table 12:* **Register-to-Register Performance**

| Description | Device Used & Speed Grade | Register-to-Register Performance | Units |
|---|---|---|---|
| **Basic Functions** | | | |
| 16-bit Address Decoder | XC2V1000 -5 | 398 | MHz |
| 32-bit Address Decoder | XC2V1000 -5 | 291 | MHz |
| 64-bit Address Decoder | XC2V1000 -5 | 274 | MHz |
| 4:1 MUX | XC2V1000 -5 | 563 | MHz |
| 8:1 MUX | XC2V1000 -5 | 454 | MHz |
| 16:1 MUX | XC2V1000 -5 | 414 | MHz |
| 32:1 MUX | XC2V1000 -5 | 323 | MHz |
| Register to LUT to Register | XC2V1000 -5 | 613 | MHz |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **Register-to-Register Performance *(Continued)***

| Description | Device Used & Speed Grade | Register-to-Register Performance | Units |
|---|---|---|---|
| 8-bit Adder | XC2V1000 -5 | 292 | MHz |
| 16-bit Adder | XC2V1000 -5 | 239 | MHz |
| 64-bit Adder | XC2V1000 -5 | 114 | MHz |
| 64-bit Counter | XC2V1000 -5 | 114 | MHz |
| 64-bit Accumulator | XC2V1000 -5 | 110 | MHz |
| Multiplier 18x18 (with Block RAM inputs) | XC2V1000 -5 | 88 | MHz |
| Multiplier 18x18 (with Register inputs) | XC2V1000 -5 | 105 | MHz |
| **Memory** | | | |
| **Block RAM** | | | |
| Single-Port 4096 x 4 bits | | 278 | MHz |
| Single-Port 2048 x 9 bits | | 277 | MHz |
| Single-Port 1024 x 18 bits | | 270 | MHz |
| Single-Port 512 x 36 bits | | 253 | MHz |
| Dual-Port A:4096 x 4 bits & B:1024 x 18 bits | | 257 | MHz |
| Dual-Port A:1024 x 18 bits & B:1024 x 18 bits | | 259 | MHz |
| Dual-Port A:2048 x 9 bits & B: 512 x 36 bits | | 250 | MHz |
| **Distributed RAM** | | | |
| Single-Port 32 x 8-bit | XC2V1000 -5 | 387 | MHz |
| Single-Port 64 x 8-bit | XC2V1000 -5 | 335 | MHz |
| Single-Port 128 x 8-bit | XC2V1000 -5 | 266 | MHz |
| Dual-Port 16 x 8 | XC2V1000 -5 | 409 | MHz |
| Dual-Port 32 x 8 | XC2V1000 -5 | 311 | MHz |
| Dual-Port 64 x 8 | XC2V1000 -5 | 294 | MHz |
| **Shift Registers** | | | |
| 128-bit SRL | | N/A | MHz |
| 256-bit SRL | | N/A | MHz |
| **FIFOs (Async. in Block RAM)** | | | |
| 1024 x 18-bit Read | | 279 | MHz |
| 1024 x 18-bit Write | | 172 | MHz |
| **FIFOs (Sync. in SRL)** | | | |
| 128 x 8-bit | | N/A | MHz |
| 128 x 16-bit | | N/A | MHz |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Virtex-II Switching Characteristics

Switching characteristics in this document are specified on a per-speed-grade basis and can be designated as Advance, Preliminary, or Production. Note that Virtex-II Performance Characteristics, page 7 are subject to these guidelines as well. Each designation is defined as follows:

**Advance**: These speed files are based on simulations only and are typically available soon after device design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

**Preliminary**: These speed files are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to Advance data.

**Production**: These speed files are released once enough production silicon of a particular device family member has been characterized to provide full correlation between speed files and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. Table 13 correlates the current status of each Virtex-II device with a corresponding speed grade designation.

All specifications are always representative of worst-case supply voltage and junction temperature conditions.

## Testing of Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the Xilinx static timing analyzer and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Virtex-II devices.

## IOB Input Switching Characteristics

Input delays associated with the pad are specified for LVTTL levels. For other standards, adjust the delays with the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11.

*Table 13:* **Virtex-II Device Speed Grade Designations**

| Device | Speed Grade Designations | | |
|---|---|---|---|
| | Advance | Preliminary | Production |
| XC2V40 | | | -6, -5, -4 |
| XC2V80 | | | -6, -5, -4 |
| XC2V250 | | | -6, -5, -4 |
| XC2V500 | | | -6, -5, -4 |
| XC2V1000 | | | -6, -5, -4 |
| XC2V1500 | | | -6, -5, -4 |
| XC2V2000 | | | -6, -5, -4 |
| XC2V3000 | | | -6, -5, -4 |
| XC2V4000 | | | -6, -5, -4 |
| XC2V6000 | | | -6, -5, -4 |
| XC2V8000 | | | -5, -4 |

*Table 14:* **IOB Input Switching Characteristics**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Propagation Delays** | | | | | | |
| Pad to I output, no delay | $T_{IOPI}$ | All | 0.69 | 0.76 | 0.88 | ns, Max |
| Pad to I output, with delay | $T_{IOPID}$ | XC2V40 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V80 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V250 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V500 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V1000 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V1500 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V2000 | 1.92 | 2.11 | 2.43 | ns, Max |
| | | XC2V3000 | 1.97 | 2.16 | 2.49 | ns, Max |
| | | XC2V4000 | 1.97 | 2.16 | 2.49 | ns, Max |
| | | XC2V6000 | 2.10 | 2.31 | 2.66 | ns, Max |
| | | XC2V8000 | | 2.31 | 2.66 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **IOB Input Switching Characteristics *(Continued)***

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Propagation Delays** | | | | | | |
| Pad to output IQ via transparent latch, no delay | $T_{IOPLI}$ | All | 0.83 | 0.91 | 1.05 | ns, Max |
| Pad to output IQ via transparent latch, with delay | $T_{IOPLID}$ | XC2V40 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V80 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V250 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V500 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V1000 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V1500 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V2000 | 3.23 | 3.55 | 4.09 | ns, Max |
| | | XC2V3000 | 3.32 | 3.65 | 4.20 | ns, Max |
| | | XC2V4000 | 3.32 | 3.65 | 4.20 | ns, Max |
| | | XC2V6000 | 3.60 | 3.95 | 4.55 | ns, Max |
| | | XC2V8000 | | 3.95 | 4.55 | ns, Max |
| Clock CLK to output IQ | $T_{IOCKIQ}$ | All | | 0.67 | 0.77 | ns, Max |
| **Setup and Hold Times With Respect to Clock at IOB Input Register** | | | | | | |
| Pad, no delay | $T_{IOPICK}/T_{IOICKP}$ | All | 0.84/–0.36 | 0.92/–0.39 | 1.06/–0.45 | ns, Min |
| Pad, with delay | $T_{IOPICKD}/T_{IOICKPD}$ | XC2V40 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V80 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V250 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V500 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V1000 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V1500 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V2000 | 3.24/–2.04 | 3.57/–2.24 | 4.10/–2.58 | ns, Min |
| | | XC2V3000 | 3.33/–2.10 | 3.67/–2.31 | 4.22/–2.66 | ns, Min |
| | | XC2V4000 | 3.33/–2.10 | 3.67/–2.31 | 4.22/–2.66 | ns, Min |
| | | XC2V6000 | 3.61/–2.29 | 3.97/–2.52 | 4.56/–2.90 | ns, Min |
| | | XC2V8000 | | 3.97/–2.52 | 4.56/–2.90 | ns, Min |
| ICE input | $T_{IOICECK}/T_{IOCKICE}$ | All | | 0.21/ 0.04 | 0.24/ 0.04 | ns, Min |
| SR input (IFF, synchronous) | $T_{IOSRCKI}$ | All | 0.27 | 0.30 | 0.34 | ns, Min |
| **Set/Reset Delays** | | | | | | |
| SR input to IQ (asynchronous) | $T_{IOSRIQ}$ | All | 1.11 | 1.22 | 1.40 | ns, Max |
| GSR to output IQ | $T_{GSRQ}$ | All | 5.44 | 5.98 | 6.88 | ns, Max |

**Notes:**
1. Input timing for LVTTL is measured at 1.4 V. For other I/O standards, see Table 18.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## IOB Input Switching Characteristics Standard Adjustments

Table 15 gives all standard-specific data input delay adjustments.

*Table 15:* **IOB Input Switching Characteristics Standard Adjustments**

| Description | IOSTANDARD Attribute | Timing Parameter | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVTTL (Low-Voltage Transistor-Transistor Logic) | LVTTL | $T_{ILVTTL}$ | 0.00 | 0.00 | 0.00 | ns |
| LVCMOS (Low-Voltage CMOS ), 3.3V | LVCMOS33 | $T_{ILVCMOS33}$ | 0.00 | 0.00 | 0.00 | ns |
| LVCMOS, 2.5V | LVCMOS25 | $T_{ILVCMOS25}$ | 0.11 | 0.11 | 0.12 | ns |
| LVCMOS, 1.8V | LVCMOS18 | $T_{ILVCMOS18}$ | 0.42 | 0.43 | 0.49 | ns |
| LVCMOS, 1.5V | LVCMOS15 | $T_{ILVCMOS15}$ | 0.98 | 1.00 | 1.15 | ns |
| LVDS (Low-Voltage Differential Signaling), 2.5V | LVDS_25 | $T_{ILVDS_25}$ | 0.60 | 0.60 | 0.69 | ns |
| LVDS, 3.3V | LVDS_33 | $T_{ILVDS_33}$ | 0.60 | 0.60 | 0.69 | ns |
| LVDSEXT (Extended Mode), 2.5V | LVDSEXT_25 | $T_{ILVDSEXT_25}$ | 0.68 | 0.69 | 0.79 | ns |
| LVDSEXT, 3.3V | LVDSEXT_33 | $T_{ILVDSEXT_33}$ | 0.56 | 0.56 | 0.65 | ns |
| ULVDS (Ultra LVDS), 2.5V | ULVDS_25 | $T_{IULVDS_25}$ | 0.48 | 0.49 | 0.56 | ns |
| BLVDS (Bus LVDS), 2.5V | BLVDS_25 | $T_{IBLVDS_25}$ | 0.68 | 0.69 | 0.79 | ns |
| LDT (HyperTransport), 2.5V | LDT_25 | $T_{ILDT_25}$ | 0.48 | 0.49 | 0.56 | ns |
| LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V | LVPECL_33 | $T_{ILVPECL_33}$ | 0.60 | 0.60 | 0.69 | ns |
| PCI (Peripheral Component Interface), 33 MHz, 3.3V | PCI33_3 | $T_{IPCI33_3}$ | 0.00 | 0.00 | 0.00 | ns |
| PCI, 66 MHz, 3.3V | PCI66_3 | $T_{IPCI66_3}$ | 0.00 | 0.00 | 0.00 | ns |
| PCI-X, 133 MHz, 3.3V | PCIX | $T_{IPCIX}$ | 0.00 | 0.00 | 0.00 | ns |
| GTL (Gunning Transceiver Logic) | GTL | $T_{IGTL}$ | 0.42 | 0.42 | 0.48 | ns |
| GTL Plus | GTLP | $T_{IGTLP}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL (High-Speed Transceiver Logic), Class I | HSTL_I | $T_{IHSTL_I}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class II | HSTL_II | $T_{IHSTL_II}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class III | HSTL_III | $T_{IHSTL_III}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class IV | HSTL_IV | $T_{IHSTL_IV}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class I, 1.8V | HSTL_I_18 | $T_{IHSTL_I_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class II, 1.8V | HSTL_II_18 | $T_{IHSTL_II_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class III, 1.8V | HSTL_III_18 | $T_{IHSTL_III_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class IV, 1.8V | HSTL_IV_18 | $T_{IHSTL_IV_18}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V | SSTL18_I | $T_{ISSTL18_I}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class II, 1.8V | SSTL18_II | $T_{ISSTL18_II}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class I, 2.5V | SSTL2_I | $T_{ISSTL2_I}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class II, 2.5V | SSTL2_II | $T_{ISSTL2_II}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class I, 3.3V | SSTL3_I | $T_{ISSTL3_I}$ | 0.35 | 0.35 | 0.40 | ns |
| SSTL, Class II, 3.3V | SSTL3_ II | $T_{ISSTL3_II}$ | 0.35 | 0.35 | 0.40 | ns |
| AGP-2X/AGP (Accelerated Graphics Port) | AGP | $T_{IAGP}$ | 0.35 | 0.35 | 0.40 | ns |
| LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V | LVDCI_33 | $T_{ILVDCI_33}$ | 0.00 | 0.00 | 0.00 | ns |
| LVDCI, 2.5V | LVDCI_25 | $T_{ILVDCI_25}$ | 0.11 | 0.11 | 0.12 | ns |
| LVDCI, 1.8V | LVDCI_18 | $T_{ILVDCI_18}$ | 0.42 | 0.43 | 0.49 | ns |
| LVDCI, 1.5V | LVDCI_15 | $T_{ILVDCI_15}$ | 0.98 | 1.00 | 1.14 | ns |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 15:* **IOB Input Switching Characteristics Standard Adjustments *(Continued)***

| Description | IOSTANDARD Attribute | Timing Parameter | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVDCI, 3.3V, Half-Impedance | LVDCI_DV2_33 | $T_{ILVDCI_DV2_33}$ | 0.00 | 0.00 | 0.00 | ns |
| LVDCI, 2.5V, Half-Impedance | LVDCI_DV2_25 | $T_{ILVDCI_DV2_25}$ | 0.11 | 0.11 | 0.12 | ns |
| LVDCI, 1.8V, Half-Impedance | LVDCI_DV2_18 | $T_{ILVDCI_DV2_18}$ | 0.42 | 0.43 | 0.49 | ns |
| LVDCI, 1.5V, Half-Impedance | LVDCI_DV2_15 | $T_{ILVDCI_DV2_15}$ | 0.98 | 1.00 | 1.14 | ns |
| HSLVDCI (High-Speed Low-Voltage DCI), 1.5V | HSLVDCI_15 | $T_{IHSLVDCI_15}$ | 0.42 | 0.42 | 0.48 | ns |
| HSLVDCI, 1.8V | HSLVDCI_18 | $T_{IHSLVDCI_18}$ | 0.52 | 0.53 | 0.60 | ns |
| HSLVDCI, 2.5V | HSLVDCI_25 | $T_{IHSLVDCI_25}$ | 0.42 | 0.42 | 0.48 | ns |
| HSLVDCI, 3.3V | HSLVDCI_33 | $T_{IHSLVDCI_33}$ | 0.42 | 0.42 | 0.48 | ns |
| GTL (Gunning Transceiver Logic) with DCI | GTL_DCI | $T_{IGTL_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| GTL Plus with DCI | GTLP_DCI | $T_{IGTLP_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL (High-Speed Transceiver Logic), Class I, with DCI | HSTL_I_DCI | $T_{IHSTL_I_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class II, with DCI | HSTL_II_DCI | $T_{IHSTL_II_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class III, with DCI | HSTL_III_DCI | $T_{IHSTL_III_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class IV, with DCI | HSTL_IV_DCI | $T_{IHSTL_IV_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class I, 1.8V, with DCI | HSTL_I_DCI_18 | $T_{IHSTL_I_DCI_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class II, 1.8V, with DCI | HSTL_II_DCI_18 | $T_{IHSTL_II_DCI_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class III, 1.8V, with DCI | HSTL_III_DCI_18 | $T_{IHSTL_III_DCI_18}$ | 0.42 | 0.42 | 0.48 | ns |
| HSTL, Class IV, 1.8V, with DCI | HSTL_IV_DCI_18 | $T_{IHSTL_IV_DCI_18}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI | SSTL18_I_DCI | $T_{ISSTL18_I_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class II, 1.8V, with DCI | SSTL18_II_DCI | $T_{ISSTL18_II_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class I, 2.5V, with DCI | SSTL2_I_DCI | $T_{ISSTL2_I_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class II, 2.5V, with DCI | SSTL2_II_DCI | $T_{ISSTL2_II_DCI}$ | 0.42 | 0.42 | 0.48 | ns |
| SSTL, Class I, 3.3V, with DCI | SSTL3_I_DCI | $T_{ISSTL3_I_DCI}$ | 0.35 | 0.35 | 0.40 | ns |
| SSTL, Class II, 3.3V, with DCI | SSTL3_II_DCI | $T_{ISSTL3_II_DCI}$ | 0.35 | 0.35 | 0.40 | ns |
| LVDS (Low-Voltage Differential Signaling), 2.5V, with DCI | LVDS_25_DCI | $T_{ILVDS_25_DCI}$ | 0.60 | 0.60 | 0.69 | ns |
| LVDS, 3.3V, with DCI | LVDS_33_DCI | $T_{ILVDS_33_DCI}$ | 0.60 | 0.60 | 0.69 | ns |
| LVDSEXT (LVDS Extended Mode), 2.5V, with DCI | LVDSEXT_25_DCI | $T_{ILVDSEXT_25_DCI}$ | 0.58 | 0.59 | 0.79 | ns |
| LVDSEXT, 3.3V, with DCI | LVDSEXT_33_DCI | $T_{ILVDSEXT_33_DCI}$ | 0.56 | 0.56 | 0.65 | ns |

**Notes:**
1. Input timing for LVTTL is measured at 1.4V. For other I/O standards, see Table 18.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## IOB Output Switching Characteristics

Output delays terminating at a pad are specified for LVTTL with 12 mA drive and fast slew rate. For other standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 14.

*Table 16:* **IOB Output Switching Characteristics**

| | | Speed Grade | | | |
|---|---|---|---|---|---|
| **Description** | **Symbol** | **-6** | **-5** | **-4** | **Units** |
| **Propagation Delays** | | | | | |
| O input to Pad | $T_{IOOP}$ | 1.43 | 1.51 | 1.74 | ns, Max |
| O input to Pad via transparent latch | $T_{IOOLP}$ | 1.72 | 1.83 | 2.11 | ns, Max |
| **3-State Delays** | | | | | |
| T input to Pad high-impedance(1) | $T_{IOTHZ}$ | 0.51 | 0.56 | 0.64 | ns, Max |
| T input to valid data on Pad | $T_{IOTP}$ | 1.38 | 1.45 | 1.67 | ns, Max |
| T input to Pad high-impedance via transparent latch(1) | $T_{IOTLPHZ}$ | 0.80 | 0.88 | 1.01 | ns, Max |
| T input to valid data on Pad via transparent latch | $T_{IOTLPON}$ | 1.67 | 1.77 | 2.04 | ns, Max |
| GTS to Pad high impedance(1) | $T_{GTS}$ | 4.73 | 5.20 | 5.98 | ns, Max |
| **Sequential Delays** | | | | | |
| Clock CLK to Pad | $T_{IOCKP}$ | 1.76 | 1.87 | 2.15 | ns, Max |
| Clock CLK to Pad high-impedance (synchronous)(1) | $T_{IOCKHZ}$ | 0.95 | 1.04 | 1.20 | ns, Max |
| Clock CLK to valid data on Pad (synchronous) | $T_{IOCKON}$ | 1.82 | 1.94 | 2.22 | ns, Max |
| **Setup and Hold Times Before/After Clock CLK** | | | | | |
| O input | $T_{IOOCK}/T_{IOCKO}$ | 0.31/–0.08 | 0.34/–0.09 | 0.39/–0.11 | ns, Min |
| OCE input | $T_{IOOCECK}/T_{IOCKOCE}$ | 0.19/–0.06 | 0.21/–0.07 | 0.24/–0.08 | ns, Min |
| SR input (OFF) | $T_{IOSRCKO}/T_{IOCKOSR}$ | 0.27/–0.05 | 0.30/–0.06 | 0.34/–0.07 | ns, Min |
| 3–State Setup Times, T input | $T_{IOTCK}/T_{IOCKT}$ | 0.28/–0.06 | 0.31/–0.07 | 0.35/–0.08 | ns, Min |
| 3–State Setup Times, TCE input | $T_{IOTCECK}/T_{IOCKTCE}$ | 0.19/–0.06 | 0.21/–0.07 | 0.24/–0.08 | ns, Min |
| 3–State Setup Times, SR input (TFF) | $T_{IOSRCKT}/T_{IOCKTSR}$ | 0.27/–0.05 | 0.30/–0.06 | 0.34/–0.07 | ns, Min |
| **Set/Reset Delays** | | | | | |
| Minimum Pulse Width, SR input (asynchronous) | $T_{RPW}$ | 0.61 | 0.67 | 0.77 | ns, Min |
| SR input to Pad (asynchronous) | $T_{IOSRP}$ | 2.41 | 2.59 | 2.98 | ns, Max |
| SR input to Pad high-impedance (asynchronous)(1) | $T_{IOSRHZ}$ | 1.52 | 1.67 | 1.92 | ns, Max |
| SR input to valid data on Pad (asynchronous) | $T_{IOSRON}$ | 2.39 | 2.56 | 2.95 | ns, Max |
| GSR to Pad | $T_{IOGSRQ}$ | 5.44 | 5.98 | 6.88 | ns, Max |

**Notes:**
1. The 3-state turn-off delays should not be adjusted.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## IOB Output Switching Characteristics Standard Adjustments

Table 17 gives all standard-specific adjustments for output delays terminating at pads, based on standard capacitive load, $C_{REF}$. Output delays terminating at a pad are specified for LVTTL with 12 mA drive and fast slew rate. For other standards, adjust the delays by the values shown.

*Table 17:* **IOB Output Switching Characteristics Standard Adjustments**

| Description | IOSTANDARD Attribute | Timing Parameter | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVTTL (Low-Voltage Transistor-Transistor Logic), Slow, 2 mA | LVTTL_S2 | $T_{OLVTTL_S2}$ | 9.42 | 9.71 | 10.68 | ns |
| LVTTL, Slow, 4 mA | LVTTL_S4 | $T_{OLVTTL_S4}$ | 5.77 | 5.95 | 6.55 | ns |
| LVTTL, Slow, 6 mA | LVTTL_S6 | $T_{OLVTTL_S6}$ | 4.11 | 4.24 | 4.66 | ns |
| LVTTL, Slow, 8 mA | LVTTL_S8 | $T_{OLVTTL_S8}$ | 2.87 | 2.96 | 3.26 | ns |
| LVTTL, Slow, 12 mA | LVTTL_S12 | $T_{OLVTTL_S12}$ | 2.32 | 2.39 | 2.63 | ns |
| LVTTL, Slow, 16 mA | LVTTL_S16 | $T_{OLVTTL_S16}$ | 1.70 | 1.75 | 1.93 | ns |
| LVTTL, Slow, 24 mA | LVTTL_S24 | $T_{OLVTTL_S24}$ | 1.26 | 1.30 | 1.43 | ns |
| LVTTL, Fast, 2 mA | LVTTL_F2 | $T_{OLVTTL_F2}$ | 6.52 | 6.72 | 7.39 | ns |
| LVTTL, Fast, 4 mA | LVTTL_F4 | $T_{OLVTTL_F4}$ | 2.80 | 2.88 | 3.17 | ns |
| LVTTL, Fast, 6 mA | LVTTL_F6 | $T_{OLVTTL_F6}$ | 1.57 | 1.62 | 1.78 | ns |
| LVTTL, Fast, 8 mA | LVTTL_F8 | $T_{OLVTTL_F8}$ | 0.46 | 0.48 | 0.52 | ns |
| LVTTL, Fast, 12 mA | LVTTL_F12 | $T_{OLVTTL_F12}$ | 0.00 | 0.00 | 0.00 | ns |
| LVTTL, Fast, 16 mA | LVTTL_F16 | $T_{OLVTTL_F16}$ | –0.13 | –0.14 | –0.15 | ns |
| LVTTL, Fast, 24 mA | LVTTL_F24 | $T_{OLVTTL_F24}$ | –0.22 | –0.23 | –0.26 | ns |
| LVCMOS (Low-Voltage CMOS), 3.3V, Slow, 2 mA | LVCMOS33_S2 | $T_{OLVCMOS33_S2}$ | 7.67 | 7.91 | 8.70 | ns |
| LVCMOS, 3.3V, Slow, 4 mA | LVCMOS33_S4 | $T_{OLVCMOS33_S4}$ | 4.37 | 4.50 | 4.95 | ns |
| LVCMOS, 3.3V, Slow, 6 mA | LVCMOS33_S6 | $T_{OLVCMOS33_S6}$ | 3.34 | 3.44 | 3.78 | ns |
| LVCMOS, 3.3V, Slow, 8 mA | LVCMOS33_S8 | $T_{OLVCMOS33_S8}$ | 2.29 | 2.36 | 2.60 | ns |
| LVCMOS, 3.3V, Slow, 12 mA | LVCMOS33_S12 | $T_{OLVCMOS33_S12}$ | 1.91 | 1.97 | 2.16 | ns |
| LVCMOS, 3.3V, Slow, 16 mA | LVCMOS33_S16 | $T_{OLVCMOS33_S16}$ | 1.24 | 1.27 | 1.40 | ns |
| LVCMOS, 3.3V, Slow, 24 mA | LVCMOS33_S24 | $T_{OLVCMOS33_S24}$ | 1.18 | 1.22 | 1.34 | ns |
| LVCMOS, 3.3V, Fast, 2 mA | LVCMOS33_F2 | $T_{OLVCMOS33_F2}$ | 5.82 | 6.00 | 6.60 | ns |
| LVCMOS, 3.3V, Fast, 4 mA | LVCMOS33_F4 | $T_{OLVCMOS33_F4}$ | 2.48 | 2.55 | 2.81 | ns |
| LVCMOS, 3.3V, Fast, 6 mA | LVCMOS33_F6 | $T_{OLVCMOS33_F6}$ | 1.28 | 1.31 | 1.45 | ns |
| LVCMOS, 3.3V, Fast, 8 mA | LVCMOS33_F8 | $T_{OLVCMOS33_F8}$ | 0.48 | 0.49 | 0.54 | ns |
| LVCMOS, 3.3V, Fast, 12 mA | LVCMOS33_F12 | $T_{OLVCMOS33_F12}$ | 0.27 | 0.28 | 0.31 | ns |
| LVCMOS, 3.3V, Fast, 16 mA | LVCMOS33_F16 | $T_{OLVCMOS33_F16}$ | –0.14 | –0.14 | –0.15 | ns |
| LVCMOS, 3.3V, Fast, 24 mA | LVCMOS33_F24 | $T_{OLVCMOS33_F24}$ | –0.21 | –0.21 | –0.23 | ns |
| LVCMOS, 2.5V, Slow, 2 mA | LVCMOS25_S2 | $T_{OLVCMOS25_S2}$ | 9.11 | 9.39 | 10.33 | ns |
| LVCMOS, 2.5V, Slow, 4 mA | LVCMOS25_S4 | $T_{OLVCMOS25_S4}$ | 5.00 | 5.16 | 5.67 | ns |
| LVCMOS, 2.5V, Slow, 6 mA | LVCMOS25_S6 | $T_{OLVCMOS25_S6}$ | 4.53 | 4.67 | 5.13 | ns |
| LVCMOS, 2.5V, Slow, 8 mA | LVCMOS25_S8 | $T_{OLVCMOS25_S8}$ | 3.86 | 3.98 | 4.38 | ns |
| LVCMOS, 2.5V, Slow, 12 mA | LVCMOS25_S12 | $T_{OLVCMOS25_S12}$ | 2.84 | 2.93 | 3.22 | ns |
| LVCMOS, 2.5V, Slow, 16 mA | LVCMOS25_S16 | $T_{OLVCMOS25_S16}$ | 2.36 | 2.43 | 2.67 | ns |
| LVCMOS, 2.5V, Slow, 24 mA | LVCMOS25_S24 | $T_{OLVCMOS25_S24}$ | 2.00 | 2.06 | 2.27 | ns |
| LVCMOS, 2.5V, Fast, 2 mA | LVCMOS25_F2 | $T_{OLVCMOS25_F2}$ | 4.06 | 4.18 | 4.60 | ns |
| LVCMOS, 2.5V, Fast, 4 mA | LVCMOS25_F4 | $T_{OLVCMOS25_F4}$ | 1.15 | 1.18 | 1.30 | ns |
| LVCMOS, 2.5V, Fast, 6 mA | LVCMOS25_F6 | $T_{OLVCMOS25_F6}$ | 0.72 | 0.74 | 0.81 | ns |
| LVCMOS, 2.5V, Fast, 8 mA | LVCMOS25_F8 | $T_{OLVCMOS25_F8}$ | 0.33 | 0.34 | 0.37 | ns |
| LVCMOS, 2.5V, Fast, 12 mA | LVCMOS25_F12 | $T_{OLVCMOS25_F12}$ | 0.02 | 0.02 | 0.03 | ns |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 17:* **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

| Description | IOSTANDARD Attribute | Timing Parameter | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVCMOS, 2.5V, Fast, 16 mA | LVCMOS25_F16 | $T_{OLVCMOS25_F16}$ | –0.18 | –0.19 | –0.21 | ns |
| LVCMOS, 2.5V, Fast, 24 mA | LVCMOS25_F24 | $T_{OLVCMOS25_F24}$ | –0.35 | –0.36 | –0.40 | ns |
| LVCMOS, 1.8V, Slow, 2 mA | LVCMOS18_S2 | $T_{OLVCMOS18_S2}$ | 15.62 | 16.10 | 17.71 | ns |
| LVCMOS, 1.8V, Slow, 4 mA | LVCMOS18_S4 | $T_{OLVCMOS18_S4}$ | 10.20 | 10.51 | 11.57 | ns |
| LVCMOS, 1.8V, Slow, 6 mA | LVCMOS18_S6 | $T_{OLVCMOS18_S6}$ | 7.52 | 7.75 | 8.53 | ns |
| LVCMOS, 1.8V, Slow, 8 mA | LVCMOS18_S8 | $T_{OLVCMOS18_S8}$ | 6.87 | 7.08 | 7.78 | ns |
| LVCMOS, 1.8V, Slow, 12 mA | LVCMOS18_S12 | $T_{OLVCMOS18_S12}$ | 5.54 | 5.71 | 6.28 | ns |
| LVCMOS, 1.8V, Slow, 16 mA | LVCMOS18_S16 | $T_{OLVCMOS18_S16}$ | 5.31 | 5.47 | 6.02 | ns |
| LVCMOS, 1.8V, Fast, 2 mA | LVCMOS18_F2 | $T_{OLVCMOS18_F2}$ | 5.55 | 5.72 | 6.30 | ns |
| LVCMOS, 1.8V, Fast, 4 mA | LVCMOS18_F4 | $T_{OLVCMOS18_F4}$ | 1.89 | 1.95 | 2.15 | ns |
| LVCMOS, 1.8V, Fast, 6 mA | LVCMOS18_F6 | $T_{OLVCMOS18_F6}$ | 0.83 | 0.85 | 0.94 | ns |
| LVCMOS, 1.8V, Fast, 8 mA | LVCMOS18_F8 | $T_{OLVCMOS18_F8}$ | 0.70 | 0.72 | 0.80 | ns |
| LVCMOS, 1.8V, Fast, 12 mA | LVCMOS18_F12 | $T_{OLVCMOS18_F12}$ | 0.26 | 0.27 | 0.30 | ns |
| LVCMOS, 1.8V, Fast, 16 mA | LVCMOS18_F16 | $T_{OLVCMOS18_F16}$ | 0.23 | 0.23 | 0.26 | ns |
| LVCMOS, 1.5V, Slow, 2 mA | LVCMOS15_S2 | $T_{OLVCMOS15_S2}$ | 18.96 | 19.55 | 21.50 | ns |
| LVCMOS, 1.5V, Slow, 4 mA | LVCMOS15_S4 | $T_{OLVCMOS15_S4}$ | 12.77 | 13.17 | 14.48 | ns |
| LVCMOS, 1.5V, Slow, 6 mA | LVCMOS15_S6 | $T_{OLVCMOS15_S6}$ | 12.05 | 12.42 | 13.66 | ns |
| LVCMOS, 1.5V, Slow, 8 mA | LVCMOS15_S8 | $T_{OLVCMOS15_S8}$ | 9.75 | 10.06 | 11.06 | ns |
| LVCMOS, 1.5V, Slow, 12 mA | LVCMOS15_S12 | $T_{OLVCMOS15_S12}$ | 9.04 | 9.32 | 10.25 | ns |
| LVCMOS, 1.5V, Slow, 16 mA | LVCMOS15_S16 | $T_{OLVCMOS15_S16}$ | 8.21 | 8.46 | 9.31 | ns |
| LVCMOS, 1.5V, Fast, 2 mA | LVCMOS15_F2 | $T_{OLVCMOS15_F2}$ | 5.09 | 5.25 | 5.78 | ns |
| LVCMOS, 1.5V, Fast, 4 mA | LVCMOS15_F4 | $T_{OLVCMOS15_F4}$ | 2.01 | 2.07 | 2.27 | ns |
| LVCMOS, 1.5V, Fast, 6 mA | LVCMOS15_F6 | $T_{OLVCMOS15_F6}$ | 1.46 | 1.51 | 1.66 | ns |
| LVCMOS, 1.5V, Fast, 8 mA | LVCMOS15_F8 | $T_{OLVCMOS15_F8}$ | 0.93 | 0.96 | 1.05 | ns |
| LVCMOS, 1.5V, Fast, 12 mA | LVCMOS15_F12 | $T_{OLVCMOS15_F12}$ | 0.74 | 0.77 | 0.84 | ns |
| LVCMOS, 1.5V, Fast, 16 mA | LVCMOS15_F16 | $T_{OLVCMOS15_F16}$ | 0.67 | 0.69 | 0.75 | ns |
| LVDS (Low-Voltage Differential Signaling), 2.5V | LVDS_25 | $T_{OLVDS_25}$ | –0.31 | –0.32 | –0.36 | ns |
| LVDS, 3.3V | LVDS_33 | $T_{OLVDS_33}$ | –0.25 | –0.26 | –0.29 | ns |
| LVDSEXT (LVDS Extended Mode), 2.5V | LVDSEXT_25 | $T_{OLVDSEXT_25}$ | –0.18 | –0.19 | –0.21 | ns |
| LVDSEXT, 3.3V | LVDSEXT_33 | $T_{OLVDSEXT_33}$ | –0.17 | –0.18 | –0.19 | ns |
| ULVDS (Ultra LVDS), 2.5V | ULVDS_25 | $T_{OULVDS_25}$ | –0.20 | –0.21 | –0.23 | ns |
| BLVDS (Bus LVDS), 2.5V | BLVDS_25 | $T_{OBLVDS_25}$ | 0.67 | 0.69 | 0.76 | ns |
| LDT (HyperTransport), 2.5V | LDT_25 | $T_{OLDT_25}$ | –0.20 | –0.21 | –0.23 | ns |
| LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V | LVPECL_33 | $T_{OLVPECL_33}$ | 0.29 | 0.30 | 0.33 | ns |
| PCI (Peripheral Component Interface), 33 MHz, 3.3V | PCI33_3 | $T_{OPCI33_3}$ | 1.15 | 1.19 | 1.31 | ns |
| PCI, 66 MHz, 3.3V | PCI66_3 | $T_{OPCI66_3}$ | –0.01 | –0.01 | –0.01 | ns |
| PCI-X, 133 MHz, 3.3V | PCIX | $T_{OPCIX}$ | –0.01 | –0.01 | –0.01 | ns |
| GTL (Gunning Transceiver Logic) | GTL | $T_{OGTL}$ | –0.31 | –0.32 | –0.36 | ns |
| GTL Plus | GTLP | $T_{OGTLP}$ | –0.17 | –0.18 | –0.20 | ns |
| HSTL (High-Speed Transceiver Logic), Class I | HSTL_I | $T_{OHSTL_I}$ | 0.26 | 0.27 | 0.29 | ns |
| HSTL, Class II | HSTL_II | $T_{OHSTL_II}$ | –0.15 | –0.16 | –0.17 | ns |
| HSTL, Class III | HSTL_III | $T_{OHSTL_III}$ | –0.17 | –0.17 | –0.19 | ns |
| HSTL, Class IV | HSTL_IV | $T_{OHSTL_IV}$ | –0.40 | –0.41 | –0.45 | ns |
| HSTL, Class I, 1.8V | HSTL_I_18 | $T_{OHSTL_I_18}$ | 0.03 | 0.03 | 0.04 | ns |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 17:* **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

| Description | IOSTANDARD Attribute | Timing Parameter | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| HSTL, Class II, 1.8V | HSTL_II_18 | $T_{OHSTL_II_18}$ | –0.17 | –0.18 | –0.20 | ns |
| HSTL, Class III, 1.8V | HSTL_III_18 | $T_{OHSTL_III_18}$ | –0.16 | –0.16 | –0.18 | ns |
| HSTL, Class IV, 1.8V | HSTL_IV_18 | $T_{OHSTL_IV_18}$ | –0.39 | –0.40 | –0.44 | ns |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V | SSTL18_I | $T_{OSSTL18_I}$ | 0.20 | 0.20 | 0.22 | ns |
| SSTL, Class II, 1.8V | SSTL18_II | $T_{OSSTL18_II}$ | –0.05 | –0.05 | –0.06 | ns |
| SSTL, Class I, 2.5V | SSTL2_I | $T_{OSSTL2_I}$ | 0.21 | 0.22 | 0.24 | ns |
| SSTL, Class II, 2.5V | SSTL2_II | $T_{OSSTL2_II}$ | –0.15 | –0.16 | –0.18 | ns |
| SSTL, Class I, 3.3V | SSTL3_I | $T_{OSSTL3_I}$ | 0.29 | 0.30 | 0.33 | ns |
| SSTL, Class II, 3.3V | SSTL3_II | $T_{OSSTL3_II}$ | –0.05 | –0.05 | –0.05 | ns |
| AGP-2X/AGP (Accelerated Graphics Port) | AGP | $T_{OAGP}$ | –0.27 | –0.28 | –0.31 | ns |
| LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V | LVDCI_33 | $T_{OLVDCI_33}$ | 0.74 | 0.77 | 0.84 | ns |
| LVDCI, 2.5V | LVDCI_25 | $T_{OLVDCI_25}$ | 0.78 | 0.80 | 0.88 | ns |
| LVDCI, 1.8V | LVDCI_18 | $T_{OLVDCI_18}$ | 0.84 | 0.87 | 0.95 | ns |
| LVDCI, 1.5V | LVDCI_15 | $T_{OLVDCI_15}$ | 1.82 | 1.88 | 2.06 | ns |
| LVDCI, 3.3V, Half-Impedance | LVDCI_DV2_33 | $T_{OLVDCI_DV2_33}$ | 0.12 | 0.12 | 0.13 | ns |
| LVDCI, 2.5V, Half-Impedance | LVDCI_DV2_25 | $T_{OLVDCI_DV2_25}$ | 0.03 | 0.03 | 0.03 | ns |
| LVDCI, 1.8V, Half-Impedance | LVDCI_DV2_18 | $T_{OLVDCI_DV2_18}$ | 0.42 | 0.43 | 0.48 | ns |
| LVDCI, 1.5V, Half-Impedance | LVDCI_DV2_15 | $T_{OLVDCI_DV2_15}$ | 1.20 | 1.23 | 1.36 | ns |
| HSLVDCI (High-Speed Low-Voltage DCI), 1.5V | HSLVDCI_15 | $T_{OHSLVDCI_15}$ | 1.82 | 1.88 | 2.06 | ns |
| HSLVDCI, 1.8V | HSLVDCI_18 | $T_{OHSLVDCI_18}$ | 1.05 | 1.08 | 1.24 | ns |
| HSLVDCI, 2.5V | HSLVDCI_25 | $T_{OHSLVDCI_25}$ | 0.78 | 0.80 | 0.88 | ns |
| HSLVDCI, 3.3V | HSLVDCI_33 | $T_{OHSLVDCI_33}$ | 0.74 | 0.77 | 0.84 | ns |
| GTL (Gunning Transceiver Logic) with DCI | GTL_DCI | $T_{OGTL_DCI}$ | –0.31 | –0.32 | –0.35 | ns |
| GTL Plus with DCI | GTLP_DCI | $T_{OGTLP_DCI}$ | –0.15 | –0.16 | –0.17 | ns |
| HSTL (High-Speed Transceiver Logic), Class I, with DCI | HSTL_I_DCI | $T_{OHSTL_I_DCI}$ | 0.23 | 0.23 | 0.26 | ns |
| HSTL, Class II, with DCI | HSTL_II_DCI | $T_{OHSTL_II_DCI}$ | 0.06 | 0.06 | 0.07 | ns |
| HSTL, Class III, with DCI | HSTL_III_DCI | $T_{OHSTL_III_DCI}$ | –0.17 | –0.18 | –0.20 | ns |
| HSTL, Class IV, with DCI | HSTL_IV_DCI | $T_{OHSTL_IV_DCI}$ | –0.46 | –0.47 | –0.52 | ns |
| HSTL, Class I, 1.8V, with DCI | HSTL_I_DCI_18 | $T_{OHSTL_I_DCI_18}$ | 0.05 | 0.05 | 0.06 | ns |
| HSTL, Class II, 1.8V, with DCI | HSTL_II_DCI_18 | $T_{OHSTL_II_DCI_18}$ | –0.03 | –0.03 | –0.03 | ns |
| HSTL, Class III, 1.8V, with DCI | HSTL_III_DCI_18 | $T_{OHSTL_III_DCI_18}$ | –0.14 | –0.14 | –0.16 | ns |
| HSTL, Class IV, 1.8V, with DCI | HSTL_IV_DCI_18 | $T_{OHSTL_IV_DCI_18}$ | –0.41 | –0.42 | –0.47 | ns |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI | SSTL18_I_DCI | $T_{OSSTL18_I_DCI}$ | 0.36 | 0.37 | 0.40 | ns |
| SSTL, Class II, 1.8V, with DCI | SSTL18_II_DCI | $T_{OSSTL18_II_DCI}$ | 0.06 | 0.06 | 0.07 | ns |
| SSTL, Class I, 2.5V, with DCI | SSTL2_I_DCI | $T_{OSSTL2_I_DCI}$ | 0.12 | 0.13 | 0.14 | ns |
| SSTL, Class II, 2.5V, with DCI | SSTL2_II_DCI | $T_{OSSTL2_II_DCI}$ | –0.10 | –0.10 | –0.11 | ns |
| SSTL, Class I, 3.3V, with DCI | SSTL3_I_DCI | $T_{OSSTL3_I_DCI}$ | 0.15 | 0.16 | 0.17 | ns |
| SSTL, Class II, 3.3V, with DCI | SSTL3_II_DCI | $T_{OSSTL3_II_DCI}$ | 0.08 | 0.08 | 0.09 | ns |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## I/O Standard Adjustment Measurement Methodology

### *Input Delay Measurements*

Table 18 shows the test setup parameters used for measuring Input standard adjustments (see Table 15, page 11).

*Table 18:* **Input Delay Measurement Methodology**

| Description | IOSTANDARD Attribute | $V_L$ (1,2) | $V_H$ (1,2) | $V_{MEAS}$ (1,4,5) | $V_{REF}$ (1,3,5) |
|---|---|---|---|---|---|
| LVTTL (Low-Voltage Transistor-Transistor Logic) | LVTTL | 0 | 3.0 | 1.4 | – |
| LVCMOS (Low-Voltage CMOS), 3.3V | LVCMOS33 | 0 | 3.3 | 1.65 | – |
| LVCMOS, 2.5V | LVCMOS25 | 0 | 2.5 | 1.25 | – |
| LVCMOS, 1.8V | LVCMOS18 | 0 | 1.8 | 0.9 | – |
| LVCMOS, 1.5V | LVCMOS15 | 0 | 1.5 | 0.75 | – |
| PCI (Peripheral Component Interface), 33 MHz, 3.3V | PCI33_3 | Per PCI Specification | | | – |
| PCI, 66 MHz, 3.3V | PCI66_3 | Per PCI Specification | | | – |
| PCI-X, 133 MHz, 3.3V | PCIX | Per PCI-X Specification | | | – |
| GTL (Gunning Transceiver Logic) | GTL | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | $V_{REF}$ | 0.80 |
| GTL Plus | GTLP | $V_{REF}$ – 0.2 | $V_{REF}$ + 0.2 | $V_{REF}$ | 1.0 |
| HSTL (High-Speed Transceiver Logic), Class I & II | HSTL_I, HSTL_II | $V_{REF}$ – 0.5 | $V_{REF}$ + 0.5 | $V_{REF}$ | 0.75 |
| HSTL, Class III & IV | HSTL_III, HSTL_IV | $V_{REF}$ – 0.5 | $V_{REF}$ + 0.5 | $V_{REF}$ | 0.90 |
| HSTL, Class I & II, 1.8V | HSTL_I_18, HSTL_II_18 | $V_{REF}$ – 0.5 | $V_{REF}$ + 0.5 | $V_{REF}$ | 0.90 |
| HSTL, Class III & IV, 1.8V | HSTL_III_18, HSTL_IV_18 | $V_{REF}$ – 0.5 | $V_{REF}$ + 0.5 | $V_{REF}$ | 1.08 |
| SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V | SSTL3_I, SSTL3_II | $V_{REF}$ – 1.00 | $V_{REF}$ + 1.00 | $V_{REF}$ | 1.5 |
| SSTL, Class I & II, 2.5V | SSTL2_I, SSTL2_II | $V_{REF}$ – 0.75 | $V_{REF}$ + 0.75 | $V_{REF}$ | 1.25 |
| SSTL, Class I & II, 1.8V | SSTL18_I, SSTL18_II | $V_{REF}$ – 0.5 | $V_{REF}$ + 0.5 | $V_{REF}$ | 0.90 |
| AGP-2X/AGP (Accelerated Graphics Port) | AGP | $V_{REF}$ – ($0.2 \times V_{CCO}$) | $V_{REF}$ + ($0.2 \times V_{CCO}$) | $V_{REF}$ | AGP Spec |
| LVDS (Low-Voltage Differential Signaling), 2.5V | LVDS_25 | 1.2 – 0.125 | 1.2 + 0.125 | 1.2 | |
| LVDS, 3.3V | LVDS_33 | 1.2 – 0.125 | 1.2 + 0.125 | 1.2 | |
| LVDSEXT (LVDS Extended Mode), 2.5V | LVDSEXT_25 | 1.2 – 0.125 | 1.2 + 0.125 | 1.2 | |
| LVDSEXT, 3.3V | LVDSEXT_33 | 1.2 – 0.125 | 1.2 + 0.125 | 1.2 | |
| ULVDS (Ultra LVDS), 2.5V | ULVDS_25 | 0.6 – 0.125 | 0.6 + 0.125 | 0.6 | |
| LDT (HyperTransport), 2.5V | LDT_25 | 0.6 – 0.125 | 0.6 + 0.125 | 0.6 | |
| LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V | LVPECL_33 | 1.6 – 0.3 | 1.6 + 0.3 | 1.6 | |

**Notes:**
1. Input delay measurement methodology parameters for LVDCI and HSLVDCI are the same as for LVCMOS standards of the same voltage. Parameters for all other DCI standards are the same as for the corresponding non-DCI standards.
2. Input waveform switches between $V_L$ and $V_H$.
3. Measurements are made at typical, minimum, and maximum $V_{REF}$ values. Reported delays reflect worst case of these measurements. $V_{REF}$ values listed are typical. See **Virtex-II Platform FPGA User Guide** for min/max specifications.
4. Input voltage level from which measurement starts.
5. Note that this is an input voltage reference that bears no relation to the $V_{REF}$ / $V_{MEAS}$ parameters found in IBIS models and/or noted in Figure 1.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


### *Output Delay Measurements*

Output delays are measured using a Tektronix P6245 TDS500/600 probe (< 1 pF) across approximately 4" of FR4 microstrip trace. Standard termination was used for all testing. (See ***Virtex-II Platform FPGA User Guide*** for details.) The propagation delay of the 4" trace is characterized separately and subtracted from the final measurement, and is therefore not included in the generalized test setup shown in Figure 1.

Measurements and test conditions are reflected in the IBIS models except where the IBIS format precludes it. (IBIS models can be found on the web at **http://support.xilinx.com/support/sw_ibis.htm**.) Parameters $V_{REF}$, $R_{REF}$, $C_{REF}$, and $V_{MEAS}$ fully describe the test conditions for each I/O standard. The most accurate prediction of propagation delay in any given application can be obtained through IBIS simulation, using the following method:

1. Simulate the output driver of choice into the generalized test setup, using values from Table 19.
2. Record the time to $V_{MEAS}$.
3. Simulate the output driver of choice into the actual PCB trace and load, using the appropriate IBIS model or capacitance value to represent the load.
4. Record the time to $V_{MEAS}$.
5. Compare the results of steps 2 and 4. The increase or decrease in delay should be added to or subtracted from the I/O Output Standard Adjustment value (Table 17) to yield the actual worst-case propagation delay (clock-to-input) of the PCB trace.

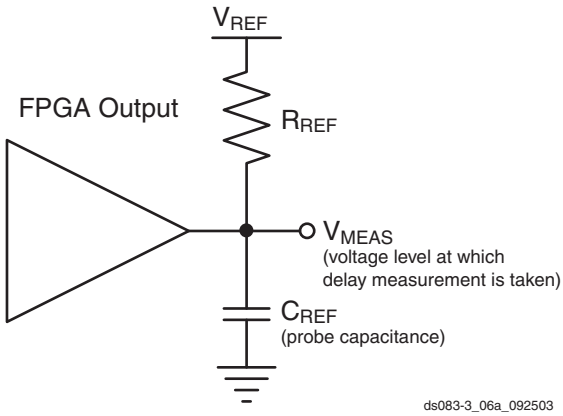



*Figure 1:* **Generalized Test Setup**

*Table 19:* **Output Delay Measurement Methodology**

| Description | IOSTANDARD Attribute | $R_{REF}$ (Ω) | $C_{REF}$ (1) (pF) | $V_{MEAS}$ (V) | $V_{REF}$ (V) |
|---|---|---|---|---|---|
| LVTTL (Low-Voltage Transistor-Transistor Logic) | LVTTL (all) | 1M | 0 | 1.4 | 0 |
| LVCMOS (Low-Voltage CMOS ), 3.3V | LVCMOS33 | 1M | 0 | 1.65 | 0 |
| LVCMOS, 2.5V | LVCMOS25 | 1M | 0 | 1.25 | 0 |
| LVCMOS, 1.8V | LVCMOS18 | 1M | 0 | 0.9 | 0 |
| LVCMOS, 1.5V | LVCMOS15 | 1M | 0 | 0.75 | 0 |
| PCI (Peripheral Component Interface), 33 MHz, 3.3V | PCI33_3 (rising edge) | 25 | 10 (2) | 0.94 | 0 |
| | PCI33_3 (falling edge) | 25 | 10 (2) | 2.03 | 3.3 |
| PCI, 66 MHz, 3.3V | PCI66_3 (rising edge) | 25 | 10 (2) | 0.94 | 0 |
| | PCI66_3 (falling edge) | 25 | 10 (2) | 2.03 | 3.3 |
| PCI-X, 133 MHz, 3.3V | PCIX (rising edge) | 25 | 10 (3) | 0.94 | |
| | PCIX (falling edge | 25 | 10 (3) | 2.03 | 3.3 |
| GTL (Gunning Transceiver Logic) | GTL | 25 | 0 | 0.8 | 1.2 |
| GTL Plus | GTLP | 25 | 0 | 1.0 | 1.5 |
| HSTL (High-Speed Transceiver Logic), Class I | HSTL_I | 50 | 0 | $V_{REF}$ | 0.75 |
| HSTL, Class II | HSTL_II | 25 | 0 | $V_{REF}$ | 0.75 |
| HSTL, Class III | HSTL_III | 50 | 0 | 0.9 | 1.5 |
| HSTL, Class IV | HSTL_IV | 25 | 0 | 0.9 | 1.5 |
| HSTL, Class I, 1.8V | HSTL_I_18 | 50 | 0 | $V_{REF}$ | 0.9 |
| HSTL, Class II, 1.8V | HSTL_II_18 | 25 | 0 | $V_{REF}$ | 0.9 |
| HSTL, Class III, 1.8V | HSTL_III_18 | 50 | 0 | 1.1 | 1.8 |
| HSTL, Class IV, 1.8V | HSTL_IV_18 | 25 | 0 | 1.1 | 1.8 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 19:* **Output Delay Measurement Methodology**

| Description | IOSTANDARD Attribute | $R_{REF}$ (Ω) | $C_{REF}$ (1) (pF) | $V_{MEAS}$ (V) | $V_{REF}$ (V) |
|---|---|---|---|---|---|
| SSTL (Stub Series Terminated Logic), Class I, 1.8V | SSTL18_I | 50 | 0 | $V_{REF}$ | 0.9 |
| SSTL, Class II, 1.8V | SSTL18_II | 25 | 0 | $V_{REF}$ | 0.9 |
| SSTL, Class I, 2.5V | SSTL2_I | 50 | 0 | $V_{REF}$ | 1.25 |
| SSTL, Class II, 2.5V | SSTL2_II | 25 | 0 | $V_{REF}$ | 1.25 |
| SSTL, Class I, 3.3V | SSTL3_I | 50 | 0 | $V_{REF}$ | 1.5 |
| SSTL, Class II, 3.3V | SSTL3_II | 25 | 0 | $V_{REF}$ | 1.5 |
| AGP-2X/AGP (Accelerated Graphics Port) | AGP-2X/AGP (rising edge) | 50 | 0 | 0.94 | 0 |
| | AGP-2X/AGP (falling edge) | 50 | 0 | 2.03 | 3.3 |
| LVDS (Low-Voltage Differential Signaling), 2.5V | LVDS_25 | 50 | 0 | $V_{REF}$ | 1.2 |
| LVDS, 3.3V | LVDSEXT_25 | 50 | 0 | $V_{REF}$ | 1.2 |
| LVDSEXT (LVDS Extended Mode), 2.5V | LVDS_33 | 50 | 0 | $V_{REF}$ | 1.2 |
| LVDSEXT, 3.3V | LVDSEXT_33 | 50 | 0 | $V_{REF}$ | 1.2 |
| BLVDS (Bus LVDS), 2.5V | BLVDS_25 | 1M | 0 | 1.2 | 0 |
| LDT (HyperTransport), 2.5V | LDT_25 | 50 | 0 | $V_{REF}$ | 0.6 |
| LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V | LVPECL_33 | 1M | 0 | 1.23 | 0 |
| LVDCI/HSLVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V | LVDCI_33, HSLVDCI_33 | 1M | 0 | 1.65 | 0 |
| LVDCI/HSLVDCI, 2.5V | LVDCI_25, HSLVDCI_25 | 1M | 0 | 1.25 | 0 |
| LVDCI/HSLVDCI, 1.8V | LVDCI_18, HSLVDCI_18 | 1M | 0 | 0.9 | 0 |
| LVDCI/HSLVDCI, 1.5V | LVDCI_15, HSLVDCI_15 | 1M | 0 | 0.75 | 0 |
| HSTL (High-Speed Transceiver Logic), Class I & II, with DCI | HSTL_I_DCI, HSTL_II_DCI | 50 | 0 | $V_{REF}$ | 0.75 |
| HSTL, Class III & IV, with DCI | HSTL_III_DCI, HSTL_IV_DCI | 50 | 0 | 0.9 | 1.5 |
| HSTL, Class I & II, 1.8V, with DCI | HSTL_I_DCI_18, HSTL_II_DCI_18 | 50 | 0 | $V_{REF}$ | 0.9 |
| HSTL, Class III & IV, 1.8V, with DCI | HSTL_III_DCI_18, HSTL_IV_DCI_18 | 50 | 0 | 1.1 | 1.8 |
| SSTL (Stub Series Termi.Logic), Class I & II, 1.8V, with DCI | SSTL18_I_DCI, SSTL18_II_DCI | 50 | 0 | $V_{REF}$ | 0.9 |
| SSTL, Class I & II, 2.5V, with DCI | SSTL2_I_DCI, SSTL2_II_DCI | 50 | 0 | $V_{REF}$ | 1.25 |
| SSTL, Class I & II, 3.3V, with DCI | SSTL3_I_DCI, SSTL3_II_DCI | 50 | 0 | $V_{REF}$ | 1.5 |
| GTL (Gunning Transceiver Logic) with DCI | GTL_DCI | 50 | 0 | 0.8 | 1.2 |
| GTL Plus with DCI | GTLP_DCI | 50 | 0 | 1.0 | 1.5 |

**Notes:**
1. $C_{REF}$ is the capacitance of the probe, nominally 0 pF.
2. Per PCI specifications.
3. Per PCI-X specifications.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Clock Distribution Switching Characteristics

*Table 20:* **Clock Distribution Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| Global Clock Buffer I input to O output | $T_{GIO}$ | 0.47 | 0.52 | 0.59 | ns, Max |
| Global Clock Buffer S input Setup/Hold to I1 an I2 inputs | $T_{GSI}/T_{GIS}$ | 0.55/ 0 | 0.61/ 0 | 0.70/ 0 | ns, Max |

## CLB Switching Characteristics

Delays originating at F/G inputs vary slightly according to the input used (see Figure 16 in Module 2). The values listed below are worst-case. Precise values are provided by the timing analyzer.

*Table 21:* **CLB Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Combinatorial Delays** | | | | | |
| 4-input function: F/G inputs to X/Y outputs | $T_{ILO}$ | 0.35 | 0.39 | 0.44 | ns, Max |
| 5-input function: F/G inputs to F5 output | $T_{IF5}$ | 0.57 | 0.63 | 0.72 | ns, Max |
| 5-input function: F/G inputs to X output | $T_{IF5X}$ | 0.76 | 0.83 | 0.95 | ns, Max |
| FXINA or FXINB inputs to Y output via MUXFX | $T_{IFXY}$ | 0.36 | 0.39 | 0.45 | ns, Max |
| FXINA input to FX output via MUXFX | $T_{INAFX}$ | 0.26 | 0.28 | 0.32 | ns, Max |
| FXINB input to FX output via MUXFX | $T_{INBFX}$ | 0.26 | 0.28 | 0.32 | ns, Max |
| SOPIN input to SOPOUT output via ORCY | $T_{SOPSOP}$ | 0.35 | 0.38 | 0.44 | ns, Max |
| Incremental delay routing through transparent latch to XQ/YQ outputs | $T_{IFNCTL}$ | 0.41 | 0.45 | 0.51 | ns, Max |
| **Sequential Delays** | | | | | |
| FF Clock CLK to XQ/YQ outputs | $T_{CKO}$ | 0.45 | 0.50 | 0.57 | ns, Max |
| Latch Clock CLK to XQ/YQ outputs | $T_{CKLO}$ | 0.54 | 0.59 | 0.68 | ns, Max |
| **Setup and Hold Times Before/After Clock CLK** | | | | | |
| BX/BY inputs | $T_{DICK}/T_{CKDI}$ | 0.30/–0.07 | 0.33/–0.08 | 0.37/–0.09 | ns, Min |
| DY inputs | $T_{DYCK}/T_{CKDY}$ | 0.30/–0.07 | 0.33/–0.08 | 0.37/–0.09 | ns, Min |
| DX inputs | $T_{DXCK}/T_{CKDX}$ | 0.30/–0.07 | 0.33/–0.08 | 0.37/–0.09 | ns, Min |
| CE input | $T_{CECK}/T_{CKCE}$ | 0.19/–0.06 | 0.21/–0.07 | 0.24/–0.08 | ns, Min |
| SR/BY inputs (synchronous) | $T_{SRCK}/T_{SCKR}$ | 0.21/–0.02 | 0.23/–0.03 | 0.26/–0.03 | ns, Min |
| **Clock CLK** | | | | | |
| Minimum Pulse Width, High | $T_{CH}$ | 0.61 | 0.67 | 0.77 | ns, Min |
| Minimum Pulse Width, Low | $T_{CL}$ | 0.61 | 0.67 | 0.77 | ns, Min |
| **Set/Reset** | | | | | |
| Minimum Pulse Width, SR/BY inputs (asynchronous) | $T_{RPW}$ | 0.61 | 0.67 | 0.77 | ns, Min |
| Delay from SR/BY inputs to XQ/YQ outputs (asynchronous) | $T_{RQ}$ | 1.06 | 1.17 | 1.34 | ns, Max |
| Toggle Frequency (MHz) (for export control) | $F_{TOG}$ | 820 | 750 | 650 | MHz |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## CLB Distributed RAM Switching Characteristics

*Table 22:* **CLB Distributed RAM Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Sequential Delays** | | | | | |
| Clock CLK to X/Y outputs (WE active) in 16 x 1 mode | $T_{SHCKO16}$ | 1.63 | 1.79 | 2.05 | ns, Max |
| Clock CLK to X/Y outputs (WE active) in 32 x 1 mode | $T_{SHCKO32}$ | 1.97 | 2.17 | 2.49 | ns, Max |
| Clock CLK to F5 output | $T_{SHCKOF5}$ | 1.77 | 1.94 | 2.23 | ns, Max |
| **Setup and Hold Times Before/After Clock CLK** | | | | | |
| BX/BY data inputs (DIN) | $T_{DS}/T_{DH}$ | 0.53/–0.09 | 0.58/–0.10 | 0.67/–0.11 | ns, Min |
| F/G address inputs | $T_{AS}/T_{AH}$ | 0.40/ 0.00 | 0.44/ 0.00 | 0.50/ 0.00 | ns, Min |
| SR input (WS) | $T_{WES}/T_{WEH}$ | 0.42/–0.01 | 0.46/–0.01 | 0.53/–0.01 | ns, Min |
| **Clock CLK** | | | | | |
| Minimum Pulse Width, High | $T_{WPH}$ | 0.57 | 0.63 | 0.72 | ns, Min |
| Minimum Pulse Width, Low | $T_{WPL}$ | 0.57 | 0.63 | 0.72 | ns, Min |
| Minimum clock period to meet address write cycle time | $T_{WC}$ | 1.14 | 1.25 | 1.44 | ns, Min |

## CLB Shift Register Switching Characteristics

*Table 23:* **CLB Shift Register Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Sequential Delays** | | | | | |
| Clock CLK to X/Y outputs | $T_{REG}$ | 2.31 | 2.54 | 2.92 | ns, Max |
| Clock CLK to X/Y outputs | $T_{REG32}$ | 2.65 | 2.92 | 3.35 | ns, Max |
| Clock CLK to XB output via MC15 LUT output | $T_{REGXB}$ | 2.23 | 2.46 | 2.82 | ns, Max |
| Clock CLK to YB output via MC15 LUT output | $T_{REGYB}$ | 2.18 | 2.40 | 2.75 | ns, Max |
| Clock CLK to Shiftout | $T_{CKSH}$ | 1.92 | 2.11 | 2.43 | ns, Max |
| Clock CLK to F5 output | $T_{REGF5}$ | 2.45 | 2.69 | 3.09 | ns, Max |
| **Setup and Hold Times Before/After Clock CLK** | | | | | |
| BX/BY data inputs (DIN) | $T_{SRLDS}/T_{SRLDH}$ | 0.53/–0.07 | 0.58/–0.08 | 0.67/–0.09 | ns, Min |
| SR input (WS) | $T_{WSS}/T_{WSH}$ | 0.19/–0.06 | 0.21/–0.07 | 0.24/–0.08 | ns, Min |
| **Clock CLK** | | | | | |
| Minimum Pulse Width, High | $T_{SRPH}$ | 0.57 | 0.63 | 0.72 | ns, Min |
| Minimum Pulse Width, Low | $T_{SRPL}$ | 0.57 | 0.63 | 0.72 | ns, Min |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Multiplier Switching Characteristics

*Table 24:* **Multiplier Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| Propagation Delay to Output Pin | | | | | |
| Input to Pin 35 | $T_{MULT_P35}$ | 4.66 | 8.50 | 10.36 | ns, Max |
| Input to Pin 34 | $T_{MULT_P34}$ | 4.57 | 8.33 | 10.15 | ns, Max |
| Input to Pin 33 | $T_{MULT_P33}$ | 4.47 | 8.16 | 9.95 | ns, Max |
| Input to Pin 32 | $T_{MULT_P32}$ | 4.37 | 7.99 | 9.74 | ns, Max |
| Input to Pin 31 | $T_{MULT_P31}$ | 4.28 | 7.82 | 9.53 | ns, Max |
| Input to Pin 30 | $T_{MULT_P30}$ | 4.18 | 7.65 | 9.33 | ns, Max |
| Input to Pin 29 | $T_{MULT_P29}$ | 4.08 | 7.48 | 9.12 | ns, Max |
| Input to Pin 28 | $T_{MULT_P28}$ | 3.99 | 7.31 | 8.91 | ns, Max |
| Input to Pin 27 | $T_{MULT_P27}$ | 3.89 | 7.14 | 8.70 | ns, Max |
| Input to Pin 26 | $T_{MULT_P26}$ | 3.79 | 6.97 | 8.50 | ns, Max |
| Input to Pin 25 | $T_{MULT_P25}$ | 3.69 | 6.80 | 8.29 | ns, Max |
| Input to Pin 24 | $T_{MULT_P24}$ | 3.60 | 6.63 | 8.08 | ns, Max |
| Input to Pin 23 | $T_{MULT_P23}$ | 3.50 | 6.46 | 7.88 | ns, Max |
| Input to Pin 22 | $T_{MULT_P22}$ | 3.40 | 6.29 | 7.67 | ns, Max |
| Input to Pin 21 | $T_{MULT_P21}$ | 3.31 | 6.12 | 7.46 | ns, Max |
| Input to Pin 20 | $T_{MULT_P20}$ | 3.21 | 5.95 | 7.26 | ns, Max |
| Input to Pin 19 | $T_{MULT_P19}$ | 3.11 | 5.78 | 7.05 | ns, Max |
| Input to Pin 18 | $T_{MULT_P18}$ | 3.02 | 5.61 | 6.84 | ns, Max |
| Input to Pin 17 | $T_{MULT_P17}$ | 2.92 | 5.44 | 6.63 | ns, Max |
| Input to Pin 16 | $T_{MULT_P16}$ | 2.82 | 5.27 | 6.43 | ns, Max |
| Input to Pin 15 | $T_{MULT_P15}$ | 2.72 | 5.10 | 6.22 | ns, Max |
| Input to Pin 14 | $T_{MULT_P14}$ | 2.63 | 4.93 | 6.01 | ns, Max |
| Input to Pin 13 | $T_{MULT_P13}$ | 2.53 | 4.76 | 5.81 | ns, Max |
| Input to Pin 12 | $T_{MULT_P12}$ | 2.43 | 4.59 | 5.60 | ns, Max |
| Input to Pin 11 | $T_{MULT_P11}$ | 2.34 | 4.42 | 5.39 | ns, Max |
| Input to Pin 10 | $T_{MULT_P10}$ | 2.24 | 4.25 | 5.19 | ns, Max |
| Input to Pin 9 | $T_{MULT_P9}$ | 2.14 | 4.08 | 4.98 | ns, Max |
| Input to Pin 8 | $T_{MULT_P8}$ | 2.05 | 3.91 | 4.77 | ns, Max |
| Input to Pin 7 | $T_{MULT_P7}$ | 1.95 | 3.74 | 4.56 | ns, Max |
| Input to Pin 6 | $T_{MULT_P6}$ | 1.85 | 3.57 | 4.36 | ns, Max |
| Input to Pin 5 | $T_{MULT_P5}$ | 1.75 | 3.40 | 4.15 | ns, Max |
| Input to Pin 4 | $T_{MULT_P4}$ | 1.66 | 3.23 | 3.94 | ns, Max |
| Input to Pin 3 | $T_{MULT_P3}$ | 1.56 | 3.06 | 3.74 | ns, Max |
| Input to Pin 2 | $T_{MULT_P2}$ | 1.46 | 2.89 | 3.53 | ns, Max |
| Input to Pin 1 | $T_{MULT_P1}$ | 1.37 | 2.72 | 3.32 | ns, Max |
| Input to Pin 0 | $T_{MULT_P0}$ | 1.27 | 2.55 | 3.12 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 25:* **Pipelined Multiplier Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Setup and Hold Times Before/After Clock** | | | | | |
| Data Inputs | $T_{MULIDCK}/T_{MULCKID}$ | 3.00/ 0.00 | 3.45/ 0.00 | 3.89/ 0.00 | ns, Max |
| Clock Enable | $T_{MULIDCK_CE}/T_{MULCKID_CE}$ | 0.72/ 0.00 | 0.80/ 0.00 | 0.86/ 0.00 | ns, Max |
| Reset | $T_{MULIDCK_RST}/T_{MULCKID_RST}$ | 0.72/ 0.00 | 0.80/ 0.00 | 0.86/ 0.00 | ns, Max |
| **Clock to Output Pin** | | | | | |
| Clock to Pin 35 | $T_{MULTCK_P35}$ | 3.05 | 6.91 | 8.12 | ns, Max |
| Clock to Pin 34 | $T_{MULTCK_P34}$ | 2.95 | 6.75 | 7.93 | ns, Max |
| Clock to Pin 33 | $T_{MULTCK_P33}$ | 2.85 | 6.59 | 7.74 | ns, Max |
| Clock to Pin 32 | $T_{MULTCK_P32}$ | 2.76 | 6.43 | 7.56 | ns, Max |
| Clock to Pin 31 | $T_{MULTCK_P31}$ | 2.66 | 6.27 | 7.37 | ns, Max |
| Clock to Pin 30 | $T_{MULTCK_P30}$ | 2.56 | 6.11 | 7.19 | ns, Max |
| Clock to Pin 29 | $T_{MULTCK_P29}$ | 2.47 | 5.95 | 7.00 | ns, Max |
| Clock to Pin 28 | $T_{MULTCK_P28}$ | 2.37 | 5.79 | 6.81 | ns, Max |
| Clock to Pin 27 | $T_{MULTCK_P27}$ | 2.27 | 5.63 | 6.63 | ns, Max |
| Clock to Pin 26 | $T_{MULTCK_P26}$ | 2.17 | 5.47 | 6.44 | ns, Max |
| Clock to Pin 25 | $T_{MULTCK_P25}$ | 2.08 | 5.31 | 6.26 | ns, Max |
| Clock to Pin 24 | $T_{MULTCK_P24}$ | 1.98 | 5.15 | 6.07 | ns, Max |
| Clock to Pin 23 | $T_{MULTCK_P23}$ | 1.88 | 4.99 | 5.88 | ns, Max |
| Clock to Pin 22 | $T_{MULTCK_P22}$ | 1.79 | 4.83 | 5.70 | ns, Max |
| Clock to Pin 21 | $T_{MULTCK_P21}$ | 1.69 | 4.67 | 5.51 | ns, Max |
| Clock to Pin 20 | $T_{MULTCK_P20}$ | 1.59 | 4.51 | 5.33 | ns, Max |
| Clock to Pin 19 | $T_{MULTCK_P19}$ | 1.50 | 4.35 | 5.14 | ns, Max |
| Clock to Pin 18 | $T_{MULTCK_P18}$ | 1.40 | 4.19 | 4.95 | ns, Max |
| Clock to Pin 17 | $T_{MULTCK_P17}$ | 1.30 | 4.03 | 4.77 | ns, Max |
| Clock to Pin 16 | $T_{MULTCK_P16}$ | 1.20 | 3.87 | 4.58 | ns, Max |
| Clock to Pin 15 | $T_{MULTCK_P15}$ | 1.11 | 3.71 | 4.40 | ns, Max |
| Clock to Pin 14 | $T_{MULTCK_P14}$ | 1.01 | 3.55 | 4.21 | ns, Max |
| Clock to Pin 13 | $T_{MULTCK_P13}$ | 0.91 | 3.39 | 4.02 | ns, Max |
| Clock to Pin 12 | $T_{MULTCK_P12}$ | 0.91 | 3.23 | 3.84 | ns, Max |
| Clock to Pin 11 | $T_{MULTCK_P11}$ | 0.91 | 3.07 | 3.65 | ns, Max |
| Clock to Pin 10 | $T_{MULTCK_P10}$ | 0.91 | 2.91 | 3.47 | ns, Max |
| Clock to Pin 9 | $T_{MULTCK_P9}$ | 0.91 | 2.75 | 3.28 | ns, Max |
| Clock to Pin 8 | $T_{MULTCK_P8}$ | 0.91 | 2.59 | 3.09 | ns, Max |
| Clock to Pin 7 | $T_{MULTCK_P7}$ | 0.91 | 2.43 | 2.91 | ns, Max |
| Clock to Pin 6 | $T_{MULTCK_P6}$ | 0.91 | 2.27 | 2.72 | ns, Max |
| Clock to Pin 5 | $T_{MULTCK_P5}$ | 0.91 | 2.11 | 2.54 | ns, Max |
| Clock to Pin 4 | $T_{MULTCK_P4}$ | 0.91 | 1.95 | 2.35 | ns, Max |
| Clock to Pin 3 | $T_{MULTCK_P3}$ | 0.91 | 1.79 | 2.16 | ns, Max |
| Clock to Pin 2 | $T_{MULTCK_P2}$ | 0.91 | 1.63 | 1.98 | ns, Max |
| Clock to Pin 1 | $T_{MULTCK_P1}$ | 0.91 | 1.47 | 1.79 | ns, Max |
| Clock to Pin 0 | $T_{MULTCK_P0}$ | 0.91 | 1.31 | 1.61 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Enhanced Multiplier Switching Characteristics

Table 26 and Table 27 provide timing information for enhanced Virtex-II multiplier blocks, available in stepping revisions of Virtex-II devices. For more information on stepping revisions, availability, and ordering instructions, see your local sales representative.

*Table 26:* **Enhanced Multiplier Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Propagation Delay to Output Pin** | | | | | |
| Input to Pin 35 | $T_{MULT1_P35}$ | 4.66 | 5.14 | 5.91 | ns, Max |
| Input to Pin 34 | $T_{MULT1_P34}$ | 4.57 | 5.03 | 5.79 | ns, Max |
| Input to Pin 33 | $T_{MULT1_P33}$ | 4.47 | 4.93 | 5.66 | ns, Max |
| Input to Pin 32 | $T_{MULT1_P32}$ | 4.37 | 4.82 | 5.54 | ns, Max |
| Input to Pin 31 | $T_{MULT1_P31}$ | 4.28 | 4.71 | 5.42 | ns, Max |
| Input to Pin 30 | $T_{MULT1_P30}$ | 4.18 | 4.61 | 5.29 | ns, Max |
| Input to Pin 29 | $T_{MULT1_P29}$ | 4.08 | 4.50 | 5.17 | ns, Max |
| Input to Pin 28 | $T_{MULT1_P28}$ | 3.99 | 4.39 | 5.05 | ns, Max |
| Input to Pin 27 | $T_{MULT1_P27}$ | 3.89 | 4.28 | 4.92 | ns, Max |
| Input to Pin 26 | $T_{MULT1_P26}$ | 3.79 | 4.18 | 4.80 | ns, Max |
| Input to Pin 25 | $T_{MULT1_P25}$ | 3.69 | 4.07 | 4.68 | ns, Max |
| Input to Pin 24 | $T_{MULT1_P24}$ | 3.60 | 3.96 | 4.56 | ns, Max |
| Input to Pin 23 | $T_{MULT1_P23}$ | 3.50 | 3.86 | 4.43 | ns, Max |
| Input to Pin 22 | $T_{MULT1_P22}$ | 3.40 | 3.75 | 4.31 | ns, Max |
| Input to Pin 21 | $T_{MULT1_P21}$ | 3.31 | 3.64 | 4.19 | ns, Max |
| Input to Pin 20 | $T_{MULT1_P20}$ | 3.21 | 3.54 | 4.06 | ns, Max |
| Input to Pin 19 | $T_{MULT1_P19}$ | 3.11 | 3.43 | 3.94 | ns, Max |
| Input to Pin 18 | $T_{MULT1_P18}$ | 3.02 | 3.32 | 3.82 | ns, Max |
| Input to Pin 17 | $T_{MULT1_P17}$ | 2.92 | 3.21 | 3.69 | ns, Max |
| Input to Pin 16 | $T_{MULT1_P16}$ | 2.82 | 3.11 | 3.57 | ns, Max |
| Input to Pin 15 | $T_{MULT1_P15}$ | 2.72 | 3.00 | 3.45 | ns, Max |
| Input to Pin 14 | $T_{MULT1_P14}$ | 2.63 | 2.89 | 3.33 | ns, Max |
| Input to Pin 13 | $T_{MULT1_P13}$ | 2.53 | 2.79 | 3.20 | ns, Max |
| Input to Pin 12 | $T_{MULT1_P12}$ | 2.43 | 2.68 | 3.08 | ns, Max |
| Input to Pin 11 | $T_{MULT1_P11}$ | 2.34 | 2.57 | 2.96 | ns, Max |
| Input to Pin 10 | $T_{MULT1_P10}$ | 2.24 | 2.47 | 2.83 | ns, Max |
| Input to Pin 9 | $T_{MULT1_P9}$ | 2.14 | 2.36 | 2.71 | ns, Max |
| Input to Pin 8 | $T_{MULT1_P8}$ | 2.05 | 2.25 | 2.59 | ns, Max |
| Input to Pin 7 | $T_{MULT1_P7}$ | 1.95 | 2.14 | 2.46 | ns, Max |
| Input to Pin 6 | $T_{MULT1_P6}$ | 1.85 | 2.04 | 2.34 | ns, Max |
| Input to Pin 5 | $T_{MULT1_P5}$ | 1.75 | 1.93 | 2.22 | ns, Max |
| Input to Pin 4 | $T_{MULT1_P4}$ | 1.66 | 1.82 | 2.10 | ns, Max |
| Input to Pin 3 | $T_{MULT1_P3}$ | 1.56 | 1.72 | 1.97 | ns, Max |
| Input to Pin 2 | $T_{MULT1_P2}$ | 1.46 | 1.61 | 1.85 | ns, Max |
| Input to Pin 1 | $T_{MULT1_P1}$ | 1.37 | 1.50 | 1.73 | ns, Max |
| Input to Pin 0 | $T_{MULT1_P0}$ | 1.27 | 1.40 | 1.60 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 27:* **Enhanced Pipelined Multiplier Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Setup and Hold Times Before/After Clock** | | | | | |
| Data Inputs | $T_{MULIDCK}/T_{MULCKID}$ | 3.00/0.00 | 3.45/0.00 | 3.89/0.00 | ns, Max |
| Clock Enable | $T_{MULIDCK_CE}/T_{MULCKID_CE}$ | 0.72/0.00 | 0.80/0.00 | 0.86/0.00 | ns, Max |
| Reset | $T_{MULIDCK_RST}/T_{MULCKID_RST}$ | 0.72/0.00 | 0.80/0.00 | 0.86/0.00 | ns, Max |
| **Clock to Output Pin** | | | | | |
| Clock to Pin 35 | $T_{MULTCK1_P35}$ | 3.05 | 3.25 | 3.74 | ns, Max |
| Clock to Pin 34 | $T_{MULTCK1_P34}$ | 2.95 | 3.14 | 3.61 | ns, Max |
| Clock to Pin 33 | $T_{MULTCK1_P33}$ | 2.85 | 3.04 | 3.49 | ns, Max |
| Clock to Pin 32 | $T_{MULTCK1_P32}$ | 2.76 | 2.93 | 3.37 | ns, Max |
| Clock to Pin 31 | $T_{MULTCK1_P31}$ | 2.66 | 2.82 | 3.25 | ns, Max |
| Clock to Pin 30 | $T_{MULTCK1_P30}$ | 2.56 | 2.72 | 3.12 | ns, Max |
| Clock to Pin 29 | $T_{MULTCK1_P29}$ | 2.47 | 2.61 | 3.00 | ns, Max |
| Clock to Pin 28 | $T_{MULTCK1_P28}$ | 2.37 | 2.50 | 2.88 | ns, Max |
| Clock to Pin 27 | $T_{MULTCK1_P27}$ | 2.27 | 2.40 | 2.75 | ns, Max |
| Clock to Pin 26 | $T_{MULTCK1_P26}$ | 2.17 | 2.29 | 2.63 | ns, Max |
| Clock to Pin 25 | $T_{MULTCK1_P25}$ | 2.08 | 2.18 | 2.51 | ns, Max |
| Clock to Pin 24 | $T_{MULTCK1_P24}$ | 1.98 | 2.07 | 2.38 | ns, Max |
| Clock to Pin 23 | $T_{MULTCK1_P23}$ | 1.88 | 1.97 | 2.26 | ns, Max |
| Clock to Pin 22 | $T_{MULTCK1_P22}$ | 1.79 | 1.86 | 2.14 | ns, Max |
| Clock to Pin 21 | $T_{MULTCK1_P21}$ | 1.69 | 1.75 | 2.02 | ns, Max |
| Clock to Pin 20 | $T_{MULTCK1_P20}$ | 1.59 | 1.65 | 1.89 | ns, Max |
| Clock to Pin 19 | $T_{MULTCK1_P19}$ | 1.50 | 1.54 | 1.77 | ns, Max |
| Clock to Pin 18 | $T_{MULTCK1_P18}$ | 1.40 | 1.43 | 1.65 | ns, Max |
| Clock to Pin 17 | $T_{MULTCK1_P17}$ | 1.30 | 1.33 | 1.52 | ns, Max |
| Clock to Pin 16 | $T_{MULTCK1_P16}$ | 1.20 | 1.22 | 1.40 | ns, Max |
| Clock to Pin 15 | $T_{MULTCK1_P15}$ | 1.11 | 1.11 | 1.28 | ns, Max |
| Clock to Pin 14 | $T_{MULTCK1_P14}$ | 1.01 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 13 | $T_{MULTCK1_P13}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 12 | $T_{MULTCK1_P12}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 11 | $T_{MULTCK1_P11}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 10 | $T_{MULTCK1_P10}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 9 | $T_{MULTCK1_P9}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 8 | $T_{MULTCK1_P8}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 7 | $T_{MULTCK1_P7}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 6 | $T_{MULTCK1_P6}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 5 | $T_{MULTCK1_P5}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 4 | $T_{MULTCK1_P4}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 3 | $T_{MULTCK1_P3}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 2 | $T_{MULTCK1_P2}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 1 | $T_{MULTCK1_P1}$ | 0.91 | 1.00 | 1.15 | ns, Max |
| Clock to Pin 0 | $T_{MULTCK1_P0}$ | 0.91 | 1.00 | 1.15 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Block SelectRAM Switching Characteristics

*Table 28:* **Block SelectRAM Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Sequential Delays** | | | | | |
| Clock CLK to DOUT output | $T_{BCKO}$ | 2.10 | 2.31 | 2.65 | ns, Max |
| **Setup and Hold Times Before Clock CLK** | | | | | |
| ADDR inputs | $T_{BACK}/T_{BCKA}$ | 0.29/ 0.00 | 0.32/ 0.00 | 0.36/ 0.00 | ns, Min |
| DIN inputs | $T_{BDCK}/T_{BCKD}$ | 0.29/ 0.00 | 0.32/ 0.00 | 0.36/ 0.00 | ns, Min |
| EN input | $T_{BECK}/T_{BCKE}$ | 0.95/–0.46 | 1.04/–0.50 | 1.20/–0.58 | ns, Min |
| RST input | $T_{BRCK}/T_{BCKR}$ | 1.31/–0.71 | 1.44/–0.78 | 1.65/–0.90 | ns, Min |
| WEN input | $T_{BWCK}/T_{BCKW}$ | 0.57/–0.19 | 0.63/–0.21 | 0.72/–0.25 | ns, Min |
| **Clock CLK** | | | | | |
| CLKA to CLKB setup time for different ports | $T_{BCCS}$ | 1.0 | 1.0 | 1.0 | ns, min |
| Minimum Pulse Width, High | $T_{BPWH}$ | 1.17 | 1.29 | 1.48 | ns, Min |
| Minimum Pulse Width, Low | $T_{BPWL}$ | 1.17 | 1.29 | 1.48 | ns, Min |

## TBUF Switching Characteristics

*Table 29:* **TBUF Switching Characteristics**

| Description | Symbol | Speed Grade | | | Units |
|---|---|---|---|---|---|
| | | -6 | -5 | -4 | |
| **Combinatorial Delays** | | | | | |
| IN input to OUT output | $T_{IO}$ | 0.45 | 0.50 | 0.58 | ns, Max |
| TRI input to OUT output high-impedance | $T_{OFF}$ | 0.44 | 0.48 | 0.55 | ns, Max |
| TRI input to valid data on OUT output | $T_{ON}$ | 0.44 | 0.48 | 0.55 | ns, Max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Configuration Timing

### *Configuration Memory Clearing Parameters*

Power-up timing of configuration signals is shown in Figure 2; corresponding timing characteristics are listed in Table 30.

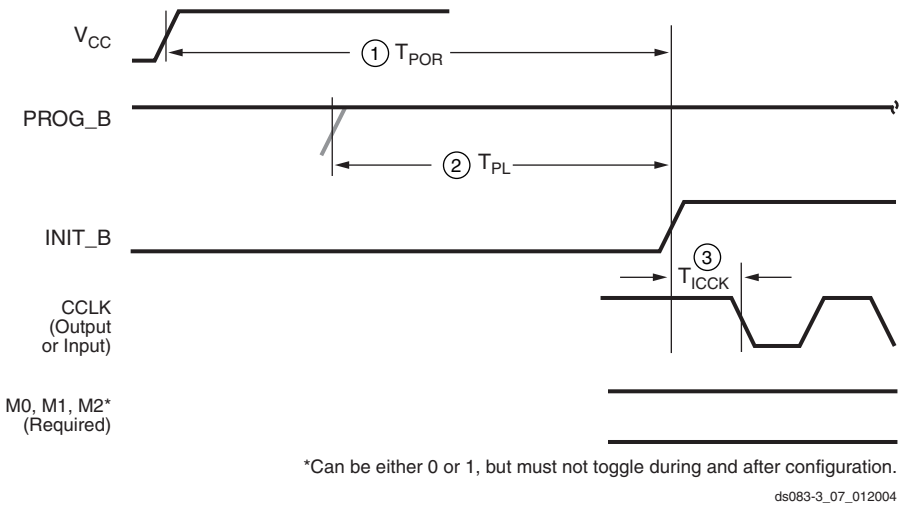



*Figure 2:* **Configuration Power-Up Timing**

*Table 30:* **Power-Up Timing Characteristics**

| Description | Figure References | Symbol | Value | Units |
|---|---|---|---|---|
| Power-on reset | 1 | $T_{POR}$ | $T_{PL}$ + 2 | ms, max |
| Program latency | 2 | $T_{PL}$ | 4 | µs per frame, max |
| CCLK (output) delay | 3 | $T_{ICCK}$ | 0.5 | µs, min |
| | | | 4.0 | µs, max |
| Program pulse width | | $T_{PROGRAM}$ | 300 | ns, min |

**Notes:**
1. The M2, M1, and M0 mode pins should be set at a constant DC voltage level, either through pull-up or pull-down resistors, or tied directly to ground or $V_{CCAUX}$. The mode pins should not be toggled during and after configuration.

### *Master/Slave Serial Mode Parameters*

Clock timing for Slave Serial configuration programming is shown in Figure 3, with Master Serial clock timing shown in Figure 4. Programming parameters for both Slave and Master modes are given in Table 31.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

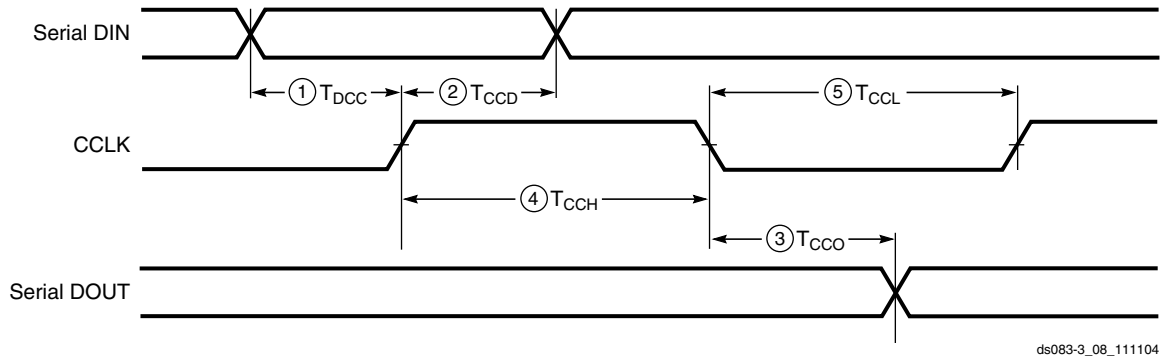




*Figure 3:* **Slave Serial Mode Timing Sequence**

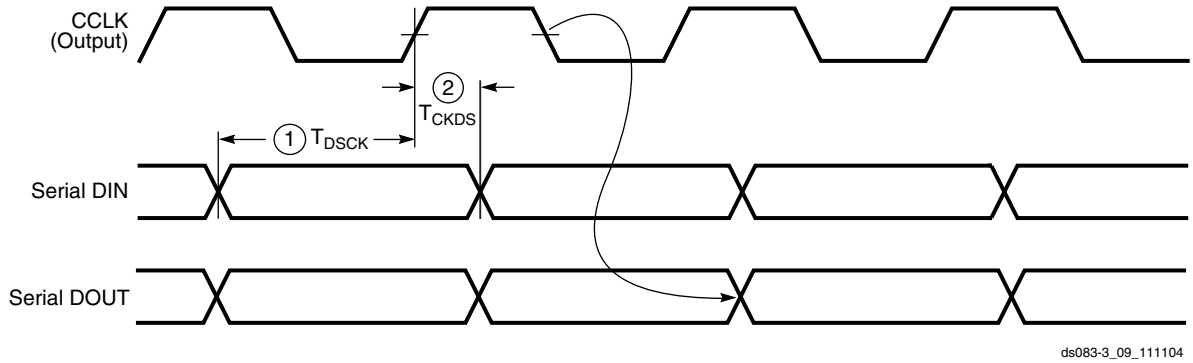



*Figure 4:* **Master Serial Mode Timing Sequence**

*Table 31:* **Master/Slave Serial Mode Timing Characteristics**

| | Description | Figure References | Symbol | Value | Units |
|---|---|---|---|---|---|
| CCLK | DIN setup/hold, slave mode (Figure 3) | 1/2 | $T_{DCC}/T_{CCD}$ | 5.0/0.0 | ns, min |
| | DIN setup/hold, master mode (Figure 4) | 1/2 | $T_{DSCK}/T_{CKDS}$ | 5.0/0.0 | ns, min |
| | DOUT | 3 | $T_{CCO}$ | 12.0 | ns, max |
| | High time | 4 | $T_{CCH}$ | 5.0 | ns, min |
| | Low time | 5 | $T_{CCL}$ | 5.0 | ns, min |
| | Maximum start-up frequency | | $F_{CC_STARTUP}$ | 50 | MHz, max |
| | Maximum frequency | | $F_{CC_SERIAL}$ | 66(1) | MHz, max |
| | Frequency tolerance, master mode with respect to nominal | | | +45%<br>–30% | |

**Notes:**
1. If no provision is made in the design to adjust the frequency of CCLK, $F_{CC_SERIAL}$ should not exceed $F_{CC_STARTUP}$.

### *Master/Slave SelectMAP Parameters*

Figure 5 is a generic timing diagram for data loading using SelectMAP. For other data loading diagrams, refer to the ***Virtex-II Pro Platform FPGA User Guide***.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

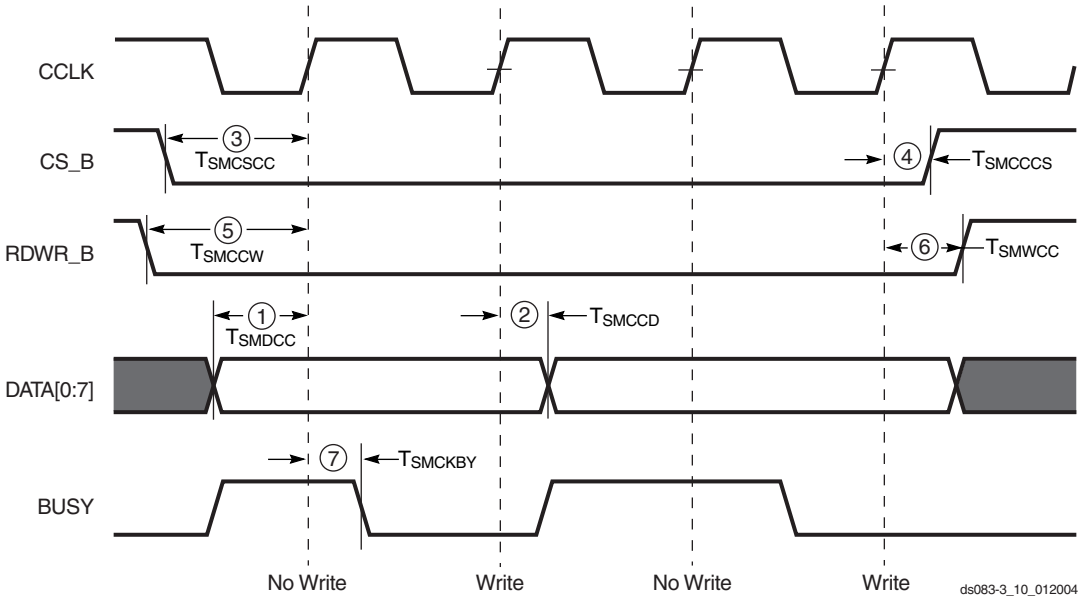




*Figure 5:* **SelectMAP Mode Data Loading Sequence (Generic)**

*Table 32:* **SelectMAP Mode Write Timing Characteristics**

| | Description | Figure References | Symbol | Value | Units |
|---|---|---|---|---|---|
| CCLK | DATA[0:7] setup/hold | 1/2 | $T_{SMDCC}/T_{SMCCD}$ | 5.0/0.0 | ns, min |
| | CS_B setup/hold | 3/4 | $T_{SMCSCC}/T_{SMCCCS}$ | 7.0/0.0 | ns, min |
| | RDWR_B setup/hold | 5/6 | $T_{SMCCW}/T_{SMWCC}$ | 7.0/0.0 | ns, min |
| | BUSY propagation delay | 7 | $T_{SMCKBY}$ | 12.0 | ns, max |
| | Maximum start-up frequency | | $F_{CC_STARTUP}$ | 50 | MHz, max |
| | Maximum frequency | | $F_{CC_SELECTMAP}$ | 50 | MHz, max |
| | Maximum frequency with no handshake | | $F_{CCNH}$ | 50 | MHz, max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## JTAG Test Access Port Switching Characteristics

Characterization data for some of the most commonly requested timing parameters shown in Figure 6 is listed in Table 33.

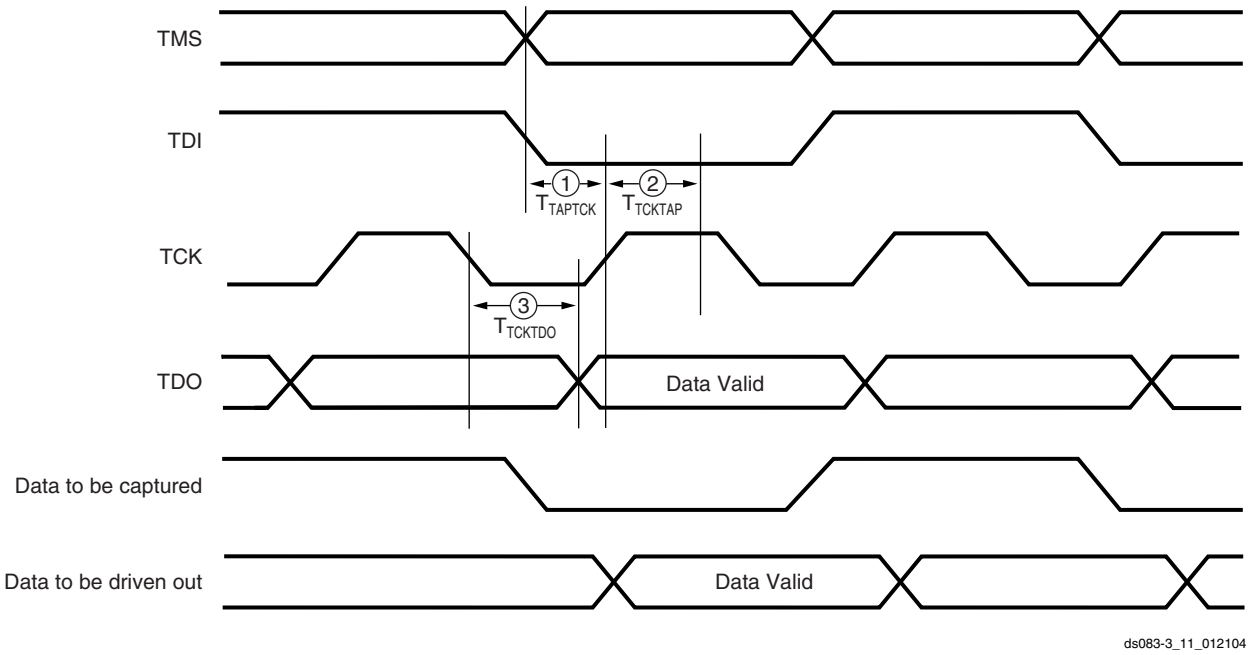



*Figure 6:* **Virtex-II Pro Boundary Scan Port Timing Waveforms**

*Table 33:* **Boundary-Scan Port Timing Specifications**

| | Description | Figure References | Symbol | Value | Units |
|---|---|---|---|---|---|
| TCK | TMS and TDI setup time | 1 | $T_{TAPTCK}$ | 5.5 | ns, min |
| | TMS and TDI hold times | 2 | $T_{TCKTAP}$ | 0.0 | ns, min |
| | Falling edge to TDO output valid | 3 | $T_{TCKTDO}$ | 10.0 | ns, max |
| | Maximum frequency | | $F_{TCK}$ | 33.0 | MHz, max |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Virtex-II Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

## Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *With* DCM

*Table 34:* **Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *With* DCM**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVTTL Global Clock Input to Output delay using Output flip-flop, 12 mA, Fast Slew Rate, *with* DCM.<br>For data *output* with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 14. | | | | | | |
| Global Clock and OFF with DCM | $T_{ICKOFDCM}$ | XC2V40 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V80 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V250 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V500 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V1000 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V1500 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V2000 | 1.10 | 1.28 | 1.48 | ns |
| | | XC2V3000 | 1.19 | 1.38 | 1.59 | ns |
| | | XC2V4000 | 1.19 | 1.38 | 1.59 | ns |
| | | XC2V6000 | 1.64 | 1.88 | 2.17 | ns |
| | | XC2V8000 | | 1.88 | 2.17 | ns |

**Notes:**
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% $V_{CC}$ threshold with test setup shown in Figure 1. For other I/O standards, see Table 19.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *Without* DCM

*Table 35:* **Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *Without* DCM**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| LVTTL Global Clock Input to Output Delay using Output flip-flop, 12 mA, Fast Slew Rate, *without* DCM.<br>For data *output* with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments, page 14. | | | | | | |
| Global Clock and OFF without DCM | $T_{ICKOF}$ | XC2V40 | 3.46 | 3.58 | 3.69 | ns |
| | | XC2V80 | 3.62 | 3.58 | 3.69 | ns |
| | | XC2V250 | 3.79 | 3.88 | 4.47 | ns |
| | | XC2V500 | 3.85 | 3.88 | 4.47 | ns |
| | | XC2V1000 | 4.02 | 4.28 | 4.62 | ns |
| | | XC2V1500 | 4.16 | 4.28 | 4.62 | ns |
| | | XC2V2000 | 4.30 | 4.43 | 5.10 | ns |
| | | XC2V3000 | 4.49 | 4.64 | 5.34 | ns |
| | | XC2V4000 | 4.82 | 4.99 | 5.74 | ns |
| | | XC2V6000 | 5.19 | 5.38 | 5.93 | ns |
| | | XC2V8000 | | 6.09 | 7.00 | ns |

**Notes:**
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% $V_{CC}$ threshold with test setup shown in Figure 1. For other I/O standards, see Table 19.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# Virtex-II Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

## Global Clock Setup and Hold for LVTTL Standard, *With* DCM

*Table 36:* **Global Clock Setup and Hold for LVTTL Standard, *With* DCM**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTL Standard.<br>For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11. | | | | | | |
| No Delay<br>Global Clock and IFF with DCM | $T_{PSDCM}/T_{PHDCM}$ | XC2V40 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V80 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V250 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V500 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V1000 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V1500 | 1.60/–0.90 | 1.60/–0.90 | 1.84/–0.76 | ns |
| | | XC2V2000 | 1.70/–0.90 | 1.70/–0.90 | 1.96/–0.76 | ns |
| | | XC2V3000 | 1.70/–0.90 | 1.70/–0.90 | 1.96/–0.76 | ns |
| | | XC2V4000 | 1.70/–0.90 | 1.70/–0.90 | 1.96/–0.76 | ns |
| | | XC2V6000 | 1.70/–0.90 | 1.70/–0.90 | 1.96/–0.76 | ns |
| | | XC2V8000 | | 1.70/–0.90 | 1.96/–0.76 | ns |

**Notes:**
1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Global Clock Setup and Hold for LVTTL Standard, *Without* DCM

*Table 37:* **Global Clock Setup and Hold for LVTTL Standard, *Without* DCM**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTL Standard.(2)<br>For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11. | | | | | | |
| Full Delay<br>Global Clock and IFF(1) without DCM | $T_{PSFD}/T_{PHFD}$ | XC2V40 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V80 | 2.10/ 0.00 | 2.10/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V250 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V500 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V1000 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V1500 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V2000 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V3000 | 1.92/ 0.00 | 1.92/ 0.00 | 2.21/ 0.00 | ns |
| | | XC2V4000 | 2.00/ 0.00 | 2.00/ 0.00 | 2.30/ 0.00 | ns |
| | | XC2V6000 | 1.92/ 0.50 | 1.92/ 0.50 | 2.21/ 0.50 | ns |
| | | XC2V8000 | | 2.38/ 0.00 | 2.60/ 0.00 | ns |

**Notes:**
1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.
3. These values are parametrically measured.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# DCM Timing Parameters

All devices are 100% functionally tested. Because of the difficulty in directly measuring many internal timing parameters, those parameters are derived from benchmark timing patterns. The following guidelines reflect worst-case values across the recommended operating conditions. All output jitter and phase specifications are determined through statistical measurement at the package pins.

## Operating Frequency Ranges

*Table 38:* **Operating Frequency Ranges**

| Description | Symbol | Constraints | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Output Clocks (Low Frequency Mode)** | | | | | | |
| CLK0, CLK90, CLK180, CLK270 | CLKOUT_FREQ_1X_LF_Min | | 24.00 | 24.00 | 24.00 | MHz |
| | CLKOUT_FREQ_1X_LF_Max | | 230.00 | 210.00 | 180.00 | MHz |
| CLK2X, CLK2X180 | CLKOUT_FREQ_2X_LF_Min | | 48.00 | 48.00 | 48.00 | MHz |
| | CLKOUT_FREQ_2X_LF_Max | | 450.00 | 420.00 | 360.00 | MHz |
| CLKDV | CLKOUT_FREQ_DV_LF_Min | | 1.50 | 1.50 | 1.50 | MHz |
| | CLKOUT_FREQ_DV_LF_Max | | 150.00 | 140.00 | 120.00 | MHz |
| CLKFX, CLKFX180 | CLKOUT_FREQ_FX_LF_Min | | 24.00 | 24.00 | 24.00 | MHz |
| | CLKOUT_FREQ_FX_LF_Max | | 260.00 | 240.00 | 210.00 | MHz |
| **Input Clocks (Low Frequency Mode)** | | | | | | |
| CLKIN (using DLL outputs) (1,3,4) | CLKIN_FREQ_DLL_LF_Min | | 24.00 | 24.00 | 24.00 | MHz |
| | CLKIN_FREQ_DLL_LF_Max | | 230.00 | 210.00 | 180.00 | MHz |
| CLKIN (using CLKFX outputs) (2,3,4) | CLKIN_FREQ_FX_LF_Min | | 1.00 | 1.00 | 1.00 | MHz |
| | CLKIN_FREQ_FX_LF_Max | | 260.00 | 240.00 | 210.00 | MHz |
| PSCLK | PSCLK_FREQ_LF_Min | | 0.01 | 0.01 | 0.01 | MHz |
| | PSCLK_FREQ_LF_Max | | 450.00 | 420.00 | 360.00 | MHz |
| **Output Clocks (High Frequency Mode)** | | | | | | |
| CLK0, CLK180 | CLKOUT_FREQ_1X_HF_Min | | 48.00 | 48.00 | 48.00 | MHz |
| | CLKOUT_FREQ_1X_HF_Max | | 450.00 | 420.00 | 360.00 | MHz |
| CLKDV | CLKOUT_FREQ_DV_HF_Min | | 3.00 | 3.00 | 3.00 | MHz |
| | CLKOUT_FREQ_DV_HF_Max | | 300.00 | 280.00 | 240.00 | MHz |
| CLKFX, CLKFX180 | CLKOUT_FREQ_FX_HF_Min | | 210.00 | 210.00 | 210.00 | MHz |
| | CLKOUT_FREQ_FX_HF_Max | | 350.00 | 320.00 | 270.00 | MHz |
| **Input Clocks (High Frequency Mode)** | | | | | | |
| CLKIN (using DLL outputs) (1,3,4) | CLKIN_FREQ_DLL_HF_Min | | 48.00 | 48.00 | 48.00 | MHz |
| | CLKIN_FREQ_DLL_HF_Max | | 450.00 | 420.00 | 360.00 | MHz |
| CLKIN (using CLKFX outputs) (2,3,4) | CLKIN_FRQ_FX_HF_Min | | 50.00 | 50.00 | 50.00 | MHz |
| | CLKIN_FRQ_FX_HF_Max | | 350.00 | 320.00 | 270.00 | MHz |
| PSCLK | PSCLK_FREQ_HF_Min | | 0.01 | 0.01 | 0.01 | MHz |
| | PSCLK_FREQ_HF_Max | | 450.00 | 420.00 | 360.00 | MHz |

**Notes:**
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If the CLKIN_DIVIDE_BY_2 attribute of the DCM is used, then double these values.
4. If the CLKIN_DIVIDE_BY_2 attribute of the DCM is used and CLKIN frequency > 400 MHz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Input Clock Tolerances

*Table 39:* **Input Clock Tolerances**

| Description | Symbol | Constraints $F_{CLKIN}$ | Speed Grade | | | | | | Units |
|---|---|---|---|---|---|---|---|---|---|
| | | | -6 | | -5 | | -4 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| **Input Clock Low/High Pulse Width** | | | | | | | | | |
| PSCLK | PSCLK_PULSE | < 1MHz | 25.00 | | 25.00 | | 25.00 | | ns |
| PSCLK and CLKIN(3) | PSCLK_PULSE and CLKIN_PULSE | 1 – 10 MHz | 25.00 | | 25.00 | | 25.00 | | ns |
| | | 10 – 25 MHz | 10.00 | | 10.00 | | 10.00 | | ns |
| | | 25 – 50 MHz | 5.00 | | 5.00 | | 5.00 | | ns |
| | | 50 – 100 MHz | 3.00 | | 3.00 | | 3.00 | | ns |
| | | 100 – 150 MHz | 2.40 | | 2.40 | | 2.40 | | ns |
| | | 150 – 200 MHz | 2.00 | | 2.00 | | 2.00 | | ns |
| | | 200 – 250 MHz | 1.80 | | 1.80 | | 1.80 | | ns |
| | | 250 – 300 MHz | 1.50 | | 1.50 | | 1.50 | | ns |
| | | 300 – 350 MHz | 1.30 | | 1.30 | | 1.30 | | ns |
| | | 350 – 400 MHz | 1.15 | | 1.15 | | 1.15 | | ns |
| | | > 400 MHz | 1.05 | | 1.05 | | 1.05 | | ns |
| **Input Clock Cycle-Cycle Jitter (Low Frequency Mode)** | | | | | | | | | |
| CLKIN (using DLL outputs)(1) | CLKIN_CYC_JITT_DLL_LF | | | ±300 | | ±300 | | ±300 | ps |
| CLKIN (using CLKFX outputs)(2) | CLKIN_CYC_JITT_FX_LF | | | ±300 | | ±300 | | ±300 | ps |
| **Input Clock Cycle-Cycle Jitter (High Frequency Mode)** | | | | | | | | | |
| CLKIN (using DLL outputs)(1) | CLKIN_CYC_JITT_DLL_HF | | | ±150 | | ±150 | | ±150 | ps |
| CLKIN (using CLKFX outputs)(2) | CLKIN_CYC_JITT_FX_HF | | | ±150 | | ±150 | | ±150 | ps |
| **Input Clock Period Jitter (Low Frequency Mode)** | | | | | | | | | |
| CLKIN (using DLL outputs)(1) | CLKIN_PER_JITT_DLL_LF | | | ±1 | | ±1 | | ±1 | ns |
| CLKIN (using CLKFX outputs)(2) | CLKIN_PER_JITT_FX_LF | | | ±1 | | ±1 | | ±1 | ns |
| **Input Clock Period Jitter (High Frequency Mode)** | | | | | | | | | |
| CLKIN (using DLL outputs)(1) | CLKIN_PER_JITT_DLL_HF | | | ±1 | | ±1 | | ±1 | ns |
| CLKIN (using CLKFX outputs)(2) | CLKIN_PER_JITT_FX_HF | | | ±1 | | ±1 | | ±1 | ns |
| **Feedback Clock Path Delay Variation** | | | | | | | | | |
| CLKFB off-chip feedback | CLKFB_DELAY_VAR_EXT | | | ±1 | | ±1 | | ±1 | ns |

**Notes:**
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Output Clock Jitter

*Table 40:* **Output Clock Jitter**

| Description | Symbol | Constraints | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Clock Synthesis Period Jitter** | | | | | | |
| CLK0 | CLKOUT_PER_JITT_0 | | ±100 | ±100 | ±100 | ps |
| CLK90 | CLKOUT_PER_JITT_90 | | ±150 | ±150 | ±150 | ps |
| CLK180 | CLKOUT_PER_JITT_180 | | ±150 | ±150 | ±150 | ps |
| CLK270 | CLKOUT_PER_JITT_270 | | ±150 | ±150 | ±150 | ps |
| CLK2X, CLK2X180 | CLKOUT_PER_JITT_2X | | ±200 | ±200 | ±200 | ps |
| CLKDV (integer division) | CLKOUT_PER_JITT_DV1 | | ±150 | ±150 | ±150 | ps |
| CLKDV (non-integer division) | CLKOUT_PER_JITT_DV2 | | ±300 | ±300 | ±300 | ps |
| CLKFX, CLKFX180 | CLKOUT_PER_JITT_FX | | Note 1 | Note 1 | Note 1 | ps |

**Notes:**
1. Values for this parameter are available at www.xilinx.com.

## Output Clock Phase Alignment

*Table 41:* **Output Clock Phase Alignment**

| Description | Symbol | Constraints | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Phase Offset Between CLKIN and CLKFB** | | | | | | |
| CLKIN/CLKFB | CLKIN_CLKFB_PHASE | | ±50 | ±50 | ±50 | ps |
| **Phase Offset Between Any DCM Outputs** | | | | | | |
| All CLK outputs | CLKOUT_PHASE | | ±140 | ±140 | ±140 | ps |
| **Duty Cycle Precision** | | | | | | |
| DLL outputs(1) | CLKOUT_DUTY_CYCLE_DLL(2) | | ±150 | ±150 | ±150 | ps |
| CLKFX outputs | CLKOUT_DUTY_CYCLE_FX | | ±100 | ±100 | ±100 | ps |

**Notes:**
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. CLKOUT_DUTY_CYCLE_DLL applies to the 1X clock outputs (CLK0, CLK90, CLK180, and CLK270) only if DUTY_CYCLE_CORRECTION = TRUE.
3. Specification also applies to PSCLK.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Miscellaneous Timing Parameters

*Table 42:* **Miscellaneous Timing Parameters**

| Description | Symbol | Constraints $F_{CLKIN}$ | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| **Time Required to Achieve LOCK** | | | | | | |
| Using DLL outputs(1) | LOCK_DLL | | | | | |
| | LOCK_DLL_60 | > 60MHz | 20.0 | 20.0 | 20.0 | µs |
| | LOCK_DLL_50_60 | 50 - 60 MHz | 25.0 | 25.0 | 25.0 | µs |
| | LOCK_DLL_40_50 | 40 - 50 MHz | 50.0 | 50.0 | 50.0 | µs |
| | LOCK_DLL_30_40 | 30 - 40 MHz | 90.0 | 90.0 | 90.0 | µs |
| | LOCK_DLL_24_30 | 24 - 30 MHz | 120.0 | 120.0 | 120.0 | µs |
| Using CLKFX outputs | LOCK_FX_MIN | | 10.0 | 10.0 | 10.0 | ms |
| | LOCK_FX_MAX | | 10.0 | 10.0 | 10.0 | ms |
| Additional lock time with fine-phase shifting | LOCK_DLL_FINE_SHIFT | | 50.0 | 50.0 | 50.0 | µs |
| **Fine-Phase Shifting** | | | | | | |
| Absolute shifting range | FINE_SHIFT_RANGE | | 10.0 | 10.0 | 10.0 | ns |
| **Delay Lines** | | | | | | |
| Tap delay resolution | DCM_TAP_MIN | | 30.0 | 30.0 | 30.0 | ps |
| | DCM_TAP_MAX | | 60.0 | 60.0 | 60.0 | ps |

**Notes:**
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. Specification also applies to PSCLK.

## Frequency Synthesis

*Table 43:* **Frequency Synthesis**

| Attribute | Min | Max |
|---|---|---|
| CLKFX_MULTIPLY | 2 | 32 |
| CLKFX_DIVIDE | 1 | 32 |

## Parameter Cross Reference

*Table 44:* **Parameter Cross Reference**

| Libraries Guide | Data Sheet |
|---|---|
| DLL_CLKOUT_{MIN\|MAX}_LF | CLKOUT_FREQ_{1X\|2X\|DV}_LF |
| DFS_CLKOUT_{MIN\|MAX}_LF | CLKOUT_FREQ_FX_LF |
| DLL_CLKIN_{MIN\|MAX}_LF | CLKIN_FREQ_DLL_LF |
| DFS_CLKIN_{MIN\|MAX}_LF | CLKIN_FREQ_FX_LF |
| DLL_CLKOUT_{MIN\|MAX}_HF | CLKOUT_FREQ_{1X\|DV}_HF |
| DFS_CLKOUT_{MIN\|MAX}_HF | CLKOUT_FREQ_FX_HF |
| DLL_CLKIN_{MIN\|MAX}_HF | CLKIN_FREQ_DLL_HF |
| DFS_CLKIN_{MIN\|MAX}_HF | CLKIN_FREQ_FX_HF |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Virtex-II source-synchronous transmitter and receiver data-valid windows.

*Table 45:* **Duty Cycle Distortion and Clock-Tree Skew**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| Duty Cycle Distortion(1) | $T_{DCD_CLK0}$ | All | 140 | 140 | 140 | ps |
| | $T_{DCD_CLK180}$ | All | 50 | 50 | 50 | ps |
| Clock Tree Skew(2) | $T_{CKSKEW}$ | XC2V40 | 50 | 50 | 60 | ps |
| | | XC2V80 | 50 | 50 | 60 | ps |
| | | XC2V250 | 50 | 50 | 60 | ps |
| | | XC2V500 | 50 | 50 | 60 | ps |
| | | XC2V1000 | 80 | 80 | 90 | ps |
| | | XC2V1500 | 80 | 80 | 90 | ps |
| | | XC2V2000 | 100 | 100 | 110 | ps |
| | | XC2V3000 | 100 | 100 | 110 | ps |
| | | XC2V4000 | 400 | 400 | 450 | ps |
| | | XC2V6000 | 500 | 500 | 550 | ps |
| | | XC2V8000 | | 600 | 650 | ps |

**Notes:**

1. These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
   $T_{DCD_CLK0}$ applies to cases where local (IOB) inversion is used to provide the negative-edge clock to the DDR element in the I/O.
   $T_{DCD_CLK180}$ applies to cases where the CLK180 output of the DCM is used to provide the negative-edge clock to the DDR element in the I/O.
2. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.

*Table 46:* **Package Skew**

| Description | Symbol | Device/Package | Value | Units |
|---|---|---|---|---|
| Package Skew(1) | $T_{PKGSKEW}$ | XC2V1000 / FF896 | 130 | ps |
| | | XC2V3000 / FF1152 | 115 | ps |
| | | XC2V3000 / BF957 | 130 | ps |
| | | XC2V4000 / FF1152 | 130 | ps |
| | | XC2V4000 / FF1517 | 200 | ps |
| | | XC2V4000 / BF957 | 140 | ps |
| | | XC2V6000 / FF1152 | 90 | ps |
| | | XC2V6000 / FF1517 | 105 | ps |
| | | XC2V6000 / BF957 | 105 | ps |

**Notes:**

1. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball (7.1ps per mm).
2. Package trace length information is available for these device/package combinations. This information can be used to deskew the package.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 47:* **Sample Window**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| Sampling Error at Receiver Pins(1) | $T_{SAMP}$ | XC2V40 | 500 | 500 | 550 | ps |
| | | XC2V80 | 500 | 500 | 550 | ps |
| | | XC2V250 | 500 | 500 | 550 | ps |
| | | XC2V500 | 500 | 500 | 550 | ps |
| | | XC2V1000 | 500 | 500 | 550 | ps |
| | | XC2V1500 | 500 | 500 | 550 | ps |
| | | XC2V2000 | 500 | 500 | 550 | ps |
| | | XC2V3000 | 500 | 500 | 550 | ps |
| | | XC2V4000 | 500 | 500 | 550 | ps |
| | | XC2V6000 | 500 | 500 | 550 | ps |
| | | XC2V8000 | | 500 | 550 | ps |

**Notes:**
1. This parameter indicates the total sampling error of Virtex-II DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
   - CLK0 and CLK180 DCM jitter
   - Worst-case Duty-Cycle Distortion - $T_{DCD_CLK180}$
   - DCM accuracy (phase offset)
   - DCM phase shift resolution.

   These measurements do not include package or clock tree skew.

*Table 48:* **Pin-to-Pin Setup/Hold: Source-Synchronous Configuration**

| Description | Symbol | Device | Speed Grade | | | Units |
|---|---|---|---|---|---|---|
| | | | -6 | -5 | -4 | |
| Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, Using DCM and Global Clock Buffer.<br>For situations where clock and data inputs conform to different standards, adjust the setup and hold values accordingly using the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11. | | | | | | |
| No Delay<br>Global Clock and IFF with DCM | $T_{PSDCM}$/ $T_{PHDCM}$ | XC2V40 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V80 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V250 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V500 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V1000 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V1500 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V2000 | 0.2/0.5 | 0.2/0.5 | 0.2/0.5 | ns |
| | | XC2V3000 | 0.2/0.5 | 0.2/0.5 | 0.2/0.6 | ns |
| | | XC2V4000 | 0.2/0.5 | 0.2/0.6 | 0.2/0.6 | ns |
| | | XC2V6000 | 0.2/0.5 | 0.2/0.6 | 0.2/0.6 | ns |
| | | XC2V8000 | | 0.2/0.6 | 0.2/0.7 | ns |

**Notes:**
1. IFF = Input Flip-Flop
2. The timing values were measured using the fine-phase adjustment feature of the DCM.
3. The worst-case duty-cycle distortion and DCM jitter on CLK0 and CLK180 is included in these measurements.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Source Synchronous Timing Budgets

This section describes how to use the parameters provided in the Source-Synchronous Switching Characteristics section to develop system-specific timing budgets. The following analysis provides information necessary for determining Virtex-II contributions to an overall system timing analysis; no assumptions are made about the effects of Inter-Symbol Interference or PCB skew.

### *Virtex-II Transmitter Data-Valid Window ($T_X$)*

$T_X$ is the minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$T_X = \text{Data Period} - [\text{Jitter}^{(1)} + \text{Duty Cycle Distortion}^{(2)} + \text{TCKSKEW}^{(3)} + \text{TPKGSKEW}^{(4)}]$$

**Notes:**

1. Jitter values and accumulation methodology to be provided in a future release of this document. The absolute period jitter values found in the DCM Timing Parameters section of the particular DCM output clock used to clock the IOB FF can be used for a best case analysis.
2. This value depends on the clocking methodology used. See Note1 for Table 45.
3. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

### *Virtex-II Receiver Data-Valid Window ($R_X$)*

$R_X$ is the required minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$R_X = [\text{TSAMP}^{(1)} + \text{TCKSKEW}^{(2)} + \text{TPKGSKEW}^{(3)}]$$

**Notes:**

1. This parameter indicates the total sampling error of Virtex-II DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
   - CLK0 and CLK180 DCM jitter in a quiet system
   - Worst-case duty-cycle distortion
   - DCM accuracy (phase offset)
   - DCM phase shift resolution.

   These measurements do not include package or clock tree skew.
2. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
3. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

## Revision History

This section records the change history for this module of the data sheet.

| Date | Version | Revision |
|---|---|---|
| 11/07/2000 | 1.0 | Early access draft. |
| 12/06/2000 | 1.1 | Initial release. |
| 01/15/2001 | 1.2 | Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections. |
| 01/25/2001 | 1.3 | • The data sheet was divided into four modules (per the current style standard).<br>• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.<br>• Table 18, "Delay Measurement Methodology" |
| 04/23/2001 | 1.5 | • Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.<br>• Added $T_{REG32}$ symbol to Table 23.<br>• Skipped v1.4 to sync with other modules. Reverted to traditional double-column format. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


| Date | Version | Revision |
|---|---|---|
| 07/30/2001 | 1.6 | • Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.<br>• Added values to the Virtex-II Pin-to-Pin Output Parameter Guidelines and Virtex-II Pin-to-Pin Input Parameter Guidelines tables.<br>• Added Frequency Synthesis table. |
| 10/02/2001 | 1.7 | • Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.<br>• Updated the speed grade designations used in data sheets, and added Table 13, which shows the current speed grade designation for each device. |
| 10/05/2001 | 1.8 | • Corrected the speed grade designation for the XC2V1000 device in Table 13. |
| 10/12/2001 | 1.9 | • Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. |
| 11/28/2001 | 2.0 | • Updated values in Table 3, Table 4, Table 5, Virtex-II Performance Characteristics, and Virtex-II Switching Characteristics tables. |
| 01/03/2002 | 2.1 | • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.96**.<br>• Changed the speed grade designation for the XC2V6000 device in Table 13. |
| 07/16/2002 | 2.2 | • Updated values in Table 4, "Quiescent Supply Current."<br>• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.111**.<br>• Added Enhanced Multiplier Switching Characteristics section.<br>• Added footnote to Table 37, "Global Clock Setup and Hold for LVTTL Standard, Without DCM."<br>• Added Source-Synchronous Switching Characteristics section. |
| 09/26/2002 | 2.3 | • Removed mention of MIL-M-38510/605 specification.<br>• Added footnotes to Table 2 and Table 6. |
| 12/06/2002 | 2.4 | • Revised SSTL2 values in Table 6 to match the latest JEDEC specification.<br>• Added footnote regarding $V_{IN}$ PCI compliance to Table 1.<br>• Added footnote regarding CLKOUT_DUTY_CYCLE_DLL to Table 41. |
| 05/07/2003 | 2.5 | • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.114**.<br>• Table 4, Quiescent Supply Current, and Table 5, Minimum Power On Current Required for Virtex-II Devices: Added parameters for XC2V8000 device.<br>• Table 16, IOB Output Switching Characteristics: Changed parameter designator $T_{IOTON}$ to $T_{IOTP}$.<br>• Table 26, Enhanced Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULT_P[nn]}$ to $T_{MULT1_P[nn]}$ in order to correspond with designators used in speedsfile.<br>• Table 27, Enhanced Pipelined Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULTCK_P[nn]}$ to $T_{MULTCK1_P[nn]}$ in order to correspond with designators used in speedsfile.<br>• Removed old Table 19, **Standard Capacitive Loads**.<br>• Added Figure 1, page 17, showing test configuration for measuring I/O standard adjustments. |
| 06/19/2003 | 2.5.1 | • Removed footnotes in Table 34 and Table 36 that stated DCM jitter was included in the measurements. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


| Date | Version | Revision |
|---|---|---|
| 08/01/2003 | 3.0 | • Table 13: All Virtex-II devices and speed grades now Production.<br>• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.116**.<br>• Table 34 and Table 35: Revised test setup footnote to refer to Figure 1. Previously specified a capacitive load parameter.<br>• Figure 1: Added note to figure regarding termination resistors. |
| 10/14/2003 | 3.1 | • Table 1: Changed $T_J$ description from “Operating junction temperature” to “Maximum junction temperature”.<br>• In section General Power Supply Requirements, replaced reference to Answer Record 11713 with reference to **XAPP689** regarding handling of simultaneously switching outputs (SSO).<br>• In section I/O Standard Adjustment Measurement Methodology:<br>- Table 18 renamed Input Delay Measurement Methodology. Added footnotes.<br>- Added new Table 19, Output Delay Measurement Methodology.<br>- Replaced Figure 1, Generalized Test Setup, with new drawing.<br>- Revised and extended text describing output delay measurement procedure.<br>• Table 45, Table 47, and Table 48: All Source-Synchronous parameters for all devices now available in these tables.<br>• XC2V8000 is no longer offered in the -6 speed grade. The following tables containing parameters or other references to this device/grade combination were corrected accordingly: Table 13, Table 14, Table 34, Table 35, Table 36, Table 37, Table 45, Table 47, and Table 48.<br>• Table 39: For Input Clock Low/High Pulse Width, PSCLK and CLKIN, changed existing Footnote (2) to new Footnote (3). |
| 03/29/2004 | 3.2 | • Table 4:<br>- For XC2V40, added Maximum quiescent supply current specifications.<br>- For all devices, updated Typical specifications for $I_{CCINTQ}$ and $I_{CCAUXQ}$.<br>• Section Power-On Power Supply Requirements, page 3: Added Footnote (1) qualifying statement that power supplies can be turned on in any sequence.<br>• Added section Configuration Timing, page 27. This section includes new timing diagrams as well as parameter specification tables formerly included in the **Virtex-II Platform FPGA User Guide**.<br>• Table 20, Clock Distribution Switching Characteristics: Added parameter $T_{GSI}/T_{GIS}$ (Global Clock Buffer S Input Setup/Hold to I1 and I2 Inputs).<br>• Table 38, Operating Frequency Ranges: Added Footnote (4) to all four CLKIN parameters.<br>• Recompiled for backward compatibility with Acrobat 4 and above. |
| 06/24/2004 | 3.3 | • Table 1: Added $T_{SOL}$ parameters for Pb-free package devices. |
| 03/01/2005 | 3.4 | • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.120**.<br>• Table 2: Corrected Footnote (1) to require connecting $V_{BATT}$ to $V_{CCAUX}$ or GND if battery is not used.<br>• Table 3: Corrected "$V_{REF}$ current per bank" to "$V_{REF}$ current per pin."<br>• Section Power-On Power Supply Requirements: Added word “monotonically” to description of supply voltage ramp-on requirements. Added sentence to footnote (1) indicating that if the stated requirements are violated, no damage to the device will result, but configuration will probably fail.<br>• Figure 3 and Figure 4: Corrected to show DOUT transitions driven by falling edge of CCLK. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


| Date | Version | Revision |
|---|---|---|
| 03/01/2005 (*cont'd*) | 3.4 (*cont'd*) | • Table 15, Table 17, Table 18, and Table 19: Restructured these I/O-related tables to include descriptions, as well as the actual IOSTANDARD attributes (used in Xilinx ISE™ software) for all I/O standards.<br>• Table 15: Added data for the following I/O standards: SSTL18_I, SSTL18_II, SSTL18_I_DCI, SSTL18_II_DCI, HSTL_I_18, HSTL_II_18, HSTL_III_18, HSTL_IV_18, LVDSEXT_25, LVDSEXT_33, BLVDS_25, LVDS_25_DCI, LVDS_33_DCI, LVDSEXT_25_DCI, LVDSEXT_33_DCI, HSLVDCI_15, HSLVDCI_18, HSLVDCI_25, HSLVDCI_33. Rearranged I/O standards in a more logical order.<br>• Table 16: Added parameter $T_{RPW}$ (Minimum Pulse Width, SR Input).<br>• Table 17: Added data for the following I/O standards: SSTL18_I, SSTL18_II, SSTL18_I_DCI, SSTL18_II_DCI, HSLVDCI_15, HSLVDCI_18, HSLVDCI_25, HSLVDCI_33. Changed "Csl" to "$C_{REF}$" to agree with Figure 1 and Table 19. Rearranged I/O standards in a more logical order.<br>• Table 18: Added data for the following I/O standards: SSTL18_I, SSTL18_II, HSTL_I_18, HSTL_II_18, HSTL_III_18, HSTL_IV_18. Added footnote defining equivalents for DCI standards.<br>• Table 19: Added Footnotes (2) and (3) to PCI/PCI-X capacitive load ($C_{REF}$) values. Added HSLVDCI callouts to LVDCI parameter rows (same values).<br>• Table 28: Added parameter $T_{BCCS}$, CLKA to CLKB Setup Time.<br>• Table 31: Added Footnote (1) indicating that $F_{CC_SERIAL}$ should not exceed $F_{CC_STARTUP}$ if no provision is made to adjust the speed of CCLK.<br>• Table 33: $T_{TCKTDO}$ corrected from a "Min" to a "Max" specification. |
| 11/05/2007 | 3.5 | • Updated copyright notice and legal disclaimer. |
| 04/07/2014 | 4.0 | This product is obsolete/discontinued per **XCN11003** and **XCN12026**. |

## Notice of Disclaimer

THE XILINX HARDWARE FPGA AND CPLD DEVICES REFERRED TO HEREIN ("PRODUCTS") ARE SUBJECT TO THE TERMS AND CONDITIONS OF THE XILINX LIMITED WARRANTY WHICH CAN BE VIEWED AT http://www.xilinx.com/warranty.htm. THIS LIMITED WARRANTY DOES NOT EXTEND TO ANY USE OF PRODUCTS IN AN APPLICATION OR ENVIRONMENT THAT IS NOT WITHIN THE SPECIFICATIONS STATED IN THE XILINX DATA SHEET. ALL SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, OR ANY OTHER APPLICATION THAT INVOKES THE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). USE OF PRODUCTS IN CRITICAL APPLICATIONS IS AT THE SOLE RISK OF CUSTOMER, SUBJECT TO APPLICABLE LAWS AND REGULATIONS.

## Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

# Virtex-II Platform FPGAs: Pinout Information

DS031-4 (v4.0) April 7, 2014 **Product Specification**

This document provides Virtex-II™ Device/Package Combinations, Maximum I/Os Available, and Virtex-II Pin Definitions, followed by pinout tables for the following packages:

- CS144/CSG144 Chip-Scale BGA Package
- FG256/FGG256 Fine-Pitch BGA Package
- FG456/FGG456 Fine-Pitch BGA Package
- FG676/FGG676 Fine-Pitch BGA Package
- BG575/BGG575 Standard BGA Package
- BG728/BGG728 Standard BGA Package
- FF896 Flip-Chip Fine-Pitch BGA Package
- FF1152 Flip-Chip Fine-Pitch BGA Package
- FF1517 Flip-Chip Fine-Pitch BGA Package
- BF957 Flip-Chip BGA Package

For device pinout diagrams and layout guidelines, refer to the ***Virtex-II Platform FPGA User Guide***. ASCII package pinout files are also available for download from the Xilinx website (**www.xilinx.com**).

## Virtex-II Device/Package Combinations and Maximum I/Os Available

Wire-bond and flip-chip packages are available. Table 1 and Table 2 show the maximum number of user I/Os possible in wire-bond and flip-chip packages, respectively.

Table 3 shows the number of user I/Os available for all device/package combinations.

- CS denotes wire-bond chip-scale ball grid array (BGA) (0.80 mm pitch).
- CSG denotes Pb-free wire-bond chip-scale ball grid array (BGA) (0.80 mm pitch).
- FG denotes wire-bond fine-pitch BGA (1.00 mm pitch).
- FGG denotes Pb-free wire-bond fine-pitch BGA (1.00 mm pitch).
- BG denotes standard BGA (1.27 mm pitch).
- BGG denotes Pb-free standard BGA (1.27 mm pitch).
- FF denotes flip-chip fine-pitch BGA (1.00 mm pitch).
- BF denotes flip-chip BGA (1.27 mm pitch).

The number of I/Os per package include all user I/Os except the 15 control pins (CCLK, DONE, M0, M1, M2, PROG_B, PWRDWN_B, TCK, TDI, TDO, TMS, HSWAP_EN, DXN, DXP, AND RSVD).

*Table 1:* **Wire-Bond Packages Information**

| Package[1] | CS144/ CSG144 | FG256/ FGG256 | FG456/ FGG456 | FG676/ FGG676 | BG575/ BGG575 | BG728/ BGG728 |
|---|---|---|---|---|---|---|
| Pitch (mm) | 0.80 | 1.00 | 1.00 | 1.00 | 1.27 | 1.27 |
| Size (mm) | 12 x 12 | 17 x 17 | 23 x 23 | 27 x 27 | 31 x 31 | 35 x 35 |
| I/Os | 92 | 172 | 324 | 484 | 408 | 516 |

**Notes:**
1. Wire-bond packages include FGG*nnn* Pb-free versions. See Virtex-II Ordering Examples (Module 1).

*Table 2:* **Flip-Chip Packages Information**

| Package | FF896 | FF1152 | FF1517 | BF957 |
|---|---|---|---|---|
| Pitch (mm) | 1.00 | 1.00 | 1.00 | 1.27 |
| Size (mm) | 31 x 31 | 35 x 35 | 40 x 40 | 40 x 40 |
| I/Os | 624 | 824 | 1,108 | 684 |

© 2000–2014 Xilinx, Inc. All rights reserved. XILINX, the Xilinx logo, the Brand Window, and other designated brands included herein are trademarks of Xilinx, Inc. All other trademarks are the property of their respective owners.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 3:* **Virtex-II Device/Package Combinations and Maximum Number of Available I/Os**

| Package | Available I/Os | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | XC2V 40 | XC2V 80 | XC2V 250 | XC2V 500 | XC2V 1000 | XC2V 1500 | XC2V 2000 | XC2V 3000 | XC2V 4000 | XC2V 6000 | XC2V 8000 |
| CS144 | 88 | 92 | 92 | - | - | - | - | - | - | - | - |
| FG256 | 88 | 120 | 172 | 172 | 172 | - | - | - | - | - | - |
| FG456 | - | - | 200 | 264 | 324 | - | - | - | - | - | - |
| FG676 | - | - | - | - | - | 392 | 456 | 484 | - | - | - |
| FF896 | - | - | - | - | 432 | 528 | 624 | - | - | - | - |
| FF1152 | - | - | - | - | - | - | - | 720 | 824 | 824 | 824 |
| FF1517 | - | - | - | - | - | - | - | - | 912 | 1,104 | 1,108 |
| BG575 | - | - | - | - | 328 | 392 | 408 | - | - | - | - |
| BG728 | - | - | - | - | - | - | - | 516 | - | - | - |
| BF957 | - | - | - | - | - | - | 624 | 684 | 684 | 684 | - |

## Virtex-II Pin Definitions

This section describes the pinouts for Virtex-II devices in the following packages:

- CS144: wire-bond chip-scale ball grid array (BGA) of 0.80 mm pitch
- FG256, FG456, and FG676: wire-bond fine-pitch BGA of 1.00 mm pitch
- FF896, FF1152, FF1517: flip-chip fine-pitch BGA of 1.00 mm pitch
- BG575 and BG728: wire-bond BGA of 1.27 mm pitch
- BF957: flip-chip BGA of 1.27 mm pitch

All of the devices supported in a particular package are pin-out compatible and are listed in the same table (one table per package). In addition, the FG456 and FG676 packages are compatible, as are the FF896 and FF1152 packages. Pins that are not available for the smallest devices are listed in right-hand columns.

Each device is split into eight I/O banks to allow for flexibility in the choice of I/O standards (see the Virtex-II *Data Sheet*). Global pins, including JTAG, configuration, and power/ground pins, are listed at the end of each table. Table 4 provides definitions for all pin types.

The FG256 pinouts (Table 6) is included as an example. All Virtex-II pinout tables are available on the distribution CD-ROM, or on the web (at **http://www.xilinx.com**).

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

*Table 4:* **Virtex-II Pin Definitions**

| Pin Name | Direction | Description |
|---|---|---|
| **User I/O Pins** | | |
| IO_LXXY_# | Input/Output/ Bidirectional | All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled "**IO_LXXY_#**", where:<br>**IO** indicates a user I/O pin.<br>**LXXY** indicates a differential pair, with **XX** a unique pair in the bank and **Y = P/N** for the positive and negative sides of the differential pair.<br>**#** indicates the bank number (0 through 7) |
| **Dual-Function Pins** | | |
| IO_LXXY_#/ZZZ | | The dual-function pins are labelled "**IO_LXXY_#/ZZZ**", where **ZZZ** can be one of the following pins:<br>Per Bank - **VRP, VRN,** or **VREF**<br>Globally - **GCLKX(S/P), BUSY/DOUT, INIT_B, D0/DIN – D7, RDWR_B,** or **CS_B** |
| **With /ZZZ:** | | |
| D0/DIN, D1, D2, D3, D4, D5, D6, D7 | Input/Output | • *In* SelectMAP *mode,* D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained.<br>• *In bit-serial modes,* DIN (D0) is the single-data input. This pin becomes a user I/O after configuration. |
| CS_B | Input | In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. |
| RDWR_B | Input | In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. |
| BUSY/DOUT | Output | • *In* SelectMAP *mode,* BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.<br>• *In bit-serial modes,* DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration. |
| INIT_B | Bidirectional (open-drain) | When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration. |
| GCLKx (S/P) | Input/Output | These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks. |
| VRP | Input | This pin is for the DCI voltage reference resistor of P transistor (per bank). |
| VRN | Input | This pin is for the DCI voltage reference resistor of N transistor (per bank). |
| ALT_VRP | Input | This is the alternative pin for the DCI voltage reference resistor of P transistor. |
| ALT_VRN | Input | This is the alternative pin for the DCI voltage reference resistor of N transistor. |
| $V_{REF}$ | Input | These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank). |
| **Dedicated Pins**(1) | | |
| CCLK | Input/Output | Configuration clock. Output in Master mode or Input in Slave mode. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 4:* **Virtex-II Pin Definitions *(Continued)***

| Pin Name | Direction | Description |
|---|---|---|
| PROG_B | Input | Active Low asynchronous reset to configuration logic. This pin has a permanent weak pull-up resistor. |
| DONE | Input/Output | DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, this pin indicates completion of the configuration process. As an input, a Low level on DONE can be configured to delay the start-up sequence. |
| M2, M1, M0 | Input | Configuration mode selection. |
| HSWAP_EN | Input | Enable I/O pull-ups during configuration. |
| TCK | Input | Boundary Scan Clock. |
| TDI | Input | Boundary Scan Data Input. |
| TDO | Output | Boundary Scan Data Output. |
| TMS | Input | Boundary Scan Mode Select. |
| PWRDWN_B | Input *(unsupported)* | Active Low power-down pin (unsupported). *Driving this pin Low can adversely affect device operation and configuration.* PWRDWN_B is internally pulled High, which is its default state. It does not require an external pull-up. |
| **Other Pins** | | |
| DXN, DXP | N/A | Temperature-sensing diode pins (Anode: DXP, Cathode: DXN). |
| $V_{BATT}$ | Input | Decryptor key memory backup supply. Connect $V_{BATT}$ to $V_{CCAUX}$ or GND if battery is not used. |
| RSVD | N/A | Reserved pin - do not connect. |
| $V_{CCO}$ | Input | Power-supply pins for the output drivers (per bank). |
| $V_{CCAUX}$ | Input | Power-supply pins for auxiliary circuits. |
| $V_{CCINT}$ | Input | Power-supply pins for the internal core logic. |
| GND | Input | Ground. |

**Notes:**
1. All dedicated pins (JTAG and configuration) are powered by $V_{CCAUX}$ (independent of the bank $V_{CCO}$ voltage).

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


# CS144/CSG144 Chip-Scale BGA Package

As shown in Table 5, XC2V40, XC2V80, and XC2V250 Virtex-II devices are available in the CS144/CSG144 package. Pins in the XC2V40, XC2V80, and XC2V250 devices are the same except for pin differences in the XC2V40 device, shown in the No Connect column. Following this table are the CS144/CSG144 Chip-Scale BGA Package Specifications (0.80mm pitch).

*Table 5:* **CS144/CSG144 — XC2V40, XC2V80, and XC2V250**

| Bank | Pin Description | Pin Number | No Connect in the XC2V40 |
|---|---|---|---|
| 0 | IO_L01N_0 | B3 | |
| 0 | IO_L01P_0 | A3 | |
| 0 | IO_L02N_0 | C4 | |
| 0 | IO_L02P_0 | B4 | |
| 0 | IO_L03N_0/VRP_0 | A4 | |
| 0 | IO_L03P_0/VRN_0 | D5 | |
| 0 | IO_L94N_0/VREF_0 | A5 | |
| 0 | IO_L94P_0 | D6 | |
| 0 | IO_L95N_0/GCLK7P | C6 | |
| 0 | IO_L95P_0/GCLK6S | B6 | |
| 0 | IO_L96N_0/GCLK5P | A6 | |
| 0 | IO_L96P_0/GCLK4S | D7 | |
| | | | |
| 1 | IO_L96N_1/GCLK3P | A7 | |
| 1 | IO_L96P_1/GCLK2S | B7 | |
| 1 | IO_L95N_1/GCLK1P | A8 | |
| 1 | IO_L95P_1/GCLK0S | B8 | |
| 1 | IO_L94N_1 | C8 | |
| 1 | IO_L94P_1/VREF_1 | D8 | |
| 1 | IO_L03N_1/VRP_1 | C9 | |
| 1 | IO_L03P_1/VRN_1 | D9 | |
| 1 | IO_L02N_1 | A10 | |
| 1 | IO_L02P_1 | B10 | |
| 1 | IO_L01N_1 | C10 | |
| 1 | IO_L01P_1 | D10 | |
| | | | |
| 2 | IO_L01N_2 | C13 | |
| 2 | IO_L01P_2 | D11 | |
| 2 | IO_L02N_2/VRP_2 | D12 | |
| 2 | IO_L02P_2/VRN_2 | D13 | |
| 2 | IO_L03N_2 | E10 | |
| 2 | IO_L03P_2/VREF_2 | E11 | |
| 2 | IO_L93N_2 | E13 | NC |
| 2 | IO_L93P_2/VREF_2 | F11 | NC |
| 2 | IO_L94N_2 | F12 | |
| 2 | IO_L94P_2 | G10 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 5:* **CS144/CSG144 — XC2V40, XC2V80, and XC2V250**

| Bank | Pin Description | Pin Number | No Connect in the XC2V40 |
|---|---|---|---|
| 2 | IO_L96N_2 | G11 | |
| 2 | IO_L96P_2 | G13 | |
| | | | |
| 3 | IO_L96N_3 | G12 | |
| 3 | IO_L96P_3 | H12 | |
| 3 | IO_L94N_3 | H11 | |
| 3 | IO_L94P_3 | J13 | |
| 3 | IO_L03N_3/VREF_3 | J10 | |
| 3 | IO_L03P_3 | K13 | |
| 3 | IO_L02N_3/VRP_3 | K12 | |
| 3 | IO_L02P_3/VRN_3 | K11 | |
| 3 | IO_L01N_3 | K10 | |
| 3 | IO_L01P_3 | L13 | |
| | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | M11 | |
| 4 | IO_L01P_4/INIT_B | N11 | |
| 4 | IO_L02N_4/D0/DIN(1) | L10 | |
| 4 | IO_L02P_4/D1 | M10 | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | N10 | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | K9 | |
| 4 | IO_L94N_4/VREF_4 | N9 | |
| 4 | IO_L94P_4 | K8 | |
| 4 | IO_L95N_4/GCLK3S | L8 | |
| 4 | IO_L95P_4/GCLK2P | M8 | |
| 4 | IO_L96N_4/GCLK1S | N8 | |
| 4 | IO_L96P_4/GCLK0P | K7 | |
| | | | |
| 5 | IO_L96N_5/GCLK7S | N7 | |
| 5 | IO_L96P_5/GCLK6P | M7 | |
| 5 | IO_L95N_5/GCLK5S | N6 | |
| 5 | IO_L95P_5/GCLK4P | M6 | |
| 5 | IO_L94N_5 | L6 | |
| 5 | IO_L94P_5/VREF_5 | K6 | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | L5 | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | K5 | |
| 5 | IO_L02N_5/D6 | N4 | |
| 5 | IO_L02P_5/D7 | M4 | |
| 5 | IO_L01N_5/RDWR_B | L4 | |
| 5 | IO_L01P_5/CS_B | K4 | |
| | | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 5:* **CS144/CSG144 — XC2V40, XC2V80, and XC2V250**

| Bank | Pin Description | Pin Number | No Connect in the XC2V40 |
|---|---|---|---|
| 6 | IO_L01P_6 | L3 | |
| 6 | IO_L01N_6 | L2 | |
| 6 | IO_L02P_6/VRN_6 | L1 | |
| 6 | IO_L02N_6/VRP_6 | K3 | |
| 6 | IO_L03P_6 | K2 | |
| 6 | IO_L03N_6/VREF_6 | K1 | |
| 6 | IO_L94P_6 | J2 | |
| 6 | IO_L94N_6 | H4 | |
| 6 | IO_L96P_6 | H3 | |
| 6 | IO_L96N_6 | H1 | |
| | | | |
| 7 | IO_L96P_7 | G4 | |
| 7 | IO_L96N_7 | G3 | |
| 7 | IO_L94P_7 | G1 | |
| 7 | IO_L94N_7 | F1 | |
| 7 | IO_L93P_7/VREF_7 | F2 | NC |
| 7 | IO_L93N_7 | F4 | NC |
| 7 | IO_L03P_7/VREF_7 | E2 | |
| 7 | IO_L03N_7 | E3 | |
| 7 | IO_L02P_7/VRN_7 | E4 | |
| 7 | IO_L02N_7/VRP_7 | D1 | |
| 7 | IO_L01P_7 | D2 | |
| 7 | IO_L01N_7 | D3 | |
| | | | |
| 0 | VCCO_0 | B5 | |
| 0 | VCCO_0 | C3 | |
| 1 | VCCO_1 | A11 | |
| 1 | VCCO_1 | A9 | |
| 2 | VCCO_2 | F10 | |
| 2 | VCCO_2 | C12 | |
| 3 | VCCO_3 | L12 | |
| 3 | VCCO_3 | J12 | |
| 4 | VCCO_4 | M9 | |
| 4 | VCCO_4 | L11 | |
| 5 | VCCO_5 | N3 | |
| 5 | VCCO_5 | N5 | |
| 6 | VCCO_6 | J3 | |
| 6 | VCCO_6 | M1 | |
| 7 | VCCO_7 | D4 | |
| 7 | VCCO_7 | F3 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

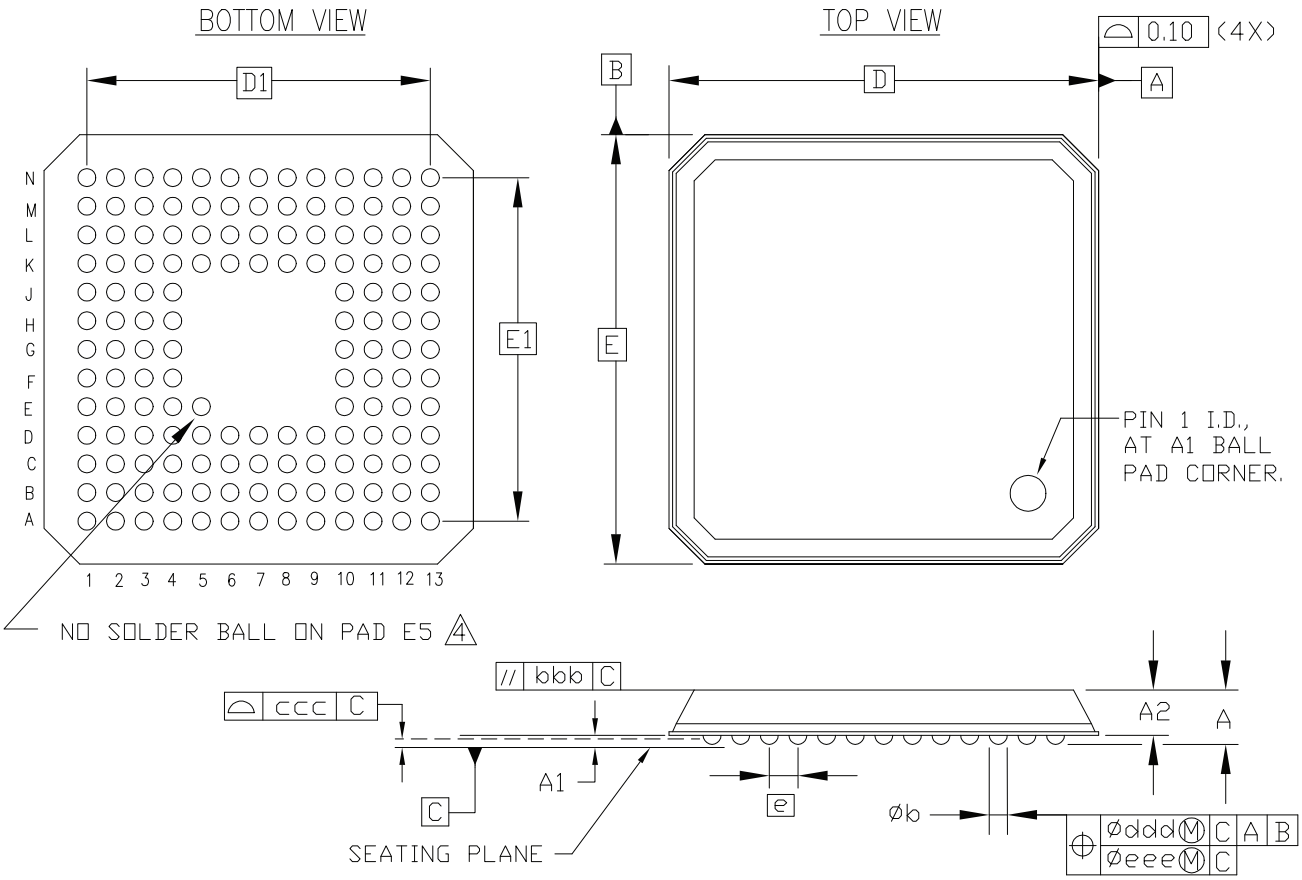

*Table 5:* **CS144/CSG144 — XC2V40, XC2V80, and XC2V250**

| Bank | Pin Description | Pin Number | No Connect in the XC2V40 |
|---|---|---|---|
| | | | |
| NA | CCLK | M13 | |
| NA | PROG_B | B1 | |
| NA | DONE | N12 | |
| NA | M0 | N2 | |
| NA | M1 | M2 | |
| NA | M2 | M3 | |
| NA | TCK | B12 | |
| NA | TDI | C1 | |
| NA | TDO | C11 | |
| NA | TMS | A13 | |
| NA | PWRDWN_B | M12 | |
| NA | HSWAP_EN | A1 | |
| NA | RSVD | A2 | |
| NA | RSVD | B2 | |
| NA | VBATT | A12 | |
| NA | RSVD | B11 | |
| | | | |
| NA | VCCAUX | C2 | |
| NA | VCCAUX | N1 | |
| NA | VCCAUX | N13 | |
| NA | VCCAUX | B13 | |
| NA | VCCINT | H2 | |
| NA | VCCINT | L7 | |
| NA | VCCINT | H13 | |
| NA | VCCINT | C7 | |
| NA | GND | E1 | |
| NA | GND | G2 | |
| NA | GND | J1 | |
| NA | GND | J4 | |
| NA | GND | M5 | |
| NA | GND | L9 | |
| NA | GND | J11 | |
| NA | GND | H10 | |
| NA | GND | F13 | |
| NA | GND | E12 | |
| NA | GND | B9 | |
| NA | GND | C5 | |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## CS144/CSG144 Chip-Scale BGA Package Specifications (0.80mm pitch)




| SYMBOL | MILLIMETERS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | | | 1.20 |
| $A_1$ | 0.20 | | |
| $A_2$ | 0.65 | | |
| D/E | 12.00 BSC | | |
| $D_1/E_1$ | 9.60 BSC | | |
| e | 0.80 BSC | | |
| øb | 0.40 | 0.45 | 0.50 |
| bbb | | | 0.20 |
| ccc | | | 0.12 |
| ddd | | | 0.15 |
| eee | | | 0.08 |
| M | 13 | | |

NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M–1994
2. SYMBOL "M" IS THE PIN MATRIX SIZE.
3. CONFORMS TO JEDEC MO–216–BAG–2 (DEPOPULATED).
4. PAD 'E5' IS FOR PAD 'A1' CORNER INDICATION.

144–BALL CHIP SCALE BGA (CS144/CSG144)

*Figure 1:* **CS144/CSG144 Chip-Scale BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG256/FGG256 Fine-Pitch BGA Package

As shown in Table 6, XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000 Virtex-II devices are available in the FG256/FGG256 fine-pitch BGA package. The pins in the XC2V250, XC2V500, and XC2V1000 devices are same. The No Connect columns show pin differences for the XC2V40 and XC2V80 devices. Following this table are the FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch).

*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | C4 | | |
| 0 | IO_L01P_0 | B4 | | |
| 0 | IO_L02N_0 | D5 | | |
| 0 | IO_L02P_0 | C5 | | |
| 0 | IO_L03N_0/VRP_0 | B5 | | |
| 0 | IO_L03P_0/VRN_0 | A5 | | |
| 0 | IO_L04N_0/VREF_0 | D6 | NC | NC |
| 0 | IO_L04P_0 | C6 | NC | NC |
| 0 | IO_L05N_0 | B6 | NC | NC |
| 0 | IO_L05P_0 | A6 | NC | NC |
| 0 | IO_L92N_0 | E6 | NC | NC |
| 0 | IO_L92P_0 | E7 | NC | NC |
| 0 | IO_L93N_0 | D7 | NC | NC |
| 0 | IO_L93P_0 | C7 | NC | NC |
| 0 | IO_L94N_0/VREF_0 | B7 | | |
| 0 | IO_L94P_0 | A7 | | |
| 0 | IO_L95N_0/GCLK7P | D8 | | |
| 0 | IO_L95P_0/GCLK6S | C8 | | |
| 0 | IO_L96N_0/GCLK5P | B8 | | |
| 0 | IO_L96P_0/GCLK4S | A8 | | |
| | | | | |
| 1 | IO_L96N_1/GCLK3P | A9 | | |
| 1 | IO_L96P_1/GCLK2S | B9 | | |
| 1 | IO_L95N_1/GCLK1P | C9 | | |
| 1 | IO_L95P_1/GCLK0S | D9 | | |
| 1 | IO_L94N_1 | A10 | | |
| 1 | IO_L94P_1/VREF_1 | B10 | | |
| 1 | IO_L93N_1 | C10 | NC | NC |
| 1 | IO_L93P_1 | D10 | NC | NC |
| 1 | IO_L92N_1 | E10 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 1 | IO_L92P_1 | E11 | NC | NC |
| 1 | IO_L05N_1 | A11 | NC | NC |
| 1 | IO_L05P_1 | B11 | NC | NC |
| 1 | IO_L04N_1 | C11 | NC | NC |
| 1 | IO_L04P_1/VREF_1 | D11 | NC | NC |
| 1 | IO_L03N_1/VRP_1 | A12 | | |
| 1 | IO_L03P_1/VRN_1 | B12 | | |
| 1 | IO_L02N_1 | C12 | | |
| 1 | IO_L02P_1 | D12 | | |
| 1 | IO_L01N_1 | B13 | | |
| 1 | IO_L01P_1 | C13 | | |
| | | | | |
| 2 | IO_L01N_2 | C16 | | |
| 2 | IO_L01P_2 | D16 | | |
| 2 | IO_L02N_2/VRP_2 | D14 | | |
| 2 | IO_L02P_2/VRN_2 | D15 | | |
| 2 | IO_L03N_2 | E13 | | |
| 2 | IO_L03P_2/VREF_2 | E14 | | |
| 2 | IO_L04N_2 | E15 | NC | |
| 2 | IO_L04P_2 | E16 | NC | |
| 2 | IO_L06N_2 | F13 | NC | |
| 2 | IO_L06P_2 | F14 | NC | |
| 2 | IO_L43N_2 | F15 | NC | NC |
| 2 | IO_L43P_2 | F16 | NC | NC |
| 2 | IO_L45N_2 | F12 | NC | NC |
| 2 | IO_L45P_2/VREF_2 | G12 | NC | NC |
| 2 | IO_L91N_2 | G13 | NC | |
| 2 | IO_L91P_2 | G14 | NC | |
| 2 | IO_L93N_2 | G15 | NC | |
| 2 | IO_L93P_2/VREF_2 | G16 | NC | |
| 2 | IO_L94N_2 | H13 | | |
| 2 | IO_L94P_2 | H14 | | |
| 2 | IO_L96N_2 | H15 | | |
| 2 | IO_L96P_2 | H16 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| | | | | |
| 3 | IO_L96N_3 | J16 | | |
| 3 | IO_L96P_3 | J15 | | |
| 3 | IO_L94N_3 | J14 | | |
| 3 | IO_L94P_3 | J13 | | |
| 3 | IO_L93N_3/VREF_3 | K16 | NC | |
| 3 | IO_L93P_3 | K15 | NC | |
| 3 | IO_L91N_3 | K14 | NC | |
| 3 | IO_L91P_3 | K13 | NC | |
| 3 | IO_L45N_3/VREF_3 | K12 | NC | NC |
| 3 | IO_L45P_3 | L12 | NC | NC |
| 3 | IO_L43N_3 | L16 | NC | NC |
| 3 | IO_L43P_3 | L15 | NC | NC |
| 3 | IO_L06N_3 | L14 | NC | |
| 3 | IO_L06P_3 | L13 | NC | |
| 3 | IO_L04N_3 | M16 | NC | |
| 3 | IO_L04P_3 | M15 | NC | |
| 3 | IO_L03N_3/VREF_3 | M14 | | |
| 3 | IO_L03P_3 | M13 | | |
| 3 | IO_L02N_3/VRP_3 | N15 | | |
| 3 | IO_L02P_3/VRN_3 | N14 | | |
| 3 | IO_L01N_3 | N16 | | |
| 3 | IO_L01P_3 | P16 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | T14 | | |
| 4 | IO_L01P_4/INIT_B | T13 | | |
| 4 | IO_L02N_4/D0/DIN(1) | P13 | | |
| 4 | IO_L02P_4/D1 | R13 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | N12 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | P12 | | |
| 4 | IO_L04N_4/VREF_4 | R12 | NC | NC |
| 4 | IO_L04P_4 | T12 | NC | NC |
| 4 | IO_L05N_4/VRP_4 | N11 | NC | NC |
| 4 | IO_L05P_4/VRN_4 | P11 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 4 | IO_L91N_4/VREF_4 | R11 | NC | NC |
| 4 | IO_L91P_4 | T11 | NC | NC |
| 4 | IO_L92N_4 | M11 | NC | NC |
| 4 | IO_L92P_4 | M10 | NC | NC |
| 4 | IO_L93N_4 | N10 | NC | NC |
| 4 | IO_L93P_4 | P10 | NC | NC |
| 4 | IO_L94N_4/VREF_4 | R10 | | |
| 4 | IO_L94P_4 | T10 | | |
| 4 | IO_L95N_4/GCLK3S | N9 | | |
| 4 | IO_L95P_4/GCLK2P | P9 | | |
| 4 | IO_L96N_4/GCLK1S | R9 | | |
| 4 | IO_L96P_4/GCLK0P | T9 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | T8 | | |
| 5 | IO_L96P_5/GCLK6P | R8 | | |
| 5 | IO_L95N_5/GCLK5S | P8 | | |
| 5 | IO_L95P_5/GCLK4P | N8 | | |
| 5 | IO_L94N_5 | T7 | | |
| 5 | IO_L94P_5/VREF_5 | R7 | | |
| 5 | IO_L93N_5 | P7 | NC | NC |
| 5 | IO_L93P_5 | N7 | NC | NC |
| 5 | IO_L92N_5 | M7 | NC | NC |
| 5 | IO_L92P_5 | M6 | NC | NC |
| 5 | IO_L91N_5 | T6 | NC | NC |
| 5 | IO_L91P_5/VREF_5 | R6 | NC | NC |
| 5 | IO_L05N_5/VRP_5 | P6 | NC | NC |
| 5 | IO_L05P_5/VRN_5 | N6 | NC | NC |
| 5 | IO_L04N_5 | T5 | NC | NC |
| 5 | IO_L04P_5/VREF_5 | R5 | NC | NC |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | P5 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | N5 | | |
| 5 | IO_L02N_5/D6 | R4 | | |
| 5 | IO_L02P_5/D7 | P4 | | |
| 5 | IO_L01N_5/RDWR_B | T4 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 5 | IO_L01P_5/CS_B | T3 | | |
| | | | | |
| 6 | IO_L01P_6 | P1 | | |
| 6 | IO_L01N_6 | N1 | | |
| 6 | IO_L02P_6/VRN_6 | N3 | | |
| 6 | IO_L02N_6/VRP_6 | N2 | | |
| 6 | IO_L03P_6 | M4 | | |
| 6 | IO_L03N_6/VREF_6 | M3 | | |
| 6 | IO_L04P_6 | M2 | NC | |
| 6 | IO_L04N_6 | M1 | NC | |
| 6 | IO_L06P_6 | L4 | NC | |
| 6 | IO_L06N_6 | L3 | NC | |
| 6 | IO_L43P_6 | L2 | NC | NC |
| 6 | IO_L43N_6 | L1 | NC | NC |
| 6 | IO_L45P_6 | L5 | NC | NC |
| 6 | IO_L45N_6/VREF_6 | K5 | NC | NC |
| 6 | IO_L91P_6 | K4 | NC | |
| 6 | IO_L91N_6 | K3 | NC | |
| 6 | IO_L93P_6 | K2 | NC | |
| 6 | IO_L93N_6/VREF_6 | K1 | NC | |
| 6 | IO_L94P_6 | J4 | | |
| 6 | IO_L94N_6 | J3 | | |
| 6 | IO_L96P_6 | J2 | | |
| 6 | IO_L96N_6 | J1 | | |
| | | | | |
| 7 | IO_L96P_7 | H1 | | |
| 7 | IO_L96N_7 | H2 | | |
| 7 | IO_L94P_7 | H3 | | |
| 7 | IO_L94N_7 | H4 | | |
| 7 | IO_L93P_7/VREF_7 | G1 | NC | |
| 7 | IO_L93N_7 | G2 | NC | |
| 7 | IO_L91P_7 | G3 | NC | |
| 7 | IO_L91N_7 | G4 | NC | |
| 7 | IO_L45P_7/VREF_7 | G5 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 7 | IO_L45N_7 | F5 | NC | NC |
| 7 | IO_L43P_7 | F1 | NC | NC |
| 7 | IO_L43N_7 | F2 | NC | NC |
| 7 | IO_L06P_7 | F3 | NC | |
| 7 | IO_L06N_7 | F4 | NC | |
| 7 | IO_L04P_7 | E1 | NC | |
| 7 | IO_L04N_7 | E2 | NC | |
| 7 | IO_L03P_7/VREF_7 | E3 | | |
| 7 | IO_L03N_7 | E4 | | |
| 7 | IO_L02P_7/VRN_7 | D2 | | |
| 7 | IO_L02N_7/VRP_7 | D3 | | |
| 7 | IO_L01P_7 | D1 | | |
| 7 | IO_L01N_7 | C1 | | |
| | | | | |
| 0 | VCCO_0 | F8 | | |
| 0 | VCCO_0 | F7 | | |
| 0 | VCCO_0 | E8 | | |
| 1 | VCCO_1 | F10 | | |
| 1 | VCCO_1 | F9 | | |
| 1 | VCCO_1 | E9 | | |
| 2 | VCCO_2 | H12 | | |
| 2 | VCCO_2 | H11 | | |
| 2 | VCCO_2 | G11 | | |
| 3 | VCCO_3 | K11 | | |
| 3 | VCCO_3 | J12 | | |
| 3 | VCCO_3 | J11 | | |
| 4 | VCCO_4 | M9 | | |
| 4 | VCCO_4 | L10 | | |
| 4 | VCCO_4 | L9 | | |
| 5 | VCCO_5 | M8 | | |
| 5 | VCCO_5 | L8 | | |
| 5 | VCCO_5 | L7 | | |
| 6 | VCCO_6 | K6 | | |
| 6 | VCCO_6 | J6 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| 6 | VCCO_6 | J5 | | |
| 7 | VCCO_7 | H6 | | |
| 7 | VCCO_7 | H5 | | |
| 7 | VCCO_7 | G6 | | |
| | | | | |
| NA | CCLK | P15 | | |
| NA | PROG_B | A2 | | |
| NA | DONE | R14 | | |
| NA | M0 | T2 | | |
| NA | M1 | P2 | | |
| NA | M2 | R3 | | |
| NA | HSWAP_EN | B3 | | |
| NA | TCK | A15 | | |
| NA | TDI | C2 | | |
| NA | TDO | C15 | | |
| NA | TMS | B14 | | |
| NA | PWRDWN_B | T15 | | |
| NA | RSVD | A4 | | |
| NA | RSVD | A3 | | |
| NA | VBATT | A14 | | |
| NA | RSVD | A13 | | |
| | | | | |
| NA | VCCAUX | R16 | | |
| NA | VCCAUX | R1 | | |
| NA | VCCAUX | B16 | | |
| NA | VCCAUX | B1 | | |
| NA | VCCINT | N13 | | |
| NA | VCCINT | N4 | | |
| NA | VCCINT | M12 | | |
| NA | VCCINT | M5 | | |
| NA | VCCINT | E12 | | |
| NA | VCCINT | E5 | | |
| NA | VCCINT | D13 | | |
| NA | VCCINT | D4 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

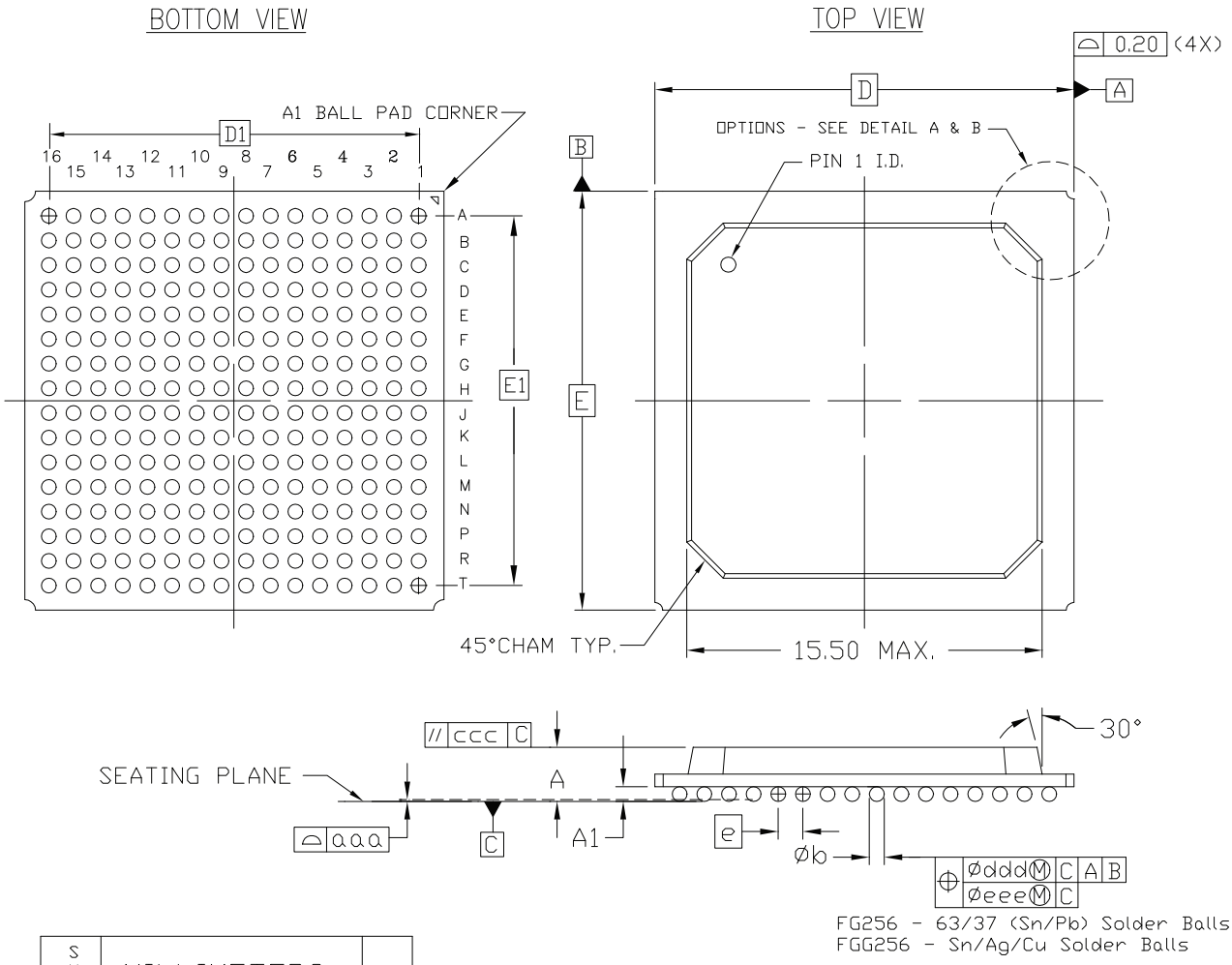

*Table 6:* **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V40 | No Connect in XC2V80 |
|---|---|---|---|---|
| | | | | |
| NA | GND | T16 | | |
| NA | GND | T1 | | |
| NA | GND | R15 | | |
| NA | GND | R2 | | |
| NA | GND | P14 | | |
| NA | GND | P3 | | |
| NA | GND | L11 | | |
| NA | GND | L6 | | |
| NA | GND | K10 | | |
| NA | GND | K9 | | |
| NA | GND | K8 | | |
| NA | GND | K7 | | |
| NA | GND | J10 | | |
| NA | GND | J9 | | |
| NA | GND | J8 | | |
| NA | GND | J7 | | |
| NA | GND | H10 | | |
| NA | GND | H9 | | |
| NA | GND | H8 | | |
| NA | GND | H7 | | |
| NA | GND | G10 | | |
| NA | GND | G9 | | |
| NA | GND | G8 | | |
| NA | GND | G7 | | |
| NA | GND | F11 | | |
| NA | GND | F6 | | |
| NA | GND | C14 | | |
| NA | GND | C3 | | |
| NA | GND | B15 | | |
| NA | GND | B2 | | |
| NA | GND | A16 | | |
| NA | GND | A1 | | |

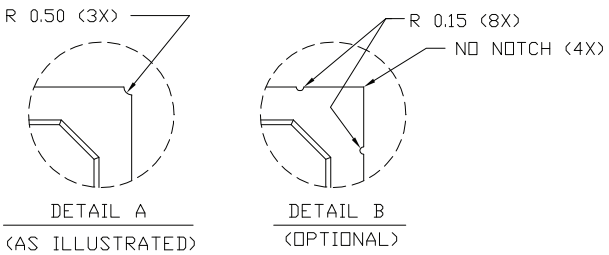
**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch)




| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | | | 2.00 | 3 |
| $A_1$ | 0.35 | 0.50 | 0.60 | |
| D/E | 17.00 BSC | | | |
| $D_1/E_1$ | 15.00 REF | | | |
| e | 1.00 BSC | | | |
| øb | 0.50 | 0.60 | 0.70 | |
| aaa | | | 0.20 | |
| ccc | | | 0.35 | |
| ddd | | | 0.30 | |
| eee | | | 0.10 | |
| M | 16 | | | 2 |




NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994.
2. SYMBOL 'M' IS THE BALL MATRIX SIZE
3. NOMINAL DIMENSION IS TYPICALLY 1.60–1.73mm
4. CONFORMS TO JEDEC MS–034–AAF–1

256–BALL FINE PITCH BGA (FG256/FGG256)

*Figure 2:* **FG256/FGG256 Fine-Pitch BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG456/FGG456 Fine-Pitch BGA Package

As shown in Table 7, XC2V250, XC2V500, and XC2V1000 Virtex-II devices are available in the FG456/FGG456 fine-pitch BGA package. Pins in the XC2V250, XC2V500, and XC2V1000 devices are the same, except for the pin differences in the XC2V250 and XC2V500 devices shown in the No Connect columns. Following this table are the FG456/FGG456 Fine-Pitch BGA Package Specifications (1.00mm pitch).

*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | B4 | | |
| 0 | IO_L01P_0 | A4 | | |
| 0 | IO_L02N_0 | C4 | | |
| 0 | IO_L02P_0 | C5 | | |
| 0 | IO_L03N_0/VRP_0 | B5 | | |
| 0 | IO_L03P_0/VRN_0 | A5 | | |
| 0 | IO_L04N_0/VREF_0 | D6 | | |
| 0 | IO_L04P_0 | C6 | | |
| 0 | IO_L05N_0 | B6 | | |
| 0 | IO_L05P_0 | A6 | | |
| 0 | IO_L06N_0 | E7 | | |
| 0 | IO_L06P_0 | E8 | | |
| 0 | IO_L21N_0 | D7 | NC | NC |
| 0 | IO_L21P_0/VREF_0 | C7 | NC | NC |
| 0 | IO_L22N_0 | B7 | NC | NC |
| 0 | IO_L22P_0 | A7 | NC | NC |
| 0 | IO_L24N_0 | D8 | NC | NC |
| 0 | IO_L24P_0 | C8 | NC | NC |
| 0 | IO_L49N_0 | B8 | NC | |
| 0 | IO_L49P_0 | A8 | NC | |
| 0 | IO_L51N_0 | E9 | NC | |
| 0 | IO_L51P_0/VREF_0 | F9 | NC | |
| 0 | IO_L52N_0 | D9 | NC | |
| 0 | IO_L52P_0 | C9 | NC | |
| 0 | IO_L54N_0 | B9 | NC | |
| 0 | IO_L54P_0 | A9 | NC | |
| 0 | IO_L91N_0/VREF_0 | E10 | | |
| 0 | IO_L91P_0 | F10 | | |
| 0 | IO_L92N_0 | D10 | | |
| 0 | IO_L92P_0 | C10 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 0 | IO_L93N_0 | B10 | | |
| 0 | IO_L93P_0 | A10 | | |
| 0 | IO_L94N_0/VREF_0 | E11 | | |
| 0 | IO_L94P_0 | F11 | | |
| 0 | IO_L95N_0/GCLK7P | D11 | | |
| 0 | IO_L95P_0/GCLK6S | C11 | | |
| 0 | IO_L96N_0/GCLK5P | B11 | | |
| 0 | IO_L96P_0/GCLK4S | A11 | | |
| | | | | |
| 1 | IO_L96N_1/GCLK3P | F12 | | |
| 1 | IO_L96P_1/GCLK2S | F13 | | |
| 1 | IO_L95N_1/GCLK1P | E12 | | |
| 1 | IO_L95P_1/GCLK0S | D12 | | |
| 1 | IO_L94N_1 | C12 | | |
| 1 | IO_L94P_1/VREF_1 | B12 | | |
| 1 | IO_L93N_1 | A13 | | |
| 1 | IO_L93P_1 | B13 | | |
| 1 | IO_L92N_1 | C13 | | |
| 1 | IO_L92P_1 | D13 | | |
| 1 | IO_L91N_1 | E13 | | |
| 1 | IO_L91P_1/VREF_1 | E14 | | |
| 1 | IO_L54N_1 | A14 | NC | |
| 1 | IO_L54P_1 | B14 | NC | |
| 1 | IO_L52N_1 | C14 | NC | |
| 1 | IO_L52P_1 | D14 | NC | |
| 1 | IO_L51N_1/VREF_1 | A15 | NC | |
| 1 | IO_L51P_1 | B15 | NC | |
| 1 | IO_L49N_1 | C15 | NC | |
| 1 | IO_L49P_1 | D15 | NC | |
| 1 | IO_L24N_1 | F14 | NC | NC |
| 1 | IO_L24P_1 | E15 | NC | NC |
| 1 | IO_L22N_1 | A16 | NC | NC |
| 1 | IO_L22P_1 | B16 | NC | NC |
| 1 | IO_L21N_1/VREF_1 | C16 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 1 | IO_L21P_1 | D16 | NC | NC |
| 1 | IO_L06N_1 | E16 | | |
| 1 | IO_L06P_1 | E17 | | |
| 1 | IO_L05N_1 | A17 | | |
| 1 | IO_L05P_1 | B17 | | |
| 1 | IO_L04N_1 | C17 | | |
| 1 | IO_L04P_1/VREF_1 | D17 | | |
| 1 | IO_L03N_1/VRP_1 | A18 | | |
| 1 | IO_L03P_1/VRN_1 | B18 | | |
| 1 | IO_L02N_1 | C18 | | |
| 1 | IO_L02P_1 | D18 | | |
| 1 | IO_L01N_1 | A19 | | |
| 1 | IO_L01P_1 | B19 | | |
| | | | | |
| 2 | IO_L01N_2 | C21 | | |
| 2 | IO_L01P_2 | C22 | | |
| 2 | IO_L02N_2/VRP_2 | E18 | | |
| 2 | IO_L02P_2/VRN_2 | F18 | | |
| 2 | IO_L03N_2 | D21 | | |
| 2 | IO_L03P_2/VREF_2 | D22 | | |
| 2 | IO_L04N_2 | E19 | | |
| 2 | IO_L04P_2 | E20 | | |
| 2 | IO_L06N_2 | E21 | | |
| 2 | IO_L06P_2 | E22 | | |
| 2 | IO_L19N_2 | F19 | NC | NC |
| 2 | IO_L19P_2 | F20 | NC | NC |
| 2 | IO_L21N_2 | F21 | NC | NC |
| 2 | IO_L21P_2/VREF_2 | F22 | NC | NC |
| 2 | IO_L22N_2 | G18 | NC | NC |
| 2 | IO_L22P_2 | H18 | NC | NC |
| 2 | IO_L24N_2 | G19 | NC | NC |
| 2 | IO_L24P_2 | G20 | NC | NC |
| 2 | IO_L43N_2 | G21 | | |
| 2 | IO_L43P_2 | G22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 2 | IO_L45N_2 | H19 | | |
| 2 | IO_L45P_2/VREF_2 | H20 | | |
| 2 | IO_L46N_2 | H21 | | |
| 2 | IO_L46P_2 | H22 | | |
| 2 | IO_L48N_2 | J17 | | |
| 2 | IO_L48P_2 | J18 | | |
| 2 | IO_L49N_2 | J19 | NC | |
| 2 | IO_L49P_2 | J20 | NC | |
| 2 | IO_L51N_2 | J21 | NC | |
| 2 | IO_L51P_2/VREF_2 | J22 | NC | |
| 2 | IO_L52N_2 | K17 | NC | |
| 2 | IO_L52P_2 | K18 | NC | |
| 2 | IO_L54N_2 | K19 | NC | |
| 2 | IO_L54P_2 | K20 | NC | |
| 2 | IO_L91N_2 | K21 | | |
| 2 | IO_L91P_2 | K22 | | |
| 2 | IO_L93N_2 | L17 | | |
| 2 | IO_L93P_2/VREF_2 | L18 | | |
| 2 | IO_L94N_2 | L19 | | |
| 2 | IO_L94P_2 | L20 | | |
| 2 | IO_L96N_2 | L21 | | |
| 2 | IO_L96P_2 | L22 | | |
| | | | | |
| 3 | IO_L96N_3 | M21 | | |
| 3 | IO_L96P_3 | M20 | | |
| 3 | IO_L94N_3 | M19 | | |
| 3 | IO_L94P_3 | M18 | | |
| 3 | IO_L93N_3/VREF_3 | M17 | | |
| 3 | IO_L93P_3 | N17 | | |
| 3 | IO_L91N_3 | N22 | | |
| 3 | IO_L91P_3 | N21 | | |
| 3 | IO_L54N_3 | N20 | NC | |
| 3 | IO_L54P_3 | N19 | NC | |
| 3 | IO_L52N_3 | N18 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 3 | IO_L52P_3 | P18 | NC | |
| 3 | IO_L51N_3/VREF_3 | P22 | NC | |
| 3 | IO_L51P_3 | P21 | NC | |
| 3 | IO_L49N_3 | P20 | NC | |
| 3 | IO_L49P_3 | P19 | NC | |
| 3 | IO_L48N_3 | R22 | | |
| 3 | IO_L48P_3 | R21 | | |
| 3 | IO_L46N_3 | R20 | | |
| 3 | IO_L46P_3 | R19 | | |
| 3 | IO_L45N_3/VREF_3 | R18 | | |
| 3 | IO_L45P_3 | P17 | | |
| 3 | IO_L43N_3 | T22 | | |
| 3 | IO_L43P_3 | T21 | | |
| 3 | IO_L24N_3 | T20 | NC | NC |
| 3 | IO_L24P_3 | T19 | NC | NC |
| 3 | IO_L22N_3 | U22 | NC | NC |
| 3 | IO_L22P_3 | U21 | NC | NC |
| 3 | IO_L21N_3/VREF_3 | U20 | NC | NC |
| 3 | IO_L21P_3 | U19 | NC | NC |
| 3 | IO_L19N_3 | T18 | NC | NC |
| 3 | IO_L19P_3 | U18 | NC | NC |
| 3 | IO_L06N_3 | V22 | | |
| 3 | IO_L06P_3 | V21 | | |
| 3 | IO_L04N_3 | V20 | | |
| 3 | IO_L04P_3 | V19 | | |
| 3 | IO_L03N_3/VREF_3 | W22 | | |
| 3 | IO_L03P_3 | W21 | | |
| 3 | IO_L02N_3/VRP_3 | Y22 | | |
| 3 | IO_L02P_3/VRN_3 | Y21 | | |
| 3 | IO_L01N_3 | W20 | | |
| 3 | IO_L01P_3 | AA20 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AB19 | | |
| 4 | IO_L01P_4/INIT_B | AA19 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 4 | IO_L02N_4/D0/DIN(1) | V18 | | |
| 4 | IO_L02P_4/D1 | V17 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | W18 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | Y18 | | |
| 4 | IO_L04N_4/VREF_4 | AA18 | | |
| 4 | IO_L04P_4 | AB18 | | |
| 4 | IO_L05N_4/VRP_4 | W17 | | |
| 4 | IO_L05P_4/VRN_4 | Y17 | | |
| 4 | IO_L06N_4 | AA17 | | |
| 4 | IO_L06P_4 | AB17 | | |
| 4 | IO_L19N_4 | V16 | NC | NC |
| 4 | IO_L19P_4 | V15 | NC | NC |
| 4 | IO_L21N_4 | W16 | NC | NC |
| 4 | IO_L21P_4/VREF_4 | Y16 | NC | NC |
| 4 | IO_L22N_4 | AA16 | NC | NC |
| 4 | IO_L22P_4 | AB16 | NC | NC |
| 4 | IO_L24N_4 | W15 | NC | NC |
| 4 | IO_L24P_4 | Y15 | NC | NC |
| 4 | IO_L49N_4 | AA15 | NC | |
| 4 | IO_L49P_4 | AB15 | NC | |
| 4 | IO_L51N_4 | U14 | NC | |
| 4 | IO_L51P_4/VREF_4 | V14 | NC | |
| 4 | IO_L52N_4 | W14 | NC | |
| 4 | IO_L52P_4 | Y14 | NC | |
| 4 | IO_L54N_4 | AA14 | NC | |
| 4 | IO_L54P_4 | AB14 | NC | |
| 4 | IO_L91N_4/VREF_4 | U13 | | |
| 4 | IO_L91P_4 | V13 | | |
| 4 | IO_L92N_4 | W13 | | |
| 4 | IO_L92P_4 | Y13 | | |
| 4 | IO_L93N_4 | AA13 | | |
| 4 | IO_L93P_4 | AB13 | | |
| 4 | IO_L94N_4/VREF_4 | U12 | | |
| 4 | IO_L94P_4 | V12 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 4 | IO_L95N_4/GCLK3S | W12 | | |
| 4 | IO_L95P_4/GCLK2P | Y12 | | |
| 4 | IO_L96N_4/GCLK1S | AA12 | | |
| 4 | IO_L96P_4/GCLK0P | AB12 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | AA11 | | |
| 5 | IO_L96P_5/GCLK6P | Y11 | | |
| 5 | IO_L95N_5/GCLK5S | W11 | | |
| 5 | IO_L95P_5/GCLK4P | V11 | | |
| 5 | IO_L94N_5 | U11 | | |
| 5 | IO_L94P_5/VREF_5 | U10 | | |
| 5 | IO_L93N_5 | AB10 | | |
| 5 | IO_L93P_5 | AA10 | | |
| 5 | IO_L92N_5 | Y10 | | |
| 5 | IO_L92P_5 | W10 | | |
| 5 | IO_L91N_5 | V10 | | |
| 5 | IO_L91P_5/VREF_5 | V9 | | |
| 5 | IO_L54N_5 | AB9 | NC | |
| 5 | IO_L54P_5 | AA9 | NC | |
| 5 | IO_L52N_5 | Y9 | NC | |
| 5 | IO_L52P_5 | W9 | NC | |
| 5 | IO_L51N_5/VREF_5 | AB8 | NC | |
| 5 | IO_L51P_5 | AA8 | NC | |
| 5 | IO_L49N_5 | Y8 | NC | |
| 5 | IO_L49P_5 | W8 | NC | |
| 5 | IO_L24N_5 | U9 | NC | NC |
| 5 | IO_L24P_5 | V8 | NC | NC |
| 5 | IO_L22N_5 | AB7 | NC | NC |
| 5 | IO_L22P_5 | AA7 | NC | NC |
| 5 | IO_L21N_5/VREF_5 | Y7 | NC | NC |
| 5 | IO_L21P_5 | W7 | NC | NC |
| 5 | IO_L19N_5 | AB6 | NC | NC |
| 5 | IO_L19P_5 | AA6 | NC | NC |
| 5 | IO_L06N_5 | Y6 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 5 | IO_L06P_5 | W6 | | |
| 5 | IO_L05N_5/VRP_5 | V7 | | |
| 5 | IO_L05P_5/VRN_5 | V6 | | |
| 5 | IO_L04N_5 | AB5 | | |
| 5 | IO_L04P_5/VREF_5 | AA5 | | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | Y5 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | W5 | | |
| 5 | IO_L02N_5/D6 | AB4 | | |
| 5 | IO_L02P_5/D7 | AA4 | | |
| 5 | IO_L01N_5/RDWR_B | Y4 | | |
| 5 | IO_L01P_5/CS_B | AA3 | | |
| | | | | |
| 6 | IO_L01P_6 | V5 | | |
| 6 | IO_L01N_6 | U5 | | |
| 6 | IO_L02P_6/VRN_6 | Y2 | | |
| 6 | IO_L02N_6/VRP_6 | Y1 | | |
| 6 | IO_L03P_6 | V4 | | |
| 6 | IO_L03N_6/VREF_6 | V3 | | |
| 6 | IO_L04P_6 | W2 | | |
| 6 | IO_L04N_6 | W1 | | |
| 6 | IO_L06P_6 | U4 | | |
| 6 | IO_L06N_6 | U3 | | |
| 6 | IO_L19P_6 | V2 | NC | NC |
| 6 | IO_L19N_6 | V1 | NC | NC |
| 6 | IO_L21P_6 | U2 | NC | NC |
| 6 | IO_L21N_6/VREF_6 | U1 | NC | NC |
| 6 | IO_L22P_6 | T5 | NC | NC |
| 6 | IO_L22N_6 | R5 | NC | NC |
| 6 | IO_L24P_6 | T4 | NC | NC |
| 6 | IO_L24N_6 | T3 | NC | NC |
| 6 | IO_L43P_6 | T2 | | |
| 6 | IO_L43N_6 | T1 | | |
| 6 | IO_L45P_6 | R4 | | |
| 6 | IO_L45N_6/VREF_6 | R3 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 6 | IO_L46P_6 | R2 | | |
| 6 | IO_L46N_6 | R1 | | |
| 6 | IO_L48P_6 | P6 | | |
| 6 | IO_L48N_6 | P5 | | |
| 6 | IO_L49P_6 | P4 | NC | |
| 6 | IO_L49N_6 | P3 | NC | |
| 6 | IO_L51P_6 | P2 | NC | |
| 6 | IO_L51N_6/VREF_6 | P1 | NC | |
| 6 | IO_L52P_6 | N6 | NC | |
| 6 | IO_L52N_6 | N5 | NC | |
| 6 | IO_L54P_6 | N4 | NC | |
| 6 | IO_L54N_6 | N3 | NC | |
| 6 | IO_L91P_6 | N2 | | |
| 6 | IO_L91N_6 | N1 | | |
| 6 | IO_L93P_6 | M6 | | |
| 6 | IO_L93N_6/VREF_6 | M5 | | |
| 6 | IO_L94P_6 | M4 | | |
| 6 | IO_L94N_6 | M3 | | |
| 6 | IO_L96P_6 | M2 | | |
| 6 | IO_L96N_6 | M1 | | |
| | | | | |
| 7 | IO_L96P_7 | L2 | | |
| 7 | IO_L96N_7 | L3 | | |
| 7 | IO_L94P_7 | L4 | | |
| 7 | IO_L94N_7 | L5 | | |
| 7 | IO_L93P_7/VREF_7 | K1 | | |
| 7 | IO_L93N_7 | K2 | | |
| 7 | IO_L91P_7 | K3 | | |
| 7 | IO_L91N_7 | K4 | | |
| 7 | IO_L54P_7 | L6 | NC | |
| 7 | IO_L54N_7 | K6 | NC | |
| 7 | IO_L52P_7 | K5 | NC | |
| 7 | IO_L52N_7 | J5 | NC | |
| 7 | IO_L51P_7/VREF_7 | J1 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 7 | IO_L51N_7 | J2 | NC | |
| 7 | IO_L49P_7 | J3 | NC | |
| 7 | IO_L49N_7 | J4 | NC | |
| 7 | IO_L48P_7 | H1 | | |
| 7 | IO_L48N_7 | H2 | | |
| 7 | IO_L46P_7 | H3 | | |
| 7 | IO_L46N_7 | H4 | | |
| 7 | IO_L45P_7/VREF_7 | J6 | | |
| 7 | IO_L45N_7 | H5 | | |
| 7 | IO_L43P_7 | G1 | | |
| 7 | IO_L43N_7 | G2 | | |
| 7 | IO_L24P_7 | G3 | NC | NC |
| 7 | IO_L24N_7 | G4 | NC | NC |
| 7 | IO_L22P_7 | F1 | NC | NC |
| 7 | IO_L22N_7 | F2 | NC | NC |
| 7 | IO_L21P_7/VREF_7 | F3 | NC | NC |
| 7 | IO_L21N_7 | F4 | NC | NC |
| 7 | IO_L19P_7 | G5 | NC | NC |
| 7 | IO_L19N_7 | F5 | NC | NC |
| 7 | IO_L06P_7 | E1 | | |
| 7 | IO_L06N_7 | E2 | | |
| 7 | IO_L04P_7 | E3 | | |
| 7 | IO_L04N_7 | E4 | | |
| 7 | IO_L03P_7/VREF_7 | D1 | | |
| 7 | IO_L03N_7 | D2 | | |
| 7 | IO_L02P_7/VRN_7 | C1 | | |
| 7 | IO_L02N_7/VRP_7 | C2 | | |
| 7 | IO_L01P_7 | E5 | | |
| 7 | IO_L01N_7 | E6 | | |
| | | | | |
| 0 | VCCO_0 | G11 | | |
| 0 | VCCO_0 | G10 | | |
| 0 | VCCO_0 | G9 | | |
| 0 | VCCO_0 | F8 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 0 | VCCO_0 | F7 | | |
| 1 | VCCO_1 | G14 | | |
| 1 | VCCO_1 | G13 | | |
| 1 | VCCO_1 | G12 | | |
| 1 | VCCO_1 | F16 | | |
| 1 | VCCO_1 | F15 | | |
| 2 | VCCO_2 | L16 | | |
| 2 | VCCO_2 | K16 | | |
| 2 | VCCO_2 | J16 | | |
| 2 | VCCO_2 | H17 | | |
| 2 | VCCO_2 | G17 | | |
| 3 | VCCO_3 | T17 | | |
| 3 | VCCO_3 | R17 | | |
| 3 | VCCO_3 | P16 | | |
| 3 | VCCO_3 | N16 | | |
| 3 | VCCO_3 | M16 | | |
| 4 | VCCO_4 | U16 | | |
| 4 | VCCO_4 | U15 | | |
| 4 | VCCO_4 | T14 | | |
| 4 | VCCO_4 | T13 | | |
| 4 | VCCO_4 | T12 | | |
| 5 | VCCO_5 | U8 | | |
| 5 | VCCO_5 | U7 | | |
| 5 | VCCO_5 | T11 | | |
| 5 | VCCO_5 | T10 | | |
| 5 | VCCO_5 | T9 | | |
| 6 | VCCO_6 | T6 | | |
| 6 | VCCO_6 | R6 | | |
| 6 | VCCO_6 | P7 | | |
| 6 | VCCO_6 | N7 | | |
| 6 | VCCO_6 | M7 | | |
| 7 | VCCO_7 | L7 | | |
| 7 | VCCO_7 | K7 | | |
| 7 | VCCO_7 | J7 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| 7 | VCCO_7 | H6 | | |
| 7 | VCCO_7 | G6 | | |
| | | | | |
| NA | CCLK | Y19 | | |
| NA | PROG_B | A2 | | |
| NA | DONE | AB20 | | |
| NA | M0 | AB2 | | |
| NA | M1 | W3 | | |
| NA | M2 | AB3 | | |
| NA | HSWAP_EN | B3 | | |
| NA | TCK | C19 | | |
| NA | TDI | D3 | | |
| NA | TDO | D20 | | |
| NA | TMS | B20 | | |
| NA | PWRDWN_B | AB21 | | |
| NA | DXN | D5 | | |
| NA | DXP | A3 | | |
| NA | VBATT | A21 | | |
| NA | RSVD | A20 | | |
| | | | | |
| NA | VCCAUX | AB11 | | |
| NA | VCCAUX | AA22 | | |
| NA | VCCAUX | AA1 | | |
| NA | VCCAUX | M22 | | |
| NA | VCCAUX | L1 | | |
| NA | VCCAUX | B22 | | |
| NA | VCCAUX | B1 | | |
| NA | VCCAUX | A12 | | |
| NA | VCCINT | U17 | | |
| NA | VCCINT | U6 | | |
| NA | VCCINT | T16 | | |
| NA | VCCINT | T15 | | |
| NA | VCCINT | T8 | | |
| NA | VCCINT | T7 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| NA | VCCINT | R16 | | |
| NA | VCCINT | R7 | | |
| NA | VCCINT | H16 | | |
| NA | VCCINT | H7 | | |
| NA | VCCINT | G16 | | |
| NA | VCCINT | G15 | | |
| NA | VCCINT | G8 | | |
| NA | VCCINT | G7 | | |
| NA | VCCINT | F17 | | |
| NA | VCCINT | F6 | | |
| NA | GND | AB22 | | |
| NA | GND | AB1 | | |
| NA | GND | AA21 | | |
| NA | GND | AA2 | | |
| NA | GND | Y20 | | |
| NA | GND | Y3 | | |
| NA | GND | W19 | | |
| NA | GND | W4 | | |
| NA | GND | P14 | | |
| NA | GND | P13 | | |
| NA | GND | P12 | | |
| NA | GND | P11 | | |
| NA | GND | P10 | | |
| NA | GND | P9 | | |
| NA | GND | N14 | | |
| NA | GND | N13 | | |
| NA | GND | N12 | | |
| NA | GND | N11 | | |
| NA | GND | N10 | | |
| NA | GND | N9 | | |
| NA | GND | M14 | | |
| NA | GND | M13 | | |
| NA | GND | M12 | | |
| NA | GND | M11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

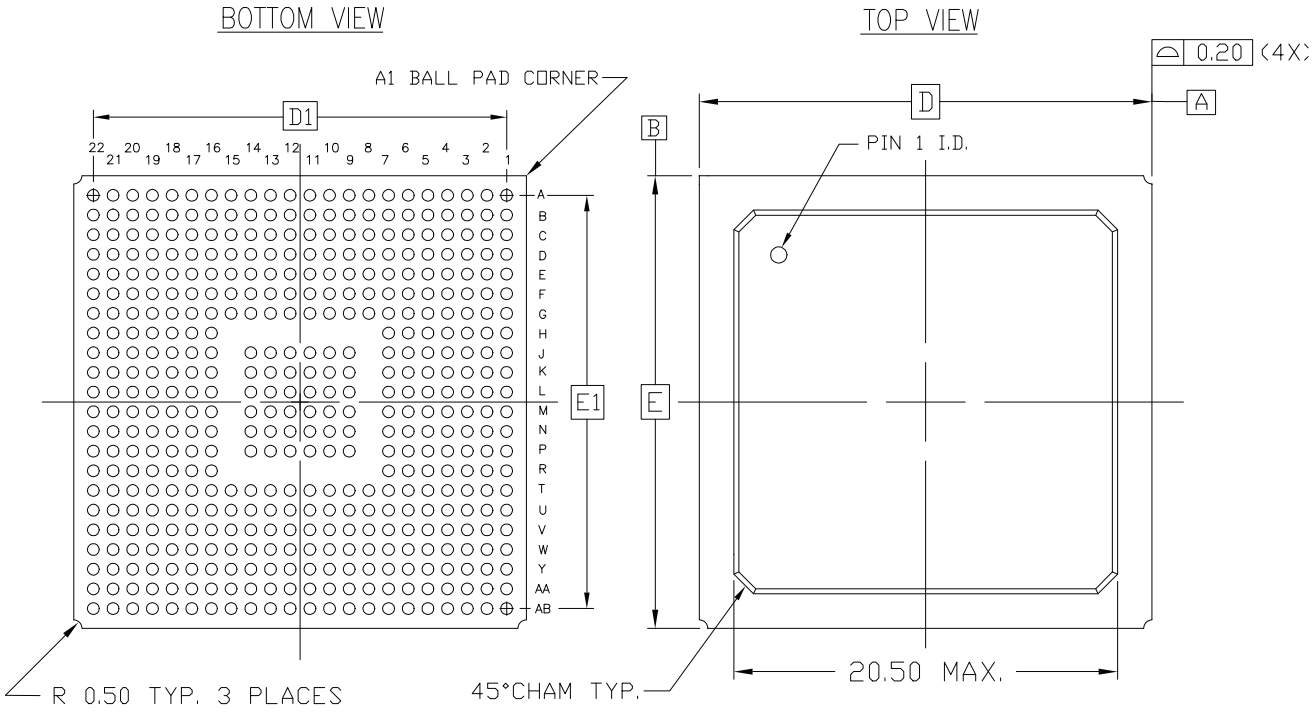

*Table 7:* **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

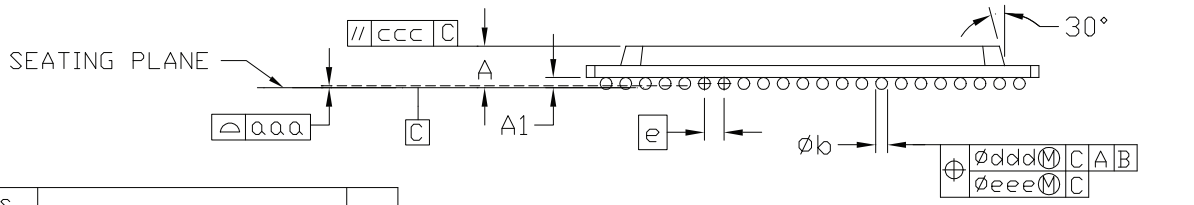
| Bank | Pin Description | Pin Number | No Connect in XC2V250 | No Connect in XC2V500 |
|---|---|---|---|---|
| NA | GND | M10 | | |
| NA | GND | M9 | | |
| NA | GND | L14 | | |
| NA | GND | L13 | | |
| NA | GND | L12 | | |
| NA | GND | L11 | | |
| NA | GND | L10 | | |
| NA | GND | L9 | | |
| NA | GND | K14 | | |
| NA | GND | K13 | | |
| NA | GND | K12 | | |
| NA | GND | K11 | | |
| NA | GND | K10 | | |
| NA | GND | K9 | | |
| NA | GND | J14 | | |
| NA | GND | J13 | | |
| NA | GND | J12 | | |
| NA | GND | J11 | | |
| NA | GND | J10 | | |
| NA | GND | J9 | | |
| NA | GND | D19 | | |
| NA | GND | D4 | | |
| NA | GND | C20 | | |
| NA | GND | C3 | | |
| NA | GND | B21 | | |
| NA | GND | B2 | | |
| NA | GND | A22 | | |
| NA | GND | A1 | | |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG456/FGG456 Fine-Pitch BGA Package Specifications (1.00mm pitch)




FG456 - 63/37 (Sn/Pb) Solder Balls
FGG456 - Sn/Ag/Cu Solder Balls

| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | | | 2.60 | 3 |
| $A_1$ | 0.35 | 0.50 | 0.60 | |
| D/E | 23.00 BSC | | | |
| $D_1/E_1$ | 21.00 REF | | | |
| e | 1.00 BSC | | | |
| øb | 0.50 | 0.60 | 0.70 | |
| aaa | | | 0.20 | |
| ccc | | | 0.35 | |
| ddd | | | 0.30 | |
| eee | | | 0.10 | |
| M | 22 | | | 2 |

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. NOMINAL 'A' DIMENSION FOR 2-LAYER IS 2.03mm AND FOR 4-LAYER IS 2.20mm.
4. CONFORMS TO JEDEC MS-034-AAJ-1 (DEPOPULATED)

456-BALL FINE PITCH BGA (FG456/FGG456)

*Figure 3:* **FG456/FGG456 Fine-Pitch BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG676/FGG676 Fine-Pitch BGA Package

As shown in Table 8, XC2V1500, XC2V2000, and XC2V3000 Virtex-II devices are available in the FG676/FGG676 fine-pitch BGA package. Pins in the XC2V1500, XC2V2000, and XC2V3000 devices are the same, except for the pin differences in the XC2V1500 and XC2V2000 devices shown in the No Connect columns. Following this table are the FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch).

*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | D6 | | |
| 0 | IO_L01P_0 | C6 | | |
| 0 | IO_L02N_0 | B1 | | |
| 0 | IO_L02P_0 | A2 | | |
| 0 | IO_L03N_0/VRP_0 | D7 | | |
| 0 | IO_L03P_0/VRN_0 | C7 | | |
| 0 | IO_L04N_0/VREF_0 | B3 | | |
| 0 | IO_L04P_0 | A3 | | |
| 0 | IO_L05N_0 | G6 | | |
| 0 | IO_L05P_0 | G7 | | |
| 0 | IO_L06N_0 | E6 | | |
| 0 | IO_L06P_0 | E7 | | |
| 0 | IO_L19N_0 | B4 | | |
| 0 | IO_L19P_0 | A4 | | |
| 0 | IO_L21N_0 | B5 | | |
| 0 | IO_L21P_0/VREF_0 | A5 | | |
| 0 | IO_L22N_0 | B6 | | |
| 0 | IO_L22P_0 | A6 | | |
| 0 | IO_L24N_0 | A7 | | |
| 0 | IO_L24P_0 | A8 | | |
| 0 | IO_L25N_0 | E8 | NC | NC |
| 0 | IO_L25P_0 | D8 | NC | NC |
| 0 | IO_L27N_0 | G8 | NC | NC |
| 0 | IO_L27P_0/VREF_0 | F8 | NC | NC |
| 0 | IO_L49N_0 | C8 | | |
| 0 | IO_L49P_0 | B8 | | |
| 0 | IO_L51N_0 | D9 | | |
| 0 | IO_L51P_0/VREF_0 | E9 | | |
| 0 | IO_L52N_0 | F9 | | |
| 0 | IO_L52P_0 | G9 | | |
| 0 | IO_L54N_0 | B9 | | |
| 0 | IO_L54P_0 | A9 | | |
| 0 | IO_L67N_0 | C9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 0 | IO_L67P_0 | C10 | | |
| 0 | IO_L69N_0 | F10 | | |
| 0 | IO_L69P_0/VREF_0 | G10 | | |
| 0 | IO_L70N_0 | E10 | | |
| 0 | IO_L70P_0 | D10 | | |
| 0 | IO_L72N_0 | A10 | | |
| 0 | IO_L72P_0 | A11 | | |
| 0 | IO_L73N_0 | F11 | NC | |
| 0 | IO_L73P_0 | E11 | NC | |
| 0 | IO_L75N_0 | G11 | NC | |
| 0 | IO_L75P_0/VREF_0 | H11 | NC | |
| 0 | IO_L76N_0 | D11 | NC | |
| 0 | IO_L76P_0 | C11 | NC | |
| 0 | IO_L78N_0 | B11 | NC | |
| 0 | IO_L78P_0 | B12 | NC | |
| 0 | IO_L91N_0/VREF_0 | G12 | | |
| 0 | IO_L91P_0 | H12 | | |
| 0 | IO_L92N_0 | F12 | | |
| 0 | IO_L92P_0 | E12 | | |
| 0 | IO_L93N_0 | D12 | | |
| 0 | IO_L93P_0 | C12 | | |
| 0 | IO_L94N_0/VREF_0 | G13 | | |
| 0 | IO_L94P_0 | H13 | | |
| 0 | IO_L95N_0/GCLK7P | F13 | | |
| 0 | IO_L95P_0/GCLK6S | E13 | | |
| 0 | IO_L96N_0/GCLK5P | D13 | | |
| 0 | IO_L96P_0/GCLK4S | C13 | | |
| | | | | |
| 1 | IO_L96N_1/GCLK3P | H14 | | |
| 1 | IO_L96P_1/GCLK2S | H15 | | |
| 1 | IO_L95N_1/GCLK1P | G14 | | |
| 1 | IO_L95P_1/GCLK0S | F14 | | |
| 1 | IO_L94N_1 | E14 | | |
| 1 | IO_L94P_1/VREF_1 | D14 | | |
| 1 | IO_L93N_1 | A12 | | |
| 1 | IO_L93P_1 | A13 | | |
| 1 | IO_L92N_1 | A14 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 1 | IO_L92P_1 | A15 | | |
| 1 | IO_L91N_1 | B15 | | |
| 1 | IO_L91P_1/VREF_1 | C15 | | |
| 1 | IO_L78N_1 | D15 | NC | |
| 1 | IO_L78P_1 | E15 | NC | |
| 1 | IO_L76N_1 | F15 | NC | |
| 1 | IO_L76P_1 | G15 | NC | |
| 1 | IO_L75N_1/VREF_1 | G16 | NC | |
| 1 | IO_L75P_1 | F16 | NC | |
| 1 | IO_L73N_1 | A16 | NC | |
| 1 | IO_L73P_1 | A17 | NC | |
| 1 | IO_L72N_1 | B16 | | |
| 1 | IO_L72P_1 | C16 | | |
| 1 | IO_L70N_1 | D16 | | |
| 1 | IO_L70P_1 | E16 | | |
| 1 | IO_L69N_1/VREF_1 | C17 | | |
| 1 | IO_L69P_1 | D17 | | |
| 1 | IO_L67N_1 | H16 | | |
| 1 | IO_L67P_1 | G17 | | |
| 1 | IO_L54N_1 | E17 | | |
| 1 | IO_L54P_1 | F17 | | |
| 1 | IO_L52N_1 | A18 | | |
| 1 | IO_L52P_1 | A19 | | |
| 1 | IO_L51N_1/VREF_1 | E18 | | |
| 1 | IO_L51P_1 | D18 | | |
| 1 | IO_L49N_1 | B18 | | |
| 1 | IO_L49P_1 | C18 | | |
| 1 | IO_L27N_1/VREF_1 | F19 | NC | NC |
| 1 | IO_L27P_1 | F18 | NC | NC |
| 1 | IO_L25N_1 | G18 | NC | NC |
| 1 | IO_L25P_1 | G19 | NC | NC |
| 1 | IO_L24N_1 | B19 | | |
| 1 | IO_L24P_1 | C19 | | |
| 1 | IO_L22N_1 | D19 | | |
| 1 | IO_L22P_1 | E19 | | |
| 1 | IO_L21N_1/VREF_1 | A20 | | |
| 1 | IO_L21P_1 | A21 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 1 | IO_L19N_1 | E20 | | |
| 1 | IO_L19P_1 | F20 | | |
| 1 | IO_L06N_1 | B21 | | |
| 1 | IO_L06P_1 | B22 | | |
| 1 | IO_L05N_1 | A22 | | |
| 1 | IO_L05P_1 | A23 | | |
| 1 | IO_L04N_1 | C21 | | |
| 1 | IO_L04P_1/VREF_1 | D21 | | |
| 1 | IO_L03N_1/VRP_1 | C20 | | |
| 1 | IO_L03P_1/VRN_1 | D20 | | |
| 1 | IO_L02N_1 | A24 | | |
| 1 | IO_L02P_1 | A25 | | |
| 1 | IO_L01N_1 | B23 | | |
| 1 | IO_L01P_1 | B24 | | |
| | | | | |
| 2 | IO_L01N_2 | B26 | | |
| 2 | IO_L01P_2 | C26 | | |
| 2 | IO_L02N_2/VRP_2 | G20 | | |
| 2 | IO_L02P_2/VRN_2 | H20 | | |
| 2 | IO_L03N_2 | C25 | | |
| 2 | IO_L03P_2/VREF_2 | D25 | | |
| 2 | IO_L04N_2 | E23 | | |
| 2 | IO_L04P_2 | E24 | | |
| 2 | IO_L06N_2 | G21 | | |
| 2 | IO_L06P_2 | G22 | | |
| 2 | IO_L19N_2 | D26 | | |
| 2 | IO_L19P_2 | E26 | | |
| 2 | IO_L21N_2 | F23 | | |
| 2 | IO_L21P_2/VREF_2 | F24 | | |
| 2 | IO_L22N_2 | E25 | | |
| 2 | IO_L22P_2 | F25 | | |
| 2 | IO_L24N_2 | H22 | | |
| 2 | IO_L24P_2 | H21 | | |
| 2 | IO_L25N_2 | G23 | NC | NC |
| 2 | IO_L25P_2 | G24 | NC | NC |
| 2 | IO_L43N_2 | F26 | | |
| 2 | IO_L43P_2 | G26 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 2 | IO_L45N_2 | H23 | | |
| 2 | IO_L45P_2/VREF_2 | H24 | | |
| 2 | IO_L46N_2 | J21 | | |
| 2 | IO_L46P_2 | J20 | | |
| 2 | IO_L48N_2 | H25 | | |
| 2 | IO_L48P_2 | H26 | | |
| 2 | IO_L49N_2 | J22 | | |
| 2 | IO_L49P_2 | J23 | | |
| 2 | IO_L51N_2 | K21 | | |
| 2 | IO_L51P_2/VREF_2 | K22 | | |
| 2 | IO_L52N_2 | K20 | | |
| 2 | IO_L52P_2 | L20 | | |
| 2 | IO_L54N_2 | J24 | | |
| 2 | IO_L54P_2 | J25 | | |
| 2 | IO_L67N_2 | K23 | | |
| 2 | IO_L67P_2 | K24 | | |
| 2 | IO_L69N_2 | J26 | | |
| 2 | IO_L69P_2/VREF_2 | K26 | | |
| 2 | IO_L70N_2 | L22 | | |
| 2 | IO_L70P_2 | L21 | | |
| 2 | IO_L72N_2 | L25 | | |
| 2 | IO_L72P_2 | L26 | | |
| 2 | IO_L73N_2 | L19 | NC | |
| 2 | IO_L73P_2 | M19 | NC | |
| 2 | IO_L75N_2 | L23 | NC | |
| 2 | IO_L75P_2/VREF_2 | L24 | NC | |
| 2 | IO_L76N_2 | M22 | NC | |
| 2 | IO_L76P_2 | M21 | NC | |
| 2 | IO_L78N_2 | M23 | NC | |
| 2 | IO_L78P_2 | M24 | NC | |
| 2 | IO_L91N_2 | M25 | | |
| 2 | IO_L91P_2 | M26 | | |
| 2 | IO_L93N_2 | M20 | | |
| 2 | IO_L93P_2/VREF_2 | N20 | | |
| 2 | IO_L94N_2 | N22 | | |
| 2 | IO_L94P_2 | N21 | | |
| 2 | IO_L96N_2 | N24 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 2 | IO_L96P_2 | N23 | | |
| | | | | |
| 3 | IO_L96N_3 | N26 | | |
| 3 | IO_L96P_3 | P26 | | |
| 3 | IO_L94N_3 | P23 | | |
| 3 | IO_L94P_3 | P22 | | |
| 3 | IO_L93N_3/VREF_3 | P19 | | |
| 3 | IO_L93P_3 | N19 | | |
| 3 | IO_L91N_3 | P21 | | |
| 3 | IO_L91P_3 | P20 | | |
| 3 | IO_L78N_3 | R26 | NC | |
| 3 | IO_L78P_3 | R25 | NC | |
| 3 | IO_L76N_3 | R20 | NC | |
| 3 | IO_L76P_3 | R19 | NC | |
| 3 | IO_L75N_3/VREF_3 | R24 | NC | |
| 3 | IO_L75P_3 | R23 | NC | |
| 3 | IO_L73N_3 | R22 | NC | |
| 3 | IO_L73P_3 | R21 | NC | |
| 3 | IO_L72N_3 | T26 | | |
| 3 | IO_L72P_3 | T25 | | |
| 3 | IO_L70N_3 | T20 | | |
| 3 | IO_L70P_3 | T19 | | |
| 3 | IO_L69N_3/VREF_3 | T24 | | |
| 3 | IO_L69P_3 | T23 | | |
| 3 | IO_L67N_3 | T22 | | |
| 3 | IO_L67P_3 | T21 | | |
| 3 | IO_L54N_3 | U26 | | |
| 3 | IO_L54P_3 | V26 | | |
| 3 | IO_L52N_3 | U24 | | |
| 3 | IO_L52P_3 | U23 | | |
| 3 | IO_L51N_3/VREF_3 | U22 | | |
| 3 | IO_L51P_3 | U21 | | |
| 3 | IO_L49N_3 | V25 | | |
| 3 | IO_L49P_3 | V24 | | |
| 3 | IO_L48N_3 | V23 | | |
| 3 | IO_L48P_3 | V22 | | |
| 3 | IO_L46N_3 | W26 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 3 | IO_L46P_3 | Y26 | | |
| 3 | IO_L45N_3/VREF_3 | U20 | | |
| 3 | IO_L45P_3 | V20 | | |
| 3 | IO_L43N_3 | W25 | | |
| 3 | IO_L43P_3 | W24 | | |
| 3 | IO_L25N_3 | V21 | NC | NC |
| 3 | IO_L25P_3 | W21 | NC | NC |
| 3 | IO_L24N_3 | AA26 | | |
| 3 | IO_L24P_3 | AA25 | | |
| 3 | IO_L22N_3 | Y24 | | |
| 3 | IO_L22P_3 | Y23 | | |
| 3 | IO_L21N_3/VREF_3 | W22 | | |
| 3 | IO_L21P_3 | W23 | | |
| 3 | IO_L19N_3 | AB26 | | |
| 3 | IO_L19P_3 | AB25 | | |
| 3 | IO_L06N_3 | AC26 | | |
| 3 | IO_L06P_3 | AC25 | | |
| 3 | IO_L04N_3 | AD26 | | |
| 3 | IO_L04P_3 | AD25 | | |
| 3 | IO_L03N_3/VREF_3 | AA24 | | |
| 3 | IO_L03P_3 | AA23 | | |
| 3 | IO_L02N_3/VRP_3 | AB24 | | |
| 3 | IO_L02P_3/VRN_3 | AB23 | | |
| 3 | IO_L01N_3 | Y22 | | |
| 3 | IO_L01P_3 | AA22 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AD21 | | |
| 4 | IO_L01P_4/INIT_B | AC21 | | |
| 4 | IO_L02N_4/D0/DIN(1) | Y20 | | |
| 4 | IO_L02P_4/D1 | Y19 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AA20 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AB20 | | |
| 4 | IO_L04N_4/VREF_4 | AC22 | | |
| 4 | IO_L04P_4 | AE21 | | |
| 4 | IO_L05N_4/VRP_4 | AE26 | | |
| 4 | IO_L05P_4/VRN_4 | AF25 | | |
| 4 | IO_L06N_4 | W20 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 4 | IO_L06P_4 | Y21 | | |
| 4 | IO_L19N_4 | AE24 | | |
| 4 | IO_L19P_4 | AF24 | | |
| 4 | IO_L21N_4 | AE23 | | |
| 4 | IO_L21P_4/VREF_4 | AF23 | | |
| 4 | IO_L22N_4 | AE22 | | |
| 4 | IO_L22P_4 | AF22 | | |
| 4 | IO_L24N_4 | AF21 | | |
| 4 | IO_L24P_4 | AF20 | | |
| 4 | IO_L25N_4 | AA19 | NC | NC |
| 4 | IO_L25P_4 | AB19 | NC | NC |
| 4 | IO_L27N_4 | AD20 | NC | NC |
| 4 | IO_L27P_4/VREF_4 | AC20 | NC | NC |
| 4 | IO_L28N_4 | AC19 | NC | NC |
| 4 | IO_L28P_4 | AD19 | NC | NC |
| 4 | IO_L49N_4 | AE19 | | |
| 4 | IO_L49P_4 | AF19 | | |
| 4 | IO_L51N_4 | AA18 | | |
| 4 | IO_L51P_4/VREF_4 | AB18 | | |
| 4 | IO_L52N_4 | Y18 | | |
| 4 | IO_L52P_4 | Y17 | | |
| 4 | IO_L54N_4 | AC18 | | |
| 4 | IO_L54P_4 | AD18 | | |
| 4 | IO_L67N_4 | AE18 | | |
| 4 | IO_L67P_4 | AF18 | | |
| 4 | IO_L69N_4 | AA17 | | |
| 4 | IO_L69P_4/VREF_4 | AB17 | | |
| 4 | IO_L70N_4 | AC17 | | |
| 4 | IO_L70P_4 | AD17 | | |
| 4 | IO_L72N_4 | AF17 | | |
| 4 | IO_L72P_4 | AF16 | | |
| 4 | IO_L73N_4 | AB16 | NC | |
| 4 | IO_L73P_4 | AC16 | NC | |
| 4 | IO_L75N_4 | AA16 | NC | |
| 4 | IO_L75P_4/VREF_4 | Y16 | NC | |
| 4 | IO_L76N_4 | AD16 | NC | |
| 4 | IO_L76P_4 | AE16 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 4 | IO_L78N_4 | Y15 | NC | |
| 4 | IO_L78P_4 | AA15 | NC | |
| 4 | IO_L91N_4/VREF_4 | W15 | | |
| 4 | IO_L91P_4 | W16 | | |
| 4 | IO_L92N_4 | AB15 | | |
| 4 | IO_L92P_4 | AC15 | | |
| 4 | IO_L93N_4 | AD15 | | |
| 4 | IO_L93P_4 | AE15 | | |
| 4 | IO_L94N_4/VREF_4 | W14 | | |
| 4 | IO_L94P_4 | Y14 | | |
| 4 | IO_L95N_4/GCLK3S | AA14 | | |
| 4 | IO_L95P_4/GCLK2P | AB14 | | |
| 4 | IO_L96N_4/GCLK1S | AC14 | | |
| 4 | IO_L96P_4/GCLK0P | AD14 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | AC13 | | |
| 5 | IO_L96P_5/GCLK6P | AB13 | | |
| 5 | IO_L95N_5/GCLK5S | AA13 | | |
| 5 | IO_L95P_5/GCLK4P | Y13 | | |
| 5 | IO_L94N_5 | W13 | | |
| 5 | IO_L94P_5/VREF_5 | W12 | | |
| 5 | IO_L93N_5 | AF15 | | |
| 5 | IO_L93P_5 | AF14 | | |
| 5 | IO_L92N_5 | AF13 | | |
| 5 | IO_L92P_5 | AF12 | | |
| 5 | IO_L91N_5 | AE12 | | |
| 5 | IO_L91P_5/VREF_5 | AD12 | | |
| 5 | IO_L78N_5 | AC12 | NC | |
| 5 | IO_L78P_5 | AB12 | NC | |
| 5 | IO_L76N_5 | AA12 | NC | |
| 5 | IO_L76P_5 | Y12 | NC | |
| 5 | IO_L75N_5/VREF_5 | AF11 | NC | |
| 5 | IO_L75P_5 | AF10 | NC | |
| 5 | IO_L73N_5 | AE11 | NC | |
| 5 | IO_L73P_5 | AD11 | NC | |
| 5 | IO_L72N_5 | AC11 | | |
| 5 | IO_L72P_5 | AB11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 5 | IO_L70N_5 | W11 | | |
| 5 | IO_L70P_5 | Y10 | | |
| 5 | IO_L69N_5/VREF_5 | Y11 | | |
| 5 | IO_L69P_5 | AA11 | | |
| 5 | IO_L67N_5 | AF9 | | |
| 5 | IO_L67P_5 | AF8 | | |
| 5 | IO_L54N_5 | AE9 | | |
| 5 | IO_L54P_5 | AD9 | | |
| 5 | IO_L52N_5 | AB10 | | |
| 5 | IO_L52P_5 | AA10 | | |
| 5 | IO_L51N_5/VREF_5 | AD10 | | |
| 5 | IO_L51P_5 | AC10 | | |
| 5 | IO_L49N_5 | AE8 | | |
| 5 | IO_L49P_5 | AF7 | | |
| 5 | IO_L28N_5 | AD8 | NC | NC |
| 5 | IO_L28P_5 | AC8 | NC | NC |
| 5 | IO_L27N_5/VREF_5 | AB9 | NC | NC |
| 5 | IO_L27P_5 | AC9 | NC | NC |
| 5 | IO_L25N_5 | AA9 | NC | NC |
| 5 | IO_L25P_5 | Y9 | NC | NC |
| 5 | IO_L24N_5 | AF6 | | |
| 5 | IO_L24P_5 | AE6 | | |
| 5 | IO_L22N_5 | AB8 | | |
| 5 | IO_L22P_5 | AA8 | | |
| 5 | IO_L21N_5/VREF_5 | AC7 | | |
| 5 | IO_L21P_5 | AD7 | | |
| 5 | IO_L19N_5 | AF5 | | |
| 5 | IO_L19P_5 | AE5 | | |
| 5 | IO_L06N_5 | AF4 | | |
| 5 | IO_L06P_5 | AE4 | | |
| 5 | IO_L05N_5/VRP_5 | AF3 | | |
| 5 | IO_L05P_5/VRN_5 | AE3 | | |
| 5 | IO_L04N_5 | Y8 | | |
| 5 | IO_L04P_5/VREF_5 | Y7 | | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AB7 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AA7 | | |
| 5 | IO_L02N_5/D6 | AD6 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 5 | IO_L02P_5/D7 | AC6 | | |
| 5 | IO_L01N_5/RDWR_B | AB6 | | |
| 5 | IO_L01P_5/CS_B | AC5 | | |
| | | | | |
| 6 | IO_L01P_6 | AF2 | | |
| 6 | IO_L01N_6 | AE1 | | |
| 6 | IO_L02P_6/VRN_6 | AB4 | | |
| 6 | IO_L02N_6/VRP_6 | AB3 | | |
| 6 | IO_L03P_6 | AD2 | | |
| 6 | IO_L03N_6/VREF_6 | AD1 | | |
| 6 | IO_L04P_6 | AC2 | | |
| 6 | IO_L04N_6 | AC1 | | |
| 6 | IO_L06P_6 | AB2 | | |
| 6 | IO_L06N_6 | AB1 | | |
| 6 | IO_L19P_6 | AA4 | | |
| 6 | IO_L19N_6 | AA3 | | |
| 6 | IO_L21P_6 | Y6 | | |
| 6 | IO_L21N_6/VREF_6 | Y5 | | |
| 6 | IO_L22P_6 | W6 | | |
| 6 | IO_L22N_6 | W7 | | |
| 6 | IO_L24P_6 | AA2 | | |
| 6 | IO_L24N_6 | AA1 | | |
| 6 | IO_L25P_6 | Y4 | NC | NC |
| 6 | IO_L25N_6 | Y3 | NC | NC |
| 6 | IO_L43P_6 | W5 | | |
| 6 | IO_L43N_6 | W4 | | |
| 6 | IO_L45P_6 | W2 | | |
| 6 | IO_L45N_6/VREF_6 | W3 | | |
| 6 | IO_L46P_6 | Y1 | | |
| 6 | IO_L46N_6 | W1 | | |
| 6 | IO_L48P_6 | V6 | | |
| 6 | IO_L48N_6 | V7 | | |
| 6 | IO_L49P_6 | V5 | | |
| 6 | IO_L49N_6 | V4 | | |
| 6 | IO_L51P_6 | V3 | | |
| 6 | IO_L51N_6/VREF_6 | V2 | | |
| 6 | IO_L52P_6 | V1 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 6 | IO_L52N_6 | U1 | | |
| 6 | IO_L54P_6 | U7 | | |
| 6 | IO_L54N_6 | T7 | | |
| 6 | IO_L67P_6 | U4 | | |
| 6 | IO_L67N_6 | U3 | | |
| 6 | IO_L69P_6 | U6 | | |
| 6 | IO_L69N_6/VREF_6 | U5 | | |
| 6 | IO_L70P_6 | T5 | | |
| 6 | IO_L70N_6 | T6 | | |
| 6 | IO_L72P_6 | T8 | | |
| 6 | IO_L72N_6 | R8 | | |
| 6 | IO_L73P_6 | T2 | NC | |
| 6 | IO_L73N_6 | T1 | NC | |
| 6 | IO_L75P_6 | T4 | NC | |
| 6 | IO_L75N_6/VREF_6 | T3 | NC | |
| 6 | IO_L76P_6 | R6 | NC | |
| 6 | IO_L76N_6 | R5 | NC | |
| 6 | IO_L78P_6 | R4 | NC | |
| 6 | IO_L78N_6 | R3 | NC | |
| 6 | IO_L91P_6 | R2 | | |
| 6 | IO_L91N_6 | R1 | | |
| 6 | IO_L93P_6 | R7 | | |
| 6 | IO_L93N_6/VREF_6 | P7 | | |
| 6 | IO_L94P_6 | P6 | | |
| 6 | IO_L94N_6 | P5 | | |
| 6 | IO_L96P_6 | P4 | | |
| 6 | IO_L96N_6 | P3 | | |
| | | | | |
| 7 | IO_L96P_7 | P1 | | |
| 7 | IO_L96N_7 | N1 | | |
| 7 | IO_L94P_7 | N4 | | |
| 7 | IO_L94N_7 | N5 | | |
| 7 | IO_L93P_7/VREF_7 | N6 | | |
| 7 | IO_L93N_7 | N7 | | |
| 7 | IO_L91P_7 | P8 | | |
| 7 | IO_L91N_7 | N8 | | |
| 7 | IO_L78P_7 | M1 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 7 | IO_L78N_7 | M2 | NC | |
| 7 | IO_L76P_7 | M5 | NC | |
| 7 | IO_L76N_7 | M6 | NC | |
| 7 | IO_L75P_7/VREF_7 | M3 | NC | |
| 7 | IO_L75N_7 | M4 | NC | |
| 7 | IO_L73P_7 | M7 | NC | |
| 7 | IO_L73N_7 | M8 | NC | |
| 7 | IO_L72P_7 | L1 | | |
| 7 | IO_L72N_7 | L2 | | |
| 7 | IO_L70P_7 | L5 | | |
| 7 | IO_L70N_7 | L6 | | |
| 7 | IO_L69P_7/VREF_7 | L3 | | |
| 7 | IO_L69N_7 | L4 | | |
| 7 | IO_L67P_7 | K1 | | |
| 7 | IO_L67N_7 | J1 | | |
| 7 | IO_L54P_7 | K3 | | |
| 7 | IO_L54N_7 | K4 | | |
| 7 | IO_L52P_7 | K5 | | |
| 7 | IO_L52N_7 | K6 | | |
| 7 | IO_L51P_7/VREF_7 | L8 | | |
| 7 | IO_L51N_7 | L7 | | |
| 7 | IO_L49P_7 | J2 | | |
| 7 | IO_L49N_7 | H1 | | |
| 7 | IO_L48P_7 | J3 | | |
| 7 | IO_L48N_7 | J4 | | |
| 7 | IO_L46P_7 | J5 | | |
| 7 | IO_L46N_7 | J6 | | |
| 7 | IO_L45P_7/VREF_7 | H5 | | |
| 7 | IO_L45N_7 | H4 | | |
| 7 | IO_L43P_7 | K7 | | |
| 7 | IO_L43N_7 | J7 | | |
| 7 | IO_L25P_7 | H2 | NC | NC |
| 7 | IO_L25N_7 | H3 | NC | NC |
| 7 | IO_L24P_7 | G1 | | |
| 7 | IO_L24N_7 | F1 | | |
| 7 | IO_L22P_7 | G3 | | |
| 7 | IO_L22N_7 | G4 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 7 | IO_L21P_7/VREF_7 | F3 | | |
| 7 | IO_L21N_7 | F2 | | |
| 7 | IO_L19P_7 | H6 | | |
| 7 | IO_L19N_7 | H7 | | |
| 7 | IO_L06P_7 | E1 | | |
| 7 | IO_L06N_7 | E2 | | |
| 7 | IO_L04P_7 | D1 | | |
| 7 | IO_L04N_7 | D2 | | |
| 7 | IO_L03P_7/VREF_7 | C1 | | |
| 7 | IO_L03N_7 | C2 | | |
| 7 | IO_L02P_7/VRN_7 | E3 | | |
| 7 | IO_L02N_7/VRP_7 | E4 | | |
| 7 | IO_L01P_7 | G5 | | |
| 7 | IO_L01N_7 | F4 | | |
| | | | | |
| 0 | VCCO_0 | J13 | | |
| 0 | VCCO_0 | J12 | | |
| 0 | VCCO_0 | J11 | | |
| 0 | VCCO_0 | H10 | | |
| 0 | VCCO_0 | H9 | | |
| 0 | VCCO_0 | B10 | | |
| 0 | VCCO_0 | B7 | | |
| 1 | VCCO_1 | B17 | | |
| 1 | VCCO_1 | J16 | | |
| 1 | VCCO_1 | J15 | | |
| 1 | VCCO_1 | J14 | | |
| 1 | VCCO_1 | H18 | | |
| 1 | VCCO_1 | H17 | | |
| 1 | VCCO_1 | B20 | | |
| 2 | VCCO_2 | N18 | | |
| 2 | VCCO_2 | M18 | | |
| 2 | VCCO_2 | L18 | | |
| 2 | VCCO_2 | K25 | | |
| 2 | VCCO_2 | K19 | | |
| 2 | VCCO_2 | J19 | | |
| 2 | VCCO_2 | G25 | | |
| 3 | VCCO_3 | Y25 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| 3 | VCCO_3 | V19 | | |
| 3 | VCCO_3 | U25 | | |
| 3 | VCCO_3 | U19 | | |
| 3 | VCCO_3 | T18 | | |
| 3 | VCCO_3 | R18 | | |
| 3 | VCCO_3 | P18 | | |
| 4 | VCCO_4 | AE20 | | |
| 4 | VCCO_4 | AE17 | | |
| 4 | VCCO_4 | W18 | | |
| 4 | VCCO_4 | W17 | | |
| 4 | VCCO_4 | V16 | | |
| 4 | VCCO_4 | V15 | | |
| 4 | VCCO_4 | V14 | | |
| 5 | VCCO_5 | AE10 | | |
| 5 | VCCO_5 | AE7 | | |
| 5 | VCCO_5 | W10 | | |
| 5 | VCCO_5 | W9 | | |
| 5 | VCCO_5 | V13 | | |
| 5 | VCCO_5 | V12 | | |
| 5 | VCCO_5 | V11 | | |
| 6 | VCCO_6 | Y2 | | |
| 6 | VCCO_6 | V8 | | |
| 6 | VCCO_6 | U8 | | |
| 6 | VCCO_6 | U2 | | |
| 6 | VCCO_6 | T9 | | |
| 6 | VCCO_6 | R9 | | |
| 6 | VCCO_6 | P9 | | |
| 7 | VCCO_7 | N9 | | |
| 7 | VCCO_7 | M9 | | |
| 7 | VCCO_7 | L9 | | |
| 7 | VCCO_7 | K8 | | |
| 7 | VCCO_7 | K2 | | |
| 7 | VCCO_7 | J8 | | |
| 7 | VCCO_7 | G2 | | |
| | | | | |
| NA | CCLK | AB21 | | |
| NA | PROG_B | C4 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| NA | DONE | AD22 | | |
| NA | M0 | AD4 | | |
| NA | M1 | AA5 | | |
| NA | M2 | AD5 | | |
| NA | HSWAP_EN | D5 | | |
| NA | TCK | E21 | | |
| NA | TDI | F5 | | |
| NA | TDO | F22 | | |
| NA | TMS | D22 | | |
| NA | PWRDWN_B | AD23 | | |
| NA | DXN | F7 | | |
| NA | DXP | C5 | | |
| NA | VBATT | C23 | | |
| NA | RSVD | C22 | | |
| | | | | |
| NA | VCCAUX | AD13 | | |
| NA | VCCAUX | AC24 | | |
| NA | VCCAUX | AC3 | | |
| NA | VCCAUX | P24 | | |
| NA | VCCAUX | N3 | | |
| NA | VCCAUX | D24 | | |
| NA | VCCAUX | D3 | | |
| NA | VCCAUX | C14 | | |
| NA | VCCINT | W19 | | |
| NA | VCCINT | W8 | | |
| NA | VCCINT | V18 | | |
| NA | VCCINT | V17 | | |
| NA | VCCINT | V10 | | |
| NA | VCCINT | V9 | | |
| NA | VCCINT | U18 | | |
| NA | VCCINT | U9 | | |
| NA | VCCINT | K18 | | |
| NA | VCCINT | K9 | | |
| NA | VCCINT | J18 | | |
| NA | VCCINT | J17 | | |
| NA | VCCINT | J10 | | |
| NA | VCCINT | J9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| NA | VCCINT | H19 | | |
| NA | VCCINT | H8 | | |
| NA | GND | AF26 | | |
| NA | GND | AF1 | | |
| NA | GND | AE25 | | |
| NA | GND | AE14 | | |
| NA | GND | AE13 | | |
| NA | GND | AE2 | | |
| NA | GND | AD24 | | |
| NA | GND | AD3 | | |
| NA | GND | AC23 | | |
| NA | GND | AC4 | | |
| NA | GND | AB22 | | |
| NA | GND | AB5 | | |
| NA | GND | AA21 | | |
| NA | GND | AA6 | | |
| NA | GND | U17 | | |
| NA | GND | U16 | | |
| NA | GND | U15 | | |
| NA | GND | U14 | | |
| NA | GND | U13 | | |
| NA | GND | U12 | | |
| NA | GND | U11 | | |
| NA | GND | U10 | | |
| NA | GND | T17 | | |
| NA | GND | T16 | | |
| NA | GND | T15 | | |
| NA | GND | T14 | | |
| NA | GND | T13 | | |
| NA | GND | T12 | | |
| NA | GND | T11 | | |
| NA | GND | T10 | | |
| NA | GND | R17 | | |
| NA | GND | R16 | | |
| NA | GND | R15 | | |
| NA | GND | R14 | | |
| NA | GND | R13 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| NA | GND | R12 | | |
| NA | GND | R11 | | |
| NA | GND | R10 | | |
| NA | GND | P25 | | |
| NA | GND | P17 | | |
| NA | GND | P16 | | |
| NA | GND | P15 | | |
| NA | GND | P14 | | |
| NA | GND | P13 | | |
| NA | GND | P12 | | |
| NA | GND | P11 | | |
| NA | GND | P10 | | |
| NA | GND | P2 | | |
| NA | GND | N25 | | |
| NA | GND | N17 | | |
| NA | GND | N16 | | |
| NA | GND | N15 | | |
| NA | GND | N14 | | |
| NA | GND | N13 | | |
| NA | GND | N12 | | |
| NA | GND | N11 | | |
| NA | GND | N10 | | |
| NA | GND | N2 | | |
| NA | GND | M17 | | |
| NA | GND | M16 | | |
| NA | GND | M15 | | |
| NA | GND | M14 | | |
| NA | GND | M13 | | |
| NA | GND | M12 | | |
| NA | GND | M11 | | |
| NA | GND | M10 | | |
| NA | GND | L17 | | |
| NA | GND | L16 | | |
| NA | GND | L15 | | |
| NA | GND | L14 | | |
| NA | GND | L13 | | |
| NA | GND | L12 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

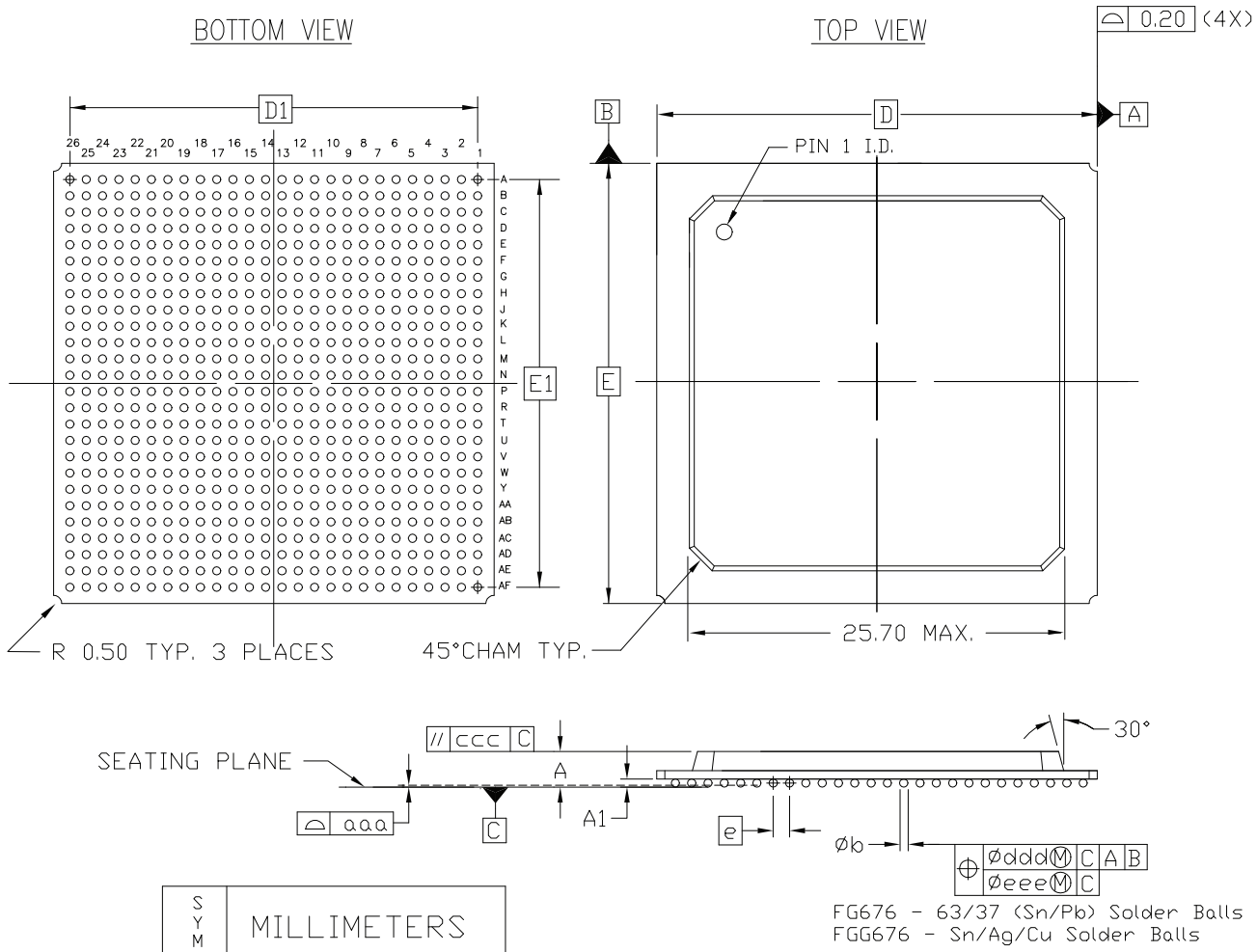

*Table 8:* **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1500 | No Connect in XC2V2000 |
|---|---|---|---|---|
| NA | GND | L11 | | |
| NA | GND | L10 | | |
| NA | GND | K17 | | |
| NA | GND | K16 | | |
| NA | GND | K15 | | |
| NA | GND | K14 | | |
| NA | GND | K13 | | |
| NA | GND | K12 | | |
| NA | GND | K11 | | |
| NA | GND | K10 | | |
| NA | GND | F21 | | |
| NA | GND | F6 | | |
| NA | GND | E22 | | |
| NA | GND | E5 | | |
| NA | GND | D23 | | |
| NA | GND | D4 | | |
| NA | GND | C24 | | |
| NA | GND | C3 | | |
| NA | GND | B25 | | |
| NA | GND | B14 | | |
| NA | GND | B13 | | |
| NA | GND | B2 | | |
| NA | GND | A26 | | |
| NA | GND | A1 | | |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch)




| SYMBOL | MILLIMETERS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | | 2.25 | 2.60 |
| $A_1$ | 0.40 | 0.50 | 0.60 |
| D/E | 27.00 BSC | | |
| $D_1/E_1$ | 25.00 REF | | |
| e | 1.00 BSC | | |
| øb | 0.50 | 0.60 | 0.70 |
| aaa | | | 0.20 |
| ccc | | | 0.35 |
| ddd | | | 0.30 |
| eee | | | 0.10 |
| M | 26 | | |

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAL–1

676–BALL FINE PITCH BGA (FG676/FGG676)

*Figure 4:* **FG676/FGG676 Fine-Pitch BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch).

*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | A3 | | |
| 0 | IO_L01P_0 | A4 | | |
| 0 | IO_L02N_0 | D5 | | |
| 0 | IO_L02P_0 | C5 | | |
| 0 | IO_L03N_0/VRP_0 | E6 | | |
| 0 | IO_L03P_0/VRN_0 | D6 | | |
| 0 | IO_L04N_0/VREF_0 | F7 | | |
| 0 | IO_L04P_0 | E7 | | |
| 0 | IO_L05N_0 | G8 | | |
| 0 | IO_L05P_0 | H9 | | |
| 0 | IO_L06N_0 | A5 | | |
| 0 | IO_L06P_0 | A6 | | |
| 0 | IO_L19N_0 | B5 | | |
| 0 | IO_L19P_0 | B6 | | |
| 0 | IO_L21N_0 | D7 | | |
| 0 | IO_L21P_0/VREF_0 | C7 | | |
| 0 | IO_L22N_0 | F8 | | |
| 0 | IO_L22P_0 | E8 | | |
| 0 | IO_L24N_0 | G9 | | |
| 0 | IO_L24P_0 | F9 | | |
| 0 | IO_L49N_0 | G10 | | |
| 0 | IO_L49P_0 | H10 | | |
| 0 | IO_L51N_0 | B7 | | |
| 0 | IO_L51P_0/VREF_0 | B8 | | |
| 0 | IO_L52N_0 | D8 | | |
| 0 | IO_L52P_0 | C8 | | |
| 0 | IO_L54N_0 | E9 | | |
| 0 | IO_L54P_0 | D9 | | |
| 0 | IO_L67N_0 | A8 | NC | |
| 0 | IO_L67P_0 | A9 | NC | |
| 0 | IO_L69N_0 | C9 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 0 | IO_L69P_0/VREF_0 | B9 | NC | |
| 0 | IO_L70N_0 | F10 | NC | |
| 0 | IO_L70P_0 | E10 | NC | |
| 0 | IO_L72N_0 | A10 | NC | |
| 0 | IO_L72P_0 | A11 | NC | |
| 0 | IO_L73N_0 | C10 | NC | NC |
| 0 | IO_L73P_0 | B10 | NC | NC |
| 0 | IO_L91N_0/VREF_0 | D11 | | |
| 0 | IO_L91P_0 | C11 | | |
| 0 | IO_L92N_0 | G11 | | |
| 0 | IO_L92P_0 | E11 | | |
| 0 | IO_L93N_0 | C12 | | |
| 0 | IO_L93P_0 | B12 | | |
| 0 | IO_L94N_0/VREF_0 | E12 | | |
| 0 | IO_L94P_0 | D12 | | |
| 0 | IO_L95N_0/GCLK7P | G12 | | |
| 0 | IO_L95P_0/GCLK6S | F12 | | |
| 0 | IO_L96N_0/GCLK5P | H11 | | |
| 0 | IO_L96P_0/GCLK4S | H12 | | |
| | | | | |
| 1 | IO_L96N_1/GCLK3P | A13 | | |
| 1 | IO_L96P_1/GCLK2S | A14 | | |
| 1 | IO_L95N_1/GCLK1P | B13 | | |
| 1 | IO_L95P_1/GCLK0S | C13 | | |
| 1 | IO_L94N_1 | D13 | | |
| 1 | IO_L94P_1/VREF_1 | E13 | | |
| 1 | IO_L93N_1 | F13 | | |
| 1 | IO_L93P_1 | G13 | | |
| 1 | IO_L92N_1 | H13 | | |
| 1 | IO_L92P_1 | H14 | | |
| 1 | IO_L91N_1 | C14 | | |
| 1 | IO_L91P_1/VREF_1 | D14 | | |
| 1 | IO_L73N_1 | E14 | NC | NC |
| 1 | IO_L73P_1 | G14 | NC | NC |
| 1 | IO_L72N_1 | A15 | NC | |
| 1 | IO_L72P_1 | A16 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 1 | IO_L70N_1 | B15 | NC | |
| 1 | IO_L70P_1 | C15 | NC | |
| 1 | IO_L69N_1/VREF_1 | E15 | NC | |
| 1 | IO_L69P_1 | F15 | NC | |
| 1 | IO_L67N_1 | G15 | NC | |
| 1 | IO_L67P_1 | H15 | NC | |
| 1 | IO_L54N_1 | B16 | | |
| 1 | IO_L54P_1 | C16 | | |
| 1 | IO_L52N_1 | D16 | | |
| 1 | IO_L52P_1 | E16 | | |
| 1 | IO_L51N_1/VREF_1 | F16 | | |
| 1 | IO_L51P_1 | G16 | | |
| 1 | IO_L49N_1 | A17 | | |
| 1 | IO_L49P_1 | A19 | | |
| 1 | IO_L24N_1 | B17 | | |
| 1 | IO_L24P_1 | B18 | | |
| 1 | IO_L22N_1 | C17 | | |
| 1 | IO_L22P_1 | D17 | | |
| 1 | IO_L21N_1/VREF_1 | F17 | | |
| 1 | IO_L21P_1 | E17 | | |
| 1 | IO_L19N_1 | A20 | | |
| 1 | IO_L19P_1 | A21 | | |
| 1 | IO_L06N_1 | B19 | | |
| 1 | IO_L06P_1 | B20 | | |
| 1 | IO_L05N_1 | C18 | | |
| 1 | IO_L05P_1 | D18 | | |
| 1 | IO_L04N_1 | C20 | | |
| 1 | IO_L04P_1/VREF_1 | D20 | | |
| 1 | IO_L03N_1/VRP_1 | D19 | | |
| 1 | IO_L03P_1/VRN_1 | E19 | | |
| 1 | IO_L02N_1 | E18 | | |
| 1 | IO_L02P_1 | F18 | | |
| 1 | IO_L01N_1 | H16 | | |
| 1 | IO_L01P_1 | G17 | | |
| | | | | |
| 2 | IO_L01N_2 | D22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 2 | IO_L01P_2 | D23 | | |
| 2 | IO_L02N_2/VRP_2 | E21 | | |
| 2 | IO_L02P_2/VRN_2 | E22 | | |
| 2 | IO_L03N_2 | F21 | | |
| 2 | IO_L03P_2/VREF_2 | F20 | | |
| 2 | IO_L04N_2 | G20 | | |
| 2 | IO_L04P_2 | G19 | | |
| 2 | IO_L06N_2 | H18 | | |
| 2 | IO_L06P_2 | J17 | | |
| 2 | IO_L19N_2 | D24 | | |
| 2 | IO_L19P_2 | E23 | | |
| 2 | IO_L21N_2 | E24 | | |
| 2 | IO_L21P_2/VREF_2 | F24 | | |
| 2 | IO_L22N_2 | F23 | | |
| 2 | IO_L22P_2 | G23 | | |
| 2 | IO_L24N_2 | G21 | | |
| 2 | IO_L24P_2 | G22 | | |
| 2 | IO_L43N_2 | H19 | | |
| 2 | IO_L43P_2 | H20 | | |
| 2 | IO_L45N_2 | J18 | | |
| 2 | IO_L45P_2/VREF_2 | J19 | | |
| 2 | IO_L46N_2 | K17 | | |
| 2 | IO_L46P_2 | K18 | | |
| 2 | IO_L48N_2 | H23 | | |
| 2 | IO_L48P_2 | H24 | | |
| 2 | IO_L49N_2 | H21 | | |
| 2 | IO_L49P_2 | H22 | | |
| 2 | IO_L51N_2 | J24 | | |
| 2 | IO_L51P_2/VREF_2 | K24 | | |
| 2 | IO_L52N_2 | J22 | | |
| 2 | IO_L52P_2 | J23 | | |
| 2 | IO_L54N_2 | J20 | | |
| 2 | IO_L54P_2 | J21 | | |
| 2 | IO_L67N_2 | K19 | NC | |
| 2 | IO_L67P_2 | K20 | NC | |
| 2 | IO_L69N_2 | L17 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 2 | IO_L69P_2/VREF_2 | L18 | NC | |
| 2 | IO_L70N_2 | K23 | NC | |
| 2 | IO_L70P_2 | L24 | NC | |
| 2 | IO_L72N_2 | K22 | NC | |
| 2 | IO_L72P_2 | L22 | NC | |
| 2 | IO_L73N_2 | L21 | NC | NC |
| 2 | IO_L73P_2 | L20 | NC | NC |
| 2 | IO_L91N_2 | M23 | | |
| 2 | IO_L91P_2 | N24 | | |
| 2 | IO_L93N_2 | M21 | | |
| 2 | IO_L93P_2/VREF_2 | M22 | | |
| 2 | IO_L94N_2 | M19 | | |
| 2 | IO_L94P_2 | M20 | | |
| 2 | IO_L96N_2 | M17 | | |
| 2 | IO_L96P_2 | M18 | | |
| | | | | |
| 3 | IO_L96N_3 | N23 | | |
| 3 | IO_L96P_3 | N22 | | |
| 3 | IO_L94N_3 | N20 | | |
| 3 | IO_L94P_3 | N21 | | |
| 3 | IO_L93N_3/VREF_3 | N19 | | |
| 3 | IO_L93P_3 | N18 | | |
| 3 | IO_L91N_3 | N17 | | |
| 3 | IO_L91P_3 | P17 | | |
| 3 | IO_L73N_3 | P24 | NC | NC |
| 3 | IO_L73P_3 | R24 | NC | NC |
| 3 | IO_L72N_3 | R23 | NC | |
| 3 | IO_L72P_3 | R22 | NC | |
| 3 | IO_L70N_3 | P22 | NC | |
| 3 | IO_L70P_3 | P21 | NC | |
| 3 | IO_L69N_3/VREF_3 | P20 | NC | |
| 3 | IO_L69P_3 | P18 | NC | |
| 3 | IO_L67N_3 | T24 | NC | |
| 3 | IO_L67P_3 | U24 | NC | |
| 3 | IO_L54N_3 | T23 | | |
| 3 | IO_L54P_3 | T22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 3 | IO_L52N_3 | T21 | | |
| 3 | IO_L52P_3 | T20 | | |
| 3 | IO_L51N_3/VREF_3 | R20 | | |
| 3 | IO_L51P_3 | R19 | | |
| 3 | IO_L49N_3 | W24 | | |
| 3 | IO_L49P_3 | W23 | | |
| 3 | IO_L48N_3 | U23 | | |
| 3 | IO_L48P_3 | V23 | | |
| 3 | IO_L46N_3 | U22 | | |
| 3 | IO_L46P_3 | U21 | | |
| 3 | IO_L45N_3/VREF_3 | V22 | | |
| 3 | IO_L45P_3 | V21 | | |
| 3 | IO_L43N_3 | U19 | | |
| 3 | IO_L43P_3 | U20 | | |
| 3 | IO_L24N_3 | T19 | | |
| 3 | IO_L24P_3 | T18 | | |
| 3 | IO_L22N_3 | R18 | | |
| 3 | IO_L22P_3 | R17 | | |
| 3 | IO_L21N_3/VREF_3 | Y24 | | |
| 3 | IO_L21P_3 | Y23 | | |
| 3 | IO_L19N_3 | AA24 | | |
| 3 | IO_L19P_3 | AB24 | | |
| 3 | IO_L06N_3 | AA23 | | |
| 3 | IO_L06P_3 | AA22 | | |
| 3 | IO_L04N_3 | Y22 | | |
| 3 | IO_L04P_3 | Y21 | | |
| 3 | IO_L03N_3/VREF_3 | W21 | | |
| 3 | IO_L03P_3 | W20 | | |
| 3 | IO_L02N_3/VRP_3 | V20 | | |
| 3 | IO_L02P_3/VRN_3 | V19 | | |
| 3 | IO_L01N_3 | U18 | | |
| 3 | IO_L01P_3 | T17 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AD22 | | |
| 4 | IO_L01P_4/INIT_B | AD21 | | |
| 4 | IO_L02N_4/D0/DIN(1) | AA20 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 4 | IO_L02P_4/D1 | AB20 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | Y19 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AA19 | | |
| 4 | IO_L04N_4/VREF_4 | W18 | | |
| 4 | IO_L04P_4 | Y18 | | |
| 4 | IO_L05N_4/VRP_4 | U16 | | |
| 4 | IO_L05P_4/VRN_4 | V17 | | |
| 4 | IO_L06N_4 | AD20 | | |
| 4 | IO_L06P_4 | AD19 | | |
| 4 | IO_L19N_4 | AC20 | | |
| 4 | IO_L19P_4 | AC19 | | |
| 4 | IO_L21N_4 | AA18 | | |
| 4 | IO_L21P_4/VREF_4 | AB18 | | |
| 4 | IO_L22N_4 | AC18 | | |
| 4 | IO_L22P_4 | AC17 | | |
| 4 | IO_L24N_4 | AA17 | | |
| 4 | IO_L24P_4 | AB17 | | |
| 4 | IO_L49N_4 | Y17 | | |
| 4 | IO_L49P_4 | W17 | | |
| 4 | IO_L51N_4 | V16 | | |
| 4 | IO_L51P_4/VREF_4 | W16 | | |
| 4 | IO_L52N_4 | AD17 | | |
| 4 | IO_L52P_4 | AD16 | | |
| 4 | IO_L54N_4 | AB16 | | |
| 4 | IO_L54P_4 | AC16 | | |
| 4 | IO_L67N_4 | Y16 | NC | |
| 4 | IO_L67P_4 | AA16 | NC | |
| 4 | IO_L69N_4 | W15 | NC | |
| 4 | IO_L69P_4/VREF_4 | Y15 | NC | |
| 4 | IO_L70N_4 | U15 | NC | |
| 4 | IO_L70P_4 | V15 | NC | |
| 4 | IO_L72N_4 | AD15 | NC | |
| 4 | IO_L72P_4 | AD14 | NC | |
| 4 | IO_L73N_4 | AB15 | NC | NC |
| 4 | IO_L73P_4 | AC15 | NC | NC |
| 4 | IO_L91N_4/VREF_4 | AA14 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 4 | IO_L91P_4 | AB14 | | |
| 4 | IO_L92N_4 | V14 | | |
| 4 | IO_L92P_4 | Y14 | | |
| 4 | IO_L93N_4 | AB13 | | |
| 4 | IO_L93P_4 | AC13 | | |
| 4 | IO_L94N_4/VREF_4 | Y13 | | |
| 4 | IO_L94P_4 | AA13 | | |
| 4 | IO_L95N_4/GCLK3S | V13 | | |
| 4 | IO_L95P_4/GCLK2P | W13 | | |
| 4 | IO_L96N_4/GCLK1S | U14 | | |
| 4 | IO_L96P_4/GCLK0P | U13 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | AD12 | | |
| 5 | IO_L96P_5/GCLK6P | AD11 | | |
| 5 | IO_L95N_5/GCLK5S | AC12 | | |
| 5 | IO_L95P_5/GCLK4P | AB12 | | |
| 5 | IO_L94N_5 | AA12 | | |
| 5 | IO_L94P_5/VREF_5 | Y12 | | |
| 5 | IO_L93N_5 | W12 | | |
| 5 | IO_L93P_5 | V12 | | |
| 5 | IO_L92N_5 | U12 | | |
| 5 | IO_L92P_5 | U11 | | |
| 5 | IO_L91N_5 | AB11 | | |
| 5 | IO_L91P_5/VREF_5 | AA11 | | |
| 5 | IO_L73N_5 | Y11 | NC | NC |
| 5 | IO_L73P_5 | V11 | NC | NC |
| 5 | IO_L72N_5 | AD10 | NC | |
| 5 | IO_L72P_5 | AD9 | NC | |
| 5 | IO_L70N_5 | AC10 | NC | |
| 5 | IO_L70P_5 | AB10 | NC | |
| 5 | IO_L69N_5/VREF_5 | Y10 | NC | |
| 5 | IO_L69P_5 | W10 | NC | |
| 5 | IO_L67N_5 | V10 | NC | |
| 5 | IO_L67P_5 | U10 | NC | |
| 5 | IO_L54N_5 | AC9 | | |
| 5 | IO_L54P_5 | AB9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 5 | IO_L52N_5 | AA9 | | |
| 5 | IO_L52P_5 | Y9 | | |
| 5 | IO_L51N_5/VREF_5 | W9 | | |
| 5 | IO_L51P_5 | V9 | | |
| 5 | IO_L49N_5 | AD8 | | |
| 5 | IO_L49P_5 | AD6 | | |
| 5 | IO_L24N_5 | AC8 | | |
| 5 | IO_L24P_5 | AC7 | | |
| 5 | IO_L22N_5 | AB8 | | |
| 5 | IO_L22P_5 | AA8 | | |
| 5 | IO_L21N_5/VREF_5 | W8 | | |
| 5 | IO_L21P_5 | Y8 | | |
| 5 | IO_L19N_5 | AD5 | | |
| 5 | IO_L19P_5 | AD4 | | |
| 5 | IO_L06N_5 | AC6 | | |
| 5 | IO_L06P_5 | AC5 | | |
| 5 | IO_L05N_5/VRP_5 | AB7 | | |
| 5 | IO_L05P_5/VRN_5 | AA7 | | |
| 5 | IO_L04N_5 | AB5 | | |
| 5 | IO_L04P_5/VREF_5 | AA5 | | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AA6 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | Y6 | | |
| 5 | IO_L02N_5/D6 | Y7 | | |
| 5 | IO_L02P_5/D7 | W7 | | |
| 5 | IO_L01N_5/RDWR_B | V8 | | |
| 5 | IO_L01P_5/CS_B | U9 | | |
| | | | | |
| 6 | IO_L01P_6 | AB2 | | |
| 6 | IO_L01N_6 | AB1 | | |
| 6 | IO_L02P_6/VRN_6 | AA3 | | |
| 6 | IO_L02N_6/VRP_6 | AA2 | | |
| 6 | IO_L03P_6 | Y4 | | |
| 6 | IO_L03N_6/VREF_6 | Y3 | | |
| 6 | IO_L04P_6 | W4 | | |
| 6 | IO_L04N_6 | W5 | | |
| 6 | IO_L06P_6 | V5 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 6 | IO_L06N_6 | V6 | | |
| 6 | IO_L19P_6 | U7 | | |
| 6 | IO_L19N_6 | T8 | | |
| 6 | IO_L21P_6 | AA1 | | |
| 6 | IO_L21N_6/VREF_6 | Y2 | | |
| 6 | IO_L22P_6 | Y1 | | |
| 6 | IO_L22N_6 | W1 | | |
| 6 | IO_L24P_6 | W2 | | |
| 6 | IO_L24N_6 | V2 | | |
| 6 | IO_L43P_6 | V4 | | |
| 6 | IO_L43N_6 | V3 | | |
| 6 | IO_L45P_6 | U6 | | |
| 6 | IO_L45N_6/VREF_6 | U5 | | |
| 6 | IO_L46P_6 | T7 | | |
| 6 | IO_L46N_6 | T6 | | |
| 6 | IO_L48P_6 | R8 | | |
| 6 | IO_L48N_6 | R7 | | |
| 6 | IO_L49P_6 | U2 | | |
| 6 | IO_L49N_6 | U1 | | |
| 6 | IO_L51P_6 | U4 | | |
| 6 | IO_L51N_6/VREF_6 | U3 | | |
| 6 | IO_L52P_6 | T1 | | |
| 6 | IO_L52N_6 | R1 | | |
| 6 | IO_L54P_6 | T3 | | |
| 6 | IO_L54N_6 | T2 | | |
| 6 | IO_L67P_6 | T5 | NC | |
| 6 | IO_L67N_6 | T4 | NC | |
| 6 | IO_L69P_6 | R6 | NC | |
| 6 | IO_L69N_6/VREF_6 | R5 | NC | |
| 6 | IO_L70P_6 | P8 | NC | |
| 6 | IO_L70N_6 | P7 | NC | |
| 6 | IO_L72P_6 | R2 | NC | |
| 6 | IO_L72N_6 | P1 | NC | |
| 6 | IO_L73P_6 | R3 | NC | NC |
| 6 | IO_L73N_6 | P3 | NC | NC |
| 6 | IO_L91P_6 | P5 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 6 | IO_L91N_6 | P4 | | |
| 6 | IO_L93P_6 | N4 | | |
| 6 | IO_L93N_6/VREF_6 | N3 | | |
| 6 | IO_L94P_6 | N6 | | |
| 6 | IO_L94N_6 | N5 | | |
| 6 | IO_L96P_6 | N8 | | |
| 6 | IO_L96N_6 | N7 | | |
| | | | | |
| 7 | IO_L96P_7 | N2 | | |
| 7 | IO_L96N_7 | M1 | | |
| 7 | IO_L94P_7 | M2 | | |
| 7 | IO_L94N_7 | M3 | | |
| 7 | IO_L93P_7/VREF_7 | M4 | | |
| 7 | IO_L93N_7 | M5 | | |
| 7 | IO_L91P_7 | M6 | | |
| 7 | IO_L91N_7 | M7 | | |
| 7 | IO_L73P_7 | M8 | NC | NC |
| 7 | IO_L73N_7 | L8 | NC | NC |
| 7 | IO_L72P_7 | L1 | NC | |
| 7 | IO_L72N_7 | K1 | NC | |
| 7 | IO_L70P_7 | K2 | NC | |
| 7 | IO_L70N_7 | K3 | NC | |
| 7 | IO_L69P_7/VREF_7 | L3 | NC | |
| 7 | IO_L69N_7 | L4 | NC | |
| 7 | IO_L67P_7 | L5 | NC | |
| 7 | IO_L67N_7 | L7 | NC | |
| 7 | IO_L54P_7 | J1 | | |
| 7 | IO_L54N_7 | H1 | | |
| 7 | IO_L52P_7 | J2 | | |
| 7 | IO_L52N_7 | J3 | | |
| 7 | IO_L51P_7/VREF_7 | J4 | | |
| 7 | IO_L51N_7 | J5 | | |
| 7 | IO_L49P_7 | K5 | | |
| 7 | IO_L49N_7 | K6 | | |
| 7 | IO_L48P_7 | F1 | | |
| 7 | IO_L48N_7 | F2 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 7 | IO_L46P_7 | H2 | | |
| 7 | IO_L46N_7 | G2 | | |
| 7 | IO_L45P_7/VREF_7 | H3 | | |
| 7 | IO_L45N_7 | H4 | | |
| 7 | IO_L43P_7 | G3 | | |
| 7 | IO_L43N_7 | G4 | | |
| 7 | IO_L24P_7 | H5 | | |
| 7 | IO_L24N_7 | H6 | | |
| 7 | IO_L22P_7 | J6 | | |
| 7 | IO_L22N_7 | J7 | | |
| 7 | IO_L21P_7/VREF_7 | K7 | | |
| 7 | IO_L21N_7 | K8 | | |
| 7 | IO_L19P_7 | E1 | | |
| 7 | IO_L19N_7 | E2 | | |
| 7 | IO_L06P_7 | D2 | | |
| 7 | IO_L06N_7 | D3 | | |
| 7 | IO_L04P_7 | E3 | | |
| 7 | IO_L04N_7 | E4 | | |
| 7 | IO_L03P_7/VREF_7 | F4 | | |
| 7 | IO_L03N_7 | F5 | | |
| 7 | IO_L02P_7/VRN_7 | G5 | | |
| 7 | IO_L02N_7/VRP_7 | G6 | | |
| 7 | IO_L01P_7 | H7 | | |
| 7 | IO_L01N_7 | J8 | | |
| | | | | |
| 0 | VCCO_0 | J12 | | |
| 0 | VCCO_0 | J11 | | |
| 0 | VCCO_0 | J10 | | |
| 0 | VCCO_0 | F11 | | |
| 0 | VCCO_0 | C6 | | |
| 0 | VCCO_0 | B11 | | |
| 1 | VCCO_1 | J15 | | |
| 1 | VCCO_1 | J14 | | |
| 1 | VCCO_1 | J13 | | |
| 1 | VCCO_1 | F14 | | |
| 1 | VCCO_1 | C19 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 1 | VCCO_1 | B14 | | |
| 2 | VCCO_2 | M16 | | |
| 2 | VCCO_2 | L23 | | |
| 2 | VCCO_2 | L19 | | |
| 2 | VCCO_2 | L16 | | |
| 2 | VCCO_2 | K16 | | |
| 2 | VCCO_2 | F22 | | |
| 3 | VCCO_3 | W22 | | |
| 3 | VCCO_3 | R16 | | |
| 3 | VCCO_3 | P23 | | |
| 3 | VCCO_3 | P19 | | |
| 3 | VCCO_3 | P16 | | |
| 3 | VCCO_3 | N16 | | |
| 4 | VCCO_4 | AC14 | | |
| 4 | VCCO_4 | AB19 | | |
| 4 | VCCO_4 | W14 | | |
| 4 | VCCO_4 | T15 | | |
| 4 | VCCO_4 | T14 | | |
| 4 | VCCO_4 | T13 | | |
| 5 | VCCO_5 | AC11 | | |
| 5 | VCCO_5 | AB6 | | |
| 5 | VCCO_5 | W11 | | |
| 5 | VCCO_5 | T12 | | |
| 5 | VCCO_5 | T11 | | |
| 5 | VCCO_5 | T10 | | |
| 6 | VCCO_6 | W3 | | |
| 6 | VCCO_6 | R9 | | |
| 6 | VCCO_6 | P9 | | |
| 6 | VCCO_6 | P6 | | |
| 6 | VCCO_6 | P2 | | |
| 6 | VCCO_6 | N9 | | |
| 7 | VCCO_7 | M9 | | |
| 7 | VCCO_7 | L9 | | |
| 7 | VCCO_7 | L6 | | |
| 7 | VCCO_7 | L2 | | |
| 7 | VCCO_7 | K9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| 7 | VCCO_7 | F3 | | |
| | | | | |
| NA | CCLK | AB23 | | |
| NA | PROG_B | C1 | | |
| NA | DONE | AB21 | | |
| NA | M0 | AC4 | | |
| NA | M1 | AB4 | | |
| NA | M2 | AD3 | | |
| NA | HSWAP_EN | C2 | | |
| NA | TCK | C23 | | |
| NA | TDI | D1 | | |
| NA | TDO | C24 | | |
| NA | TMS | C21 | | |
| NA | PWRDWN_B | AC21 | | |
| NA | DXN | B4 | | |
| NA | DXP | C4 | | |
| NA | VBATT | B21 | | |
| NA | RSVD | A22 | | |
| | | | | |
| NA | VCCAUX | AD13 | | |
| NA | VCCAUX | AC22 | | |
| NA | VCCAUX | AC3 | | |
| NA | VCCAUX | N1 | | |
| NA | VCCAUX | M24 | | |
| NA | VCCAUX | B22 | | |
| NA | VCCAUX | B3 | | |
| NA | VCCAUX | A12 | | |
| NA | VCCINT | U17 | | |
| NA | VCCINT | U8 | | |
| NA | VCCINT | T16 | | |
| NA | VCCINT | T9 | | |
| NA | VCCINT | R15 | | |
| NA | VCCINT | R14 | | |
| NA | VCCINT | R13 | | |
| NA | VCCINT | R12 | | |
| NA | VCCINT | R11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| NA | VCCINT | R10 | | |
| NA | VCCINT | P15 | | |
| NA | VCCINT | P10 | | |
| NA | VCCINT | N15 | | |
| NA | VCCINT | N10 | | |
| NA | VCCINT | M15 | | |
| NA | VCCINT | M10 | | |
| NA | VCCINT | L15 | | |
| NA | VCCINT | L10 | | |
| NA | VCCINT | K15 | | |
| NA | VCCINT | K14 | | |
| NA | VCCINT | K13 | | |
| NA | VCCINT | K12 | | |
| NA | VCCINT | K11 | | |
| NA | VCCINT | K10 | | |
| NA | VCCINT | J16 | | |
| NA | VCCINT | J9 | | |
| NA | VCCINT | H17 | | |
| NA | VCCINT | H8 | | |
| NA | GND | AD24 | | |
| NA | GND | AD23 | | |
| NA | GND | AD18 | | |
| NA | GND | AD7 | | |
| NA | GND | AD2 | | |
| NA | GND | AD1 | | |
| NA | GND | AC24 | | |
| NA | GND | AC23 | | |
| NA | GND | AC2 | | |
| NA | GND | AC1 | | |
| NA | GND | AB22 | | |
| NA | GND | AB3 | | |
| NA | GND | AA21 | | |
| NA | GND | AA15 | | |
| NA | GND | AA10 | | |
| NA | GND | AA4 | | |
| NA | GND | Y20 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| NA | GND | Y5 | | |
| NA | GND | W19 | | |
| NA | GND | W6 | | |
| NA | GND | V24 | | |
| NA | GND | V18 | | |
| NA | GND | V7 | | |
| NA | GND | V1 | | |
| NA | GND | R21 | | |
| NA | GND | R4 | | |
| NA | GND | P14 | | |
| NA | GND | P13 | | |
| NA | GND | P12 | | |
| NA | GND | P11 | | |
| NA | GND | N14 | | |
| NA | GND | N13 | | |
| NA | GND | N12 | | |
| NA | GND | N11 | | |
| NA | GND | M14 | | |
| NA | GND | M13 | | |
| NA | GND | M12 | | |
| NA | GND | M11 | | |
| NA | GND | L14 | | |
| NA | GND | L13 | | |
| NA | GND | L12 | | |
| NA | GND | L11 | | |
| NA | GND | K21 | | |
| NA | GND | K4 | | |
| NA | GND | G24 | | |
| NA | GND | G18 | | |
| NA | GND | G7 | | |
| NA | GND | G1 | | |
| NA | GND | F19 | | |
| NA | GND | F6 | | |
| NA | GND | E20 | | |
| NA | GND | E5 | | |
| NA | GND | D21 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

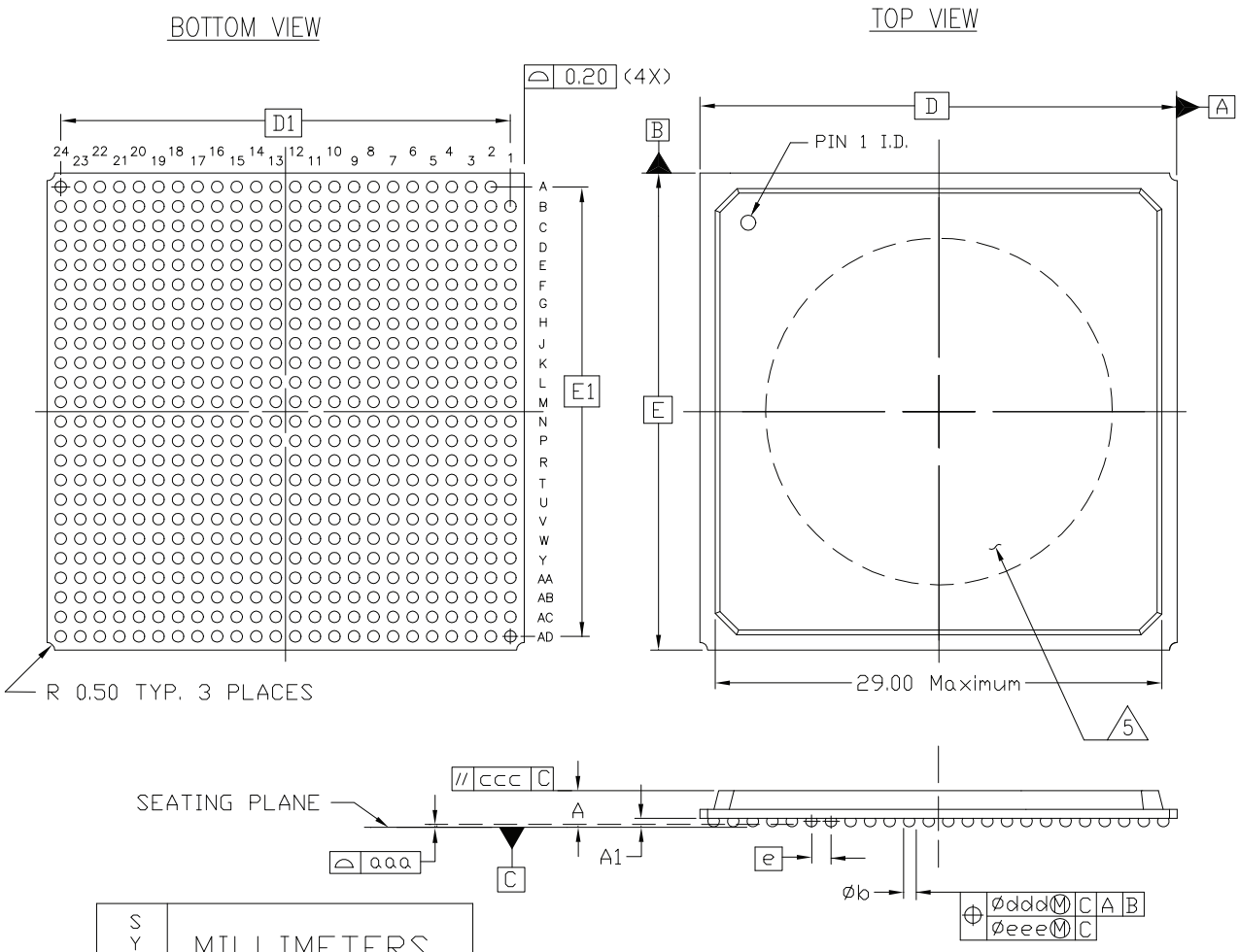

*Table 9:* **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in XC2V1000 | No Connect in XC2V1500 |
|---|---|---|---|---|
| NA | GND | D15 | | |
| NA | GND | D10 | | |
| NA | GND | D4 | | |
| NA | GND | C22 | | |
| NA | GND | C3 | | |
| NA | GND | B24 | | |
| NA | GND | B23 | | |
| NA | GND | B2 | | |
| NA | GND | B1 | | |
| NA | GND | A24 | | |
| NA | GND | A23 | | |
| NA | GND | A18 | | |
| NA | GND | A7 | | |
| NA | GND | A2 | | |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch)




| SYMBOL | MILLIMETERS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | | 2.33 | 2.60 |
| $A_1$ | 0.50 | 0.60 | 0.70 |
| D/E | 31.00 BSC | | |
| $D_1/E_1$ | 29.21 REF | | |
| e | 1.27BSC | | |
| øb | 0.60 | 0.75 | 0.90 |
| aaa | | | 0.20 |
| ccc | | | 0.35 |
| ddd | | | 0.30 |
| eee | | | 0.15 |
| M | 24 | | |

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS-034-BAN-1 (DEPOPULATED)
4. NO SOLDER BALL AND LAND ON A1.

5 HEAT SINK OPTION

575-BALL MOLDED BGA (BG575/BGG575)

*Figure 5:* **BG575/BGG575 Standard BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BG728/BGG728 Standard BGA Package

As shown in Table 10, XC2V3000 Virtex-II devices are available in the BG728/BGG728 BGA package. Following this table are the BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch).

*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 0 | IO_L01N_0 | B3 |
| 0 | IO_L01P_0 | A3 |
| 0 | IO_L02N_0 | B4 |
| 0 | IO_L02P_0 | A4 |
| 0 | IO_L03N_0/VRP_0 | C5 |
| 0 | IO_L03P_0/VRN_0 | C6 |
| 0 | IO_L04N_0/VREF_0 | B5 |
| 0 | IO_L04P_0 | A5 |
| 0 | IO_L05N_0 | E6 |
| 0 | IO_L05P_0 | D6 |
| 0 | IO_L06N_0 | B6 |
| 0 | IO_L06P_0 | A6 |
| 0 | IO_L19N_0 | E7 |
| 0 | IO_L19P_0 | D8 |
| 0 | IO_L21N_0 | F8 |
| 0 | IO_L21P_0/VREF_0 | E8 |
| 0 | IO_L22N_0 | C7 |
| 0 | IO_L22P_0 | C8 |
| 0 | IO_L24N_0 | B7 |
| 0 | IO_L24P_0 | A7 |
| 0 | IO_L25N_0 | H9 |
| 0 | IO_L25P_0 | J9 |
| 0 | IO_L27N_0 | F9 |
| 0 | IO_L27P_0/VREF_0 | G9 |
| 0 | IO_L28N_0 | E9 |
| 0 | IO_L28P_0 | D9 |
| 0 | IO_L30N_0 | C9 |
| 0 | IO_L30P_0 | B9 |
| 0 | IO_L49N_0 | A8 |
| 0 | IO_L49P_0 | A9 |
| 0 | IO_L51N_0 | G10 |
| 0 | IO_L51P_0/VREF_0 | H10 |
| 0 | IO_L52N_0 | F10 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 0 | IO_L52P_0 | E10 |
| 0 | IO_L54N_0 | D10 |
| 0 | IO_L54P_0 | C10 |
| 0 | IO_L67N_0 | B10 |
| 0 | IO_L67P_0 | A10 |
| 0 | IO_L69N_0 | G11 |
| 0 | IO_L69P_0/VREF_0 | H11 |
| 0 | IO_L70N_0 | F11 |
| 0 | IO_L70P_0 | F12 |
| 0 | IO_L72N_0 | D11 |
| 0 | IO_L72P_0 | C11 |
| 0 | IO_L73N_0 | B11 |
| 0 | IO_L73P_0 | A11 |
| 0 | IO_L75N_0 | H12 |
| 0 | IO_L75P_0/VREF_0 | J12 |
| 0 | IO_L76N_0 | E12 |
| 0 | IO_L76P_0 | D12 |
| 0 | IO_L78N_0 | B12 |
| 0 | IO_L78P_0 | A12 |
| 0 | IO_L91N_0/VREF_0 | J13 |
| 0 | IO_L91P_0 | H13 |
| 0 | IO_L92N_0 | G13 |
| 0 | IO_L92P_0 | F13 |
| 0 | IO_L93N_0 | E13 |
| 0 | IO_L93P_0 | D13 |
| 0 | IO_L94N_0/VREF_0 | B13 |
| 0 | IO_L94P_0 | A13 |
| 0 | IO_L95N_0/GCLK7P | C13 |
| 0 | IO_L95P_0/GCLK6S | C14 |
| 0 | IO_L96N_0/GCLK5P | F14 |
| 0 | IO_L96P_0/GCLK4S | E14 |
| | | |
| 1 | IO_L96N_1/GCLK3P | G14 |
| 1 | IO_L96P_1/GCLK2S | H14 |
| 1 | IO_L95N_1/GCLK1P | A15 |
| 1 | IO_L95P_1/GCLK0S | B15 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 1 | IO_L94N_1 | C15 |
| 1 | IO_L94P_1/VREF_1 | D15 |
| 1 | IO_L93N_1 | E15 |
| 1 | IO_L93P_1 | F15 |
| 1 | IO_L92N_1 | G15 |
| 1 | IO_L92P_1 | H15 |
| 1 | IO_L91N_1 | J15 |
| 1 | IO_L91P_1/VREF_1 | J16 |
| 1 | IO_L78N_1 | A16 |
| 1 | IO_L78P_1 | B16 |
| 1 | IO_L76N_1 | D16 |
| 1 | IO_L76P_1 | E16 |
| 1 | IO_L75N_1/VREF_1 | F16 |
| 1 | IO_L75P_1 | F17 |
| 1 | IO_L73N_1 | H16 |
| 1 | IO_L73P_1 | H17 |
| 1 | IO_L72N_1 | A17 |
| 1 | IO_L72P_1 | B17 |
| 1 | IO_L70N_1 | C17 |
| 1 | IO_L70P_1 | D17 |
| 1 | IO_L69N_1/VREF_1 | G18 |
| 1 | IO_L69P_1 | G17 |
| 1 | IO_L67N_1 | A18 |
| 1 | IO_L67P_1 | B18 |
| 1 | IO_L54N_1 | C18 |
| 1 | IO_L54P_1 | D18 |
| 1 | IO_L52N_1 | E18 |
| 1 | IO_L52P_1 | F18 |
| 1 | IO_L51N_1/VREF_1 | H19 |
| 1 | IO_L51P_1 | H18 |
| 1 | IO_L49N_1 | A19 |
| 1 | IO_L49P_1 | A20 |
| 1 | IO_L30N_1 | B19 |
| 1 | IO_L30P_1 | C19 |
| 1 | IO_L28N_1 | D19 |
| 1 | IO_L28P_1 | E19 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 1 | IO_L27N_1/VREF_1 | F19 |
| 1 | IO_L27P_1 | G19 |
| 1 | IO_L25N_1 | J19 |
| 1 | IO_L25P_1 | J20 |
| 1 | IO_L24N_1 | C20 |
| 1 | IO_L24P_1 | C21 |
| 1 | IO_L22N_1 | D20 |
| 1 | IO_L22P_1 | E21 |
| 1 | IO_L21N_1/VREF_1 | E20 |
| 1 | IO_L21P_1 | F20 |
| 1 | IO_L19N_1 | A21 |
| 1 | IO_L19P_1 | B21 |
| 1 | IO_L06N_1 | A22 |
| 1 | IO_L06P_1 | B22 |
| 1 | IO_L05N_1 | C22 |
| 1 | IO_L05P_1 | C23 |
| 1 | IO_L04N_1 | D22 |
| 1 | IO_L04P_1/VREF_1 | E22 |
| 1 | IO_L03N_1/VRP_1 | A23 |
| 1 | IO_L03P_1/VRN_1 | B23 |
| 1 | IO_L02N_1 | A24 |
| 1 | IO_L02P_1 | B24 |
| 1 | IO_L01N_1 | A25 |
| 1 | IO_L01P_1 | B25 |
| | | |
| 2 | IO_L01N_2 | C27 |
| 2 | IO_L01P_2 | D27 |
| 2 | IO_L02N_2/VRP_2 | D25 |
| 2 | IO_L02P_2/VRN_2 | D26 |
| 2 | IO_L03N_2 | E24 |
| 2 | IO_L03P_2/VREF_2 | E25 |
| 2 | IO_L04N_2 | E26 |
| 2 | IO_L04P_2 | E27 |
| 2 | IO_L06N_2 | F23 |
| 2 | IO_L06P_2 | F24 |
| 2 | IO_L19N_2 | F25 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 2 | IO_L19P_2 | F26 |
| 2 | IO_L21N_2 | F27 |
| 2 | IO_L21P_2/VREF_2 | G27 |
| 2 | IO_L22N_2 | G23 |
| 2 | IO_L22P_2 | H23 |
| 2 | IO_L24N_2 | G25 |
| 2 | IO_L24P_2 | G26 |
| 2 | IO_L25N_2 | H21 |
| 2 | IO_L25P_2 | J21 |
| 2 | IO_L27N_2 | H22 |
| 2 | IO_L27P_2/VREF_2 | J22 |
| 2 | IO_L28N_2 | H24 |
| 2 | IO_L28P_2 | H25 |
| 2 | IO_L30N_2 | H27 |
| 2 | IO_L30P_2 | J27 |
| 2 | IO_L43N_2 | J23 |
| 2 | IO_L43P_2 | J24 |
| 2 | IO_L45N_2 | J25 |
| 2 | IO_L45P_2/VREF_2 | J26 |
| 2 | IO_L46N_2 | K20 |
| 2 | IO_L46P_2 | K21 |
| 2 | IO_L48N_2 | K22 |
| 2 | IO_L48P_2 | K23 |
| 2 | IO_L49N_2 | K24 |
| 2 | IO_L49P_2 | K25 |
| 2 | IO_L51N_2 | K26 |
| 2 | IO_L51P_2/VREF_2 | K27 |
| 2 | IO_L52N_2 | L20 |
| 2 | IO_L52P_2 | M20 |
| 2 | IO_L54N_2 | L21 |
| 2 | IO_L54P_2 | L22 |
| 2 | IO_L67N_2 | L24 |
| 2 | IO_L67P_2 | L25 |
| 2 | IO_L69N_2 | L26 |
| 2 | IO_L69P_2/VREF_2 | L27 |
| 2 | IO_L70N_2 | M19 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 2 | IO_L70P_2 | N19 |
| 2 | IO_L72N_2 | M22 |
| 2 | IO_L72P_2 | M23 |
| 2 | IO_L73N_2 | M24 |
| 2 | IO_L73P_2 | N24 |
| 2 | IO_L75N_2 | M26 |
| 2 | IO_L75P_2/VREF_2 | M27 |
| 2 | IO_L76N_2 | N20 |
| 2 | IO_L76P_2 | N21 |
| 2 | IO_L78N_2 | N22 |
| 2 | IO_L78P_2 | N23 |
| 2 | IO_L91N_2 | N25 |
| 2 | IO_L91P_2 | P25 |
| 2 | IO_L93N_2 | N26 |
| 2 | IO_L93P_2/VREF_2 | N27 |
| 2 | IO_L94N_2 | P20 |
| 2 | IO_L94P_2 | P21 |
| 2 | IO_L96N_2 | P22 |
| 2 | IO_L96P_2 | P23 |
| | | |
| 3 | IO_L96N_3 | R27 |
| 3 | IO_L96P_3 | R26 |
| 3 | IO_L94N_3 | R25 |
| 3 | IO_L94P_3 | R24 |
| 3 | IO_L93N_3/VREF_3 | R23 |
| 3 | IO_L93P_3 | T23 |
| 3 | IO_L91N_3 | R22 |
| 3 | IO_L91P_3 | R21 |
| 3 | IO_L78N_3 | R20 |
| 3 | IO_L78P_3 | R19 |
| 3 | IO_L76N_3 | T27 |
| 3 | IO_L76P_3 | T26 |
| 3 | IO_L75N_3/VREF_3 | T24 |
| 3 | IO_L75P_3 | U24 |
| 3 | IO_L73N_3 | T22 |
| 3 | IO_L73P_3 | U22 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 3 | IO_L72N_3 | T20 |
| 3 | IO_L72P_3 | T19 |
| 3 | IO_L70N_3 | U27 |
| 3 | IO_L70P_3 | U26 |
| 3 | IO_L69N_3/VREF_3 | U25 |
| 3 | IO_L69P_3 | V25 |
| 3 | IO_L67N_3 | U21 |
| 3 | IO_L67P_3 | U20 |
| 3 | IO_L54N_3 | V27 |
| 3 | IO_L54P_3 | V26 |
| 3 | IO_L52N_3 | V24 |
| 3 | IO_L52P_3 | V23 |
| 3 | IO_L51N_3/VREF_3 | V22 |
| 3 | IO_L51P_3 | W22 |
| 3 | IO_L49N_3 | V21 |
| 3 | IO_L49P_3 | V20 |
| 3 | IO_L48N_3 | W27 |
| 3 | IO_L48P_3 | Y27 |
| 3 | IO_L46N_3 | W26 |
| 3 | IO_L46P_3 | W25 |
| 3 | IO_L45N_3/VREF_3 | W24 |
| 3 | IO_L45P_3 | W23 |
| 3 | IO_L43N_3 | W21 |
| 3 | IO_L43P_3 | W20 |
| 3 | IO_L28N_3 | W19 |
| 3 | IO_L28P_3 | Y19 |
| 3 | IO_L27N_3/VREF_3 | Y25 |
| 3 | IO_L27P_3 | Y24 |
| 3 | IO_L25N_3 | Y23 |
| 3 | IO_L25P_3 | AA23 |
| 3 | IO_L24N_3 | Y22 |
| 3 | IO_L24P_3 | Y21 |
| 3 | IO_L22N_3 | AA27 |
| 3 | IO_L22P_3 | AB27 |
| 3 | IO_L21N_3/VREF_3 | AA26 |
| 3 | IO_L21P_3 | AA25 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 3 | IO_L19N_3 | AB26 |
| 3 | IO_L19P_3 | AB25 |
| 3 | IO_L06N_3 | AB24 |
| 3 | IO_L06P_3 | AB23 |
| 3 | IO_L04N_3 | AC27 |
| 3 | IO_L04P_3 | AC26 |
| 3 | IO_L03N_3/VREF_3 | AC25 |
| 3 | IO_L03P_3 | AC24 |
| 3 | IO_L02N_3/VRP_3 | AD27 |
| 3 | IO_L02P_3/VRN_3 | AE27 |
| 3 | IO_L01N_3 | AD26 |
| 3 | IO_L01P_3 | AD25 |
| | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AF25 |
| 4 | IO_L01P_4/INIT_B | AG25 |
| 4 | IO_L02N_4/D0/DIN(1) | AF24 |
| 4 | IO_L02P_4/D1 | AG24 |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AD23 |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AE23 |
| 4 | IO_L04N_4/VREF_4 | AF23 |
| 4 | IO_L04P_4 | AG23 |
| 4 | IO_L05N_4/VRP_4 | AD22 |
| 4 | IO_L05P_4/VRN_4 | AE22 |
| 4 | IO_L06N_4 | AF22 |
| 4 | IO_L06P_4 | AG22 |
| 4 | IO_L19N_4 | AC21 |
| 4 | IO_L19P_4 | AB21 |
| 4 | IO_L21N_4 | AE21 |
| 4 | IO_L21P_4/VREF_4 | AE20 |
| 4 | IO_L22N_4 | AF21 |
| 4 | IO_L22P_4 | AG21 |
| 4 | IO_L24N_4 | AB20 |
| 4 | IO_L24P_4 | AA20 |
| 4 | IO_L25N_4 | AC20 |
| 4 | IO_L25P_4 | AD20 |
| 4 | IO_L27N_4 | AG20 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 4 | IO_L27P_4/VREF_4 | AG19 |
| 4 | IO_L28N_4 | AB19 |
| 4 | IO_L28P_4 | AA19 |
| 4 | IO_L30N_4 | AC19 |
| 4 | IO_L30P_4 | AD19 |
| 4 | IO_L49N_4 | AE19 |
| 4 | IO_L49P_4 | AF19 |
| 4 | IO_L51N_4 | AA18 |
| 4 | IO_L51P_4/VREF_4 | Y18 |
| 4 | IO_L52N_4 | AB18 |
| 4 | IO_L52P_4 | AC18 |
| 4 | IO_L54N_4 | AD18 |
| 4 | IO_L54P_4 | AE18 |
| 4 | IO_L67N_4 | AF18 |
| 4 | IO_L67P_4 | AG18 |
| 4 | IO_L69N_4 | AA17 |
| 4 | IO_L69P_4/VREF_4 | Y17 |
| 4 | IO_L70N_4 | AB17 |
| 4 | IO_L70P_4 | AB16 |
| 4 | IO_L72N_4 | AD17 |
| 4 | IO_L72P_4 | AE17 |
| 4 | IO_L73N_4 | AF17 |
| 4 | IO_L73P_4 | AG17 |
| 4 | IO_L75N_4 | Y16 |
| 4 | IO_L75P_4/VREF_4 | W16 |
| 4 | IO_L76N_4 | AC16 |
| 4 | IO_L76P_4 | AD16 |
| 4 | IO_L78N_4 | AF16 |
| 4 | IO_L78P_4 | AG16 |
| 4 | IO_L91N_4/VREF_4 | W15 |
| 4 | IO_L91P_4 | Y15 |
| 4 | IO_L92N_4 | AB15 |
| 4 | IO_L92P_4 | AA15 |
| 4 | IO_L93N_4 | AC15 |
| 4 | IO_L93P_4 | AD15 |
| 4 | IO_L94N_4/VREF_4 | AE15 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 4 | IO_L94P_4 | AE14 |
| 4 | IO_L95N_4/GCLK3S | AF15 |
| 4 | IO_L95P_4/GCLK2P | AG15 |
| 4 | IO_L96N_4/GCLK1S | Y14 |
| 4 | IO_L96P_4/GCLK0P | AA14 |
| | | |
| 5 | IO_L96N_5/GCLK7S | AC14 |
| 5 | IO_L96P_5/GCLK6P | AB14 |
| 5 | IO_L95N_5/GCLK5S | AG13 |
| 5 | IO_L95P_5/GCLK4P | AF13 |
| 5 | IO_L94N_5 | AE13 |
| 5 | IO_L94P_5/VREF_5 | AD13 |
| 5 | IO_L93N_5 | AC13 |
| 5 | IO_L93P_5 | AB13 |
| 5 | IO_L92N_5 | AA13 |
| 5 | IO_L92P_5 | Y13 |
| 5 | IO_L91N_5 | W13 |
| 5 | IO_L91P_5/VREF_5 | W12 |
| 5 | IO_L78N_5 | AG12 |
| 5 | IO_L78P_5 | AF12 |
| 5 | IO_L76N_5 | AD12 |
| 5 | IO_L76P_5 | AC12 |
| 5 | IO_L75N_5/VREF_5 | AB12 |
| 5 | IO_L75P_5 | AB11 |
| 5 | IO_L73N_5 | Y12 |
| 5 | IO_L73P_5 | Y11 |
| 5 | IO_L72N_5 | AG11 |
| 5 | IO_L72P_5 | AF11 |
| 5 | IO_L70N_5 | AE11 |
| 5 | IO_L70P_5 | AD11 |
| 5 | IO_L69N_5/VREF_5 | AA10 |
| 5 | IO_L69P_5 | AA11 |
| 5 | IO_L67N_5 | AG10 |
| 5 | IO_L67P_5 | AF10 |
| 5 | IO_L54N_5 | AE10 |
| 5 | IO_L54P_5 | AD10 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 5 | IO_L52N_5 | AC10 |
| 5 | IO_L52P_5 | AB10 |
| 5 | IO_L51N_5/VREF_5 | Y9 |
| 5 | IO_L51P_5 | Y10 |
| 5 | IO_L49N_5 | AG9 |
| 5 | IO_L49P_5 | AG8 |
| 5 | IO_L30N_5 | AF9 |
| 5 | IO_L30P_5 | AE9 |
| 5 | IO_L28N_5 | AD9 |
| 5 | IO_L28P_5 | AC9 |
| 5 | IO_L27N_5/VREF_5 | AB9 |
| 5 | IO_L27P_5 | AA9 |
| 5 | IO_L25N_5 | AE8 |
| 5 | IO_L25P_5 | AE7 |
| 5 | IO_L24N_5 | AD8 |
| 5 | IO_L24P_5 | AC8 |
| 5 | IO_L22N_5 | AB8 |
| 5 | IO_L22P_5 | AA8 |
| 5 | IO_L21N_5/VREF_5 | AG7 |
| 5 | IO_L21P_5 | AF7 |
| 5 | IO_L19N_5 | AC7 |
| 5 | IO_L19P_5 | AB7 |
| 5 | IO_L06N_5 | AG6 |
| 5 | IO_L06P_5 | AF6 |
| 5 | IO_L05N_5/VRP_5 | AE6 |
| 5 | IO_L05P_5/VRN_5 | AD6 |
| 5 | IO_L04N_5 | AG5 |
| 5 | IO_L04P_5/VREF_5 | AF5 |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AE5 |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AD5 |
| 5 | IO_L02N_5/D6 | AG4 |
| 5 | IO_L02P_5/D7 | AF4 |
| 5 | IO_L01N_5/RDWR_B | AG3 |
| 5 | IO_L01P_5/CS_B | AF3 |
| | | |
| 6 | IO_L01P_6 | AE1 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 6 | IO_L01N_6 | AD1 |
| 6 | IO_L02P_6/VRN_6 | AD3 |
| 6 | IO_L02N_6/VRP_6 | AD2 |
| 6 | IO_L03P_6 | AC4 |
| 6 | IO_L03N_6/VREF_6 | AC3 |
| 6 | IO_L04P_6 | AC2 |
| 6 | IO_L04N_6 | AC1 |
| 6 | IO_L06P_6 | AB5 |
| 6 | IO_L06N_6 | AB4 |
| 6 | IO_L19P_6 | AB3 |
| 6 | IO_L19N_6 | AB2 |
| 6 | IO_L21P_6 | AB1 |
| 6 | IO_L21N_6/VREF_6 | AA1 |
| 6 | IO_L22P_6 | AA5 |
| 6 | IO_L22N_6 | AA6 |
| 6 | IO_L24P_6 | AA3 |
| 6 | IO_L24N_6 | AA2 |
| 6 | IO_L25P_6 | Y5 |
| 6 | IO_L25N_6 | Y6 |
| 6 | IO_L27P_6 | Y4 |
| 6 | IO_L27N_6/VREF_6 | Y3 |
| 6 | IO_L28P_6 | Y1 |
| 6 | IO_L28N_6 | W1 |
| 6 | IO_L43P_6 | W8 |
| 6 | IO_L43N_6 | W9 |
| 6 | IO_L45P_6 | W6 |
| 6 | IO_L45N_6/VREF_6 | W7 |
| 6 | IO_L46P_6 | W5 |
| 6 | IO_L46N_6 | W4 |
| 6 | IO_L48P_6 | W3 |
| 6 | IO_L48N_6 | W2 |
| 6 | IO_L49P_6 | V7 |
| 6 | IO_L49N_6 | V8 |
| 6 | IO_L51P_6 | V5 |
| 6 | IO_L51N_6/VREF_6 | V6 |
| 6 | IO_L52P_6 | V4 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 6 | IO_L52N_6 | V3 |
| 6 | IO_L54P_6 | V2 |
| 6 | IO_L54N_6 | V1 |
| 6 | IO_L67P_6 | U8 |
| 6 | IO_L67N_6 | T8 |
| 6 | IO_L69P_6 | U6 |
| 6 | IO_L69N_6/VREF_6 | U7 |
| 6 | IO_L70P_6 | U4 |
| 6 | IO_L70N_6 | U3 |
| 6 | IO_L72P_6 | U2 |
| 6 | IO_L72N_6 | U1 |
| 6 | IO_L73P_6 | T9 |
| 6 | IO_L73N_6 | R9 |
| 6 | IO_L75P_6 | T5 |
| 6 | IO_L75N_6/VREF_6 | T6 |
| 6 | IO_L76P_6 | T4 |
| 6 | IO_L76N_6 | R4 |
| 6 | IO_L78P_6 | T2 |
| 6 | IO_L78N_6 | T1 |
| 6 | IO_L91P_6 | R7 |
| 6 | IO_L91N_6 | R8 |
| 6 | IO_L93P_6 | R5 |
| 6 | IO_L93N_6/VREF_6 | R6 |
| 6 | IO_L94P_6 | R3 |
| 6 | IO_L94N_6 | P3 |
| 6 | IO_L96P_6 | R2 |
| 6 | IO_L96N_6 | R1 |
| | | |
| 7 | IO_L96P_7 | P5 |
| 7 | IO_L96N_7 | P6 |
| 7 | IO_L94P_7 | P7 |
| 7 | IO_L94N_7 | P8 |
| 7 | IO_L93P_7/VREF_7 | N1 |
| 7 | IO_L93N_7 | N2 |
| 7 | IO_L91P_7 | N3 |
| 7 | IO_L91N_7 | N4 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 7 | IO_L78P_7 | N6 |
| 7 | IO_L78N_7 | N7 |
| 7 | IO_L76P_7 | N9 |
| 7 | IO_L76N_7 | N8 |
| 7 | IO_L75P_7/VREF_7 | N5 |
| 7 | IO_L75N_7 | M6 |
| 7 | IO_L73P_7 | M1 |
| 7 | IO_L73N_7 | M2 |
| 7 | IO_L72P_7 | M4 |
| 7 | IO_L72N_7 | M5 |
| 7 | IO_L70P_7 | M8 |
| 7 | IO_L70N_7 | M9 |
| 7 | IO_L69P_7/VREF_7 | L1 |
| 7 | IO_L69N_7 | L2 |
| 7 | IO_L67P_7 | L3 |
| 7 | IO_L67N_7 | L4 |
| 7 | IO_L54P_7 | K1 |
| 7 | IO_L54N_7 | K2 |
| 7 | IO_L52P_7 | K4 |
| 7 | IO_L52N_7 | K5 |
| 7 | IO_L51P_7/VREF_7 | L6 |
| 7 | IO_L51N_7 | L7 |
| 7 | IO_L49P_7 | K6 |
| 7 | IO_L49N_7 | K7 |
| 7 | IO_L48P_7 | L8 |
| 7 | IO_L48N_7 | K8 |
| 7 | IO_L46P_7 | J1 |
| 7 | IO_L46N_7 | H1 |
| 7 | IO_L45P_7/VREF_7 | J2 |
| 7 | IO_L45N_7 | J3 |
| 7 | IO_L43P_7 | K3 |
| 7 | IO_L43N_7 | J4 |
| 7 | IO_L30P_7 | H3 |
| 7 | IO_L30N_7 | H4 |
| 7 | IO_L28P_7 | J5 |
| 7 | IO_L28N_7 | J6 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 7 | IO_L27P_7/VREF_7 | H5 |
| 7 | IO_L27N_7 | H6 |
| 7 | IO_L25P_7 | J7 |
| 7 | IO_L25N_7 | J8 |
| 7 | IO_L24P_7 | G1 |
| 7 | IO_L24N_7 | F1 |
| 7 | IO_L22P_7 | G2 |
| 7 | IO_L22N_7 | G3 |
| 7 | IO_L21P_7/VREF_7 | F2 |
| 7 | IO_L21N_7 | F3 |
| 7 | IO_L19P_7 | G5 |
| 7 | IO_L19N_7 | G6 |
| 7 | IO_L06P_7 | F4 |
| 7 | IO_L06N_7 | F5 |
| 7 | IO_L04P_7 | E1 |
| 7 | IO_L04N_7 | E2 |
| 7 | IO_L03P_7/VREF_7 | D1 |
| 7 | IO_L03N_7 | C1 |
| 7 | IO_L02P_7/VRN_7 | E3 |
| 7 | IO_L02N_7/VRP_7 | E4 |
| 7 | IO_L01P_7 | D2 |
| 7 | IO_L01N_7 | D3 |
| | | |
| 0 | VCCO_0 | K13 |
| 0 | VCCO_0 | K12 |
| 0 | VCCO_0 | K11 |
| 0 | VCCO_0 | J11 |
| 0 | VCCO_0 | J10 |
| 0 | VCCO_0 | G12 |
| 0 | VCCO_0 | D7 |
| 0 | VCCO_0 | C12 |
| 1 | VCCO_1 | K17 |
| 1 | VCCO_1 | K16 |
| 1 | VCCO_1 | K15 |
| 1 | VCCO_1 | J18 |
| 1 | VCCO_1 | J17 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 1 | VCCO_1 | G16 |
| 1 | VCCO_1 | D21 |
| 1 | VCCO_1 | C16 |
| 2 | VCCO_2 | N18 |
| 2 | VCCO_2 | M25 |
| 2 | VCCO_2 | M21 |
| 2 | VCCO_2 | M18 |
| 2 | VCCO_2 | L19 |
| 2 | VCCO_2 | L18 |
| 2 | VCCO_2 | K19 |
| 2 | VCCO_2 | G24 |
| 3 | VCCO_3 | AA24 |
| 3 | VCCO_3 | V19 |
| 3 | VCCO_3 | U19 |
| 3 | VCCO_3 | U18 |
| 3 | VCCO_3 | T25 |
| 3 | VCCO_3 | T21 |
| 3 | VCCO_3 | T18 |
| 3 | VCCO_3 | R18 |
| 4 | VCCO_4 | AE16 |
| 4 | VCCO_4 | AD21 |
| 4 | VCCO_4 | AA16 |
| 4 | VCCO_4 | W18 |
| 4 | VCCO_4 | W17 |
| 4 | VCCO_4 | V17 |
| 4 | VCCO_4 | V16 |
| 4 | VCCO_4 | V15 |
| 5 | VCCO_5 | AE12 |
| 5 | VCCO_5 | AD7 |
| 5 | VCCO_5 | AA12 |
| 5 | VCCO_5 | W11 |
| 5 | VCCO_5 | W10 |
| 5 | VCCO_5 | V13 |
| 5 | VCCO_5 | V12 |
| 5 | VCCO_5 | V11 |
| 6 | VCCO_6 | AA4 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| 6 | VCCO_6 | V9 |
| 6 | VCCO_6 | U10 |
| 6 | VCCO_6 | U9 |
| 6 | VCCO_6 | T10 |
| 6 | VCCO_6 | T7 |
| 6 | VCCO_6 | T3 |
| 6 | VCCO_6 | R10 |
| 7 | VCCO_7 | M10 |
| 7 | VCCO_7 | M7 |
| 7 | VCCO_7 | M3 |
| 7 | VCCO_7 | L10 |
| 7 | VCCO_7 | L9 |
| 7 | VCCO_7 | K9 |
| 7 | VCCO_7 | G4 |
| 7 | VCCO_7 | N10 |
| | | |
| NA | CCLK | AA22 |
| NA | PROG_B | C4 |
| NA | DONE | AC22 |
| NA | M0 | AC6 |
| NA | M1 | Y7 |
| NA | M2 | AE4 |
| NA | HSWAP_EN | D5 |
| NA | TCK | G20 |
| NA | TDI | H7 |
| NA | TDO | G22 |
| NA | TMS | F21 |
| NA | PWRDWN_B | AE24 |
| NA | DXN | G8 |
| NA | DXP | F7 |
| NA | VBATT | D23 |
| NA | RSVD | C24 |
| | | |
| NA | VCCAUX | AF14 |
| NA | VCCAUX | AE26 |
| NA | VCCAUX | AE2 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| NA | VCCAUX | P26 |
| NA | VCCAUX | P2 |
| NA | VCCAUX | C26 |
| NA | VCCAUX | C2 |
| NA | VCCAUX | B14 |
| NA | VCCINT | V18 |
| NA | VCCINT | V14 |
| NA | VCCINT | V10 |
| NA | VCCINT | U17 |
| NA | VCCINT | U16 |
| NA | VCCINT | U15 |
| NA | VCCINT | U14 |
| NA | VCCINT | U13 |
| NA | VCCINT | U12 |
| NA | VCCINT | U11 |
| NA | VCCINT | T17 |
| NA | VCCINT | T11 |
| NA | VCCINT | R17 |
| NA | VCCINT | R11 |
| NA | VCCINT | P18 |
| NA | VCCINT | P17 |
| NA | VCCINT | P11 |
| NA | VCCINT | P10 |
| NA | VCCINT | N17 |
| NA | VCCINT | N11 |
| NA | VCCINT | M17 |
| NA | VCCINT | M11 |
| NA | VCCINT | L17 |
| NA | VCCINT | L16 |
| NA | VCCINT | L15 |
| NA | VCCINT | L14 |
| NA | VCCINT | L13 |
| NA | VCCINT | L12 |
| NA | VCCINT | L11 |
| NA | VCCINT | K18 |
| NA | VCCINT | K14 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| NA | VCCINT | K10 |
| NA | GND | AG27 |
| NA | GND | AG26 |
| NA | GND | AG14 |
| NA | GND | AG2 |
| NA | GND | AG1 |
| NA | GND | AF27 |
| NA | GND | AF26 |
| NA | GND | AF20 |
| NA | GND | AF8 |
| NA | GND | AF2 |
| NA | GND | AF1 |
| NA | GND | AE25 |
| NA | GND | AE3 |
| NA | GND | AD24 |
| NA | GND | AD14 |
| NA | GND | AD4 |
| NA | GND | AC23 |
| NA | GND | AC17 |
| NA | GND | AC11 |
| NA | GND | AC5 |
| NA | GND | AB22 |
| NA | GND | AB6 |
| NA | GND | AA21 |
| NA | GND | AA7 |
| NA | GND | Y26 |
| NA | GND | Y20 |
| NA | GND | Y8 |
| NA | GND | Y2 |
| NA | GND | W14 |
| NA | GND | U23 |
| NA | GND | U5 |
| NA | GND | T16 |
| NA | GND | T15 |
| NA | GND | T14 |
| NA | GND | T13 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| NA | GND | T12 |
| NA | GND | R16 |
| NA | GND | R15 |
| NA | GND | R14 |
| NA | GND | R13 |
| NA | GND | R12 |
| NA | GND | P27 |
| NA | GND | P24 |
| NA | GND | P19 |
| NA | GND | P16 |
| NA | GND | P15 |
| NA | GND | P14 |
| NA | GND | P13 |
| NA | GND | P12 |
| NA | GND | P9 |
| NA | GND | P4 |
| NA | GND | P1 |
| NA | GND | N16 |
| NA | GND | N15 |
| NA | GND | N14 |
| NA | GND | N13 |
| NA | GND | N12 |
| NA | GND | M16 |
| NA | GND | M15 |
| NA | GND | M14 |
| NA | GND | M13 |
| NA | GND | M12 |
| NA | GND | L23 |
| NA | GND | L5 |
| NA | GND | J14 |
| NA | GND | H26 |
| NA | GND | H20 |
| NA | GND | H8 |
| NA | GND | H2 |
| NA | GND | G21 |
| NA | GND | G7 |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

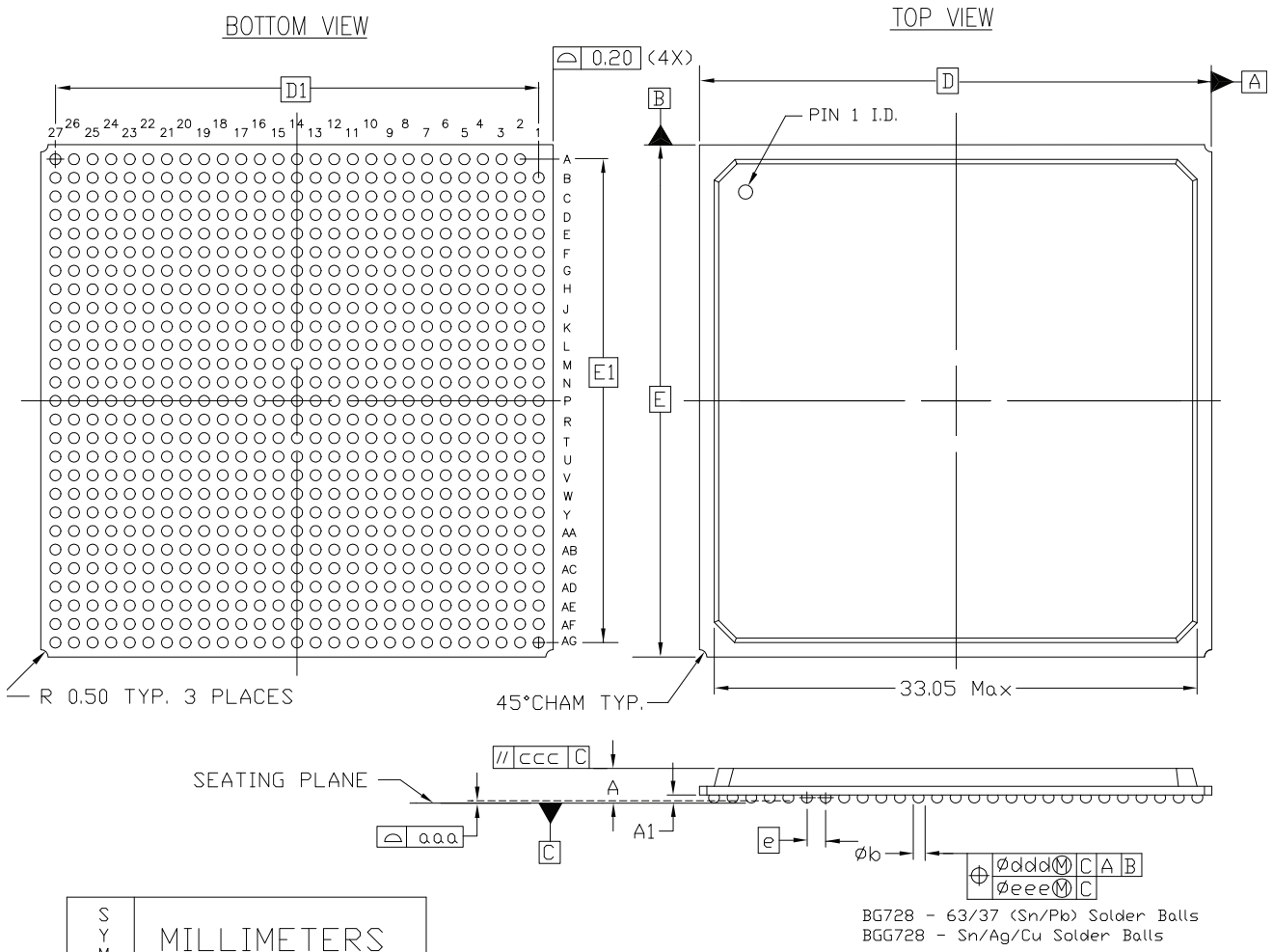

*Table 10:* **BG728 BGA — XC2V3000**

| Bank | Pin Description | Pin Number |
|---|---|---|
| NA | GND | F22 |
| NA | GND | F6 |
| NA | GND | E23 |
| NA | GND | E17 |
| NA | GND | E11 |
| NA | GND | E5 |
| NA | GND | D24 |
| NA | GND | D14 |
| NA | GND | D4 |
| NA | GND | C25 |
| NA | GND | C3 |
| NA | GND | B27 |
| NA | GND | B26 |
| NA | GND | B20 |
| NA | GND | B8 |
| NA | GND | B2 |
| NA | GND | B1 |
| NA | GND | A27 |
| NA | GND | A26 |
| NA | GND | A14 |
| NA | GND | A2 |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch)




| SYMBOL | MILLIMETERS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | | 2.33 | 2.60 |
| $A_1$ | 0.50 | 0.60 | 0.70 |
| D/E | 35.00 BSC | | |
| $D_1/E_1$ | 33.02 REF | | |
| e | 1.27BSC | | |
| øb | 0.60 | 0.75 | 0.90 |
| aaa | | | 0.20 |
| ccc | | | 0.35 |
| ddd | | | 0.30 |
| eee | | | 0.15 |
| M | 27 | | |

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS-034-BAR-1
4. NO SOLDER BALL AND LAND ON A1.

728-BALL MOLDED BGA (BG728/BGG728)

*Figure 6:* **BG728/BGG728 Standard BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FF896 Flip-Chip Fine-Pitch BGA Package

As shown in Table 11, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the FF896 flip-chip fine-pitch BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the FF896 Flip-Chip

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Fine-Pitch BGA Package Specifications (1.00mm pitch).

*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | B27 | | |
| 0 | IO_L01P_0 | A27 | | |
| 0 | IO_L02N_0 | F24 | | |
| 0 | IO_L02P_0 | E24 | | |
| 0 | IO_L03N_0/VRP_0 | C26 | | |
| 0 | IO_L03P_0/VRN_0 | C25 | | |
| 0 | IO_L04N_0/VREF_0 | A26 | | |
| 0 | IO_L04P_0 | A25 | | |
| 0 | IO_L05N_0 | F23 | | |
| 0 | IO_L05P_0 | F22 | | |
| 0 | IO_L06N_0 | C24 | | |
| 0 | IO_L06P_0 | D25 | | |
| 0 | IO_L19N_0 | A24 | | |
| 0 | IO_L19P_0 | B25 | | |
| 0 | IO_L20N_0 | G22 | | |
| 0 | IO_L20P_0 | G21 | | |
| 0 | IO_L21N_0 | D24 | | |
| 0 | IO_L21P_0/VREF_0 | D23 | | |
| 0 | IO_L22N_0 | B23 | | |
| 0 | IO_L22P_0 | B24 | | |
| 0 | IO_L23N_0 | H21 | | |
| 0 | IO_L23P_0 | H20 | | |
| 0 | IO_L24N_0 | E22 | | |
| 0 | IO_L24P_0 | E23 | | |
| 0 | IO_L49N_0 | A22 | | |
| 0 | IO_L49P_0 | B22 | | |
| 0 | IO_L50N_0 | F21 | | |
| 0 | IO_L50P_0 | F20 | | |
| 0 | IO_L51N_0 | C23 | | |
| 0 | IO_L51P_0/VREF_0 | C22 | | |
| 0 | IO_L52N_0 | B20 | | |
| 0 | IO_L52P_0 | B21 | | |
| 0 | IO_L53N_0 | G20 | | |
| 0 | IO_L53P_0 | G19 | | |
| 0 | IO_L54N_0 | D21 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 0 | IO_L54P_0 | D22 | | |
| 0 | IO_L67N_0 | E20 | NC | |
| 0 | IO_L67P_0 | E21 | NC | |
| 0 | IO_L68N_0 | H19 | NC | |
| 0 | IO_L68P_0 | H18 | NC | |
| 0 | IO_L69N_0 | D20 | NC | |
| 0 | IO_L69P_0/VREF_0 | D19 | NC | |
| 0 | IO_L70N_0 | A20 | NC | |
| 0 | IO_L70P_0 | A21 | NC | |
| 0 | IO_L71N_0 | F19 | NC | |
| 0 | IO_L71P_0 | F18 | NC | |
| 0 | IO_L72N_0 | C19 | NC | |
| 0 | IO_L72P_0 | C20 | NC | |
| 0 | IO_L73N_0 | B18 | NC | NC |
| 0 | IO_L73P_0 | B19 | NC | NC |
| 0 | IO_L74N_0 | G18 | NC | NC |
| 0 | IO_L74P_0 | H17 | NC | NC |
| 0 | IO_L75N_0 | E18 | NC | NC |
| 0 | IO_L75P_0/VREF_0 | D18 | NC | NC |
| 0 | IO_L76N_0 | A18 | NC | NC |
| 0 | IO_L76P_0 | A19 | NC | NC |
| 0 | IO_L77N_0 | J17 | NC | NC |
| 0 | IO_L77P_0 | J16 | NC | NC |
| 0 | IO_L78N_0 | E16 | NC | NC |
| 0 | IO_L78P_0 | E17 | NC | NC |
| 0 | IO_L91N_0/VREF_0 | B17 | | |
| 0 | IO_L91P_0 | B16 | | |
| 0 | IO_L92N_0 | F17 | | |
| 0 | IO_L92P_0 | F16 | | |
| 0 | IO_L93N_0 | D16 | | |
| 0 | IO_L93P_0 | D17 | | |
| 0 | IO_L94N_0/VREF_0 | A17 | | |
| 0 | IO_L94P_0 | A16 | | |
| 0 | IO_L95N_0/GCLK7P | H16 | | |
| 0 | IO_L95P_0/GCLK6S | G16 | | |
| 0 | IO_L96N_0/GCLK5P | C17 | | |
| 0 | IO_L96P_0/GCLK4S | C16 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| | | | | |
| 1 | IO_L96N_1/GCLK3P | C15 | | |
| 1 | IO_L96P_1/GCLK2S | C14 | | |
| 1 | IO_L95N_1/GCLK1P | F15 | | |
| 1 | IO_L95P_1/GCLK0S | F14 | | |
| 1 | IO_L94N_1 | B15 | | |
| 1 | IO_L94P_1/VREF_1 | B14 | | |
| 1 | IO_L93N_1 | D14 | | |
| 1 | IO_L93P_1 | D15 | | |
| 1 | IO_L92N_1 | G15 | | |
| 1 | IO_L92P_1 | H15 | | |
| 1 | IO_L91N_1 | A14 | | |
| 1 | IO_L91P_1/VREF_1 | A13 | | |
| 1 | IO_L78N_1 | E14 | NC | NC |
| 1 | IO_L78P_1 | E15 | NC | NC |
| 1 | IO_L77N_1 | J15 | NC | NC |
| 1 | IO_L77P_1 | J14 | NC | NC |
| 1 | IO_L76N_1 | B12 | NC | NC |
| 1 | IO_L76P_1 | B13 | NC | NC |
| 1 | IO_L75N_1/VREF_1 | D13 | NC | NC |
| 1 | IO_L75P_1 | E13 | NC | NC |
| 1 | IO_L74N_1 | H14 | NC | NC |
| 1 | IO_L74P_1 | H13 | NC | NC |
| 1 | IO_L73N_1 | A11 | NC | NC |
| 1 | IO_L73P_1 | A12 | NC | NC |
| 1 | IO_L72N_1 | C11 | NC | |
| 1 | IO_L72P_1 | C12 | NC | |
| 1 | IO_L71N_1 | F13 | NC | |
| 1 | IO_L71P_1 | F12 | NC | |
| 1 | IO_L70N_1 | B10 | NC | |
| 1 | IO_L70P_1 | B11 | NC | |
| 1 | IO_L69N_1/VREF_1 | D12 | NC | |
| 1 | IO_L69P_1 | D11 | NC | |
| 1 | IO_L68N_1 | G13 | NC | |
| 1 | IO_L68P_1 | G12 | NC | |
| 1 | IO_L67N_1 | A9 | NC | |
| 1 | IO_L67P_1 | A10 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 1 | IO_L54N_1 | E10 | | |
| 1 | IO_L54P_1 | E11 | | |
| 1 | IO_L53N_1 | H12 | | |
| 1 | IO_L53P_1 | H11 | | |
| 1 | IO_L52N_1 | D9 | | |
| 1 | IO_L52P_1 | D10 | | |
| 1 | IO_L51N_1/VREF_1 | C9 | | |
| 1 | IO_L51P_1 | C8 | | |
| 1 | IO_L50N_1 | F11 | | |
| 1 | IO_L50P_1 | F10 | | |
| 1 | IO_L49N_1 | B8 | | |
| 1 | IO_L49P_1 | B9 | | |
| 1 | IO_L24N_1 | E8 | | |
| 1 | IO_L24P_1 | E9 | | |
| 1 | IO_L23N_1 | G11 | | |
| 1 | IO_L23P_1 | H10 | | |
| 1 | IO_L22N_1 | B7 | | |
| 1 | IO_L22P_1 | A7 | | |
| 1 | IO_L21N_1/VREF_1 | D8 | | |
| 1 | IO_L21P_1 | E7 | | |
| 1 | IO_L20N_1 | G10 | | |
| 1 | IO_L20P_1 | G9 | | |
| 1 | IO_L19N_1 | A5 | | |
| 1 | IO_L19P_1 | A6 | | |
| 1 | IO_L06N_1 | C6 | | |
| 1 | IO_L06P_1 | C7 | | |
| 1 | IO_L05N_1 | F9 | | |
| 1 | IO_L05P_1 | G8 | | |
| 1 | IO_L04N_1 | B6 | | |
| 1 | IO_L04P_1/VREF_1 | C5 | | |
| 1 | IO_L03N_1/VRP_1 | D7 | | |
| 1 | IO_L03P_1/VRN_1 | D6 | | |
| 1 | IO_L02N_1 | F8 | | |
| 1 | IO_L02P_1 | F7 | | |
| 1 | IO_L01N_1 | B4 | | |
| 1 | IO_L01P_1 | A4 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 2 | IO_L01N_2 | C1 | | |
| 2 | IO_L01P_2 | B1 | | |
| 2 | IO_L02N_2/VRP_2 | H9 | | |
| 2 | IO_L02P_2/VRN_2 | H8 | | |
| 2 | IO_L03N_2 | D3 | | |
| 2 | IO_L03P_2/VREF_2 | E3 | | |
| 2 | IO_L04N_2 | D2 | | |
| 2 | IO_L04P_2 | C2 | | |
| 2 | IO_L05N_2 | G7 | | |
| 2 | IO_L05P_2 | H7 | | |
| 2 | IO_L06N_2 | F4 | | |
| 2 | IO_L06P_2 | E4 | | |
| 2 | IO_L19N_2 | E1 | | |
| 2 | IO_L19P_2 | D1 | | |
| 2 | IO_L20N_2 | G6 | | |
| 2 | IO_L20P_2 | H6 | | |
| 2 | IO_L21N_2 | F5 | | |
| 2 | IO_L21P_2/VREF_2 | G5 | | |
| 2 | IO_L22N_2 | G2 | | |
| 2 | IO_L22P_2 | F2 | | |
| 2 | IO_L23N_2 | J8 | | |
| 2 | IO_L23P_2 | J7 | | |
| 2 | IO_L24N_2 | G3 | | |
| 2 | IO_L24P_2 | F3 | | |
| 2 | IO_L43N_2 | G1 | | |
| 2 | IO_L43P_2 | F1 | | |
| 2 | IO_L44N_2 | K8 | | |
| 2 | IO_L44P_2 | L8 | | |
| 2 | IO_L45N_2 | G4 | | |
| 2 | IO_L45P_2/VREF_2 | H4 | | |
| 2 | IO_L46N_2 | J2 | | |
| 2 | IO_L46P_2 | H2 | | |
| 2 | IO_L47N_2 | J6 | | |
| 2 | IO_L47P_2 | K6 | | |
| 2 | IO_L48N_2 | J5 | | |
| 2 | IO_L48P_2 | H5 | | |
| 2 | IO_L49N_2 | J3 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 2 | IO_L49P_2 | H3 | | |
| 2 | IO_L50N_2 | K7 | | |
| 2 | IO_L50P_2 | L7 | | |
| 2 | IO_L51N_2 | J4 | | |
| 2 | IO_L51P_2/VREF_2 | K4 | | |
| 2 | IO_L52N_2 | K1 | | |
| 2 | IO_L52P_2 | J1 | | |
| 2 | IO_L53N_2 | L6 | | |
| 2 | IO_L53P_2 | M6 | | |
| 2 | IO_L54N_2 | L5 | | |
| 2 | IO_L54P_2 | K5 | | |
| 2 | IO_L67N_2 | L2 | NC | |
| 2 | IO_L67P_2 | K2 | NC | |
| 2 | IO_L68N_2 | M8 | NC | |
| 2 | IO_L68P_2 | N8 | NC | |
| 2 | IO_L69N_2 | L4 | NC | |
| 2 | IO_L69P_2/VREF_2 | M4 | NC | |
| 2 | IO_L70N_2 | M1 | NC | |
| 2 | IO_L70P_2 | L1 | NC | |
| 2 | IO_L71N_2 | M7 | NC | |
| 2 | IO_L71P_2 | N7 | NC | |
| 2 | IO_L72N_2 | M3 | NC | |
| 2 | IO_L72P_2 | L3 | NC | |
| 2 | IO_L73N_2 | N2 | NC | NC |
| 2 | IO_L73P_2 | M2 | NC | NC |
| 2 | IO_L74N_2 | N6 | NC | NC |
| 2 | IO_L74P_2 | P6 | NC | NC |
| 2 | IO_L75N_2 | N5 | NC | NC |
| 2 | IO_L75P_2/VREF_2 | N4 | NC | NC |
| 2 | IO_L76N_2 | P1 | NC | NC |
| 2 | IO_L76P_2 | N1 | NC | NC |
| 2 | IO_L77N_2 | P9 | NC | NC |
| 2 | IO_L77P_2 | R9 | NC | NC |
| 2 | IO_L78N_2 | R5 | NC | NC |
| 2 | IO_L78P_2 | P5 | NC | NC |
| 2 | IO_L91N_2 | R2 | | |
| 2 | IO_L91P_2 | P2 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 2 | IO_L92N_2 | P8 | | |
| 2 | IO_L92P_2 | R8 | | |
| 2 | IO_L93N_2 | P4 | | |
| 2 | IO_L93P_2/VREF_2 | R4 | | |
| 2 | IO_L94N_2 | R1 | | |
| 2 | IO_L94P_2 | T2 | | |
| 2 | IO_L95N_2 | R7 | | |
| 2 | IO_L95P_2 | R6 | | |
| 2 | IO_L96N_2 | R3 | | |
| 2 | IO_L96P_2 | P3 | | |
| | | | | |
| 3 | IO_L96N_3 | T7 | | |
| 3 | IO_L96P_3 | T6 | | |
| 3 | IO_L95N_3 | U1 | | |
| 3 | IO_L95P_3 | V1 | | |
| 3 | IO_L94N_3 | T3 | | |
| 3 | IO_L94P_3 | U3 | | |
| 3 | IO_L93N_3/VREF_3 | T8 | | |
| 3 | IO_L93P_3 | U8 | | |
| 3 | IO_L92N_3 | U2 | | |
| 3 | IO_L92P_3 | V2 | | |
| 3 | IO_L91N_3 | T4 | | |
| 3 | IO_L91P_3 | U4 | | |
| 3 | IO_L78N_3 | U9 | NC | NC |
| 3 | IO_L78P_3 | T9 | NC | NC |
| 3 | IO_L77N_3 | W1 | NC | NC |
| 3 | IO_L77P_3 | Y1 | NC | NC |
| 3 | IO_L76N_3 | T5 | NC | NC |
| 3 | IO_L76P_3 | U5 | NC | NC |
| 3 | IO_L75N_3/VREF_3 | U6 | NC | NC |
| 3 | IO_L75P_3 | V6 | NC | NC |
| 3 | IO_L74N_3 | W2 | NC | NC |
| 3 | IO_L74P_3 | Y2 | NC | NC |
| 3 | IO_L73N_3 | V4 | NC | NC |
| 3 | IO_L73P_3 | W4 | NC | NC |
| 3 | IO_L72N_3 | W7 | NC | |
| 3 | IO_L72P_3 | V7 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 3 | IO_L71N_3 | V5 | NC | |
| 3 | IO_L71P_3 | W6 | NC | |
| 3 | IO_L70N_3 | W3 | NC | |
| 3 | IO_L70P_3 | Y3 | NC | |
| 3 | IO_L69N_3/VREF_3 | V8 | NC | |
| 3 | IO_L69P_3 | W8 | NC | |
| 3 | IO_L68N_3 | AA1 | NC | |
| 3 | IO_L68P_3 | AB1 | NC | |
| 3 | IO_L67N_3 | Y4 | NC | |
| 3 | IO_L67P_3 | AA4 | NC | |
| 3 | IO_L54N_3 | AA6 | | |
| 3 | IO_L54P_3 | Y6 | | |
| 3 | IO_L53N_3 | AA2 | | |
| 3 | IO_L53P_3 | AB2 | | |
| 3 | IO_L52N_3 | Y5 | | |
| 3 | IO_L52P_3 | AA5 | | |
| 3 | IO_L51N_3/VREF_3 | Y8 | | |
| 3 | IO_L51P_3 | AA8 | | |
| 3 | IO_L50N_3 | AC2 | | |
| 3 | IO_L50P_3 | AD2 | | |
| 3 | IO_L49N_3 | Y7 | | |
| 3 | IO_L49P_3 | AA7 | | |
| 3 | IO_L48N_3 | AC6 | | |
| 3 | IO_L48P_3 | AB6 | | |
| 3 | IO_L47N_3 | AD1 | | |
| 3 | IO_L47P_3 | AE1 | | |
| 3 | IO_L46N_3 | AB3 | | |
| 3 | IO_L46P_3 | AC3 | | |
| 3 | IO_L45N_3/VREF_3 | AB7 | | |
| 3 | IO_L45P_3 | AC7 | | |
| 3 | IO_L44N_3 | AB4 | | |
| 3 | IO_L44P_3 | AC4 | | |
| 3 | IO_L43N_3 | AB5 | | |
| 3 | IO_L43P_3 | AC5 | | |
| 3 | IO_L24N_3 | AC8 | | |
| 3 | IO_L24P_3 | AB8 | | |
| 3 | IO_L23N_3 | AE2 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 3 | IO_L23P_3 | AF3 | | |
| 3 | IO_L22N_3 | AD3 | | |
| 3 | IO_L22P_3 | AE3 | | |
| 3 | IO_L21N_3/VREF_3 | AD6 | | |
| 3 | IO_L21P_3 | AD7 | | |
| 3 | IO_L20N_3 | AF1 | | |
| 3 | IO_L20P_3 | AG1 | | |
| 3 | IO_L19N_3 | AD4 | | |
| 3 | IO_L19P_3 | AE4 | | |
| 3 | IO_L06N_3 | AD8 | | |
| 3 | IO_L06P_3 | AE7 | | |
| 3 | IO_L05N_3 | AG2 | | |
| 3 | IO_L05P_3 | AH2 | | |
| 3 | IO_L04N_3 | AD5 | | |
| 3 | IO_L04P_3 | AE5 | | |
| 3 | IO_L03N_3/VREF_3 | AC9 | | |
| 3 | IO_L03P_3 | AD9 | | |
| 3 | IO_L02N_3/VRP_3 | AH1 | | |
| 3 | IO_L02P_3/VRN_3 | AJ1 | | |
| 3 | IO_L01N_3 | AF4 | | |
| 3 | IO_L01P_3 | AG3 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AK2 | | |
| 4 | IO_L01P_4/INIT_B | AJ3 | | |
| 4 | IO_L02N_4/D0/DIN(1) | AE8 | | |
| 4 | IO_L02P_4/D1 | AF9 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AH5 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AH6 | | |
| 4 | IO_L04N_4/VREF_4 | AJ4 | | |
| 4 | IO_L04P_4 | AK4 | | |
| 4 | IO_L05N_4/VRP_4 | AC10 | | |
| 4 | IO_L05P_4/VRN_4 | AC11 | | |
| 4 | IO_L06N_4 | AH7 | | |
| 4 | IO_L06P_4 | AG6 | | |
| 4 | IO_L19N_4 | AK6 | | |
| 4 | IO_L19P_4 | AK5 | | |
| 4 | IO_L20N_4 | AE9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 4 | IO_L20P_4 | AE10 | | |
| 4 | IO_L21N_4 | AF7 | | |
| 4 | IO_L21P_4/VREF_4 | AF8 | | |
| 4 | IO_L22N_4 | AK7 | | |
| 4 | IO_L22P_4 | AJ6 | | |
| 4 | IO_L23N_4 | AD10 | | |
| 4 | IO_L23P_4 | AD11 | | |
| 4 | IO_L24N_4 | AG8 | | |
| 4 | IO_L24P_4 | AG7 | | |
| 4 | IO_L49N_4 | AJ8 | | |
| 4 | IO_L49P_4 | AJ7 | | |
| 4 | IO_L50N_4 | AE11 | | |
| 4 | IO_L50P_4 | AE12 | | |
| 4 | IO_L51N_4 | AG9 | | |
| 4 | IO_L51P_4/VREF_4 | AG10 | | |
| 4 | IO_L52N_4 | AK9 | | |
| 4 | IO_L52P_4 | AJ9 | | |
| 4 | IO_L53N_4 | AH8 | | |
| 4 | IO_L53P_4 | AH9 | | |
| 4 | IO_L54N_4 | AF11 | | |
| 4 | IO_L54P_4 | AF10 | | |
| 4 | IO_L67N_4 | AJ11 | NC | |
| 4 | IO_L67P_4 | AJ10 | NC | |
| 4 | IO_L68N_4 | AC12 | NC | |
| 4 | IO_L68P_4 | AC13 | NC | |
| 4 | IO_L69N_4 | AG11 | NC | |
| 4 | IO_L69P_4/VREF_4 | AG12 | NC | |
| 4 | IO_L70N_4 | AK11 | NC | |
| 4 | IO_L70P_4 | AK10 | NC | |
| 4 | IO_L71N_4 | AD12 | NC | |
| 4 | IO_L71P_4 | AD13 | NC | |
| 4 | IO_L72N_4 | AH12 | NC | |
| 4 | IO_L72P_4 | AH11 | NC | |
| 4 | IO_L73N_4 | AJ13 | NC | NC |
| 4 | IO_L73P_4 | AJ12 | NC | NC |
| 4 | IO_L74N_4 | AE13 | NC | NC |
| 4 | IO_L74P_4 | AE14 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 4 | IO_L75N_4 | AF13 | NC | NC |
| 4 | IO_L75P_4/VREF_4 | AG13 | NC | NC |
| 4 | IO_L76N_4 | AK13 | NC | NC |
| 4 | IO_L76P_4 | AK12 | NC | NC |
| 4 | IO_L77N_4 | AB14 | NC | NC |
| 4 | IO_L77P_4 | AB15 | NC | NC |
| 4 | IO_L78N_4 | AF15 | NC | NC |
| 4 | IO_L78P_4 | AF14 | NC | NC |
| 4 | IO_L91N_4/VREF_4 | AJ14 | | |
| 4 | IO_L91P_4 | AJ15 | | |
| 4 | IO_L92N_4 | AC14 | | |
| 4 | IO_L92P_4 | AC15 | | |
| 4 | IO_L93N_4 | AG15 | | |
| 4 | IO_L93P_4 | AG14 | | |
| 4 | IO_L94N_4/VREF_4 | AK14 | | |
| 4 | IO_L94P_4 | AK15 | | |
| 4 | IO_L95N_4/GCLK3S | AD15 | | |
| 4 | IO_L95P_4/GCLK2P | AE15 | | |
| 4 | IO_L96N_4/GCLK1S | AH14 | | |
| 4 | IO_L96P_4/GCLK0P | AH15 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | AH16 | | |
| 5 | IO_L96P_5/GCLK6P | AH17 | | |
| 5 | IO_L95N_5/GCLK5S | AE16 | | |
| 5 | IO_L95P_5/GCLK4P | AD16 | | |
| 5 | IO_L94N_5 | AJ16 | | |
| 5 | IO_L94P_5/VREF_5 | AJ17 | | |
| 5 | IO_L93N_5 | AG17 | | |
| 5 | IO_L93P_5 | AG16 | | |
| 5 | IO_L92N_5 | AC16 | | |
| 5 | IO_L92P_5 | AC17 | | |
| 5 | IO_L91N_5 | AK17 | | |
| 5 | IO_L91P_5/VREF_5 | AK18 | | |
| 5 | IO_L78N_5 | AF17 | NC | NC |
| 5 | IO_L78P_5 | AF16 | NC | NC |
| 5 | IO_L77N_5 | AB16 | NC | NC |
| 5 | IO_L77P_5 | AB17 | NC | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 5 | IO_L76N_5 | AJ19 | NC | NC |
| 5 | IO_L76P_5 | AJ18 | NC | NC |
| 5 | IO_L75N_5/VREF_5 | AG18 | NC | NC |
| 5 | IO_L75P_5 | AF18 | NC | NC |
| 5 | IO_L74N_5 | AE17 | NC | NC |
| 5 | IO_L74P_5 | AE18 | NC | NC |
| 5 | IO_L73N_5 | AK20 | NC | NC |
| 5 | IO_L73P_5 | AK19 | NC | NC |
| 5 | IO_L72N_5 | AH20 | NC | |
| 5 | IO_L72P_5 | AH19 | NC | |
| 5 | IO_L71N_5 | AD18 | NC | |
| 5 | IO_L71P_5 | AD19 | NC | |
| 5 | IO_L70N_5 | AJ21 | NC | |
| 5 | IO_L70P_5 | AJ20 | NC | |
| 5 | IO_L69N_5/VREF_5 | AG19 | NC | |
| 5 | IO_L69P_5 | AG20 | NC | |
| 5 | IO_L68N_5 | AC18 | NC | |
| 5 | IO_L68P_5 | AC19 | NC | |
| 5 | IO_L67N_5 | AK22 | NC | |
| 5 | IO_L67P_5 | AK21 | NC | |
| 5 | IO_L54N_5 | AF21 | | |
| 5 | IO_L54P_5 | AF20 | | |
| 5 | IO_L53N_5 | AH22 | | |
| 5 | IO_L53P_5 | AH23 | | |
| 5 | IO_L52N_5 | AG22 | | |
| 5 | IO_L52P_5 | AG21 | | |
| 5 | IO_L51N_5/VREF_5 | AF22 | | |
| 5 | IO_L51P_5 | AF23 | | |
| 5 | IO_L50N_5 | AE19 | | |
| 5 | IO_L50P_5 | AE20 | | |
| 5 | IO_L49N_5 | AJ23 | | |
| 5 | IO_L49P_5 | AJ22 | | |
| 5 | IO_L24N_5 | AF24 | | |
| 5 | IO_L24P_5 | AG23 | | |
| 5 | IO_L23N_5 | AD20 | | |
| 5 | IO_L23P_5 | AD21 | | |
| 5 | IO_L22N_5 | AK25 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 5 | IO_L22P_5 | AK24 | | |
| 5 | IO_L21N_5/VREF_5 | AH24 | | |
| 5 | IO_L21P_5 | AH25 | | |
| 5 | IO_L20N_5 | AE21 | | |
| 5 | IO_L20P_5 | AD22 | | |
| 5 | IO_L19N_5 | AJ25 | | |
| 5 | IO_L19P_5 | AJ24 | | |
| 5 | IO_L06N_5 | AG25 | | |
| 5 | IO_L06P_5 | AG24 | | |
| 5 | IO_L05N_5/VRP_5 | AC20 | | |
| 5 | IO_L05P_5/VRN_5 | AC21 | | |
| 5 | IO_L04N_5 | AK26 | | |
| 5 | IO_L04P_5/VREF_5 | AK27 | | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AH26 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AJ27 | | |
| 5 | IO_L02N_5/D6 | AE22 | | |
| 5 | IO_L02P_5/D7 | AE23 | | |
| 5 | IO_L01N_5/RDWR_B | AJ28 | | |
| 5 | IO_L01P_5/CS_B | AK29 | | |
| | | | | |
| 6 | IO_L01P_6 | AC22 | | |
| 6 | IO_L01N_6 | AB23 | | |
| 6 | IO_L02P_6/VRN_6 | AG28 | | |
| 6 | IO_L02N_6/VRP_6 | AF28 | | |
| 6 | IO_L03P_6 | AJ30 | | |
| 6 | IO_L03N_6/VREF_6 | AH30 | | |
| 6 | IO_L04P_6 | AD23 | | |
| 6 | IO_L04N_6 | AC23 | | |
| 6 | IO_L05P_6 | AF27 | | |
| 6 | IO_L05N_6 | AE27 | | |
| 6 | IO_L06P_6 | AG29 | | |
| 6 | IO_L06N_6 | AH29 | | |
| 6 | IO_L19P_6 | AE24 | | |
| 6 | IO_L19N_6 | AD24 | | |
| 6 | IO_L20P_6 | AE26 | | |
| 6 | IO_L20N_6 | AD26 | | |
| 6 | IO_L21P_6 | AG30 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 6 | IO_L21N_6/VREF_6 | AF30 | | |
| 6 | IO_L22P_6 | AD25 | | |
| 6 | IO_L22N_6 | AC25 | | |
| 6 | IO_L23P_6 | AE28 | | |
| 6 | IO_L23N_6 | AD28 | | |
| 6 | IO_L24P_6 | AD29 | | |
| 6 | IO_L24N_6 | AE29 | | |
| 6 | IO_L43P_6 | AC24 | | |
| 6 | IO_L43N_6 | AB24 | | |
| 6 | IO_L44P_6 | AD27 | | |
| 6 | IO_L44N_6 | AC27 | | |
| 6 | IO_L45P_6 | AC26 | | |
| 6 | IO_L45N_6/VREF_6 | AB26 | | |
| 6 | IO_L46P_6 | AA23 | | |
| 6 | IO_L46N_6 | Y23 | | |
| 6 | IO_L47P_6 | AC28 | | |
| 6 | IO_L47N_6 | AB28 | | |
| 6 | IO_L48P_6 | AD30 | | |
| 6 | IO_L48N_6 | AE30 | | |
| 6 | IO_L49P_6 | AB25 | | |
| 6 | IO_L49N_6 | AA25 | | |
| 6 | IO_L50P_6 | AA24 | | |
| 6 | IO_L50N_6 | Y24 | | |
| 6 | IO_L51P_6 | AC29 | | |
| 6 | IO_L51N_6/VREF_6 | AB30 | | |
| 6 | IO_L52P_6 | Y25 | | |
| 6 | IO_L52N_6 | W25 | | |
| 6 | IO_L53P_6 | AB27 | | |
| 6 | IO_L53N_6 | AA27 | | |
| 6 | IO_L54P_6 | AA29 | | |
| 6 | IO_L54N_6 | AB29 | | |
| 6 | IO_L67P_6 | W23 | NC | |
| 6 | IO_L67N_6 | V23 | NC | |
| 6 | IO_L68P_6 | AA26 | NC | |
| 6 | IO_L68N_6 | Y26 | NC | |
| 6 | IO_L69P_6 | AA30 | NC | |
| 6 | IO_L69N_6/VREF_6 | Y30 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 6 | IO_L70P_6 | W24 | NC | |
| 6 | IO_L70N_6 | V24 | NC | |
| 6 | IO_L71P_6 | Y27 | NC | |
| 6 | IO_L71N_6 | W27 | NC | |
| 6 | IO_L72P_6 | W28 | NC | |
| 6 | IO_L72N_6 | Y28 | NC | |
| 6 | IO_L73P_6 | V25 | NC | NC |
| 6 | IO_L73N_6 | U25 | NC | NC |
| 6 | IO_L74P_6 | V26 | NC | NC |
| 6 | IO_L74N_6 | V27 | NC | NC |
| 6 | IO_L75P_6 | Y29 | NC | NC |
| 6 | IO_L75N_6/VREF_6 | W29 | NC | NC |
| 6 | IO_L76P_6 | U22 | NC | NC |
| 6 | IO_L76N_6 | T22 | NC | NC |
| 6 | IO_L77P_6 | U26 | NC | NC |
| 6 | IO_L77N_6 | T26 | NC | NC |
| 6 | IO_L78P_6 | V30 | NC | NC |
| 6 | IO_L78N_6 | W30 | NC | NC |
| 6 | IO_L91P_6 | U23 | | |
| 6 | IO_L91N_6 | T23 | | |
| 6 | IO_L92P_6 | U27 | | |
| 6 | IO_L92N_6 | T27 | | |
| 6 | IO_L93P_6 | V29 | | |
| 6 | IO_L93N_6/VREF_6 | U29 | | |
| 6 | IO_L94P_6 | T24 | | |
| 6 | IO_L94N_6 | T25 | | |
| 6 | IO_L95P_6 | U28 | | |
| 6 | IO_L95N_6 | T28 | | |
| 6 | IO_L96P_6 | T30 | | |
| 6 | IO_L96N_6 | U30 | | |
| | | | | |
| 7 | IO_L96P_7 | P28 | | |
| 7 | IO_L96N_7 | R28 | | |
| 7 | IO_L95P_7 | R25 | | |
| 7 | IO_L95N_7 | R24 | | |
| 7 | IO_L94P_7 | R29 | | |
| 7 | IO_L94N_7 | T29 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 7 | IO_L93P_7/VREF_7 | R27 | | |
| 7 | IO_L93N_7 | P27 | | |
| 7 | IO_L92P_7 | R23 | | |
| 7 | IO_L92N_7 | P23 | | |
| 7 | IO_L91P_7 | N30 | | |
| 7 | IO_L91N_7 | P30 | | |
| 7 | IO_L78P_7 | P26 | NC | NC |
| 7 | IO_L78N_7 | R26 | NC | NC |
| 7 | IO_L77P_7 | R22 | NC | NC |
| 7 | IO_L77N_7 | P22 | NC | NC |
| 7 | IO_L76P_7 | N29 | NC | NC |
| 7 | IO_L76N_7 | P29 | NC | NC |
| 7 | IO_L75P_7/VREF_7 | N27 | NC | NC |
| 7 | IO_L75N_7 | N26 | NC | NC |
| 7 | IO_L74P_7 | P25 | NC | NC |
| 7 | IO_L74N_7 | N25 | NC | NC |
| 7 | IO_L73P_7 | L30 | NC | NC |
| 7 | IO_L73N_7 | M30 | NC | NC |
| 7 | IO_L72P_7 | L28 | NC | |
| 7 | IO_L72N_7 | M28 | NC | |
| 7 | IO_L71P_7 | N24 | NC | |
| 7 | IO_L71N_7 | M24 | NC | |
| 7 | IO_L70P_7 | L29 | NC | |
| 7 | IO_L70N_7 | M29 | NC | |
| 7 | IO_L69P_7/VREF_7 | M27 | NC | |
| 7 | IO_L69N_7 | L27 | NC | |
| 7 | IO_L68P_7 | N23 | NC | |
| 7 | IO_L68N_7 | M23 | NC | |
| 7 | IO_L67P_7 | J30 | NC | |
| 7 | IO_L67N_7 | K30 | NC | |
| 7 | IO_L54P_7 | K26 | | |
| 7 | IO_L54N_7 | L26 | | |
| 7 | IO_L53P_7 | M25 | | |
| 7 | IO_L53N_7 | L25 | | |
| 7 | IO_L52P_7 | J29 | | |
| 7 | IO_L52N_7 | K29 | | |
| 7 | IO_L51P_7/VREF_7 | K27 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 7 | IO_L51N_7 | J27 | | |
| 7 | IO_L50P_7 | L24 | | |
| 7 | IO_L50N_7 | K24 | | |
| 7 | IO_L49P_7 | H27 | | |
| 7 | IO_L49N_7 | J28 | | |
| 7 | IO_L48P_7 | H26 | | |
| 7 | IO_L48N_7 | J26 | | |
| 7 | IO_L47P_7 | K25 | | |
| 7 | IO_L47N_7 | J25 | | |
| 7 | IO_L46P_7 | H28 | | |
| 7 | IO_L46N_7 | H29 | | |
| 7 | IO_L45P_7/VREF_7 | G28 | | |
| 7 | IO_L45N_7 | F28 | | |
| 7 | IO_L44P_7 | L23 | | |
| 7 | IO_L44N_7 | K23 | | |
| 7 | IO_L43P_7 | F30 | | |
| 7 | IO_L43N_7 | G30 | | |
| 7 | IO_L24P_7 | F26 | | |
| 7 | IO_L24N_7 | G27 | | |
| 7 | IO_L23P_7 | J24 | | |
| 7 | IO_L23N_7 | H24 | | |
| 7 | IO_L22P_7 | F29 | | |
| 7 | IO_L22N_7 | G29 | | |
| 7 | IO_L21P_7/VREF_7 | G26 | | |
| 7 | IO_L21N_7 | G25 | | |
| 7 | IO_L20P_7 | H25 | | |
| 7 | IO_L20N_7 | G24 | | |
| 7 | IO_L19P_7 | D30 | | |
| 7 | IO_L19N_7 | E30 | | |
| 7 | IO_L06P_7 | E27 | | |
| 7 | IO_L06N_7 | F27 | | |
| 7 | IO_L05P_7 | J23 | | |
| 7 | IO_L05N_7 | H22 | | |
| 7 | IO_L04P_7 | C29 | | |
| 7 | IO_L04N_7 | D29 | | |
| 7 | IO_L03P_7/VREF_7 | E28 | | |
| 7 | IO_L03N_7 | D28 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 7 | IO_L02P_7/VRN_7 | H23 | | |
| 7 | IO_L02N_7/VRP_7 | G23 | | |
| 7 | IO_L01P_7 | B30 | | |
| 7 | IO_L01N_7 | C30 | | |
| | | | | |
| 0 | VCCO_0 | K20 | | |
| 0 | VCCO_0 | K19 | | |
| 0 | VCCO_0 | K18 | | |
| 0 | VCCO_0 | K17 | | |
| 0 | VCCO_0 | K16 | | |
| 0 | VCCO_0 | J21 | | |
| 0 | VCCO_0 | J20 | | |
| 0 | VCCO_0 | J19 | | |
| 0 | VCCO_0 | J18 | | |
| 0 | VCCO_0 | C18 | | |
| 0 | VCCO_0 | B26 | | |
| 1 | VCCO_1 | K15 | | |
| 1 | VCCO_1 | K14 | | |
| 1 | VCCO_1 | K13 | | |
| 1 | VCCO_1 | K12 | | |
| 1 | VCCO_1 | K11 | | |
| 1 | VCCO_1 | J13 | | |
| 1 | VCCO_1 | J12 | | |
| 1 | VCCO_1 | J11 | | |
| 1 | VCCO_1 | J10 | | |
| 1 | VCCO_1 | C13 | | |
| 1 | VCCO_1 | B5 | | |
| 2 | VCCO_2 | R10 | | |
| 2 | VCCO_2 | P10 | | |
| 2 | VCCO_2 | N10 | | |
| 2 | VCCO_2 | N9 | | |
| 2 | VCCO_2 | N3 | | |
| 2 | VCCO_2 | M10 | | |
| 2 | VCCO_2 | M9 | | |
| 2 | VCCO_2 | L10 | | |
| 2 | VCCO_2 | L9 | | |
| 2 | VCCO_2 | K9 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 2 | VCCO_2 | E2 | | |
| 3 | VCCO_3 | AF2 | | |
| 3 | VCCO_3 | AA9 | | |
| 3 | VCCO_3 | Y10 | | |
| 3 | VCCO_3 | Y9 | | |
| 3 | VCCO_3 | W10 | | |
| 3 | VCCO_3 | W9 | | |
| 3 | VCCO_3 | V10 | | |
| 3 | VCCO_3 | V9 | | |
| 3 | VCCO_3 | V3 | | |
| 3 | VCCO_3 | U10 | | |
| 3 | VCCO_3 | T10 | | |
| 4 | VCCO_4 | AJ5 | | |
| 4 | VCCO_4 | AH13 | | |
| 4 | VCCO_4 | AB13 | | |
| 4 | VCCO_4 | AB12 | | |
| 4 | VCCO_4 | AB11 | | |
| 4 | VCCO_4 | AB10 | | |
| 4 | VCCO_4 | AA15 | | |
| 4 | VCCO_4 | AA14 | | |
| 4 | VCCO_4 | AA13 | | |
| 4 | VCCO_4 | AA12 | | |
| 4 | VCCO_4 | AA11 | | |
| 5 | VCCO_5 | AJ26 | | |
| 5 | VCCO_5 | AH18 | | |
| 5 | VCCO_5 | AB21 | | |
| 5 | VCCO_5 | AB20 | | |
| 5 | VCCO_5 | AB19 | | |
| 5 | VCCO_5 | AB18 | | |
| 5 | VCCO_5 | AA20 | | |
| 5 | VCCO_5 | AA19 | | |
| 5 | VCCO_5 | AA18 | | |
| 5 | VCCO_5 | AA17 | | |
| 5 | VCCO_5 | AA16 | | |
| 6 | VCCO_6 | AF29 | | |
| 6 | VCCO_6 | AA22 | | |
| 6 | VCCO_6 | Y22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| 6 | VCCO_6 | Y21 | | |
| 6 | VCCO_6 | W22 | | |
| 6 | VCCO_6 | W21 | | |
| 6 | VCCO_6 | V28 | | |
| 6 | VCCO_6 | V22 | | |
| 6 | VCCO_6 | V21 | | |
| 6 | VCCO_6 | U21 | | |
| 6 | VCCO_6 | T21 | | |
| 7 | VCCO_7 | R21 | | |
| 7 | VCCO_7 | P21 | | |
| 7 | VCCO_7 | N28 | | |
| 7 | VCCO_7 | N22 | | |
| 7 | VCCO_7 | N21 | | |
| 7 | VCCO_7 | M22 | | |
| 7 | VCCO_7 | M21 | | |
| 7 | VCCO_7 | L22 | | |
| 7 | VCCO_7 | L21 | | |
| 7 | VCCO_7 | K22 | | |
| 7 | VCCO_7 | E29 | | |
| | | | | |
| NA | CCLK | AF6 | | |
| NA | PROG_B | B28 | | |
| NA | DONE | AG5 | | |
| NA | M0 | AF25 | | |
| NA | M1 | AG26 | | |
| NA | M2 | AH27 | | |
| NA | HSWAP_EN | C27 | | |
| NA | TCK | D5 | | |
| NA | TDI | A29 | | |
| NA | TDO | B3 | | |
| NA | TMS | C4 | | |
| NA | PWRDWN_B | AH4 | | |
| NA | DXN | D26 | | |
| NA | DXP | E25 | | |
| NA | VBATT | A2 | | |
| NA | RSVD | E6 | | |
| | | | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| NA | VCCAUX | AK28 | | |
| NA | VCCAUX | AK16 | | |
| NA | VCCAUX | AK3 | | |
| NA | VCCAUX | T1 | | |
| NA | VCCAUX | R30 | | |
| NA | VCCAUX | A28 | | |
| NA | VCCAUX | A15 | | |
| NA | VCCAUX | A3 | | |
| NA | VCCINT | AB22 | | |
| NA | VCCINT | AB9 | | |
| NA | VCCINT | AA21 | | |
| NA | VCCINT | AA10 | | |
| NA | VCCINT | Y20 | | |
| NA | VCCINT | Y19 | | |
| NA | VCCINT | Y18 | | |
| NA | VCCINT | Y17 | | |
| NA | VCCINT | Y16 | | |
| NA | VCCINT | Y15 | | |
| NA | VCCINT | Y14 | | |
| NA | VCCINT | Y13 | | |
| NA | VCCINT | Y12 | | |
| NA | VCCINT | Y11 | | |
| NA | VCCINT | W20 | | |
| NA | VCCINT | W11 | | |
| NA | VCCINT | V20 | | |
| NA | VCCINT | V11 | | |
| NA | VCCINT | U20 | | |
| NA | VCCINT | U11 | | |
| NA | VCCINT | T20 | | |
| NA | VCCINT | T11 | | |
| NA | VCCINT | R20 | | |
| NA | VCCINT | R11 | | |
| NA | VCCINT | P20 | | |
| NA | VCCINT | P11 | | |
| NA | VCCINT | N20 | | |
| NA | VCCINT | N11 | | |
| NA | VCCINT | M20 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| NA | VCCINT | M11 | | |
| NA | VCCINT | L20 | | |
| NA | VCCINT | L19 | | |
| NA | VCCINT | L18 | | |
| NA | VCCINT | L17 | | |
| NA | VCCINT | L16 | | |
| NA | VCCINT | L15 | | |
| NA | VCCINT | L14 | | |
| NA | VCCINT | L13 | | |
| NA | VCCINT | L12 | | |
| NA | VCCINT | L11 | | |
| NA | VCCINT | K21 | | |
| NA | VCCINT | K10 | | |
| NA | VCCINT | J22 | | |
| NA | VCCINT | J9 | | |
| NA | GND | AK23 | | |
| NA | GND | AK8 | | |
| NA | GND | AJ29 | | |
| NA | GND | AJ2 | | |
| NA | GND | AH28 | | |
| NA | GND | AH21 | | |
| NA | GND | AH10 | | |
| NA | GND | AH3 | | |
| NA | GND | AG27 | | |
| NA | GND | AG4 | | |
| NA | GND | AF26 | | |
| NA | GND | AF19 | | |
| NA | GND | AF12 | | |
| NA | GND | AF5 | | |
| NA | GND | AE25 | | |
| NA | GND | AE6 | | |
| NA | GND | AD17 | | |
| NA | GND | AD14 | | |
| NA | GND | AC30 | | |
| NA | GND | AC1 | | |
| NA | GND | AA28 | | |
| NA | GND | AA3 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| NA | GND | W26 | | |
| NA | GND | W19 | | |
| NA | GND | W18 | | |
| NA | GND | W17 | | |
| NA | GND | W16 | | |
| NA | GND | W15 | | |
| NA | GND | W14 | | |
| NA | GND | W13 | | |
| NA | GND | W12 | | |
| NA | GND | W5 | | |
| NA | GND | V19 | | |
| NA | GND | V18 | | |
| NA | GND | V17 | | |
| NA | GND | V16 | | |
| NA | GND | V15 | | |
| NA | GND | V14 | | |
| NA | GND | V13 | | |
| NA | GND | V12 | | |
| NA | GND | U24 | | |
| NA | GND | U19 | | |
| NA | GND | U18 | | |
| NA | GND | U17 | | |
| NA | GND | U16 | | |
| NA | GND | U15 | | |
| NA | GND | U14 | | |
| NA | GND | U13 | | |
| NA | GND | U12 | | |
| NA | GND | U7 | | |
| NA | GND | T19 | | |
| NA | GND | T18 | | |
| NA | GND | T17 | | |
| NA | GND | T16 | | |
| NA | GND | T15 | | |
| NA | GND | T14 | | |
| NA | GND | T13 | | |
| NA | GND | T12 | | |
| NA | GND | R19 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| NA | GND | R18 | | |
| NA | GND | R17 | | |
| NA | GND | R16 | | |
| NA | GND | R15 | | |
| NA | GND | R14 | | |
| NA | GND | R13 | | |
| NA | GND | R12 | | |
| NA | GND | P24 | | |
| NA | GND | P19 | | |
| NA | GND | P18 | | |
| NA | GND | P17 | | |
| NA | GND | P16 | | |
| NA | GND | P15 | | |
| NA | GND | P14 | | |
| NA | GND | P13 | | |
| NA | GND | P12 | | |
| NA | GND | P7 | | |
| NA | GND | N19 | | |
| NA | GND | N18 | | |
| NA | GND | N17 | | |
| NA | GND | N16 | | |
| NA | GND | N15 | | |
| NA | GND | N14 | | |
| NA | GND | N13 | | |
| NA | GND | N12 | | |
| NA | GND | M26 | | |
| NA | GND | M19 | | |
| NA | GND | M18 | | |
| NA | GND | M17 | | |
| NA | GND | M16 | | |
| NA | GND | M15 | | |
| NA | GND | M14 | | |
| NA | GND | M13 | | |
| NA | GND | M12 | | |
| NA | GND | M5 | | |
| NA | GND | K28 | | |
| NA | GND | K3 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

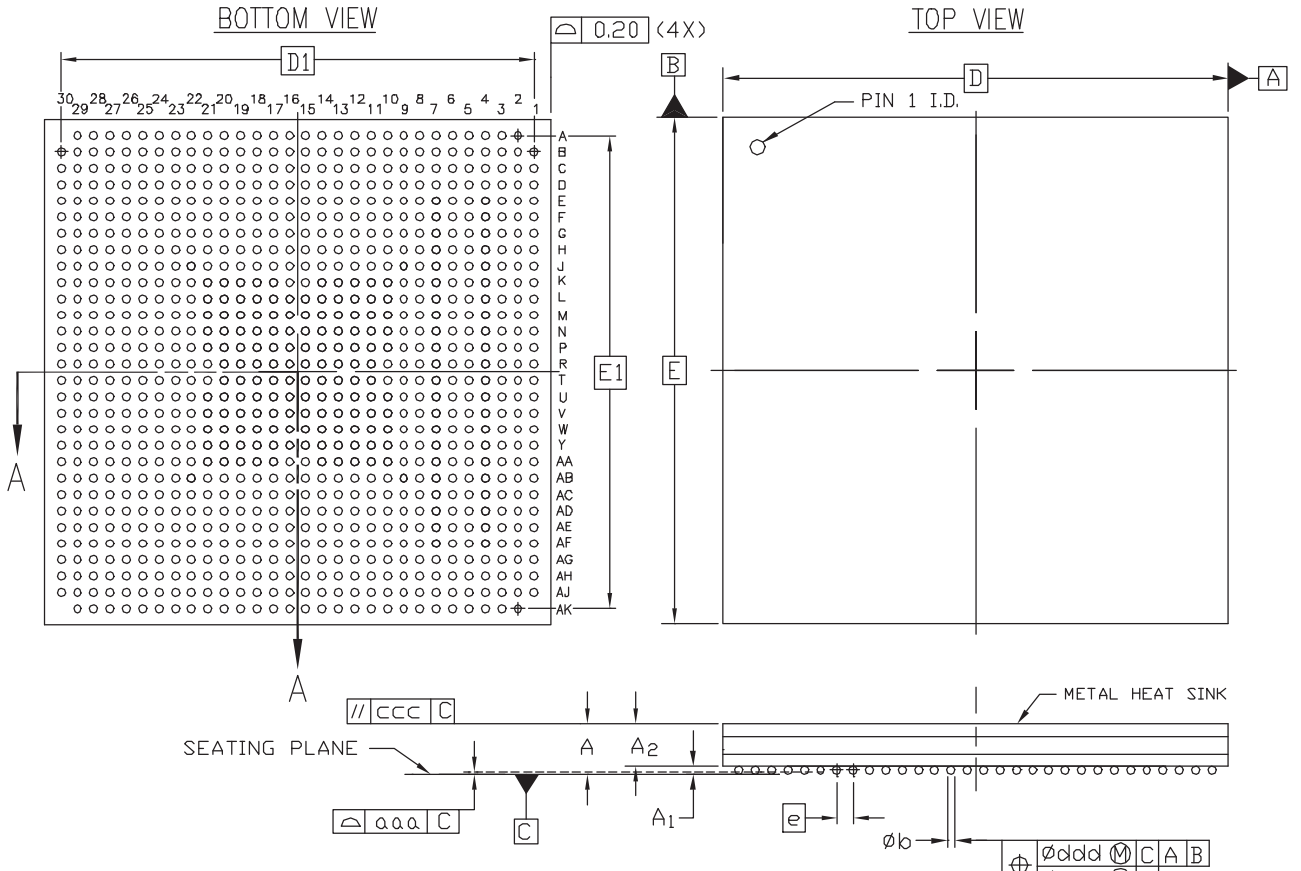

*Table 11:* **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V1000 | No Connect in the XC2V1500 |
|---|---|---|---|---|
| NA | GND | H30 | | |
| NA | GND | H1 | | |
| NA | GND | G17 | | |
| NA | GND | G14 | | |
| NA | GND | F25 | | |
| NA | GND | F6 | | |
| NA | GND | E26 | | |
| NA | GND | E19 | | |
| NA | GND | E12 | | |
| NA | GND | E5 | | |
| NA | GND | D27 | | |
| NA | GND | D4 | | |
| NA | GND | C28 | | |
| NA | GND | C21 | | |
| NA | GND | C10 | | |
| NA | GND | C3 | | |
| NA | GND | B29 | | |
| NA | GND | B2 | | |
| NA | GND | A23 | | |
| NA | GND | A8 | | |

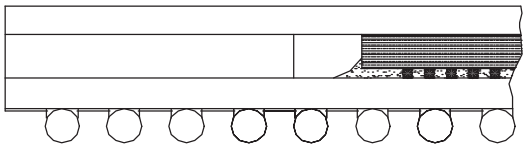
**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FF896 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)




| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | | 3.20 | 3.40 | |
| $A_1$ | 0.40 | 0.50 | 0.60 | |
| $A_2$ | | | 2.80 | |
| D/E | 31.00 BASIC | | | |
| $D_1/E_1$ | 29.00 REF | | | |
| e | 1.00 BASIC | | | |
| øb | 0.50 | 0.60 | 0.70 | |
| aaa | | | 0.20 | |
| ccc | | | 0.35 | |
| ddd | | | 0.30 | |
| eee | | | 0.10 | |
| M | 30 | | | 2 |



SECTION A–A
(NOT TO SCALE)

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAN–1 (DEPOPULATED)

*Figure 7:* **FF896 Flip-Chip Fine-Pitch BGA Package Specifications**

## FF1152 Flip-Chip Fine-Pitch BGA Package

As shown in Table 12, XC2V3000, XC2V4000, XC2V6000, and XC2V8000 Virtex-II devices are available in the FF1152 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the pin differences in the XC2V3000

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


device shown in the No Connect column. Following this table are the FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch).

*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 0 | IO_L01N_0 | D29 | |
| 0 | IO_L01P_0 | C29 | |
| 0 | IO_L02N_0 | H26 | |
| 0 | IO_L02P_0 | G26 | |
| 0 | IO_L03N_0/VRP_0 | E28 | |
| 0 | IO_L03P_0/VRN_0 | E27 | |
| 0 | IO_L04N_0/VREF_0 | F25 | |
| 0 | IO_L04P_0 | F26 | |
| 0 | IO_L05N_0 | H25 | |
| 0 | IO_L05P_0 | H24 | |
| 0 | IO_L06N_0 | E26 | |
| 0 | IO_L06P_0 | F27 | |
| 0 | IO_L19N_0 | B32 | |
| 0 | IO_L19P_0 | C33 | |
| 0 | IO_L20N_0 | J24 | |
| 0 | IO_L20P_0 | J23 | |
| 0 | IO_L21N_0 | C27 | |
| 0 | IO_L21P_0/VREF_0 | C28 | |
| 0 | IO_L22N_0 | B30 | |
| 0 | IO_L22P_0 | B31 | |
| 0 | IO_L23N_0 | K23 | |
| 0 | IO_L23P_0 | K22 | |
| 0 | IO_L24N_0 | C26 | |
| 0 | IO_L24P_0 | D27 | |
| 0 | IO_L25N_0 | A30 | |
| 0 | IO_L25P_0 | A31 | |
| 0 | IO_L26N_0 | G24 | |
| 0 | IO_L26P_0 | G25 | |
| 0 | IO_L27N_0 | E25 | |
| 0 | IO_L27P_0/VREF_0 | E24 | |
| 0 | IO_L28N_0 | D25 | |
| 0 | IO_L28P_0 | D26 | |
| 0 | IO_L29N_0 | H23 | |
| 0 | IO_L29P_0 | H22 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 0 | IO_L30N_0 | F23 | |
| 0 | IO_L30P_0 | F24 | |
| 0 | IO_L49N_0 | B28 | |
| 0 | IO_L49P_0 | B29 | |
| 0 | IO_L50N_0 | J22 | |
| 0 | IO_L50P_0 | J21 | |
| 0 | IO_L51N_0 | A28 | |
| 0 | IO_L51P_0/VREF_0 | A29 | |
| 0 | IO_L52N_0 | A26 | |
| 0 | IO_L52P_0 | B27 | |
| 0 | IO_L53N_0 | C24 | |
| 0 | IO_L53P_0 | D24 | |
| 0 | IO_L54N_0 | D22 | |
| 0 | IO_L54P_0 | D23 | |
| 0 | IO_L60N_0 | B25 | NC |
| 0 | IO_L60P_0 | B26 | NC |
| 0 | IO_L67N_0 | B23 | |
| 0 | IO_L67P_0 | B24 | |
| 0 | IO_L68N_0 | G22 | |
| 0 | IO_L68P_0 | G23 | |
| 0 | IO_L69N_0 | F22 | |
| 0 | IO_L69P_0/VREF_0 | F21 | |
| 0 | IO_L70N_0 | A23 | |
| 0 | IO_L70P_0 | A24 | |
| 0 | IO_L71N_0 | K21 | |
| 0 | IO_L71P_0 | K20 | |
| 0 | IO_L72N_0 | C22 | |
| 0 | IO_L72P_0 | C23 | |
| 0 | IO_L73N_0 | E21 | |
| 0 | IO_L73P_0 | E22 | |
| 0 | IO_L74N_0 | H21 | |
| 0 | IO_L74P_0 | H20 | |
| 0 | IO_L75N_0 | G20 | |
| 0 | IO_L75P_0/VREF_0 | F20 | |
| 0 | IO_L76N_0 | B21 | |
| 0 | IO_L76P_0 | B22 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 0 | IO_L77N_0 | J20 | |
| 0 | IO_L77P_0 | K19 | |
| 0 | IO_L78N_0 | D20 | |
| 0 | IO_L78P_0 | D21 | |
| 0 | IO_L79N_0 | A21 | NC |
| 0 | IO_L79P_0 | A22 | NC |
| 0 | IO_L80N_0 | L19 | NC |
| 0 | IO_L80P_0 | L18 | NC |
| 0 | IO_L81N_0 | B19 | NC |
| 0 | IO_L81P_0/VREF_0 | A20 | NC |
| 0 | IO_L82N_0 | A18 | NC |
| 0 | IO_L82P_0 | B18 | NC |
| 0 | IO_L83N_0 | H19 | NC |
| 0 | IO_L83P_0 | H18 | NC |
| 0 | IO_L84N_0 | C20 | NC |
| 0 | IO_L84P_0 | C21 | NC |
| 0 | IO_L91N_0/VREF_0 | D19 | |
| 0 | IO_L91P_0 | D18 | |
| 0 | IO_L92N_0 | G18 | |
| 0 | IO_L92P_0 | G19 | |
| 0 | IO_L93N_0 | F18 | |
| 0 | IO_L93P_0 | F19 | |
| 0 | IO_L94N_0/VREF_0 | C19 | |
| 0 | IO_L94P_0 | C18 | |
| 0 | IO_L95N_0/GCLK7P | K18 | |
| 0 | IO_L95P_0/GCLK6S | J18 | |
| 0 | IO_L96N_0/GCLK5P | E19 | |
| 0 | IO_L96P_0/GCLK4S | E18 | |
| | | | |
| 1 | IO_L96N_1/GCLK3P | E17 | |
| 1 | IO_L96P_1/GCLK2S | E16 | |
| 1 | IO_L95N_1/GCLK1P | H17 | |
| 1 | IO_L95P_1/GCLK0S | H16 | |
| 1 | IO_L94N_1 | D17 | |
| 1 | IO_L94P_1/VREF_1 | D16 | |
| 1 | IO_L93N_1 | F16 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 1 | IO_L93P_1 | F17 | |
| 1 | IO_L92N_1 | G16 | |
| 1 | IO_L92P_1 | G17 | |
| 1 | IO_L91N_1 | C16 | |
| 1 | IO_L91P_1/VREF_1 | C15 | |
| 1 | IO_L84N_1 | D14 | NC |
| 1 | IO_L84P_1 | D15 | NC |
| 1 | IO_L83N_1 | J17 | NC |
| 1 | IO_L83P_1 | K17 | NC |
| 1 | IO_L82N_1 | B17 | NC |
| 1 | IO_L82P_1 | A17 | NC |
| 1 | IO_L81N_1/VREF_1 | A15 | NC |
| 1 | IO_L81P_1 | B16 | NC |
| 1 | IO_L80N_1 | L17 | NC |
| 1 | IO_L80P_1 | L16 | NC |
| 1 | IO_L79N_1 | A13 | NC |
| 1 | IO_L79P_1 | A14 | NC |
| 1 | IO_L78N_1 | C13 | |
| 1 | IO_L78P_1 | C14 | |
| 1 | IO_L77N_1 | K16 | |
| 1 | IO_L77P_1 | K15 | |
| 1 | IO_L76N_1 | B13 | |
| 1 | IO_L76P_1 | B14 | |
| 1 | IO_L75N_1/VREF_1 | F15 | |
| 1 | IO_L75P_1 | G15 | |
| 1 | IO_L74N_1 | H15 | |
| 1 | IO_L74P_1 | H14 | |
| 1 | IO_L73N_1 | A11 | |
| 1 | IO_L73P_1 | A12 | |
| 1 | IO_L72N_1 | E13 | |
| 1 | IO_L72P_1 | E14 | |
| 1 | IO_L71N_1 | J15 | |
| 1 | IO_L71P_1 | J14 | |
| 1 | IO_L70N_1 | D12 | |
| 1 | IO_L70P_1 | D13 | |
| 1 | IO_L69N_1/VREF_1 | F14 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 1 | IO_L69P_1 | F13 | |
| 1 | IO_L68N_1 | C11 | |
| 1 | IO_L68P_1 | C12 | |
| 1 | IO_L67N_1 | B11 | |
| 1 | IO_L67P_1 | B12 | |
| 1 | IO_L60N_1 | F11 | NC |
| 1 | IO_L60P_1 | F12 | NC |
| 1 | IO_L54N_1 | D10 | |
| 1 | IO_L54P_1 | D11 | |
| 1 | IO_L53N_1 | G12 | |
| 1 | IO_L53P_1 | G13 | |
| 1 | IO_L52N_1 | B9 | |
| 1 | IO_L52P_1 | B10 | |
| 1 | IO_L51N_1/VREF_1 | B8 | |
| 1 | IO_L51P_1 | A9 | |
| 1 | IO_L50N_1 | K14 | |
| 1 | IO_L50P_1 | K13 | |
| 1 | IO_L49N_1 | A6 | |
| 1 | IO_L49P_1 | A7 | |
| 1 | IO_L30N_1 | D9 | |
| 1 | IO_L30P_1 | C9 | |
| 1 | IO_L29N_1 | H13 | |
| 1 | IO_L29P_1 | H12 | |
| 1 | IO_L28N_1 | C7 | |
| 1 | IO_L28P_1 | C8 | |
| 1 | IO_L27N_1/VREF_1 | E11 | |
| 1 | IO_L27P_1 | E10 | |
| 1 | IO_L26N_1 | J13 | |
| 1 | IO_L26P_1 | K12 | |
| 1 | IO_L25N_1 | B6 | |
| 1 | IO_L25P_1 | B7 | |
| 1 | IO_L24N_1 | E8 | |
| 1 | IO_L24P_1 | E9 | |
| 1 | IO_L23N_1 | G10 | |
| 1 | IO_L23P_1 | G11 | |
| 1 | IO_L22N_1 | A4 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 1 | IO_L22P_1 | A5 | |
| 1 | IO_L21N_1/VREF_1 | F10 | |
| 1 | IO_L21P_1 | G9 | |
| 1 | IO_L20N_1 | J12 | |
| 1 | IO_L20P_1 | J11 | |
| 1 | IO_L19N_1 | B4 | |
| 1 | IO_L19P_1 | B5 | |
| 1 | IO_L06N_1 | D6 | |
| 1 | IO_L06P_1 | C6 | |
| 1 | IO_L05N_1 | H11 | |
| 1 | IO_L05P_1 | J10 | |
| 1 | IO_L04N_1 | D8 | |
| 1 | IO_L04P_1/VREF_1 | E7 | |
| 1 | IO_L03N_1/VRP_1 | F9 | |
| 1 | IO_L03P_1/VRN_1 | F8 | |
| 1 | IO_L02N_1 | H10 | |
| 1 | IO_L02P_1 | H9 | |
| 1 | IO_L01N_1 | C2 | |
| 1 | IO_L01P_1 | B3 | |
| | | | |
| 2 | IO_L01N_2 | E2 | |
| 2 | IO_L01P_2 | D2 | |
| 2 | IO_L02N_2/VRP_2 | K11 | |
| 2 | IO_L02P_2/VRN_2 | K10 | |
| 2 | IO_L03N_2 | F5 | |
| 2 | IO_L03P_2/VREF_2 | G5 | |
| 2 | IO_L04N_2 | E3 | |
| 2 | IO_L04P_2 | D3 | |
| 2 | IO_L05N_2 | J9 | |
| 2 | IO_L05P_2 | K9 | |
| 2 | IO_L06N_2 | F4 | |
| 2 | IO_L06P_2 | E4 | |
| 2 | IO_L19N_2 | E1 | |
| 2 | IO_L19P_2 | D1 | |
| 2 | IO_L20N_2 | J8 | |
| 2 | IO_L20P_2 | K8 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 2 | IO_L21N_2 | H7 | |
| 2 | IO_L21P_2/VREF_2 | J7 | |
| 2 | IO_L22N_2 | H6 | |
| 2 | IO_L22P_2 | G6 | |
| 2 | IO_L23N_2 | L10 | |
| 2 | IO_L23P_2 | L9 | |
| 2 | IO_L24N_2 | G3 | |
| 2 | IO_L24P_2 | F3 | |
| 2 | IO_L25N_2 | G2 | |
| 2 | IO_L25P_2 | F2 | |
| 2 | IO_L26N_2 | M10 | |
| 2 | IO_L26P_2 | N10 | |
| 2 | IO_L27N_2 | J6 | |
| 2 | IO_L27P_2/VREF_2 | K6 | |
| 2 | IO_L28N_2 | J5 | |
| 2 | IO_L28P_2 | H5 | |
| 2 | IO_L29N_2 | L7 | |
| 2 | IO_L29P_2 | K7 | |
| 2 | IO_L30N_2 | J4 | |
| 2 | IO_L30P_2 | H4 | |
| 2 | IO_L43N_2 | G1 | |
| 2 | IO_L43P_2 | F1 | |
| 2 | IO_L44N_2 | L8 | |
| 2 | IO_L44P_2 | M8 | |
| 2 | IO_L45N_2 | J1 | |
| 2 | IO_L45P_2/VREF_2 | H2 | |
| 2 | IO_L46N_2 | J3 | |
| 2 | IO_L46P_2 | H3 | |
| 2 | IO_L47N_2 | M9 | |
| 2 | IO_L47P_2 | N9 | |
| 2 | IO_L48N_2 | L5 | |
| 2 | IO_L48P_2 | K5 | |
| 2 | IO_L49N_2 | K2 | |
| 2 | IO_L49P_2 | J2 | |
| 2 | IO_L50N_2 | N7 | |
| 2 | IO_L50P_2 | M7 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 2 | IO_L51N_2 | L6 | |
| 2 | IO_L51P_2/VREF_2 | M6 | |
| 2 | IO_L52N_2 | M3 | |
| 2 | IO_L52P_2 | L3 | |
| 2 | IO_L53N_2 | L4 | |
| 2 | IO_L53P_2 | K4 | |
| 2 | IO_L54N_2 | N4 | |
| 2 | IO_L54P_2 | M4 | |
| 2 | IO_L67N_2 | M2 | |
| 2 | IO_L67P_2 | L2 | |
| 2 | IO_L68N_2 | N8 | |
| 2 | IO_L68P_2 | P8 | |
| 2 | IO_L69N_2 | N6 | |
| 2 | IO_L69P_2/VREF_2 | P6 | |
| 2 | IO_L70N_2 | P5 | |
| 2 | IO_L70P_2 | N5 | |
| 2 | IO_L71N_2 | P10 | |
| 2 | IO_L71P_2 | R10 | |
| 2 | IO_L72N_2 | P3 | |
| 2 | IO_L72P_2 | N3 | |
| 2 | IO_L73N_2 | M1 | |
| 2 | IO_L73P_2 | L1 | |
| 2 | IO_L74N_2 | P9 | |
| 2 | IO_L74P_2 | R9 | |
| 2 | IO_L75N_2 | P2 | |
| 2 | IO_L75P_2/VREF_2 | N2 | |
| 2 | IO_L76N_2 | R4 | |
| 2 | IO_L76P_2 | P4 | |
| 2 | IO_L77N_2 | R8 | |
| 2 | IO_L77P_2 | T8 | |
| 2 | IO_L78N_2 | T3 | |
| 2 | IO_L78P_2 | R3 | |
| 2 | IO_L79N_2 | P1 | NC |
| 2 | IO_L79P_2 | N1 | NC |
| 2 | IO_L80N_2 | T11 | NC |
| 2 | IO_L80P_2 | U11 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 2 | IO_L81N_2 | R7 | NC |
| 2 | IO_L81P_2/VREF_2 | R6 | NC |
| 2 | IO_L82N_2 | U5 | NC |
| 2 | IO_L82P_2 | T5 | NC |
| 2 | IO_L83N_2 | T10 | NC |
| 2 | IO_L83P_2 | U10 | NC |
| 2 | IO_L84N_2 | U4 | NC |
| 2 | IO_L84P_2 | T4 | NC |
| 2 | IO_L91N_2 | T2 | |
| 2 | IO_L91P_2 | R1 | |
| 2 | IO_L92N_2 | U7 | |
| 2 | IO_L92P_2 | T7 | |
| 2 | IO_L93N_2 | T6 | |
| 2 | IO_L93P_2/VREF_2 | U6 | |
| 2 | IO_L94N_2 | U1 | |
| 2 | IO_L94P_2 | U2 | |
| 2 | IO_L95N_2 | U9 | |
| 2 | IO_L95P_2 | U8 | |
| 2 | IO_L96N_2 | U3 | |
| 2 | IO_L96P_2 | V4 | |
| | | | |
| 3 | IO_L96N_3 | V6 | |
| 3 | IO_L96P_3 | W6 | |
| 3 | IO_L95N_3 | V5 | |
| 3 | IO_L95P_3 | W5 | |
| 3 | IO_L94N_3 | V7 | |
| 3 | IO_L94P_3 | W7 | |
| 3 | IO_L93N_3/VREF_3 | V10 | |
| 3 | IO_L93P_3 | W10 | |
| 3 | IO_L92N_3 | V1 | |
| 3 | IO_L92P_3 | V2 | |
| 3 | IO_L91N_3 | W3 | |
| 3 | IO_L91P_3 | Y3 | |
| 3 | IO_L84N_3 | V9 | NC |
| 3 | IO_L84P_3 | V8 | NC |
| 3 | IO_L83N_3 | W4 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 3 | IO_L83P_3 | Y4 | NC |
| 3 | IO_L82N_3 | W11 | NC |
| 3 | IO_L82P_3 | V11 | NC |
| 3 | IO_L81N_3/VREF_3 | W8 | NC |
| 3 | IO_L81P_3 | Y8 | NC |
| 3 | IO_L80N_3 | W2 | NC |
| 3 | IO_L80P_3 | Y1 | NC |
| 3 | IO_L79N_3 | AA3 | NC |
| 3 | IO_L79P_3 | AB3 | NC |
| 3 | IO_L78N_3 | Y6 | |
| 3 | IO_L78P_3 | AA6 | |
| 3 | IO_L77N_3 | AA4 | |
| 3 | IO_L77P_3 | AB4 | |
| 3 | IO_L76N_3 | Y7 | |
| 3 | IO_L76P_3 | AA8 | |
| 3 | IO_L75N_3/VREF_3 | Y10 | |
| 3 | IO_L75P_3 | AA10 | |
| 3 | IO_L74N_3 | AA1 | |
| 3 | IO_L74P_3 | AB1 | |
| 3 | IO_L73N_3 | AA5 | |
| 3 | IO_L73P_3 | AB5 | |
| 3 | IO_L72N_3 | AA9 | |
| 3 | IO_L72P_3 | Y9 | |
| 3 | IO_L71N_3 | AA2 | |
| 3 | IO_L71P_3 | AB2 | |
| 3 | IO_L70N_3 | AB6 | |
| 3 | IO_L70P_3 | AC6 | |
| 3 | IO_L69N_3/VREF_3 | AD1 | |
| 3 | IO_L69P_3 | AC1 | |
| 3 | IO_L68N_3 | AC3 | |
| 3 | IO_L68P_3 | AD3 | |
| 3 | IO_L67N_3 | AC4 | |
| 3 | IO_L67P_3 | AD4 | |
| 3 | IO_L54N_3 | AB7 | |
| 3 | IO_L54P_3 | AC7 | |
| 3 | IO_L53N_3 | AC2 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 3 | IO_L53P_3 | AD2 | |
| 3 | IO_L52N_3 | AC8 | |
| 3 | IO_L52P_3 | AB8 | |
| 3 | IO_L51N_3/VREF_3 | AB10 | |
| 3 | IO_L51P_3 | AC10 | |
| 3 | IO_L50N_3 | AD5 | |
| 3 | IO_L50P_3 | AE5 | |
| 3 | IO_L49N_3 | AE4 | |
| 3 | IO_L49P_3 | AF4 | |
| 3 | IO_L48N_3 | AB9 | |
| 3 | IO_L48P_3 | AC9 | |
| 3 | IO_L47N_3 | AE2 | |
| 3 | IO_L47P_3 | AF1 | |
| 3 | IO_L46N_3 | AD6 | |
| 3 | IO_L46P_3 | AE6 | |
| 3 | IO_L45N_3/VREF_3 | AD9 | |
| 3 | IO_L45P_3 | AE9 | |
| 3 | IO_L44N_3 | AF2 | |
| 3 | IO_L44P_3 | AG2 | |
| 3 | IO_L43N_3 | AF3 | |
| 3 | IO_L43P_3 | AG3 | |
| 3 | IO_L30N_3 | AD7 | |
| 3 | IO_L30P_3 | AE7 | |
| 3 | IO_L29N_3 | AF5 | |
| 3 | IO_L29P_3 | AG5 | |
| 3 | IO_L28N_3 | AE8 | |
| 3 | IO_L28P_3 | AD8 | |
| 3 | IO_L27N_3/VREF_3 | AF8 | |
| 3 | IO_L27P_3 | AF9 | |
| 3 | IO_L26N_3 | AH1 | |
| 3 | IO_L26P_3 | AJ1 | |
| 3 | IO_L25N_3 | AG4 | |
| 3 | IO_L25P_3 | AH5 | |
| 3 | IO_L24N_3 | AF6 | |
| 3 | IO_L24P_3 | AG6 | |
| 3 | IO_L23N_3 | AH3 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 3 | IO_L23P_3 | AJ3 | |
| 3 | IO_L22N_3 | AF7 | |
| 3 | IO_L22P_3 | AG7 | |
| 3 | IO_L21N_3/VREF_3 | AL1 | |
| 3 | IO_L21P_3 | AK1 | |
| 3 | IO_L20N_3 | AH2 | |
| 3 | IO_L20P_3 | AJ2 | |
| 3 | IO_L19N_3 | AJ4 | |
| 3 | IO_L19P_3 | AK4 | |
| 3 | IO_L06N_3 | AE10 | |
| 3 | IO_L06P_3 | AD10 | |
| 3 | IO_L05N_3 | AK2 | |
| 3 | IO_L05P_3 | AL2 | |
| 3 | IO_L04N_3 | AH6 | |
| 3 | IO_L04P_3 | AJ5 | |
| 3 | IO_L03N_3/VREF_3 | AE11 | |
| 3 | IO_L03P_3 | AF11 | |
| 3 | IO_L02N_3/VRP_3 | AK3 | |
| 3 | IO_L02P_3/VRN_3 | AL3 | |
| 3 | IO_L01N_3 | AF10 | |
| 3 | IO_L01P_3 | AG9 | |
| | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AM4 | |
| 4 | IO_L01P_4/INIT_B | AL5 | |
| 4 | IO_L02N_4/D0/DIN(1) | AG10 | |
| 4 | IO_L02P_4/D1 | AH11 | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AK7 | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AK8 | |
| 4 | IO_L04N_4/VREF_4 | AL6 | |
| 4 | IO_L04P_4 | AM6 | |
| 4 | IO_L05N_4/VRP_4 | AK9 | |
| 4 | IO_L05P_4/VRN_4 | AJ8 | |
| 4 | IO_L06N_4 | AM8 | |
| 4 | IO_L06P_4 | AM7 | |
| 4 | IO_L19N_4 | AN3 | |
| 4 | IO_L19P_4 | AM2 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 4 | IO_L20N_4 | AJ10 | |
| 4 | IO_L20P_4 | AJ9 | |
| 4 | IO_L21N_4 | AH9 | |
| 4 | IO_L21P_4/VREF_4 | AH10 | |
| 4 | IO_L22N_4 | AN5 | |
| 4 | IO_L22P_4 | AN4 | |
| 4 | IO_L23N_4 | AE12 | |
| 4 | IO_L23P_4 | AE13 | |
| 4 | IO_L24N_4 | AM9 | |
| 4 | IO_L24P_4 | AL8 | |
| 4 | IO_L25N_4 | AP5 | |
| 4 | IO_L25P_4 | AP4 | |
| 4 | IO_L26N_4 | AG11 | |
| 4 | IO_L26P_4 | AG12 | |
| 4 | IO_L27N_4 | AN7 | |
| 4 | IO_L27P_4/VREF_4 | AN6 | |
| 4 | IO_L28N_4 | AL10 | |
| 4 | IO_L28P_4 | AL9 | |
| 4 | IO_L29N_4 | AF12 | |
| 4 | IO_L29P_4 | AF13 | |
| 4 | IO_L30N_4 | AK10 | |
| 4 | IO_L30P_4 | AK11 | |
| 4 | IO_L49N_4 | AP7 | |
| 4 | IO_L49P_4 | AP6 | |
| 4 | IO_L50N_4 | AH13 | |
| 4 | IO_L50P_4 | AH12 | |
| 4 | IO_L51N_4 | AJ11 | |
| 4 | IO_L51P_4/VREF_4 | AJ12 | |
| 4 | IO_L52N_4 | AP9 | |
| 4 | IO_L52P_4 | AN8 | |
| 4 | IO_L53N_4 | AG13 | |
| 4 | IO_L53P_4 | AG14 | |
| 4 | IO_L54N_4 | AM11 | |
| 4 | IO_L54P_4 | AL11 | |
| 4 | IO_L60N_4 | AN10 | NC |
| 4 | IO_L60P_4 | AN9 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 4 | IO_L67N_4 | AN12 | |
| 4 | IO_L67P_4 | AN11 | |
| 4 | IO_L68N_4 | AE14 | |
| 4 | IO_L68P_4 | AE15 | |
| 4 | IO_L69N_4 | AJ13 | |
| 4 | IO_L69P_4/VREF_4 | AJ14 | |
| 4 | IO_L70N_4 | AL13 | |
| 4 | IO_L70P_4 | AL12 | |
| 4 | IO_L71N_4 | AF14 | |
| 4 | IO_L71P_4 | AF15 | |
| 4 | IO_L72N_4 | AM13 | |
| 4 | IO_L72P_4 | AM12 | |
| 4 | IO_L73N_4 | AP12 | |
| 4 | IO_L73P_4 | AP11 | |
| 4 | IO_L74N_4 | AG15 | |
| 4 | IO_L74P_4 | AG16 | |
| 4 | IO_L75N_4 | AN14 | |
| 4 | IO_L75P_4/VREF_4 | AN13 | |
| 4 | IO_L76N_4 | AP14 | |
| 4 | IO_L76P_4 | AP13 | |
| 4 | IO_L77N_4 | AD16 | |
| 4 | IO_L77P_4 | AD17 | |
| 4 | IO_L78N_4 | AK14 | |
| 4 | IO_L78P_4 | AK13 | |
| 4 | IO_L79N_4 | AN16 | NC |
| 4 | IO_L79P_4 | AP15 | NC |
| 4 | IO_L80N_4 | AE16 | NC |
| 4 | IO_L80P_4 | AE17 | NC |
| 4 | IO_L81N_4 | AH15 | NC |
| 4 | IO_L81P_4/VREF_4 | AJ15 | NC |
| 4 | IO_L82N_4 | AP17 | NC |
| 4 | IO_L82P_4 | AN17 | NC |
| 4 | IO_L83N_4 | AH17 | NC |
| 4 | IO_L83P_4 | AH16 | NC |
| 4 | IO_L84N_4 | AL15 | NC |
| 4 | IO_L84P_4 | AL14 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 4 | IO_L91N_4/VREF_4 | AL16 | |
| 4 | IO_L91P_4 | AL17 | |
| 4 | IO_L92N_4 | AJ17 | |
| 4 | IO_L92P_4 | AJ16 | |
| 4 | IO_L93N_4 | AM15 | |
| 4 | IO_L93P_4 | AM14 | |
| 4 | IO_L94N_4/VREF_4 | AM16 | |
| 4 | IO_L94P_4 | AM17 | |
| 4 | IO_L95N_4/GCLK3S | AF17 | |
| 4 | IO_L95P_4/GCLK2P | AG17 | |
| 4 | IO_L96N_4/GCLK1S | AK16 | |
| 4 | IO_L96P_4/GCLK0P | AK17 | |
| | | | |
| 5 | IO_L96N_5/GCLK7S | AK18 | |
| 5 | IO_L96P_5/GCLK6P | AK19 | |
| 5 | IO_L95N_5/GCLK5S | AG18 | |
| 5 | IO_L95P_5/GCLK4P | AF18 | |
| 5 | IO_L94N_5 | AL18 | |
| 5 | IO_L94P_5/VREF_5 | AL19 | |
| 5 | IO_L93N_5 | AJ19 | |
| 5 | IO_L93P_5 | AJ18 | |
| 5 | IO_L92N_5 | AH19 | |
| 5 | IO_L92P_5 | AH18 | |
| 5 | IO_L91N_5 | AM19 | |
| 5 | IO_L91P_5/VREF_5 | AM20 | |
| 5 | IO_L84N_5 | AL21 | NC |
| 5 | IO_L84P_5 | AL20 | NC |
| 5 | IO_L83N_5 | AM22 | NC |
| 5 | IO_L83P_5 | AM21 | NC |
| 5 | IO_L82N_5 | AN18 | NC |
| 5 | IO_L82P_5 | AP18 | NC |
| 5 | IO_L81N_5/VREF_5 | AP20 | NC |
| 5 | IO_L81P_5 | AN19 | NC |
| 5 | IO_L80N_5 | AE18 | NC |
| 5 | IO_L80P_5 | AE19 | NC |
| 5 | IO_L79N_5 | AP22 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 5 | IO_L79P_5 | AP21 | NC |
| 5 | IO_L78N_5 | AK22 | |
| 5 | IO_L78P_5 | AK21 | |
| 5 | IO_L77N_5 | AD18 | |
| 5 | IO_L77P_5 | AD19 | |
| 5 | IO_L76N_5 | AN22 | |
| 5 | IO_L76P_5 | AN21 | |
| 5 | IO_L75N_5/VREF_5 | AJ20 | |
| 5 | IO_L75P_5 | AH20 | |
| 5 | IO_L74N_5 | AG19 | |
| 5 | IO_L74P_5 | AG20 | |
| 5 | IO_L73N_5 | AP24 | |
| 5 | IO_L73P_5 | AP23 | |
| 5 | IO_L72N_5 | AL23 | |
| 5 | IO_L72P_5 | AL22 | |
| 5 | IO_L71N_5 | AF20 | |
| 5 | IO_L71P_5 | AF21 | |
| 5 | IO_L70N_5 | AM24 | |
| 5 | IO_L70P_5 | AM23 | |
| 5 | IO_L69N_5/VREF_5 | AJ21 | |
| 5 | IO_L69P_5 | AJ22 | |
| 5 | IO_L68N_5 | AJ24 | |
| 5 | IO_L68P_5 | AJ23 | |
| 5 | IO_L67N_5 | AN24 | |
| 5 | IO_L67P_5 | AN23 | |
| 5 | IO_L60N_5 | AN26 | NC |
| 5 | IO_L60P_5 | AN25 | NC |
| 5 | IO_L54N_5 | AL25 | |
| 5 | IO_L54P_5 | AL24 | |
| 5 | IO_L53N_5 | AE20 | |
| 5 | IO_L53P_5 | AE21 | |
| 5 | IO_L52N_5 | AN27 | |
| 5 | IO_L52P_5 | AP26 | |
| 5 | IO_L51N_5/VREF_5 | AP29 | |
| 5 | IO_L51P_5 | AP28 | |
| 5 | IO_L50N_5 | AG21 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 5 | IO_L50P_5 | AG22 | |
| 5 | IO_L49N_5 | AN29 | |
| 5 | IO_L49P_5 | AN28 | |
| 5 | IO_L30N_5 | AK24 | |
| 5 | IO_L30P_5 | AK25 | |
| 5 | IO_L29N_5 | AH23 | |
| 5 | IO_L29P_5 | AH22 | |
| 5 | IO_L28N_5 | AP31 | |
| 5 | IO_L28P_5 | AP30 | |
| 5 | IO_L27N_5/VREF_5 | AH24 | |
| 5 | IO_L27P_5 | AH25 | |
| 5 | IO_L26N_5 | AF22 | |
| 5 | IO_L26P_5 | AF23 | |
| 5 | IO_L25N_5 | AM27 | |
| 5 | IO_L25P_5 | AM26 | |
| 5 | IO_L24N_5 | AL27 | |
| 5 | IO_L24P_5 | AL26 | |
| 5 | IO_L23N_5 | AH26 | |
| 5 | IO_L23P_5 | AJ25 | |
| 5 | IO_L22N_5 | AN31 | |
| 5 | IO_L22P_5 | AN30 | |
| 5 | IO_L21N_5/VREF_5 | AK26 | |
| 5 | IO_L21P_5 | AK27 | |
| 5 | IO_L20N_5 | AG23 | |
| 5 | IO_L20P_5 | AF24 | |
| 5 | IO_L19N_5 | AM33 | |
| 5 | IO_L19P_5 | AN32 | |
| 5 | IO_L06N_5 | AJ27 | |
| 5 | IO_L06P_5 | AJ26 | |
| 5 | IO_L05N_5/VRP_5 | AE22 | |
| 5 | IO_L05P_5/VRN_5 | AE23 | |
| 5 | IO_L04N_5 | AM28 | |
| 5 | IO_L04P_5/VREF_5 | AM29 | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AK28 | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AL29 | |
| 5 | IO_L02N_5/D6 | AG24 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 5 | IO_L02P_5/D7 | AG25 | |
| 5 | IO_L01N_5/RDWR_B | AL30 | |
| 5 | IO_L01P_5/CS_B | AM31 | |
| | | | |
| 6 | IO_L01P_6 | AE24 | |
| 6 | IO_L01N_6 | AD25 | |
| 6 | IO_L02P_6/VRN_6 | AJ30 | |
| 6 | IO_L02N_6/VRP_6 | AH30 | |
| 6 | IO_L03P_6 | AL32 | |
| 6 | IO_L03N_6/VREF_6 | AK32 | |
| 6 | IO_L04P_6 | AF25 | |
| 6 | IO_L04N_6 | AE25 | |
| 6 | IO_L05P_6 | AJ31 | |
| 6 | IO_L05N_6 | AK31 | |
| 6 | IO_L06P_6 | AH29 | |
| 6 | IO_L06N_6 | AG29 | |
| 6 | IO_L19P_6 | AG26 | |
| 6 | IO_L19N_6 | AF26 | |
| 6 | IO_L20P_6 | AL33 | |
| 6 | IO_L20N_6 | AK33 | |
| 6 | IO_L21P_6 | AJ32 | |
| 6 | IO_L21N_6/VREF_6 | AH32 | |
| 6 | IO_L22P_6 | AG28 | |
| 6 | IO_L22N_6 | AF28 | |
| 6 | IO_L23P_6 | AG30 | |
| 6 | IO_L23N_6 | AF30 | |
| 6 | IO_L24P_6 | AF29 | |
| 6 | IO_L24N_6 | AE29 | |
| 6 | IO_L25P_6 | AF27 | |
| 6 | IO_L25N_6 | AE27 | |
| 6 | IO_L26P_6 | AL34 | |
| 6 | IO_L26N_6 | AK34 | |
| 6 | IO_L27P_6 | AE28 | |
| 6 | IO_L27N_6/VREF_6 | AD28 | |
| 6 | IO_L28P_6 | AE26 | |
| 6 | IO_L28N_6 | AD26 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 6 | IO_L29P_6 | AF31 | |
| 6 | IO_L29N_6 | AG31 | |
| 6 | IO_L30P_6 | AF32 | |
| 6 | IO_L30N_6 | AG32 | |
| 6 | IO_L43P_6 | AC25 | |
| 6 | IO_L43N_6 | AB25 | |
| 6 | IO_L44P_6 | AJ33 | |
| 6 | IO_L44N_6 | AH33 | |
| 6 | IO_L45P_6 | AE31 | |
| 6 | IO_L45N_6/VREF_6 | AD32 | |
| 6 | IO_L46P_6 | AD27 | |
| 6 | IO_L46N_6 | AC27 | |
| 6 | IO_L47P_6 | AJ34 | |
| 6 | IO_L47N_6 | AH34 | |
| 6 | IO_L48P_6 | AE30 | |
| 6 | IO_L48N_6 | AD30 | |
| 6 | IO_L49P_6 | AC26 | |
| 6 | IO_L49N_6 | AB26 | |
| 6 | IO_L50P_6 | AD29 | |
| 6 | IO_L50N_6 | AC29 | |
| 6 | IO_L51P_6 | AF33 | |
| 6 | IO_L51N_6/VREF_6 | AG33 | |
| 6 | IO_L52P_6 | AC28 | |
| 6 | IO_L52N_6 | AB28 | |
| 6 | IO_L53P_6 | AF34 | |
| 6 | IO_L53N_6 | AE33 | |
| 6 | IO_L54P_6 | AB27 | |
| 6 | IO_L54N_6 | AA27 | |
| 6 | IO_L67P_6 | AA25 | |
| 6 | IO_L67N_6 | Y25 | |
| 6 | IO_L68P_6 | AD33 | |
| 6 | IO_L68N_6 | AC33 | |
| 6 | IO_L69P_6 | AC32 | |
| 6 | IO_L69N_6/VREF_6 | AB32 | |
| 6 | IO_L70P_6 | AA26 | |
| 6 | IO_L70N_6 | Y26 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 6 | IO_L71P_6 | AD34 | |
| 6 | IO_L71N_6 | AC34 | |
| 6 | IO_L72P_6 | AC31 | |
| 6 | IO_L72N_6 | AD31 | |
| 6 | IO_L73P_6 | Y27 | |
| 6 | IO_L73N_6 | W27 | |
| 6 | IO_L74P_6 | AB29 | |
| 6 | IO_L74N_6 | AA29 | |
| 6 | IO_L75P_6 | AB31 | |
| 6 | IO_L75N_6/VREF_6 | AA31 | |
| 6 | IO_L76P_6 | Y28 | |
| 6 | IO_L76N_6 | Y29 | |
| 6 | IO_L77P_6 | AB33 | |
| 6 | IO_L77N_6 | AA33 | |
| 6 | IO_L78P_6 | AA30 | |
| 6 | IO_L78N_6 | AB30 | |
| 6 | IO_L79P_6 | W24 | NC |
| 6 | IO_L79N_6 | V24 | NC |
| 6 | IO_L80P_6 | AB34 | NC |
| 6 | IO_L80N_6 | AA34 | NC |
| 6 | IO_L81P_6 | W33 | NC |
| 6 | IO_L81N_6/VREF_6 | Y34 | NC |
| 6 | IO_L82P_6 | W25 | NC |
| 6 | IO_L82N_6 | V25 | NC |
| 6 | IO_L83P_6 | Y32 | NC |
| 6 | IO_L83N_6 | AA32 | NC |
| 6 | IO_L84P_6 | W29 | NC |
| 6 | IO_L84N_6 | V29 | NC |
| 6 | IO_L91P_6 | W28 | |
| 6 | IO_L91N_6 | V28 | |
| 6 | IO_L92P_6 | V33 | |
| 6 | IO_L92N_6 | V34 | |
| 6 | IO_L93P_6 | Y31 | |
| 6 | IO_L93N_6/VREF_6 | W31 | |
| 6 | IO_L94P_6 | V26 | |
| 6 | IO_L94N_6 | V27 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 6 | IO_L95P_6 | W30 | |
| 6 | IO_L95N_6 | V30 | |
| 6 | IO_L96P_6 | V32 | |
| 6 | IO_L96N_6 | W32 | |
| | | | |
| 7 | IO_L96P_7 | U31 | |
| 7 | IO_L96N_7 | V31 | |
| 7 | IO_L95P_7 | T28 | |
| 7 | IO_L95N_7 | U28 | |
| 7 | IO_L94P_7 | U33 | |
| 7 | IO_L94N_7 | U34 | |
| 7 | IO_L93P_7/VREF_7 | U29 | |
| 7 | IO_L93N_7 | T29 | |
| 7 | IO_L92P_7 | U27 | |
| 7 | IO_L92N_7 | U26 | |
| 7 | IO_L91P_7 | T30 | |
| 7 | IO_L91N_7 | U30 | |
| 7 | IO_L84P_7 | R32 | NC |
| 7 | IO_L84N_7 | T32 | NC |
| 7 | IO_L83P_7 | U25 | NC |
| 7 | IO_L83N_7 | T25 | NC |
| 7 | IO_L82P_7 | R34 | NC |
| 7 | IO_L82N_7 | T33 | NC |
| 7 | IO_L81P_7/VREF_7 | N34 | NC |
| 7 | IO_L81N_7 | P34 | NC |
| 7 | IO_L80P_7 | U24 | NC |
| 7 | IO_L80N_7 | T24 | NC |
| 7 | IO_L79P_7 | R31 | NC |
| 7 | IO_L79N_7 | T31 | NC |
| 7 | IO_L78P_7 | N32 | |
| 7 | IO_L78N_7 | P32 | |
| 7 | IO_L77P_7 | T27 | |
| 7 | IO_L77N_7 | R27 | |
| 7 | IO_L76P_7 | N33 | |
| 7 | IO_L76N_7 | P33 | |
| 7 | IO_L75P_7/VREF_7 | R29 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 7 | IO_L75N_7 | R28 | |
| 7 | IO_L74P_7 | R26 | |
| 7 | IO_L74N_7 | P26 | |
| 7 | IO_L73P_7 | N31 | |
| 7 | IO_L73N_7 | P31 | |
| 7 | IO_L72P_7 | N30 | |
| 7 | IO_L72N_7 | P30 | |
| 7 | IO_L71P_7 | R25 | |
| 7 | IO_L71N_7 | P25 | |
| 7 | IO_L70P_7 | L34 | |
| 7 | IO_L70N_7 | M34 | |
| 7 | IO_L69P_7/VREF_7 | P29 | |
| 7 | IO_L69N_7 | N29 | |
| 7 | IO_L68P_7 | P27 | |
| 7 | IO_L68N_7 | N27 | |
| 7 | IO_L67P_7 | L32 | |
| 7 | IO_L67N_7 | M32 | |
| 7 | IO_L54P_7 | L31 | |
| 7 | IO_L54N_7 | M31 | |
| 7 | IO_L53P_7 | K29 | |
| 7 | IO_L53N_7 | L30 | |
| 7 | IO_L52P_7 | L33 | |
| 7 | IO_L52N_7 | M33 | |
| 7 | IO_L51P_7/VREF_7 | M29 | |
| 7 | IO_L51N_7 | L29 | |
| 7 | IO_L50P_7 | M28 | |
| 7 | IO_L50N_7 | N28 | |
| 7 | IO_L49P_7 | K30 | |
| 7 | IO_L49N_7 | K31 | |
| 7 | IO_L48P_7 | H32 | |
| 7 | IO_L48N_7 | J32 | |
| 7 | IO_L47P_7 | N26 | |
| 7 | IO_L47N_7 | M26 | |
| 7 | IO_L46P_7 | J33 | |
| 7 | IO_L46N_7 | K33 | |
| 7 | IO_L45P_7/VREF_7 | H33 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 7 | IO_L45N_7 | J34 | |
| 7 | IO_L44P_7 | M27 | |
| 7 | IO_L44N_7 | L27 | |
| 7 | IO_L43P_7 | H31 | |
| 7 | IO_L43N_7 | J31 | |
| 7 | IO_L30P_7 | F32 | |
| 7 | IO_L30N_7 | G32 | |
| 7 | IO_L29P_7 | N25 | |
| 7 | IO_L29N_7 | M25 | |
| 7 | IO_L28P_7 | F34 | |
| 7 | IO_L28N_7 | G34 | |
| 7 | IO_L27P_7/VREF_7 | J30 | |
| 7 | IO_L27N_7 | H30 | |
| 7 | IO_L26P_7 | K28 | |
| 7 | IO_L26N_7 | L28 | |
| 7 | IO_L25P_7 | H28 | |
| 7 | IO_L25N_7 | J29 | |
| 7 | IO_L24P_7 | G29 | |
| 7 | IO_L24N_7 | H29 | |
| 7 | IO_L23P_7 | L26 | |
| 7 | IO_L23N_7 | K26 | |
| 7 | IO_L22P_7 | F33 | |
| 7 | IO_L22N_7 | G33 | |
| 7 | IO_L21P_7/VREF_7 | J28 | |
| 7 | IO_L21N_7 | J27 | |
| 7 | IO_L20P_7 | K27 | |
| 7 | IO_L20N_7 | J26 | |
| 7 | IO_L19P_7 | E31 | |
| 7 | IO_L19N_7 | F31 | |
| 7 | IO_L06P_7 | D32 | |
| 7 | IO_L06N_7 | E32 | |
| 7 | IO_L05P_7 | L25 | |
| 7 | IO_L05N_7 | K24 | |
| 7 | IO_L04P_7 | D34 | |
| 7 | IO_L04N_7 | E34 | |
| 7 | IO_L03P_7/VREF_7 | G30 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 7 | IO_L03N_7 | F30 | |
| 7 | IO_L02P_7/VRN_7 | K25 | |
| 7 | IO_L02N_7/VRP_7 | J25 | |
| 7 | IO_L01P_7 | D33 | |
| 7 | IO_L01N_7 | E33 | |
| | | | |
| 0 | VCCO_0 | M22 | |
| 0 | VCCO_0 | M21 | |
| 0 | VCCO_0 | M20 | |
| 0 | VCCO_0 | M19 | |
| 0 | VCCO_0 | M18 | |
| 0 | VCCO_0 | L23 | |
| 0 | VCCO_0 | L22 | |
| 0 | VCCO_0 | L21 | |
| 0 | VCCO_0 | L20 | |
| 0 | VCCO_0 | E20 | |
| 0 | VCCO_0 | D28 | |
| 0 | VCCO_0 | A25 | |
| 0 | VCCO_0 | A19 | |
| 1 | VCCO_1 | M17 | |
| 1 | VCCO_1 | M16 | |
| 1 | VCCO_1 | M15 | |
| 1 | VCCO_1 | M14 | |
| 1 | VCCO_1 | M13 | |
| 1 | VCCO_1 | L15 | |
| 1 | VCCO_1 | L14 | |
| 1 | VCCO_1 | L13 | |
| 1 | VCCO_1 | L12 | |
| 1 | VCCO_1 | E15 | |
| 1 | VCCO_1 | D7 | |
| 1 | VCCO_1 | A16 | |
| 1 | VCCO_1 | A10 | |
| 2 | VCCO_2 | U12 | |
| 2 | VCCO_2 | T12 | |
| 2 | VCCO_2 | T1 | |
| 2 | VCCO_2 | R12 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 2 | VCCO_2 | R11 | |
| 2 | VCCO_2 | R5 | |
| 2 | VCCO_2 | P12 | |
| 2 | VCCO_2 | P11 | |
| 2 | VCCO_2 | N12 | |
| 2 | VCCO_2 | N11 | |
| 2 | VCCO_2 | M11 | |
| 2 | VCCO_2 | K1 | |
| 2 | VCCO_2 | G4 | |
| 3 | VCCO_3 | AH4 | |
| 3 | VCCO_3 | AE1 | |
| 3 | VCCO_3 | AC11 | |
| 3 | VCCO_3 | AB12 | |
| 3 | VCCO_3 | AB11 | |
| 3 | VCCO_3 | AA12 | |
| 3 | VCCO_3 | AA11 | |
| 3 | VCCO_3 | Y12 | |
| 3 | VCCO_3 | Y11 | |
| 3 | VCCO_3 | Y5 | |
| 3 | VCCO_3 | W12 | |
| 3 | VCCO_3 | W1 | |
| 3 | VCCO_3 | V12 | |
| 4 | VCCO_4 | AP16 | |
| 4 | VCCO_4 | AP10 | |
| 4 | VCCO_4 | AL7 | |
| 4 | VCCO_4 | AK15 | |
| 4 | VCCO_4 | AD15 | |
| 4 | VCCO_4 | AD14 | |
| 4 | VCCO_4 | AD13 | |
| 4 | VCCO_4 | AD12 | |
| 4 | VCCO_4 | AC17 | |
| 4 | VCCO_4 | AC16 | |
| 4 | VCCO_4 | AC15 | |
| 4 | VCCO_4 | AC14 | |
| 4 | VCCO_4 | AC13 | |
| 5 | VCCO_5 | AP25 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 5 | VCCO_5 | AP19 | |
| 5 | VCCO_5 | AL28 | |
| 5 | VCCO_5 | AK20 | |
| 5 | VCCO_5 | AD23 | |
| 5 | VCCO_5 | AD22 | |
| 5 | VCCO_5 | AD21 | |
| 5 | VCCO_5 | AD20 | |
| 5 | VCCO_5 | AC22 | |
| 5 | VCCO_5 | AC21 | |
| 5 | VCCO_5 | AC20 | |
| 5 | VCCO_5 | AC19 | |
| 5 | VCCO_5 | AC18 | |
| 6 | VCCO_6 | AH31 | |
| 6 | VCCO_6 | AE34 | |
| 6 | VCCO_6 | AC24 | |
| 6 | VCCO_6 | AB24 | |
| 6 | VCCO_6 | AB23 | |
| 6 | VCCO_6 | AA24 | |
| 6 | VCCO_6 | AA23 | |
| 6 | VCCO_6 | Y30 | |
| 6 | VCCO_6 | Y24 | |
| 6 | VCCO_6 | Y23 | |
| 6 | VCCO_6 | W34 | |
| 6 | VCCO_6 | W23 | |
| 6 | VCCO_6 | V23 | |
| 7 | VCCO_7 | U23 | |
| 7 | VCCO_7 | T34 | |
| 7 | VCCO_7 | T23 | |
| 7 | VCCO_7 | R30 | |
| 7 | VCCO_7 | R24 | |
| 7 | VCCO_7 | R23 | |
| 7 | VCCO_7 | P24 | |
| 7 | VCCO_7 | P23 | |
| 7 | VCCO_7 | N24 | |
| 7 | VCCO_7 | N23 | |
| 7 | VCCO_7 | M24 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| 7 | VCCO_7 | K34 | |
| 7 | VCCO_7 | G31 | |
| | | | |
| NA | CCLK | AH8 | |
| NA | PROG_B | D30 | |
| NA | DONE | AJ7 | |
| NA | M0 | AH27 | |
| NA | M1 | AJ28 | |
| NA | M2 | AK29 | |
| NA | HSWAP_EN | E29 | |
| NA | TCK | F7 | |
| NA | TDI | C31 | |
| NA | TDO | D5 | |
| NA | TMS | E6 | |
| NA | PWRDWN_B | AK6 | |
| NA | DXN | F28 | |
| NA | DXP | G27 | |
| NA | VBATT | C4 | |
| NA | RSVD | G8 | |
| NA | VCCAUX | AM30 | |
| NA | VCCAUX | AM18 | |
| NA | VCCAUX | AM5 | |
| NA | VCCAUX | V3 | |
| NA | VCCAUX | U32 | |
| NA | VCCAUX | C30 | |
| NA | VCCAUX | C17 | |
| NA | VCCAUX | C5 | |
| NA | VCCINT | AD24 | |
| NA | VCCINT | AD11 | |
| NA | VCCINT | AC23 | |
| NA | VCCINT | AC12 | |
| NA | VCCINT | AB22 | |
| NA | VCCINT | AB21 | |
| NA | VCCINT | AB20 | |
| NA | VCCINT | AB19 | |
| NA | VCCINT | AB18 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | VCCINT | AB17 | |
| NA | VCCINT | AB16 | |
| NA | VCCINT | AB15 | |
| NA | VCCINT | AB14 | |
| NA | VCCINT | AB13 | |
| NA | VCCINT | AA22 | |
| NA | VCCINT | AA13 | |
| NA | VCCINT | Y22 | |
| NA | VCCINT | Y13 | |
| NA | VCCINT | W22 | |
| NA | VCCINT | W13 | |
| NA | VCCINT | V22 | |
| NA | VCCINT | V13 | |
| NA | VCCINT | U22 | |
| NA | VCCINT | U13 | |
| NA | VCCINT | T22 | |
| NA | VCCINT | T13 | |
| NA | VCCINT | R22 | |
| NA | VCCINT | R13 | |
| NA | VCCINT | P22 | |
| NA | VCCINT | P13 | |
| NA | VCCINT | N22 | |
| NA | VCCINT | N21 | |
| NA | VCCINT | N20 | |
| NA | VCCINT | N19 | |
| NA | VCCINT | N18 | |
| NA | VCCINT | N17 | |
| NA | VCCINT | N16 | |
| NA | VCCINT | N15 | |
| NA | VCCINT | N14 | |
| NA | VCCINT | N13 | |
| NA | VCCINT | M23 | |
| NA | VCCINT | M12 | |
| NA | VCCINT | L24 | |
| NA | VCCINT | L11 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | GND | AP33 | |
| NA | GND | AP32 | |
| NA | GND | AP27 | |
| NA | GND | AP8 | |
| NA | GND | AP3 | |
| NA | GND | AP2 | |
| NA | GND | AN34 | |
| NA | GND | AN33 | |
| NA | GND | AN20 | |
| NA | GND | AN15 | |
| NA | GND | AN2 | |
| NA | GND | AN1 | |
| NA | GND | AM34 | |
| NA | GND | AM32 | |
| NA | GND | AM25 | |
| NA | GND | AM10 | |
| NA | GND | AM3 | |
| NA | GND | AM1 | |
| NA | GND | AL31 | |
| NA | GND | AL4 | |
| NA | GND | AK30 | |
| NA | GND | AK23 | |
| NA | GND | AK12 | |
| NA | GND | AK5 | |
| NA | GND | AJ29 | |
| NA | GND | AJ6 | |
| NA | GND | AH28 | |
| NA | GND | AH21 | |
| NA | GND | AH14 | |
| NA | GND | AH7 | |
| NA | GND | AG34 | |
| NA | GND | AG27 | |
| NA | GND | AG8 | |
| NA | GND | AG1 | |
| NA | GND | AF19 | |
| NA | GND | AF16 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | GND | AE32 | |
| NA | GND | AE3 | |
| NA | GND | AC30 | |
| NA | GND | AC5 | |
| NA | GND | AA28 | |
| NA | GND | AA21 | |
| NA | GND | AA20 | |
| NA | GND | AA19 | |
| NA | GND | AA18 | |
| NA | GND | AA17 | |
| NA | GND | AA16 | |
| NA | GND | AA15 | |
| NA | GND | AA14 | |
| NA | GND | AA7 | |
| NA | GND | Y33 | |
| NA | GND | Y21 | |
| NA | GND | Y20 | |
| NA | GND | Y19 | |
| NA | GND | Y18 | |
| NA | GND | Y17 | |
| NA | GND | Y16 | |
| NA | GND | Y15 | |
| NA | GND | Y14 | |
| NA | GND | Y2 | |
| NA | GND | W26 | |
| NA | GND | W21 | |
| NA | GND | W20 | |
| NA | GND | W19 | |
| NA | GND | W18 | |
| NA | GND | W17 | |
| NA | GND | W16 | |
| NA | GND | W15 | |
| NA | GND | W14 | |
| NA | GND | W9 | |
| NA | GND | V21 | |
| NA | GND | V20 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | GND | V19 | |
| NA | GND | V18 | |
| NA | GND | V17 | |
| NA | GND | V16 | |
| NA | GND | V15 | |
| NA | GND | V14 | |
| NA | GND | U21 | |
| NA | GND | U20 | |
| NA | GND | U19 | |
| NA | GND | U18 | |
| NA | GND | U17 | |
| NA | GND | U16 | |
| NA | GND | U15 | |
| NA | GND | U14 | |
| NA | GND | T26 | |
| NA | GND | T21 | |
| NA | GND | T20 | |
| NA | GND | T19 | |
| NA | GND | T18 | |
| NA | GND | T17 | |
| NA | GND | T16 | |
| NA | GND | T15 | |
| NA | GND | T14 | |
| NA | GND | T9 | |
| NA | GND | R33 | |
| NA | GND | R21 | |
| NA | GND | R20 | |
| NA | GND | R19 | |
| NA | GND | R18 | |
| NA | GND | R17 | |
| NA | GND | R16 | |
| NA | GND | R15 | |
| NA | GND | R14 | |
| NA | GND | R2 | |
| NA | GND | P28 | |
| NA | GND | P21 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | GND | P20 | |
| NA | GND | P19 | |
| NA | GND | P18 | |
| NA | GND | P17 | |
| NA | GND | P16 | |
| NA | GND | P15 | |
| NA | GND | P14 | |
| NA | GND | P7 | |
| NA | GND | M30 | |
| NA | GND | M5 | |
| NA | GND | K32 | |
| NA | GND | K3 | |
| NA | GND | J19 | |
| NA | GND | J16 | |
| NA | GND | H34 | |
| NA | GND | H27 | |
| NA | GND | H8 | |
| NA | GND | H1 | |
| NA | GND | G28 | |
| NA | GND | G21 | |
| NA | GND | G14 | |
| NA | GND | G7 | |
| NA | GND | F29 | |
| NA | GND | F6 | |
| NA | GND | E30 | |
| NA | GND | E23 | |
| NA | GND | E12 | |
| NA | GND | E5 | |
| NA | GND | D31 | |
| NA | GND | D4 | |
| NA | GND | C34 | |
| NA | GND | C32 | |
| NA | GND | C25 | |
| NA | GND | C10 | |
| NA | GND | C3 | |
| NA | GND | C1 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

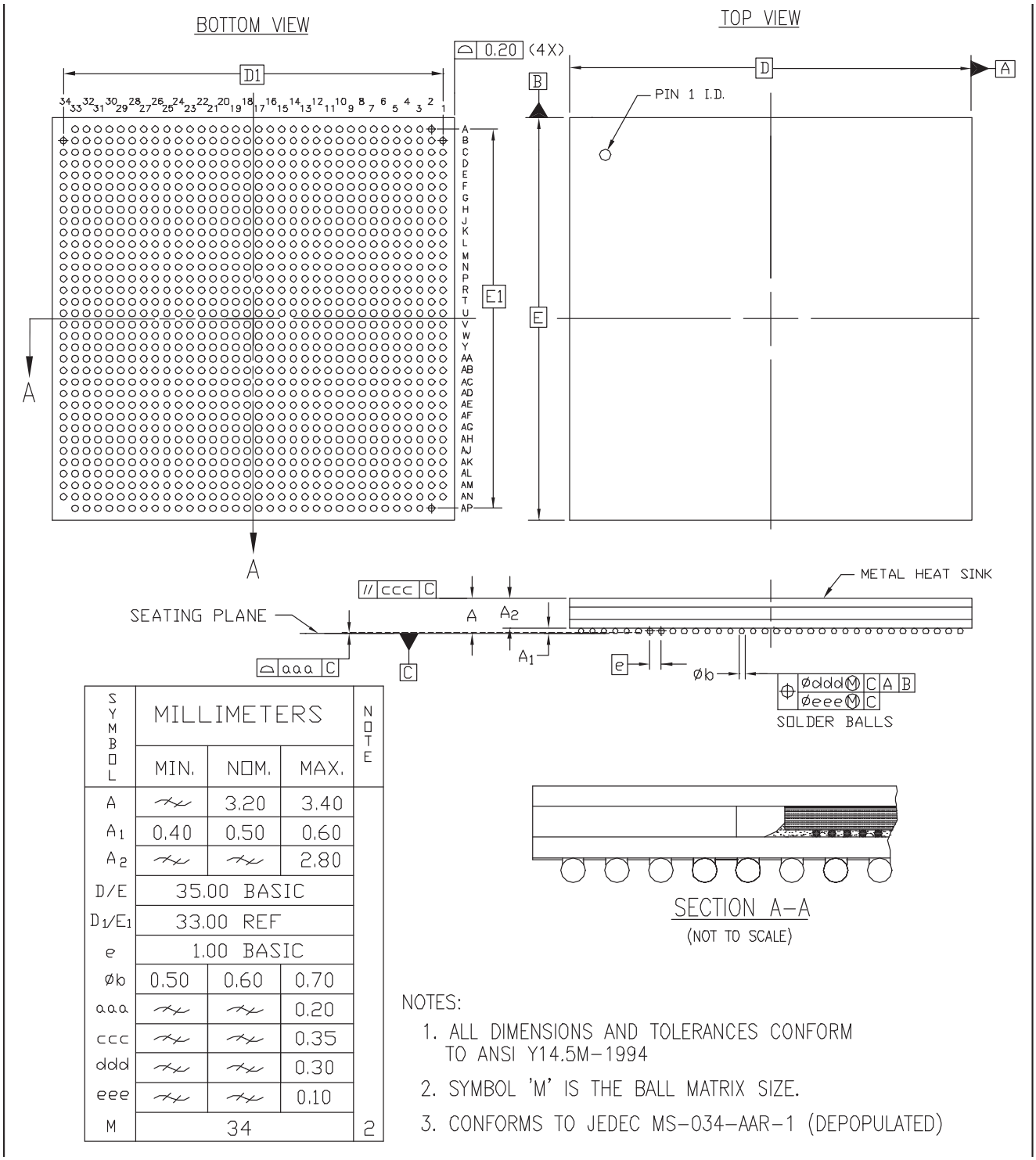

*Table 12:* **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V3000 |
|---|---|---|---|
| NA | GND | B34 | |
| NA | GND | B33 | |
| NA | GND | B20 | |
| NA | GND | B15 | |
| NA | GND | B2 | |
| NA | GND | B1 | |
| NA | GND | A33 | |
| NA | GND | A32 | |
| NA | GND | A27 | |
| NA | GND | A8 | |
| NA | GND | A3 | |
| NA | GND | A2 | |

**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)




| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | --- | 3.20 | 3.40 | |
| $A_1$ | 0.40 | 0.50 | 0.60 | |
| $A_2$ | --- | --- | 2.80 | |
| D/E | 35.00 BASIC | | | |
| $D_1/E_1$ | 33.00 REF | | | |
| e | 1.00 BASIC | | | |
| øb | 0.50 | 0.60 | 0.70 | |
| aaa | --- | --- | 0.20 | |
| ccc | --- | --- | 0.35 | |
| ddd | --- | --- | 0.30 | |
| eee | --- | --- | 0.10 | |
| M | 34 | | | 2 |

NOTES:
1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAR–1 (DEPOPULATED)

*Figure 8:* **FF1152 Flip-Chip Fine-Pitch BGA Package Specifications**

## FF1517 Flip-Chip Fine-Pitch BGA Package

As shown in Table 13, XC2V4000, XC2V6000, and XC2V8000 Virtex-II devices are available in the FF1517 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the pin differences in the XC2V4000 and XC2V6000 devices shown in the No Connect columns. Following this table are the FF1517 Flip-Chip Fine-Pitch BGA

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


Package Specifications (1.00mm pitch).

*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 0 | IO_L01N_0 | B36 | | |
| 0 | IO_L01P_0 | C36 | | |
| 0 | IO_L02N_0 | J30 | | |
| 0 | IO_L02P_0 | J29 | | |
| 0 | IO_L03N_0/VRP_0 | D33 | | |
| 0 | IO_L03P_0/VRN_0 | D34 | | |
| 0 | IO_L04N_0/VREF_0 | C34 | | |
| 0 | IO_L04P_0 | C35 | | |
| 0 | IO_L05N_0 | H30 | | |
| 0 | IO_L05P_0 | G30 | | |
| 0 | IO_L06N_0 | D32 | | |
| 0 | IO_L06P_0 | E33 | | |
| 0 | IO_L07N_0 | A35 | NC | |
| 0 | IO_L07P_0 | A36 | NC | |
| 0 | IO_L08N_0 | K28 | NC | |
| 0 | IO_L08P_0 | J28 | NC | |
| 0 | IO_L09N_0 | E32 | NC | |
| 0 | IO_L09P_0/VREF_0 | F32 | NC | |
| 0 | IO_L10N_0 | B34 | NC | |
| 0 | IO_L10P_0 | B35 | NC | |
| 0 | IO_L11N_0 | H29 | NC | |
| 0 | IO_L11P_0 | H28 | NC | |
| 0 | IO_L12N_0 | F31 | NC | |
| 0 | IO_L12P_0 | G31 | NC | |
| 0 | IO_L19N_0 | C32 | | |
| 0 | IO_L19P_0 | C33 | | |
| 0 | IO_L20N_0 | M26 | | |
| 0 | IO_L20P_0 | M25 | | |
| 0 | IO_L21N_0 | E30 | | |
| 0 | IO_L21P_0/VREF_0 | E31 | | |
| 0 | IO_L22N_0 | A33 | | |
| 0 | IO_L22P_0 | A34 | | |
| 0 | IO_L23N_0 | K27 | | |
| 0 | IO_L23P_0 | K26 | | |
| 0 | IO_L24N_0 | F29 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 0 | IO_L24P_0 | F30 | | |
| 0 | IO_L25N_0 | B32 | | |
| 0 | IO_L25P_0 | B33 | | |
| 0 | IO_L26N_0 | L26 | | |
| 0 | IO_L26P_0 | L25 | | |
| 0 | IO_L27N_0 | G28 | | |
| 0 | IO_L27P_0/VREF_0 | G29 | | |
| 0 | IO_L28N_0 | C30 | | |
| 0 | IO_L28P_0 | C31 | | |
| 0 | IO_L29N_0 | J27 | | |
| 0 | IO_L29P_0 | J26 | | |
| 0 | IO_L30N_0 | D30 | | |
| 0 | IO_L30P_0 | D31 | | |
| 0 | IO_L31N_0 | A31 | NC | |
| 0 | IO_L31P_0 | A32 | NC | |
| 0 | IO_L32N_0 | H27 | NC | |
| 0 | IO_L32P_0 | H26 | NC | |
| 0 | IO_L33N_0 | F27 | NC | |
| 0 | IO_L33P_0/VREF_0 | F28 | NC | |
| 0 | IO_L34N_0 | B30 | NC | |
| 0 | IO_L34P_0 | B31 | NC | |
| 0 | IO_L35N_0 | M24 | NC | |
| 0 | IO_L35P_0 | M23 | NC | |
| 0 | IO_L36N_0 | D28 | NC | |
| 0 | IO_L36P_0 | D29 | NC | |
| 0 | IO_L49N_0 | C28 | | |
| 0 | IO_L49P_0 | C29 | | |
| 0 | IO_L50N_0 | K25 | | |
| 0 | IO_L50P_0 | L24 | | |
| 0 | IO_L51N_0 | E27 | | |
| 0 | IO_L51P_0/VREF_0 | E28 | | |
| 0 | IO_L52N_0 | A29 | | |
| 0 | IO_L52P_0 | A30 | | |
| 0 | IO_L53N_0 | G26 | | |
| 0 | IO_L53P_0 | G25 | | |
| 0 | IO_L54N_0 | D26 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 0 | IO_L54P_0 | D27 | | |
| 0 | IO_L55N_0 | B27 | | |
| 0 | IO_L55P_0 | B28 | | |
| 0 | IO_L56N_0 | H25 | | |
| 0 | IO_L56P_0 | H24 | | |
| 0 | IO_L57N_0 | F25 | | |
| 0 | IO_L57P_0/VREF_0 | F26 | | |
| 0 | IO_L58N_0 | A27 | | |
| 0 | IO_L58P_0 | A28 | | |
| 0 | IO_L59N_0 | K24 | | |
| 0 | IO_L59P_0 | K23 | | |
| 0 | IO_L60N_0 | E24 | | |
| 0 | IO_L60P_0 | E25 | | |
| 0 | IO_L67N_0 | C26 | | |
| 0 | IO_L67P_0 | C27 | | |
| 0 | IO_L68N_0 | J24 | | |
| 0 | IO_L68P_0 | J23 | | |
| 0 | IO_L69N_0 | D24 | | |
| 0 | IO_L69P_0/VREF_0 | D25 | | |
| 0 | IO_L70N_0 | A25 | | |
| 0 | IO_L70P_0 | A26 | | |
| 0 | IO_L71N_0 | M22 | | |
| 0 | IO_L71P_0 | M21 | | |
| 0 | IO_L72N_0 | G23 | | |
| 0 | IO_L72P_0 | G24 | | |
| 0 | IO_L73N_0 | B25 | | |
| 0 | IO_L73P_0 | C25 | | |
| 0 | IO_L74N_0 | L22 | | |
| 0 | IO_L74P_0 | L21 | | |
| 0 | IO_L75N_0 | F23 | | |
| 0 | IO_L75P_0/VREF_0 | F24 | | |
| 0 | IO_L76N_0 | C23 | | |
| 0 | IO_L76P_0 | C24 | | |
| 0 | IO_L77N_0 | K22 | | |
| 0 | IO_L77P_0 | K21 | | |
| 0 | IO_L78N_0 | E22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 0 | IO_L78P_0 | E23 | | |
| 0 | IO_L79N_0 | B23 | | |
| 0 | IO_L79P_0 | B24 | | |
| 0 | IO_L80N_0 | J22 | | |
| 0 | IO_L80P_0 | J21 | | |
| 0 | IO_L81N_0 | G21 | | |
| 0 | IO_L81P_0/VREF_0 | G22 | | |
| 0 | IO_L82N_0 | A23 | | |
| 0 | IO_L82P_0 | A24 | | |
| 0 | IO_L83N_0 | H22 | | |
| 0 | IO_L83P_0 | H21 | | |
| 0 | IO_L84N_0 | F21 | | |
| 0 | IO_L84P_0 | F22 | | |
| 0 | IO_L91N_0/VREF_0 | B21 | | |
| 0 | IO_L91P_0 | B22 | | |
| 0 | IO_L92N_0 | L20 | | |
| 0 | IO_L92P_0 | M20 | | |
| 0 | IO_L93N_0 | E21 | | |
| 0 | IO_L93P_0 | D22 | | |
| 0 | IO_L94N_0/VREF_0 | A21 | | |
| 0 | IO_L94P_0 | A22 | | |
| 0 | IO_L95N_0/GCLK7P | H20 | | |
| 0 | IO_L95P_0/GCLK6S | J20 | | |
| 0 | IO_L96N_0/GCLK5P | C21 | | |
| 0 | IO_L96P_0/GCLK4S | D21 | | |
| | | | | |
| 1 | IO_L96N_1/GCLK3P | F19 | | |
| 1 | IO_L96P_1/GCLK2S | F20 | | |
| 1 | IO_L95N_1/GCLK1P | H19 | | |
| 1 | IO_L95P_1/GCLK0S | H18 | | |
| 1 | IO_L94N_1 | C19 | | |
| 1 | IO_L94P_1/VREF_1 | C20 | | |
| 1 | IO_L93N_1 | E19 | | |
| 1 | IO_L93P_1 | E20 | | |
| 1 | IO_L92N_1 | J19 | | |
| 1 | IO_L92P_1 | J18 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 1 | IO_L91N_1 | A18 | | |
| 1 | IO_L91P_1/VREF_1 | A19 | | |
| 1 | IO_L84N_1 | D18 | | |
| 1 | IO_L84P_1 | D19 | | |
| 1 | IO_L83N_1 | K19 | | |
| 1 | IO_L83P_1 | K18 | | |
| 1 | IO_L82N_1 | B18 | | |
| 1 | IO_L82P_1 | B19 | | |
| 1 | IO_L81N_1/VREF_1 | G18 | | |
| 1 | IO_L81P_1 | G19 | | |
| 1 | IO_L80N_1 | E18 | | |
| 1 | IO_L80P_1 | E17 | | |
| 1 | IO_L79N_1 | A16 | | |
| 1 | IO_L79P_1 | A17 | | |
| 1 | IO_L78N_1 | F17 | | |
| 1 | IO_L78P_1 | F18 | | |
| 1 | IO_L77N_1 | L19 | | |
| 1 | IO_L77P_1 | L18 | | |
| 1 | IO_L76N_1 | B16 | | |
| 1 | IO_L76P_1 | B17 | | |
| 1 | IO_L75N_1/VREF_1 | G16 | | |
| 1 | IO_L75P_1 | G17 | | |
| 1 | IO_L74N_1 | M19 | | |
| 1 | IO_L74P_1 | M18 | | |
| 1 | IO_L73N_1 | C16 | | |
| 1 | IO_L73P_1 | C17 | | |
| 1 | IO_L72N_1 | D15 | | |
| 1 | IO_L72P_1 | D16 | | |
| 1 | IO_L71N_1 | J17 | | |
| 1 | IO_L71P_1 | J16 | | |
| 1 | IO_L70N_1 | A14 | | |
| 1 | IO_L70P_1 | A15 | | |
| 1 | IO_L69N_1/VREF_1 | E15 | | |
| 1 | IO_L69P_1 | E16 | | |
| 1 | IO_L68N_1 | K17 | | |
| 1 | IO_L68P_1 | K16 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 1 | IO_L67N_1 | C15 | | |
| 1 | IO_L67P_1 | B15 | | |
| 1 | IO_L60N_1 | F15 | | |
| 1 | IO_L60P_1 | F16 | | |
| 1 | IO_L59N_1 | H16 | | |
| 1 | IO_L59P_1 | H15 | | |
| 1 | IO_L58N_1 | C13 | | |
| 1 | IO_L58P_1 | C14 | | |
| 1 | IO_L57N_1/VREF_1 | D13 | | |
| 1 | IO_L57P_1 | D14 | | |
| 1 | IO_L56N_1 | M17 | | |
| 1 | IO_L56P_1 | M16 | | |
| 1 | IO_L55N_1 | A12 | | |
| 1 | IO_L55P_1 | A13 | | |
| 1 | IO_L54N_1 | B12 | | |
| 1 | IO_L54P_1 | B13 | | |
| 1 | IO_L53N_1 | G15 | | |
| 1 | IO_L53P_1 | G14 | | |
| 1 | IO_L52N_1 | C11 | | |
| 1 | IO_L52P_1 | C12 | | |
| 1 | IO_L51N_1/VREF_1 | F13 | | |
| 1 | IO_L51P_1 | F14 | | |
| 1 | IO_L50N_1 | L16 | | |
| 1 | IO_L50P_1 | L15 | | |
| 1 | IO_L49N_1 | A10 | | |
| 1 | IO_L49P_1 | A11 | | |
| 1 | IO_L36N_1 | E12 | NC | |
| 1 | IO_L36P_1 | E13 | NC | |
| 1 | IO_L35N_1 | K15 | NC | |
| 1 | IO_L35P_1 | J14 | NC | |
| 1 | IO_L34N_1 | B9 | NC | |
| 1 | IO_L34P_1 | B10 | NC | |
| 1 | IO_L33N_1/VREF_1 | D11 | NC | |
| 1 | IO_L33P_1 | D12 | NC | |
| 1 | IO_L32N_1 | H14 | NC | |
| 1 | IO_L32P_1 | H13 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 1 | IO_L31N_1 | A8 | NC | |
| 1 | IO_L31P_1 | A9 | NC | |
| 1 | IO_L30N_1 | F11 | | |
| 1 | IO_L30P_1 | F12 | | |
| 1 | IO_L29N_1 | K14 | | |
| 1 | IO_L29P_1 | L14 | | |
| 1 | IO_L28N_1 | C9 | | |
| 1 | IO_L28P_1 | C10 | | |
| 1 | IO_L27N_1/VREF_1 | G11 | | |
| 1 | IO_L27P_1 | G12 | | |
| 1 | IO_L26N_1 | M15 | | |
| 1 | IO_L26P_1 | M14 | | |
| 1 | IO_L25N_1 | B7 | | |
| 1 | IO_L25P_1 | B8 | | |
| 1 | IO_L24N_1 | D9 | | |
| 1 | IO_L24P_1 | D10 | | |
| 1 | IO_L23N_1 | J13 | | |
| 1 | IO_L23P_1 | J12 | | |
| 1 | IO_L22N_1 | A6 | | |
| 1 | IO_L22P_1 | A7 | | |
| 1 | IO_L21N_1/VREF_1 | E9 | | |
| 1 | IO_L21P_1 | E10 | | |
| 1 | IO_L20N_1 | D8 | | |
| 1 | IO_L20P_1 | E7 | | |
| 1 | IO_L19N_1 | C7 | | |
| 1 | IO_L19P_1 | C8 | | |
| 1 | IO_L12N_1 | F9 | NC | |
| 1 | IO_L12P_1 | F10 | NC | |
| 1 | IO_L11N_1 | H12 | NC | |
| 1 | IO_L11P_1 | H11 | NC | |
| 1 | IO_L10N_1 | B5 | NC | |
| 1 | IO_L10P_1 | B6 | NC | |
| 1 | IO_L09N_1/VREF_1 | G9 | NC | |
| 1 | IO_L09P_1 | G10 | NC | |
| 1 | IO_L08N_1 | K13 | NC | |
| 1 | IO_L08P_1 | K12 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 1 | IO_L07N_1 | A4 | NC | |
| 1 | IO_L07P_1 | A5 | NC | |
| 1 | IO_L06N_1 | F8 | | |
| 1 | IO_L06P_1 | E8 | | |
| 1 | IO_L05N_1 | J11 | | |
| 1 | IO_L05P_1 | K11 | | |
| 1 | IO_L04N_1 | C5 | | |
| 1 | IO_L04P_1/VREF_1 | C6 | | |
| 1 | IO_L03N_1/VRP_1 | D6 | | |
| 1 | IO_L03P_1/VRN_1 | D7 | | |
| 1 | IO_L02N_1 | H10 | | |
| 1 | IO_L02P_1 | J10 | | |
| 1 | IO_L01N_1 | C4 | | |
| 1 | IO_L01P_1 | B4 | | |
| | | | | |
| 2 | IO_L01N_2 | E3 | | |
| 2 | IO_L01P_2 | D2 | | |
| 2 | IO_L02N_2/VRP_2 | L13 | | |
| 2 | IO_L02P_2/VRN_2 | M13 | | |
| 2 | IO_L03N_2 | F4 | | |
| 2 | IO_L03P_2/VREF_2 | E4 | | |
| 2 | IO_L04N_2 | E1 | | |
| 2 | IO_L04P_2 | D1 | | |
| 2 | IO_L05N_2 | L12 | | |
| 2 | IO_L05P_2 | M11 | | |
| 2 | IO_L06N_2 | G6 | | |
| 2 | IO_L06P_2 | F5 | | |
| 2 | IO_L07N_2 | F2 | NC | |
| 2 | IO_L07P_2 | E2 | NC | |
| 2 | IO_L08N_2 | M12 | NC | |
| 2 | IO_L08P_2 | N12 | NC | |
| 2 | IO_L09N_2 | H6 | NC | |
| 2 | IO_L09P_2/VREF_2 | H7 | NC | |
| 2 | IO_L10N_2 | G3 | NC | |
| 2 | IO_L10P_2 | F3 | NC | |
| 2 | IO_L11N_2 | J8 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 2 | IO_L11P_2 | K8 | NC | |
| 2 | IO_L12N_2 | H5 | NC | |
| 2 | IO_L12P_2 | G5 | NC | |
| 2 | IO_L19N_2 | G1 | | |
| 2 | IO_L19P_2 | F1 | | |
| 2 | IO_L20N_2 | K9 | | |
| 2 | IO_L20P_2 | L10 | | |
| 2 | IO_L21N_2 | K7 | | |
| 2 | IO_L21P_2/VREF_2 | J7 | | |
| 2 | IO_L22N_2 | H2 | | |
| 2 | IO_L22P_2 | G2 | | |
| 2 | IO_L23N_2 | L9 | | |
| 2 | IO_L23P_2 | M9 | | |
| 2 | IO_L24N_2 | H4 | | |
| 2 | IO_L24P_2 | G4 | | |
| 2 | IO_L25N_2 | J3 | | |
| 2 | IO_L25P_2 | H3 | | |
| 2 | IO_L26N_2 | M10 | | |
| 2 | IO_L26P_2 | N10 | | |
| 2 | IO_L27N_2 | K6 | | |
| 2 | IO_L27P_2/VREF_2 | J6 | | |
| 2 | IO_L28N_2 | K5 | | |
| 2 | IO_L28P_2 | J5 | | |
| 2 | IO_L29N_2 | N11 | | |
| 2 | IO_L29P_2 | P11 | | |
| 2 | IO_L30N_2 | M7 | | |
| 2 | IO_L30P_2 | L7 | | |
| 2 | IO_L31N_2 | J1 | NC | |
| 2 | IO_L31P_2 | H1 | NC | |
| 2 | IO_L32N_2 | L8 | NC | |
| 2 | IO_L32P_2 | M8 | NC | |
| 2 | IO_L33N_2 | K4 | NC | |
| 2 | IO_L33P_2/VREF_2 | J4 | NC | |
| 2 | IO_L34N_2 | K2 | NC | |
| 2 | IO_L34P_2 | J2 | NC | |
| 2 | IO_L35N_2 | P12 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 2 | IO_L35P_2 | R12 | NC | |
| 2 | IO_L36N_2 | M6 | NC | |
| 2 | IO_L36P_2 | L6 | NC | |
| 2 | IO_L43N_2 | L3 | | |
| 2 | IO_L43P_2 | K3 | | |
| 2 | IO_L44N_2 | N9 | | |
| 2 | IO_L44P_2 | P9 | | |
| 2 | IO_L45N_2 | M4 | | |
| 2 | IO_L45P_2/VREF_2 | L4 | | |
| 2 | IO_L46N_2 | L1 | | |
| 2 | IO_L46P_2 | K1 | | |
| 2 | IO_L47N_2 | P10 | | |
| 2 | IO_L47P_2 | R10 | | |
| 2 | IO_L48N_2 | N5 | | |
| 2 | IO_L48P_2 | M5 | | |
| 2 | IO_L49N_2 | N3 | | |
| 2 | IO_L49P_2 | M3 | | |
| 2 | IO_L50N_2 | N8 | | |
| 2 | IO_L50P_2 | P8 | | |
| 2 | IO_L51N_2 | T11 | | |
| 2 | IO_L51P_2/VREF_2 | R11 | | |
| 2 | IO_L52N_2 | N2 | | |
| 2 | IO_L52P_2 | M2 | | |
| 2 | IO_L53N_2 | T12 | | |
| 2 | IO_L53P_2 | U12 | | |
| 2 | IO_L54N_2 | P6 | | |
| 2 | IO_L54P_2 | N6 | | |
| 2 | IO_L55N_2 | N1 | | |
| 2 | IO_L55P_2 | M1 | | |
| 2 | IO_L56N_2 | R8 | | |
| 2 | IO_L56P_2 | T8 | | |
| 2 | IO_L57N_2 | R7 | | |
| 2 | IO_L57P_2/VREF_2 | P7 | | |
| 2 | IO_L58N_2 | R3 | | |
| 2 | IO_L58P_2 | P3 | | |
| 2 | IO_L59N_2 | T10 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 2 | IO_L59P_2 | U10 | | |
| 2 | IO_L60N_2 | P4 | | |
| 2 | IO_L60P_2 | N4 | | |
| 2 | IO_L67N_2 | T6 | | |
| 2 | IO_L67P_2 | R6 | | |
| 2 | IO_L68N_2 | T9 | | |
| 2 | IO_L68P_2 | U9 | | |
| 2 | IO_L69N_2 | T5 | | |
| 2 | IO_L69P_2/VREF_2 | R5 | | |
| 2 | IO_L70N_2 | R1 | | |
| 2 | IO_L70P_2 | P1 | | |
| 2 | IO_L71N_2 | V12 | | |
| 2 | IO_L71P_2 | W12 | | |
| 2 | IO_L72N_2 | T4 | | |
| 2 | IO_L72P_2 | R4 | | |
| 2 | IO_L73N_2 | T2 | | |
| 2 | IO_L73P_2 | R2 | | |
| 2 | IO_L74N_2 | V11 | | |
| 2 | IO_L74P_2 | W11 | | |
| 2 | IO_L75N_2 | U7 | | |
| 2 | IO_L75P_2/VREF_2 | T7 | | |
| 2 | IO_L76N_2 | U3 | | |
| 2 | IO_L76P_2 | T3 | | |
| 2 | IO_L77N_2 | V10 | | |
| 2 | IO_L77P_2 | W10 | | |
| 2 | IO_L78N_2 | V6 | | |
| 2 | IO_L78P_2 | U6 | | |
| 2 | IO_L79N_2 | U1 | | |
| 2 | IO_L79P_2 | T1 | | |
| 2 | IO_L80N_2 | V9 | | |
| 2 | IO_L80P_2 | W9 | | |
| 2 | IO_L81N_2 | V5 | | |
| 2 | IO_L81P_2/VREF_2 | U5 | | |
| 2 | IO_L82N_2 | V2 | | |
| 2 | IO_L82P_2 | U2 | | |
| 2 | IO_L83N_2 | V8 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 2 | IO_L83P_2 | W8 | | |
| 2 | IO_L84N_2 | W7 | | |
| 2 | IO_L84P_2 | V7 | | |
| 2 | IO_L91N_2 | W1 | | |
| 2 | IO_L91P_2 | V1 | | |
| 2 | IO_L92N_2 | Y11 | | |
| 2 | IO_L92P_2 | Y12 | | |
| 2 | IO_L93N_2 | W4 | | |
| 2 | IO_L93P_2/VREF_2 | V4 | | |
| 2 | IO_L94N_2 | W2 | | |
| 2 | IO_L94P_2 | W3 | | |
| 2 | IO_L95N_2 | Y8 | | |
| 2 | IO_L95P_2 | Y9 | | |
| 2 | IO_L96N_2 | W5 | | |
| 2 | IO_L96P_2 | W6 | | |
| | | | | |
| 3 | IO_L96N_3 | AB8 | | |
| 3 | IO_L96P_3 | AA8 | | |
| 3 | IO_L95N_3 | Y3 | | |
| 3 | IO_L95P_3 | AA3 | | |
| 3 | IO_L94N_3 | Y6 | | |
| 3 | IO_L94P_3 | AA6 | | |
| 3 | IO_L93N_3/VREF_3 | AB9 | | |
| 3 | IO_L93P_3 | AA9 | | |
| 3 | IO_L92N_3 | AA1 | | |
| 3 | IO_L92P_3 | AB1 | | |
| 3 | IO_L91N_3 | Y5 | | |
| 3 | IO_L91P_3 | AA5 | | |
| 3 | IO_L84N_3 | AB10 | | |
| 3 | IO_L84P_3 | AA10 | | |
| 3 | IO_L83N_3 | AA2 | | |
| 3 | IO_L83P_3 | AB2 | | |
| 3 | IO_L82N_3 | AA4 | | |
| 3 | IO_L82P_3 | AB4 | | |
| 3 | IO_L81N_3/VREF_3 | AB11 | | |
| 3 | IO_L81P_3 | AA11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 3 | IO_L80N_3 | AC1 | | |
| 3 | IO_L80P_3 | AD1 | | |
| 3 | IO_L79N_3 | AA7 | | |
| 3 | IO_L79P_3 | AB7 | | |
| 3 | IO_L78N_3 | AB12 | | |
| 3 | IO_L78P_3 | AA12 | | |
| 3 | IO_L77N_3 | AC2 | | |
| 3 | IO_L77P_3 | AC3 | | |
| 3 | IO_L76N_3 | AB5 | | |
| 3 | IO_L76P_3 | AC5 | | |
| 3 | IO_L75N_3/VREF_3 | AD9 | | |
| 3 | IO_L75P_3 | AC9 | | |
| 3 | IO_L74N_3 | AD2 | | |
| 3 | IO_L74P_3 | AE2 | | |
| 3 | IO_L73N_3 | AB6 | | |
| 3 | IO_L73P_3 | AC6 | | |
| 3 | IO_L72N_3 | AD10 | | |
| 3 | IO_L72P_3 | AC10 | | |
| 3 | IO_L71N_3 | AD3 | | |
| 3 | IO_L71P_3 | AE3 | | |
| 3 | IO_L70N_3 | AC7 | | |
| 3 | IO_L70P_3 | AD7 | | |
| 3 | IO_L69N_3/VREF_3 | AE8 | | |
| 3 | IO_L69P_3 | AD8 | | |
| 3 | IO_L68N_3 | AE1 | | |
| 3 | IO_L68P_3 | AF1 | | |
| 3 | IO_L67N_3 | AD4 | | |
| 3 | IO_L67P_3 | AE4 | | |
| 3 | IO_L60N_3 | AD12 | | |
| 3 | IO_L60P_3 | AC12 | | |
| 3 | IO_L59N_3 | AF3 | | |
| 3 | IO_L59P_3 | AG3 | | |
| 3 | IO_L58N_3 | AD5 | | |
| 3 | IO_L58P_3 | AE5 | | |
| 3 | IO_L57N_3/VREF_3 | AE11 | | |
| 3 | IO_L57P_3 | AD11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 3 | IO_L56N_3 | AG1 | | |
| 3 | IO_L56P_3 | AH1 | | |
| 3 | IO_L55N_3 | AD6 | | |
| 3 | IO_L55P_3 | AE6 | | |
| 3 | IO_L54N_3 | AF10 | | |
| 3 | IO_L54P_3 | AE10 | | |
| 3 | IO_L53N_3 | AG2 | | |
| 3 | IO_L53P_3 | AH2 | | |
| 3 | IO_L52N_3 | AF4 | | |
| 3 | IO_L52P_3 | AG4 | | |
| 3 | IO_L51N_3/VREF_3 | AG8 | | |
| 3 | IO_L51P_3 | AF8 | | |
| 3 | IO_L50N_3 | AH3 | | |
| 3 | IO_L50P_3 | AJ3 | | |
| 3 | IO_L49N_3 | AE7 | | |
| 3 | IO_L49P_3 | AF7 | | |
| 3 | IO_L48N_3 | AG9 | | |
| 3 | IO_L48P_3 | AF9 | | |
| 3 | IO_L47N_3 | AF6 | | |
| 3 | IO_L47P_3 | AG6 | | |
| 3 | IO_L46N_3 | AG5 | | |
| 3 | IO_L46P_3 | AH5 | | |
| 3 | IO_L45N_3/VREF_3 | AF12 | | |
| 3 | IO_L45P_3 | AE12 | | |
| 3 | IO_L44N_3 | AJ1 | | |
| 3 | IO_L44P_3 | AK1 | | |
| 3 | IO_L43N_3 | AH4 | | |
| 3 | IO_L43P_3 | AJ4 | | |
| 3 | IO_L36N_3 | AG11 | NC | |
| 3 | IO_L36P_3 | AF11 | NC | |
| 3 | IO_L35N_3 | AK2 | NC | |
| 3 | IO_L35P_3 | AL2 | NC | |
| 3 | IO_L34N_3 | AH6 | NC | |
| 3 | IO_L34P_3 | AJ6 | NC | |
| 3 | IO_L33N_3/VREF_3 | AJ8 | NC | |
| 3 | IO_L33P_3 | AH8 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 3 | IO_L32N_3 | AL1 | NC | |
| 3 | IO_L32P_3 | AM1 | NC | |
| 3 | IO_L31N_3 | AH7 | NC | |
| 3 | IO_L31P_3 | AJ7 | NC | |
| 3 | IO_L30N_3 | AH10 | | |
| 3 | IO_L30P_3 | AG10 | | |
| 3 | IO_L29N_3 | AK3 | | |
| 3 | IO_L29P_3 | AL3 | | |
| 3 | IO_L28N_3 | AK4 | | |
| 3 | IO_L28P_3 | AL4 | | |
| 3 | IO_L27N_3/VREF_3 | AJ9 | | |
| 3 | IO_L27P_3 | AH9 | | |
| 3 | IO_L26N_3 | AM2 | | |
| 3 | IO_L26P_3 | AN2 | | |
| 3 | IO_L25N_3 | AK5 | | |
| 3 | IO_L25P_3 | AL5 | | |
| 3 | IO_L24N_3 | AK9 | | |
| 3 | IO_L24P_3 | AK8 | | |
| 3 | IO_L23N_3 | AN1 | | |
| 3 | IO_L23P_3 | AP1 | | |
| 3 | IO_L22N_3 | AK6 | | |
| 3 | IO_L22P_3 | AL6 | | |
| 3 | IO_L21N_3/VREF_3 | AH12 | | |
| 3 | IO_L21P_3 | AG12 | | |
| 3 | IO_L20N_3 | AM3 | | |
| 3 | IO_L20P_3 | AN3 | | |
| 3 | IO_L19N_3 | AM4 | | |
| 3 | IO_L19P_3 | AN4 | | |
| 3 | IO_L12N_3 | AJ12 | NC | |
| 3 | IO_L12P_3 | AH11 | NC | |
| 3 | IO_L11N_3 | AP2 | NC | |
| 3 | IO_L11P_3 | AR2 | NC | |
| 3 | IO_L10N_3 | AK7 | NC | |
| 3 | IO_L10P_3 | AL7 | NC | |
| 3 | IO_L09N_3/VREF_3 | AK11 | NC | |
| 3 | IO_L09P_3 | AJ10 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 3 | IO_L08N_3 | AR1 | NC | |
| 3 | IO_L08P_3 | AT1 | NC | |
| 3 | IO_L07N_3 | AM5 | NC | |
| 3 | IO_L07P_3 | AN5 | NC | |
| 3 | IO_L06N_3 | AM7 | | |
| 3 | IO_L06P_3 | AL8 | | |
| 3 | IO_L05N_3 | AP3 | | |
| 3 | IO_L05P_3 | AP4 | | |
| 3 | IO_L04N_3 | AM6 | | |
| 3 | IO_L04P_3 | AN6 | | |
| 3 | IO_L03N_3/VREF_3 | AJ13 | | |
| 3 | IO_L03P_3 | AH13 | | |
| 3 | IO_L02N_3/VRP_3 | AR3 | | |
| 3 | IO_L02P_3/VRN_3 | AT2 | | |
| 3 | IO_L01N_3 | AP5 | | |
| 3 | IO_L01P_3 | AR4 | | |
| | | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AV4 | | |
| 4 | IO_L01P_4/INIT_B | AU4 | | |
| 4 | IO_L02N_4/D0/DIN(1) | AM9 | | |
| 4 | IO_L02P_4/D1 | AM10 | | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AT6 | | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AR6 | | |
| 4 | IO_L04N_4/VREF_4 | AU6 | | |
| 4 | IO_L04P_4 | AU5 | | |
| 4 | IO_L05N_4/VRP_4 | AL10 | | |
| 4 | IO_L05P_4/VRN_4 | AL11 | | |
| 4 | IO_L06N_4 | AR8 | | |
| 4 | IO_L06P_4 | AR7 | | |
| 4 | IO_L07N_4 | AW5 | NC | |
| 4 | IO_L07P_4 | AW4 | NC | |
| 4 | IO_L08N_4 | AK12 | NC | |
| 4 | IO_L08P_4 | AL12 | NC | |
| 4 | IO_L09N_4 | AP9 | NC | |
| 4 | IO_L09P_4/VREF_4 | AP8 | NC | |
| 4 | IO_L10N_4 | AV6 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 4 | IO_L10P_4 | AV5 | NC | |
| 4 | IO_L11N_4 | AM11 | NC | |
| 4 | IO_L11P_4 | AM12 | NC | |
| 4 | IO_L12N_4 | AN10 | NC | |
| 4 | IO_L12P_4 | AN9 | NC | |
| 4 | IO_L19N_4 | AU8 | | |
| 4 | IO_L19P_4 | AU7 | | |
| 4 | IO_L20N_4 | AH14 | | |
| 4 | IO_L20P_4 | AH15 | | |
| 4 | IO_L21N_4 | AT8 | | |
| 4 | IO_L21P_4/VREF_4 | AT7 | | |
| 4 | IO_L22N_4 | AW7 | | |
| 4 | IO_L22P_4 | AW6 | | |
| 4 | IO_L23N_4 | AK13 | | |
| 4 | IO_L23P_4 | AK14 | | |
| 4 | IO_L24N_4 | AR10 | | |
| 4 | IO_L24P_4 | AR9 | | |
| 4 | IO_L25N_4 | AV8 | | |
| 4 | IO_L25P_4 | AV7 | | |
| 4 | IO_L26N_4 | AJ14 | | |
| 4 | IO_L26P_4 | AJ15 | | |
| 4 | IO_L27N_4 | AP11 | | |
| 4 | IO_L27P_4/VREF_4 | AP10 | | |
| 4 | IO_L28N_4 | AU10 | | |
| 4 | IO_L28P_4 | AU9 | | |
| 4 | IO_L29N_4 | AL13 | | |
| 4 | IO_L29P_4 | AL14 | | |
| 4 | IO_L30N_4 | AN12 | | |
| 4 | IO_L30P_4 | AN11 | | |
| 4 | IO_L31N_4 | AW9 | NC | |
| 4 | IO_L31P_4 | AW8 | NC | |
| 4 | IO_L32N_4 | AM13 | NC | |
| 4 | IO_L32P_4 | AM14 | NC | |
| 4 | IO_L33N_4 | AT10 | NC | |
| 4 | IO_L33P_4/VREF_4 | AT9 | NC | |
| 4 | IO_L34N_4 | AV10 | NC | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 4 | IO_L34P_4 | AV9 | NC | |
| 4 | IO_L35N_4 | AH16 | NC | |
| 4 | IO_L35P_4 | AH17 | NC | |
| 4 | IO_L36N_4 | AP13 | NC | |
| 4 | IO_L36P_4 | AP12 | NC | |
| 4 | IO_L49N_4 | AU12 | | |
| 4 | IO_L49P_4 | AU11 | | |
| 4 | IO_L50N_4 | AK15 | | |
| 4 | IO_L50P_4 | AJ16 | | |
| 4 | IO_L51N_4 | AT12 | | |
| 4 | IO_L51P_4/VREF_4 | AT11 | | |
| 4 | IO_L52N_4 | AN15 | | |
| 4 | IO_L52P_4 | AN14 | | |
| 4 | IO_L53N_4 | AR12 | | |
| 4 | IO_L53P_4 | AR13 | | |
| 4 | IO_L54N_4 | AT14 | | |
| 4 | IO_L54P_4 | AT13 | | |
| 4 | IO_L55N_4 | AW11 | | |
| 4 | IO_L55P_4 | AW10 | | |
| 4 | IO_L56N_4 | AM15 | | |
| 4 | IO_L56P_4 | AM16 | | |
| 4 | IO_L57N_4 | AP15 | | |
| 4 | IO_L57P_4/VREF_4 | AP14 | | |
| 4 | IO_L58N_4 | AV13 | | |
| 4 | IO_L58P_4 | AV12 | | |
| 4 | IO_L59N_4 | AK16 | | |
| 4 | IO_L59P_4 | AK17 | | |
| 4 | IO_L60N_4 | AR16 | | |
| 4 | IO_L60P_4 | AR15 | | |
| 4 | IO_L67N_4 | AW13 | | |
| 4 | IO_L67P_4 | AW12 | | |
| 4 | IO_L68N_4 | AL16 | | |
| 4 | IO_L68P_4 | AL17 | | |
| 4 | IO_L69N_4 | AT16 | | |
| 4 | IO_L69P_4/VREF_4 | AT15 | | |
| 4 | IO_L70N_4 | AU14 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 4 | IO_L70P_4 | AU13 | | |
| 4 | IO_L71N_4 | AH18 | | |
| 4 | IO_L71P_4 | AH19 | | |
| 4 | IO_L72N_4 | AN17 | | |
| 4 | IO_L72P_4 | AN16 | | |
| 4 | IO_L73N_4 | AW15 | | |
| 4 | IO_L73P_4 | AW14 | | |
| 4 | IO_L74N_4 | AJ18 | | |
| 4 | IO_L74P_4 | AJ19 | | |
| 4 | IO_L75N_4 | AP17 | | |
| 4 | IO_L75P_4/VREF_4 | AP16 | | |
| 4 | IO_L76N_4 | AV15 | | |
| 4 | IO_L76P_4 | AU15 | | |
| 4 | IO_L77N_4 | AK18 | | |
| 4 | IO_L77P_4 | AK19 | | |
| 4 | IO_L78N_4 | AR18 | | |
| 4 | IO_L78P_4 | AR17 | | |
| 4 | IO_L79N_4 | AU17 | | |
| 4 | IO_L79P_4 | AU16 | | |
| 4 | IO_L80N_4 | AL18 | | |
| 4 | IO_L80P_4 | AL19 | | |
| 4 | IO_L81N_4 | AN19 | | |
| 4 | IO_L81P_4/VREF_4 | AN18 | | |
| 4 | IO_L82N_4 | AV17 | | |
| 4 | IO_L82P_4 | AV16 | | |
| 4 | IO_L83N_4 | AM18 | | |
| 4 | IO_L83P_4 | AM19 | | |
| 4 | IO_L84N_4 | AP19 | | |
| 4 | IO_L84P_4 | AP18 | | |
| 4 | IO_L85N_4 | AW17 | NC | NC |
| 4 | IO_L85P_4 | AW16 | NC | NC |
| 4 | IO_L91N_4/VREF_4 | AV19 | | |
| 4 | IO_L91P_4 | AV18 | | |
| 4 | IO_L92N_4 | AH20 | | |
| 4 | IO_L92P_4 | AJ20 | | |
| 4 | IO_L93N_4 | AR19 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 4 | IO_L93P_4 | AT18 | | |
| 4 | IO_L94N_4/VREF_4 | AW19 | | |
| 4 | IO_L94P_4 | AW18 | | |
| 4 | IO_L95N_4/GCLK3S | AL20 | | |
| 4 | IO_L95P_4/GCLK2P | AM20 | | |
| 4 | IO_L96N_4/GCLK1S | AU19 | | |
| 4 | IO_L96P_4/GCLK0P | AT19 | | |
| | | | | |
| 5 | IO_L96N_5/GCLK7S | AP21 | | |
| 5 | IO_L96P_5/GCLK6P | AP20 | | |
| 5 | IO_L95N_5/GCLK5S | AN21 | | |
| 5 | IO_L95P_5/GCLK4P | AN22 | | |
| 5 | IO_L94N_5 | AU21 | | |
| 5 | IO_L94P_5/VREF_5 | AU20 | | |
| 5 | IO_L93N_5 | AR21 | | |
| 5 | IO_L93P_5 | AR20 | | |
| 5 | IO_L92N_5 | AM21 | | |
| 5 | IO_L92P_5 | AM22 | | |
| 5 | IO_L91N_5 | AW22 | | |
| 5 | IO_L91P_5/VREF_5 | AW21 | | |
| 5 | IO_L85N_5 | AV22 | NC | NC |
| 5 | IO_L85P_5 | AV21 | NC | NC |
| 5 | IO_L84N_5 | AT22 | | |
| 5 | IO_L84P_5 | AT21 | | |
| 5 | IO_L83N_5 | AL21 | | |
| 5 | IO_L83P_5 | AL22 | | |
| 5 | IO_L82N_5 | AW24 | | |
| 5 | IO_L82P_5 | AW23 | | |
| 5 | IO_L81N_5/VREF_5 | AR23 | | |
| 5 | IO_L81P_5 | AR22 | | |
| 5 | IO_L80N_5 | AK21 | | |
| 5 | IO_L80P_5 | AK22 | | |
| 5 | IO_L79N_5 | AV24 | | |
| 5 | IO_L79P_5 | AV23 | | |
| 5 | IO_L78N_5 | AP23 | | |
| 5 | IO_L78P_5 | AP22 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 5 | IO_L77N_5 | AJ21 | | |
| 5 | IO_L77P_5 | AJ22 | | |
| 5 | IO_L76N_5 | AU24 | | |
| 5 | IO_L76P_5 | AU23 | | |
| 5 | IO_L75N_5/VREF_5 | AT25 | | |
| 5 | IO_L75P_5 | AT24 | | |
| 5 | IO_L74N_5 | AH21 | | |
| 5 | IO_L74P_5 | AH22 | | |
| 5 | IO_L73N_5 | AW26 | | |
| 5 | IO_L73P_5 | AW25 | | |
| 5 | IO_L72N_5 | AR25 | | |
| 5 | IO_L72P_5 | AR24 | | |
| 5 | IO_L71N_5 | AN23 | | |
| 5 | IO_L71P_5 | AN24 | | |
| 5 | IO_L70N_5 | AU25 | | |
| 5 | IO_L70P_5 | AV25 | | |
| 5 | IO_L69N_5/VREF_5 | AL24 | | |
| 5 | IO_L69P_5 | AL23 | | |
| 5 | IO_L68N_5 | AK23 | | |
| 5 | IO_L68P_5 | AK24 | | |
| 5 | IO_L67N_5 | AU27 | | |
| 5 | IO_L67P_5 | AU26 | | |
| 5 | IO_L60N_5 | AP25 | | |
| 5 | IO_L60P_5 | AP24 | | |
| 5 | IO_L59N_5 | AM24 | | |
| 5 | IO_L59P_5 | AM25 | | |
| 5 | IO_L58N_5 | AW28 | | |
| 5 | IO_L58P_5 | AW27 | | |
| 5 | IO_L57N_5/VREF_5 | AT27 | | |
| 5 | IO_L57P_5 | AT26 | | |
| 5 | IO_L56N_5 | AH23 | | |
| 5 | IO_L56P_5 | AH24 | | |
| 5 | IO_L55N_5 | AV28 | | |
| 5 | IO_L55P_5 | AV27 | | |
| 5 | IO_L54N_5 | AP27 | | |
| 5 | IO_L54P_5 | AP26 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 5 | IO_L53N_5 | AN25 | | |
| 5 | IO_L53P_5 | AN26 | | |
| 5 | IO_L52N_5 | AU29 | | |
| 5 | IO_L52P_5 | AU28 | | |
| 5 | IO_L51N_5/VREF_5 | AR28 | | |
| 5 | IO_L51P_5 | AR27 | | |
| 5 | IO_L50N_5 | AJ24 | | |
| 5 | IO_L50P_5 | AJ25 | | |
| 5 | IO_L49N_5 | AW30 | | |
| 5 | IO_L49P_5 | AW29 | | |
| 5 | IO_L36N_5 | AT29 | NC | |
| 5 | IO_L36P_5 | AT28 | NC | |
| 5 | IO_L35N_5 | AK25 | NC | |
| 5 | IO_L35P_5 | AL26 | NC | |
| 5 | IO_L34N_5 | AV31 | NC | |
| 5 | IO_L34P_5 | AV30 | NC | |
| 5 | IO_L33N_5/VREF_5 | AP29 | NC | |
| 5 | IO_L33P_5 | AP28 | NC | |
| 5 | IO_L32N_5 | AK26 | NC | |
| 5 | IO_L32P_5 | AJ26 | NC | |
| 5 | IO_L31N_5 | AW32 | NC | |
| 5 | IO_L31P_5 | AW31 | NC | |
| 5 | IO_L30N_5 | AM27 | | |
| 5 | IO_L30P_5 | AM26 | | |
| 5 | IO_L29N_5 | AN28 | | |
| 5 | IO_L29P_5 | AN29 | | |
| 5 | IO_L28N_5 | AU31 | | |
| 5 | IO_L28P_5 | AU30 | | |
| 5 | IO_L27N_5/VREF_5 | AT31 | | |
| 5 | IO_L27P_5 | AT30 | | |
| 5 | IO_L26N_5 | AH25 | | |
| 5 | IO_L26P_5 | AH26 | | |
| 5 | IO_L25N_5 | AV33 | | |
| 5 | IO_L25P_5 | AV32 | | |
| 5 | IO_L24N_5 | AR31 | | |
| 5 | IO_L24P_5 | AR30 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 5 | IO_L23N_5 | AL27 | | |
| 5 | IO_L23P_5 | AL28 | | |
| 5 | IO_L22N_5 | AW34 | | |
| 5 | IO_L22P_5 | AW33 | | |
| 5 | IO_L21N_5/VREF_5 | AN30 | | |
| 5 | IO_L21P_5 | AP30 | | |
| 5 | IO_L20N_5 | AM28 | | |
| 5 | IO_L20P_5 | AM29 | | |
| 5 | IO_L19N_5 | AU33 | | |
| 5 | IO_L19P_5 | AU32 | | |
| 5 | IO_L12N_5 | AT33 | NC | |
| 5 | IO_L12P_5 | AT32 | NC | |
| 5 | IO_L11N_5 | AK27 | NC | |
| 5 | IO_L11P_5 | AK28 | NC | |
| 5 | IO_L10N_5 | AV35 | NC | |
| 5 | IO_L10P_5 | AV34 | NC | |
| 5 | IO_L09N_5/VREF_5 | AP32 | NC | |
| 5 | IO_L09P_5 | AP31 | NC | |
| 5 | IO_L08N_5 | AL29 | NC | |
| 5 | IO_L08P_5 | AK29 | NC | |
| 5 | IO_L07N_5 | AW36 | NC | |
| 5 | IO_L07P_5 | AW35 | NC | |
| 5 | IO_L06N_5 | AR33 | | |
| 5 | IO_L06P_5 | AR32 | | |
| 5 | IO_L05N_5/VRP_5 | AM30 | | |
| 5 | IO_L05P_5/VRN_5 | AL30 | | |
| 5 | IO_L04N_5 | AU35 | | |
| 5 | IO_L04P_5/VREF_5 | AU34 | | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AR34 | | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AT34 | | |
| 5 | IO_L02N_5/D6 | AN31 | | |
| 5 | IO_L02P_5/D7 | AM31 | | |
| 5 | IO_L01N_5/RDWR_B | AU36 | | |
| 5 | IO_L01P_5/CS_B | AV36 | | |
| | | | | |
| 6 | IO_L01P_6 | AJ27 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 6 | IO_L01N_6 | AH27 | | |
| 6 | IO_L02P_6/VRN_6 | AT38 | | |
| 6 | IO_L02N_6/VRP_6 | AR37 | | |
| 6 | IO_L03P_6 | AP36 | | |
| 6 | IO_L03N_6/VREF_6 | AR36 | | |
| 6 | IO_L04P_6 | AJ28 | | |
| 6 | IO_L04N_6 | AH29 | | |
| 6 | IO_L05P_6 | AT39 | | |
| 6 | IO_L05N_6 | AR39 | | |
| 6 | IO_L06P_6 | AN34 | | |
| 6 | IO_L06N_6 | AP35 | | |
| 6 | IO_L07P_6 | AH28 | NC | |
| 6 | IO_L07N_6 | AG28 | NC | |
| 6 | IO_L08P_6 | AR38 | NC | |
| 6 | IO_L08N_6 | AP38 | NC | |
| 6 | IO_L09P_6 | AM34 | NC | |
| 6 | IO_L09N_6/VREF_6 | AM33 | NC | |
| 6 | IO_L10P_6 | AL32 | NC | |
| 6 | IO_L10N_6 | AK32 | NC | |
| 6 | IO_L11P_6 | AP37 | NC | |
| 6 | IO_L11N_6 | AN37 | NC | |
| 6 | IO_L12P_6 | AM35 | NC | |
| 6 | IO_L12N_6 | AN35 | NC | |
| 6 | IO_L19P_6 | AK31 | | |
| 6 | IO_L19N_6 | AJ30 | | |
| 6 | IO_L20P_6 | AP39 | | |
| 6 | IO_L20N_6 | AN39 | | |
| 6 | IO_L21P_6 | AK33 | | |
| 6 | IO_L21N_6/VREF_6 | AL33 | | |
| 6 | IO_L22P_6 | AJ31 | | |
| 6 | IO_L22N_6 | AH31 | | |
| 6 | IO_L23P_6 | AN38 | | |
| 6 | IO_L23N_6 | AM38 | | |
| 6 | IO_L24P_6 | AM36 | | |
| 6 | IO_L24N_6 | AN36 | | |
| 6 | IO_L25P_6 | AH30 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 6 | IO_L25N_6 | AG30 | | |
| 6 | IO_L26P_6 | AM37 | | |
| 6 | IO_L26N_6 | AL37 | | |
| 6 | IO_L27P_6 | AK34 | | |
| 6 | IO_L27N_6/VREF_6 | AL34 | | |
| 6 | IO_L28P_6 | AG29 | | |
| 6 | IO_L28N_6 | AF29 | | |
| 6 | IO_L29P_6 | AL35 | | |
| 6 | IO_L29N_6 | AK35 | | |
| 6 | IO_L30P_6 | AH33 | | |
| 6 | IO_L30N_6 | AJ33 | | |
| 6 | IO_L31P_6 | AJ32 | NC | |
| 6 | IO_L31N_6 | AH32 | NC | |
| 6 | IO_L32P_6 | AM39 | NC | |
| 6 | IO_L32N_6 | AL39 | NC | |
| 6 | IO_L33P_6 | AK36 | NC | |
| 6 | IO_L33N_6/VREF_6 | AL36 | NC | |
| 6 | IO_L34P_6 | AF28 | NC | |
| 6 | IO_L34N_6 | AE28 | NC | |
| 6 | IO_L35P_6 | AL38 | NC | |
| 6 | IO_L35N_6 | AK38 | NC | |
| 6 | IO_L36P_6 | AH34 | NC | |
| 6 | IO_L36N_6 | AJ34 | NC | |
| 6 | IO_L43P_6 | AG31 | | |
| 6 | IO_L43N_6 | AF31 | | |
| 6 | IO_L44P_6 | AK37 | | |
| 6 | IO_L44N_6 | AJ37 | | |
| 6 | IO_L45P_6 | AH36 | | |
| 6 | IO_L45N_6/VREF_6 | AJ36 | | |
| 6 | IO_L46P_6 | AF30 | | |
| 6 | IO_L46N_6 | AE30 | | |
| 6 | IO_L47P_6 | AK39 | | |
| 6 | IO_L47N_6 | AJ39 | | |
| 6 | IO_L48P_6 | AG35 | | |
| 6 | IO_L48N_6 | AH35 | | |
| 6 | IO_L49P_6 | AG32 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 6 | IO_L49N_6 | AF32 | | |
| 6 | IO_L50P_6 | AH37 | | |
| 6 | IO_L50N_6 | AG37 | | |
| 6 | IO_L51P_6 | AD29 | | |
| 6 | IO_L51N_6/VREF_6 | AE29 | | |
| 6 | IO_L52P_6 | AD28 | | |
| 6 | IO_L52N_6 | AC28 | | |
| 6 | IO_L53P_6 | AH38 | | |
| 6 | IO_L53N_6 | AG38 | | |
| 6 | IO_L54P_6 | AF34 | | |
| 6 | IO_L54N_6 | AG34 | | |
| 6 | IO_L55P_6 | AE32 | | |
| 6 | IO_L55N_6 | AD32 | | |
| 6 | IO_L56P_6 | AH39 | | |
| 6 | IO_L56N_6 | AG39 | | |
| 6 | IO_L57P_6 | AE33 | | |
| 6 | IO_L57N_6/VREF_6 | AF33 | | |
| 6 | IO_L58P_6 | AD30 | | |
| 6 | IO_L58N_6 | AC30 | | |
| 6 | IO_L59P_6 | AF37 | | |
| 6 | IO_L59N_6 | AE37 | | |
| 6 | IO_L60P_6 | AF36 | | |
| 6 | IO_L60N_6 | AG36 | | |
| 6 | IO_L67P_6 | AD31 | | |
| 6 | IO_L67N_6 | AC31 | | |
| 6 | IO_L68P_6 | AE34 | | |
| 6 | IO_L68N_6 | AD34 | | |
| 6 | IO_L69P_6 | AD35 | | |
| 6 | IO_L69N_6/VREF_6 | AE35 | | |
| 6 | IO_L70P_6 | AB28 | | |
| 6 | IO_L70N_6 | AA28 | | |
| 6 | IO_L71P_6 | AF39 | | |
| 6 | IO_L71N_6 | AE39 | | |
| 6 | IO_L72P_6 | AD36 | | |
| 6 | IO_L72N_6 | AE36 | | |
| 6 | IO_L73P_6 | AB29 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 6 | IO_L73N_6 | AA29 | | |
| 6 | IO_L74P_6 | AE38 | | |
| 6 | IO_L74N_6 | AD38 | | |
| 6 | IO_L75P_6 | AC33 | | |
| 6 | IO_L75N_6/VREF_6 | AD33 | | |
| 6 | IO_L76P_6 | AB30 | | |
| 6 | IO_L76N_6 | AA30 | | |
| 6 | IO_L77P_6 | AD37 | | |
| 6 | IO_L77N_6 | AC37 | | |
| 6 | IO_L78P_6 | AB34 | | |
| 6 | IO_L78N_6 | AC34 | | |
| 6 | IO_L79P_6 | AB31 | | |
| 6 | IO_L79N_6 | AA31 | | |
| 6 | IO_L80P_6 | AD39 | | |
| 6 | IO_L80N_6 | AC39 | | |
| 6 | IO_L81P_6 | AB35 | | |
| 6 | IO_L81N_6/VREF_6 | AC35 | | |
| 6 | IO_L82P_6 | AB32 | | |
| 6 | IO_L82N_6 | AA32 | | |
| 6 | IO_L83P_6 | AC38 | | |
| 6 | IO_L83N_6 | AB38 | | |
| 6 | IO_L84P_6 | AA33 | | |
| 6 | IO_L84N_6 | AB33 | | |
| 6 | IO_L91P_6 | Y28 | | |
| 6 | IO_L91N_6 | Y29 | | |
| 6 | IO_L92P_6 | AB39 | | |
| 6 | IO_L92N_6 | AA39 | | |
| 6 | IO_L93P_6 | AA36 | | |
| 6 | IO_L93N_6/VREF_6 | AB36 | | |
| 6 | IO_L94P_6 | Y31 | | |
| 6 | IO_L94N_6 | Y32 | | |
| 6 | IO_L95P_6 | AA37 | | |
| 6 | IO_L95N_6 | AA38 | | |
| 6 | IO_L96P_6 | AA35 | | |
| 6 | IO_L96N_6 | AA34 | | |
| | | | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 7 | IO_L96P_7 | W34 | | |
| 7 | IO_L96N_7 | Y34 | | |
| 7 | IO_L95P_7 | W32 | | |
| 7 | IO_L95N_7 | V32 | | |
| 7 | IO_L94P_7 | W37 | | |
| 7 | IO_L94N_7 | Y37 | | |
| 7 | IO_L93P_7/VREF_7 | W35 | | |
| 7 | IO_L93N_7 | Y35 | | |
| 7 | IO_L92P_7 | W31 | | |
| 7 | IO_L92N_7 | V31 | | |
| 7 | IO_L91P_7 | V39 | | |
| 7 | IO_L91N_7 | W39 | | |
| 7 | IO_L84P_7 | V36 | | |
| 7 | IO_L84N_7 | W36 | | |
| 7 | IO_L83P_7 | W30 | | |
| 7 | IO_L83N_7 | V30 | | |
| 7 | IO_L82P_7 | V38 | | |
| 7 | IO_L82N_7 | W38 | | |
| 7 | IO_L81P_7/VREF_7 | V33 | | |
| 7 | IO_L81N_7 | W33 | | |
| 7 | IO_L80P_7 | W29 | | |
| 7 | IO_L80N_7 | V29 | | |
| 7 | IO_L79P_7 | T39 | | |
| 7 | IO_L79N_7 | U39 | | |
| 7 | IO_L78P_7 | U35 | | |
| 7 | IO_L78N_7 | V35 | | |
| 7 | IO_L77P_7 | W28 | | |
| 7 | IO_L77N_7 | V28 | | |
| 7 | IO_L76P_7 | U37 | | |
| 7 | IO_L76N_7 | U38 | | |
| 7 | IO_L75P_7/VREF_7 | U34 | | |
| 7 | IO_L75N_7 | V34 | | |
| 7 | IO_L74P_7 | U31 | | |
| 7 | IO_L74N_7 | T31 | | |
| 7 | IO_L73P_7 | R38 | | |
| 7 | IO_L73N_7 | T38 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 7 | IO_L72P_7 | T33 | | |
| 7 | IO_L72N_7 | U33 | | |
| 7 | IO_L71P_7 | U30 | | |
| 7 | IO_L71N_7 | T30 | | |
| 7 | IO_L70P_7 | R37 | | |
| 7 | IO_L70N_7 | T37 | | |
| 7 | IO_L69P_7/VREF_7 | R36 | | |
| 7 | IO_L69N_7 | T36 | | |
| 7 | IO_L68P_7 | T32 | | |
| 7 | IO_L68N_7 | R32 | | |
| 7 | IO_L67P_7 | P39 | | |
| 7 | IO_L67N_7 | R39 | | |
| 7 | IO_L60P_7 | R35 | | |
| 7 | IO_L60N_7 | T35 | | |
| 7 | IO_L59P_7 | U28 | | |
| 7 | IO_L59N_7 | T28 | | |
| 7 | IO_L58P_7 | N37 | | |
| 7 | IO_L58N_7 | P37 | | |
| 7 | IO_L57P_7/VREF_7 | R34 | | |
| 7 | IO_L57N_7 | T34 | | |
| 7 | IO_L56P_7 | T29 | | |
| 7 | IO_L56N_7 | R29 | | |
| 7 | IO_L55P_7 | M39 | | |
| 7 | IO_L55N_7 | N39 | | |
| 7 | IO_L54P_7 | N36 | | |
| 7 | IO_L54N_7 | P36 | | |
| 7 | IO_L53P_7 | R30 | | |
| 7 | IO_L53N_7 | P30 | | |
| 7 | IO_L52P_7 | M38 | | |
| 7 | IO_L52N_7 | N38 | | |
| 7 | IO_L51P_7/VREF_7 | P33 | | |
| 7 | IO_L51N_7 | R33 | | |
| 7 | IO_L50P_7 | P32 | | |
| 7 | IO_L50N_7 | N32 | | |
| 7 | IO_L49P_7 | L37 | | |
| 7 | IO_L49N_7 | M37 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 7 | IO_L48P_7 | N34 | | |
| 7 | IO_L48N_7 | P34 | | |
| 7 | IO_L47P_7 | P31 | | |
| 7 | IO_L47N_7 | N31 | | |
| 7 | IO_L46P_7 | M35 | | |
| 7 | IO_L46N_7 | N35 | | |
| 7 | IO_L45P_7/VREF_7 | L36 | | |
| 7 | IO_L45N_7 | M36 | | |
| 7 | IO_L44P_7 | R28 | | |
| 7 | IO_L44N_7 | P28 | | |
| 7 | IO_L43P_7 | K39 | | |
| 7 | IO_L43N_7 | L39 | | |
| 7 | IO_L36P_7 | L34 | NC | |
| 7 | IO_L36N_7 | M34 | NC | |
| 7 | IO_L35P_7 | P29 | NC | |
| 7 | IO_L35N_7 | N29 | NC | |
| 7 | IO_L34P_7 | J38 | NC | |
| 7 | IO_L34N_7 | K38 | NC | |
| 7 | IO_L33P_7/VREF_7 | L33 | NC | |
| 7 | IO_L33N_7 | M33 | NC | |
| 7 | IO_L32P_7 | M32 | NC | |
| 7 | IO_L32N_7 | L32 | NC | |
| 7 | IO_L31P_7 | H39 | NC | |
| 7 | IO_L31N_7 | J39 | NC | |
| 7 | IO_L30P_7 | J36 | | |
| 7 | IO_L30N_7 | K36 | | |
| 7 | IO_L29P_7 | N30 | | |
| 7 | IO_L29N_7 | M30 | | |
| 7 | IO_L28P_7 | J37 | | |
| 7 | IO_L28N_7 | K37 | | |
| 7 | IO_L27P_7/VREF_7 | J35 | | |
| 7 | IO_L27N_7 | K35 | | |
| 7 | IO_L26P_7 | M31 | | |
| 7 | IO_L26N_7 | L31 | | |
| 7 | IO_L25P_7 | G38 | | |
| 7 | IO_L25N_7 | H38 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 7 | IO_L24P_7 | J34 | | |
| 7 | IO_L24N_7 | K34 | | |
| 7 | IO_L23P_7 | K32 | | |
| 7 | IO_L23N_7 | K31 | | |
| 7 | IO_L22P_7 | F39 | | |
| 7 | IO_L22N_7 | G39 | | |
| 7 | IO_L21P_7/VREF_7 | G36 | | |
| 7 | IO_L21N_7 | H36 | | |
| 7 | IO_L20P_7 | N28 | | |
| 7 | IO_L20N_7 | M28 | | |
| 7 | IO_L19P_7 | G37 | | |
| 7 | IO_L19N_7 | H37 | | |
| 7 | IO_L12P_7 | J33 | NC | |
| 7 | IO_L12N_7 | K33 | NC | |
| 7 | IO_L11P_7 | M29 | NC | |
| 7 | IO_L11N_7 | L28 | NC | |
| 7 | IO_L10P_7 | E38 | NC | |
| 7 | IO_L10N_7 | F38 | NC | |
| 7 | IO_L09P_7/VREF_7 | G35 | NC | |
| 7 | IO_L09N_7 | H35 | NC | |
| 7 | IO_L08P_7 | L30 | NC | |
| 7 | IO_L08N_7 | K29 | NC | |
| 7 | IO_L07P_7 | D39 | NC | |
| 7 | IO_L07N_7 | E39 | NC | |
| 7 | IO_L06P_7 | G34 | | |
| 7 | IO_L06N_7 | H34 | | |
| 7 | IO_L05P_7 | J32 | | |
| 7 | IO_L05N_7 | H33 | | |
| 7 | IO_L04P_7 | F36 | | |
| 7 | IO_L04N_7 | F37 | | |
| 7 | IO_L03P_7/VREF_7 | E36 | | |
| 7 | IO_L03N_7 | F35 | | |
| 7 | IO_L02P_7/VRN_7 | M27 | | |
| 7 | IO_L02N_7/VRP_7 | L27 | | |
| 7 | IO_L01P_7 | D38 | | |
| 7 | IO_L01N_7 | E37 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| | | | | |
| 0 | VCCO_0 | P25 | | |
| 0 | VCCO_0 | P24 | | |
| 0 | VCCO_0 | P23 | | |
| 0 | VCCO_0 | P22 | | |
| 0 | VCCO_0 | P21 | | |
| 0 | VCCO_0 | N26 | | |
| 0 | VCCO_0 | N25 | | |
| 0 | VCCO_0 | N24 | | |
| 0 | VCCO_0 | N23 | | |
| 0 | VCCO_0 | N22 | | |
| 0 | VCCO_0 | N21 | | |
| 0 | VCCO_0 | L23 | | |
| 0 | VCCO_0 | J25 | | |
| 0 | VCCO_0 | G27 | | |
| 0 | VCCO_0 | E29 | | |
| 0 | VCCO_0 | C22 | | |
| 0 | VCCO_0 | B26 | | |
| 1 | VCCO_1 | P19 | | |
| 1 | VCCO_1 | P18 | | |
| 1 | VCCO_1 | P17 | | |
| 1 | VCCO_1 | P16 | | |
| 1 | VCCO_1 | P15 | | |
| 1 | VCCO_1 | N19 | | |
| 1 | VCCO_1 | N18 | | |
| 1 | VCCO_1 | N17 | | |
| 1 | VCCO_1 | N16 | | |
| 1 | VCCO_1 | N15 | | |
| 1 | VCCO_1 | N14 | | |
| 1 | VCCO_1 | L17 | | |
| 1 | VCCO_1 | J15 | | |
| 1 | VCCO_1 | G13 | | |
| 1 | VCCO_1 | E11 | | |
| 1 | VCCO_1 | C18 | | |
| 1 | VCCO_1 | B14 | | |
| 2 | VCCO_2 | W14 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 2 | VCCO_2 | W13 | | |
| 2 | VCCO_2 | V14 | | |
| 2 | VCCO_2 | V13 | | |
| 2 | VCCO_2 | V3 | | |
| 2 | VCCO_2 | U14 | | |
| 2 | VCCO_2 | U13 | | |
| 2 | VCCO_2 | U11 | | |
| 2 | VCCO_2 | T14 | | |
| 2 | VCCO_2 | T13 | | |
| 2 | VCCO_2 | R14 | | |
| 2 | VCCO_2 | R13 | | |
| 2 | VCCO_2 | R9 | | |
| 2 | VCCO_2 | P13 | | |
| 2 | VCCO_2 | P2 | | |
| 2 | VCCO_2 | N7 | | |
| 2 | VCCO_2 | L5 | | |
| 3 | VCCO_3 | AJ5 | | |
| 3 | VCCO_3 | AG7 | | |
| 3 | VCCO_3 | AF13 | | |
| 3 | VCCO_3 | AF2 | | |
| 3 | VCCO_3 | AE14 | | |
| 3 | VCCO_3 | AE13 | | |
| 3 | VCCO_3 | AE9 | | |
| 3 | VCCO_3 | AD14 | | |
| 3 | VCCO_3 | AD13 | | |
| 3 | VCCO_3 | AC14 | | |
| 3 | VCCO_3 | AC13 | | |
| 3 | VCCO_3 | AC11 | | |
| 3 | VCCO_3 | AB14 | | |
| 3 | VCCO_3 | AB13 | | |
| 3 | VCCO_3 | AB3 | | |
| 3 | VCCO_3 | AA14 | | |
| 3 | VCCO_3 | AA13 | | |
| 4 | VCCO_4 | AV14 | | |
| 4 | VCCO_4 | AU18 | | |
| 4 | VCCO_4 | AR11 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 4 | VCCO_4 | AN13 | | |
| 4 | VCCO_4 | AL15 | | |
| 4 | VCCO_4 | AJ17 | | |
| 4 | VCCO_4 | AG19 | | |
| 4 | VCCO_4 | AG18 | | |
| 4 | VCCO_4 | AG17 | | |
| 4 | VCCO_4 | AG16 | | |
| 4 | VCCO_4 | AG15 | | |
| 4 | VCCO_4 | AG14 | | |
| 4 | VCCO_4 | AF19 | | |
| 4 | VCCO_4 | AF18 | | |
| 4 | VCCO_4 | AF17 | | |
| 4 | VCCO_4 | AF16 | | |
| 4 | VCCO_4 | AF15 | | |
| 5 | VCCO_5 | AV26 | | |
| 5 | VCCO_5 | AU22 | | |
| 5 | VCCO_5 | AR29 | | |
| 5 | VCCO_5 | AN27 | | |
| 5 | VCCO_5 | AL25 | | |
| 5 | VCCO_5 | AJ23 | | |
| 5 | VCCO_5 | AG26 | | |
| 5 | VCCO_5 | AG25 | | |
| 5 | VCCO_5 | AG24 | | |
| 5 | VCCO_5 | AG23 | | |
| 5 | VCCO_5 | AG22 | | |
| 5 | VCCO_5 | AG21 | | |
| 5 | VCCO_5 | AF25 | | |
| 5 | VCCO_5 | AF24 | | |
| 5 | VCCO_5 | AF23 | | |
| 5 | VCCO_5 | AF22 | | |
| 5 | VCCO_5 | AF21 | | |
| 6 | VCCO_6 | AJ35 | | |
| 6 | VCCO_6 | AG33 | | |
| 6 | VCCO_6 | AF38 | | |
| 6 | VCCO_6 | AF27 | | |
| 6 | VCCO_6 | AE31 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| 6 | VCCO_6 | AE27 | | |
| 6 | VCCO_6 | AE26 | | |
| 6 | VCCO_6 | AD27 | | |
| 6 | VCCO_6 | AD26 | | |
| 6 | VCCO_6 | AC29 | | |
| 6 | VCCO_6 | AC27 | | |
| 6 | VCCO_6 | AC26 | | |
| 6 | VCCO_6 | AB37 | | |
| 6 | VCCO_6 | AB27 | | |
| 6 | VCCO_6 | AB26 | | |
| 6 | VCCO_6 | AA27 | | |
| 6 | VCCO_6 | AA26 | | |
| 7 | VCCO_7 | W27 | | |
| 7 | VCCO_7 | W26 | | |
| 7 | VCCO_7 | V37 | | |
| 7 | VCCO_7 | V27 | | |
| 7 | VCCO_7 | V26 | | |
| 7 | VCCO_7 | U29 | | |
| 7 | VCCO_7 | U27 | | |
| 7 | VCCO_7 | U26 | | |
| 7 | VCCO_7 | T27 | | |
| 7 | VCCO_7 | T26 | | |
| 7 | VCCO_7 | R31 | | |
| 7 | VCCO_7 | R27 | | |
| 7 | VCCO_7 | R26 | | |
| 7 | VCCO_7 | P38 | | |
| 7 | VCCO_7 | P27 | | |
| 7 | VCCO_7 | N33 | | |
| 7 | VCCO_7 | L35 | | |
| | | | | |
| NA | CCLK | AT5 | | |
| NA | PROG_B | H31 | | |
| NA | DONE | AP7 | | |
| NA | M0 | AN32 | | |
| NA | M1 | AP33 | | |
| NA | M2 | AT35 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | HSWAP_EN | E34 | | |
| NA | TCK | G8 | | |
| NA | TDI | D35 | | |
| NA | TDO | E6 | | |
| NA | TMS | F7 | | |
| NA | PWRDWN_B | AN8 | | |
| NA | DXN | G32 | | |
| NA | DXP | F33 | | |
| NA | VBATT | D5 | | |
| NA | RSVD | H9 | | |
| | | | | |
| NA | VCCAUX | AV20 | | |
| NA | VCCAUX | AT37 | | |
| NA | VCCAUX | AT3 | | |
| NA | VCCAUX | Y38 | | |
| NA | VCCAUX | Y2 | | |
| NA | VCCAUX | D37 | | |
| NA | VCCAUX | D3 | | |
| NA | VCCAUX | B20 | | |
| NA | VCCINT | AG27 | | |
| NA | VCCINT | AG20 | | |
| NA | VCCINT | AG13 | | |
| NA | VCCINT | AF26 | | |
| NA | VCCINT | AF20 | | |
| NA | VCCINT | AF14 | | |
| NA | VCCINT | AE25 | | |
| NA | VCCINT | AE24 | | |
| NA | VCCINT | AE23 | | |
| NA | VCCINT | AE22 | | |
| NA | VCCINT | AE21 | | |
| NA | VCCINT | AE20 | | |
| NA | VCCINT | AE19 | | |
| NA | VCCINT | AE18 | | |
| NA | VCCINT | AE17 | | |
| NA | VCCINT | AE16 | | |
| NA | VCCINT | AE15 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | VCCINT | AD25 | | |
| NA | VCCINT | AD24 | | |
| NA | VCCINT | AD16 | | |
| NA | VCCINT | AD15 | | |
| NA | VCCINT | AC25 | | |
| NA | VCCINT | AC15 | | |
| NA | VCCINT | AB25 | | |
| NA | VCCINT | AB15 | | |
| NA | VCCINT | AA25 | | |
| NA | VCCINT | AA15 | | |
| NA | VCCINT | Y27 | | |
| NA | VCCINT | Y26 | | |
| NA | VCCINT | Y25 | | |
| NA | VCCINT | Y15 | | |
| NA | VCCINT | Y14 | | |
| NA | VCCINT | Y13 | | |
| NA | VCCINT | W25 | | |
| NA | VCCINT | W15 | | |
| NA | VCCINT | V25 | | |
| NA | VCCINT | V15 | | |
| NA | VCCINT | U25 | | |
| NA | VCCINT | U15 | | |
| NA | VCCINT | T25 | | |
| NA | VCCINT | T24 | | |
| NA | VCCINT | T16 | | |
| NA | VCCINT | T15 | | |
| NA | VCCINT | R25 | | |
| NA | VCCINT | R24 | | |
| NA | VCCINT | R23 | | |
| NA | VCCINT | R22 | | |
| NA | VCCINT | R21 | | |
| NA | VCCINT | R20 | | |
| NA | VCCINT | R19 | | |
| NA | VCCINT | R18 | | |
| NA | VCCINT | R17 | | |
| NA | VCCINT | R16 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | VCCINT | R15 | | |
| NA | VCCINT | P26 | | |
| NA | VCCINT | P20 | | |
| NA | VCCINT | P14 | | |
| NA | VCCINT | N27 | | |
| NA | VCCINT | N20 | | |
| NA | VCCINT | N13 | | |
| NA | GND | AW38 | | |
| NA | GND | AW37 | | |
| NA | GND | AW20 | | |
| NA | GND | AW3 | | |
| NA | GND | AW2 | | |
| NA | GND | AV39 | | |
| NA | GND | AV38 | | |
| NA | GND | AV37 | | |
| NA | GND | AV29 | | |
| NA | GND | AV11 | | |
| NA | GND | AV3 | | |
| NA | GND | AV2 | | |
| NA | GND | AV1 | | |
| NA | GND | AU39 | | |
| NA | GND | AU38 | | |
| NA | GND | AU37 | | |
| NA | GND | AU3 | | |
| NA | GND | AU2 | | |
| NA | GND | AU1 | | |
| NA | GND | AT36 | | |
| NA | GND | AT23 | | |
| NA | GND | AT20 | | |
| NA | GND | AT17 | | |
| NA | GND | AT4 | | |
| NA | GND | AR35 | | |
| NA | GND | AR26 | | |
| NA | GND | AR14 | | |
| NA | GND | AR5 | | |
| NA | GND | AP34 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | GND | AP6 | | |
| NA | GND | AN33 | | |
| NA | GND | AN20 | | |
| NA | GND | AN7 | | |
| NA | GND | AM32 | | |
| NA | GND | AM23 | | |
| NA | GND | AM17 | | |
| NA | GND | AM8 | | |
| NA | GND | AL31 | | |
| NA | GND | AL9 | | |
| NA | GND | AK30 | | |
| NA | GND | AK20 | | |
| NA | GND | AK10 | | |
| NA | GND | AJ38 | | |
| NA | GND | AJ29 | | |
| NA | GND | AJ11 | | |
| NA | GND | AJ2 | | |
| NA | GND | AF35 | | |
| NA | GND | AF5 | | |
| NA | GND | AD23 | | |
| NA | GND | AD22 | | |
| NA | GND | AD21 | | |
| NA | GND | AD20 | | |
| NA | GND | AD19 | | |
| NA | GND | AD18 | | |
| NA | GND | AD17 | | |
| NA | GND | AC36 | | |
| NA | GND | AC32 | | |
| NA | GND | AC24 | | |
| NA | GND | AC23 | | |
| NA | GND | AC22 | | |
| NA | GND | AC21 | | |
| NA | GND | AC20 | | |
| NA | GND | AC19 | | |
| NA | GND | AC18 | | |
| NA | GND | AC17 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | GND | AC16 | | |
| NA | GND | AC8 | | |
| NA | GND | AC4 | | |
| NA | GND | AB24 | | |
| NA | GND | AB23 | | |
| NA | GND | AB22 | | |
| NA | GND | AB21 | | |
| NA | GND | AB20 | | |
| NA | GND | AB19 | | |
| NA | GND | AB18 | | |
| NA | GND | AB17 | | |
| NA | GND | AB16 | | |
| NA | GND | AA24 | | |
| NA | GND | AA23 | | |
| NA | GND | AA22 | | |
| NA | GND | AA21 | | |
| NA | GND | AA20 | | |
| NA | GND | AA19 | | |
| NA | GND | AA18 | | |
| NA | GND | AA17 | | |
| NA | GND | AA16 | | |
| NA | GND | Y39 | | |
| NA | GND | Y36 | | |
| NA | GND | Y33 | | |
| NA | GND | Y30 | | |
| NA | GND | Y24 | | |
| NA | GND | Y23 | | |
| NA | GND | Y22 | | |
| NA | GND | Y21 | | |
| NA | GND | Y20 | | |
| NA | GND | Y19 | | |
| NA | GND | Y18 | | |
| NA | GND | Y17 | | |
| NA | GND | Y16 | | |
| NA | GND | Y10 | | |
| NA | GND | Y7 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | GND | Y4 | | |
| NA | GND | Y1 | | |
| NA | GND | W24 | | |
| NA | GND | W23 | | |
| NA | GND | W22 | | |
| NA | GND | W21 | | |
| NA | GND | W20 | | |
| NA | GND | W19 | | |
| NA | GND | W18 | | |
| NA | GND | W17 | | |
| NA | GND | W16 | | |
| NA | GND | V24 | | |
| NA | GND | V23 | | |
| NA | GND | V22 | | |
| NA | GND | V21 | | |
| NA | GND | V20 | | |
| NA | GND | V19 | | |
| NA | GND | V18 | | |
| NA | GND | V17 | | |
| NA | GND | V16 | | |
| NA | GND | U36 | | |
| NA | GND | U32 | | |
| NA | GND | U24 | | |
| NA | GND | U23 | | |
| NA | GND | U22 | | |
| NA | GND | U21 | | |
| NA | GND | U20 | | |
| NA | GND | U19 | | |
| NA | GND | U18 | | |
| NA | GND | U17 | | |
| NA | GND | U16 | | |
| NA | GND | U8 | | |
| NA | GND | U4 | | |
| NA | GND | T23 | | |
| NA | GND | T22 | | |
| NA | GND | T21 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | GND | T20 | | |
| NA | GND | T19 | | |
| NA | GND | T18 | | |
| NA | GND | T17 | | |
| NA | GND | P35 | | |
| NA | GND | P5 | | |
| NA | GND | L38 | | |
| NA | GND | L29 | | |
| NA | GND | L11 | | |
| NA | GND | L2 | | |
| NA | GND | K30 | | |
| NA | GND | K20 | | |
| NA | GND | K10 | | |
| NA | GND | J31 | | |
| NA | GND | J9 | | |
| NA | GND | H32 | | |
| NA | GND | H23 | | |
| NA | GND | H17 | | |
| NA | GND | H8 | | |
| NA | GND | G33 | | |
| NA | GND | G20 | | |
| NA | GND | G7 | | |
| NA | GND | F34 | | |
| NA | GND | F6 | | |
| NA | GND | E35 | | |
| NA | GND | E26 | | |
| NA | GND | E14 | | |
| NA | GND | E5 | | |
| NA | GND | D36 | | |
| NA | GND | D23 | | |
| NA | GND | D20 | | |
| NA | GND | D17 | | |
| NA | GND | D4 | | |
| NA | GND | C39 | | |
| NA | GND | C38 | | |
| NA | GND | C37 | | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

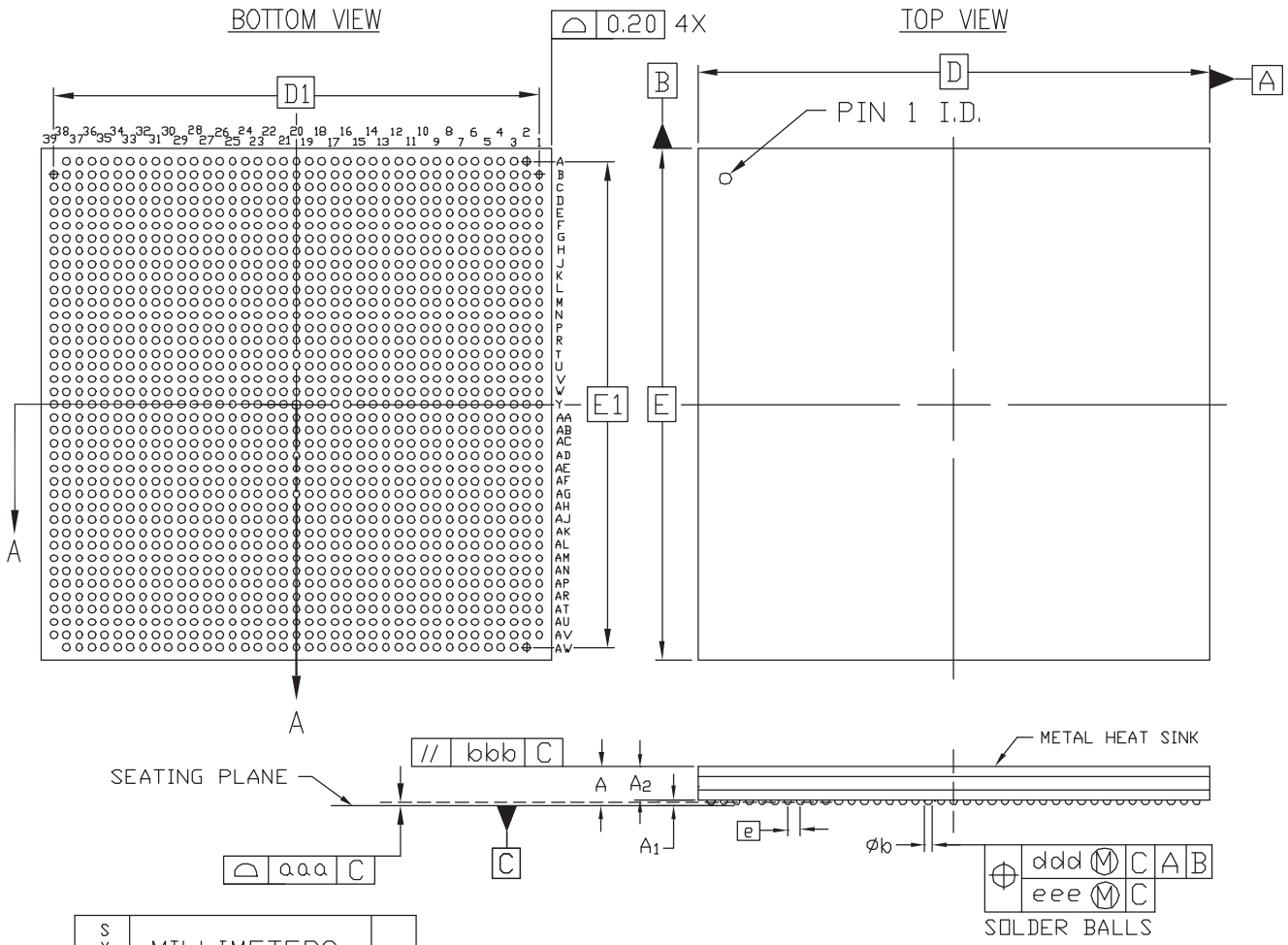

*Table 13:* **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

| Bank | Pin Description | Pin Number | No Connect in the XC2V4000 | No Connect in the XC2V6000 |
|---|---|---|---|---|
| NA | GND | C3 | | |
| NA | GND | C2 | | |
| NA | GND | C1 | | |
| NA | GND | B39 | | |
| NA | GND | B38 | | |
| NA | GND | B37 | | |
| NA | GND | B29 | | |
| NA | GND | B11 | | |
| NA | GND | B3 | | |
| NA | GND | B2 | | |
| NA | GND | B1 | | |
| NA | GND | A38 | | |
| NA | GND | A37 | | |
| NA | GND | A20 | | |
| NA | GND | A3 | | |
| NA | GND | A2 | | |

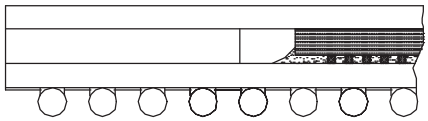
**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## FF1517 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)




| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | | 3.20 | 3.40 | |
| $A_1$ | 0.40 | 0.50 | 0.60 | |
| $A_2$ | | | 2.80 | |
| D/E | 40.00 BASIC | | | |
| $D_1/E_1$ | 38.00 REF | | | |
| e | 1.00 BASIC | | | |
| øb | 0.50 | 0.60 | 0.70 | |
| aaa | | | 0.20 | |
| bbb | | | 0.25 | |
| ddd | | | 0.25 | |
| eee | | | 0.10 | |
| M | | 39 | | 2 |



SECTION A–A
(NOT TO SCALE)

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ASME Y14.5M–1994
2. SYMBOL "M" IS THE PIN MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–AAU–1 (DEPOPULATED)

*Figure 9:* **FF1517 Flip-Chip Fine-Pitch BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BF957 Flip-Chip BGA Package

As shown in Table 14, XC2V2000, XC2V3000, XC2V4000, and XC2V6000 Virtex-II devices are available in the BF957 package. Pins in each of these devices are the same, except for the pin differences in the XC2V2000 device shown in the No Connect column. Following this table are the BF957 Flip-Chip BGA Package Specifications (1.27mm pitch).

*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 0 | IO_L01N_0 | H23 | |
| 0 | IO_L01P_0 | H22 | |
| 0 | IO_L02N_0 | G24 | |
| 0 | IO_L02P_0 | E25 | |
| 0 | IO_L03N_0/VRP_0 | B29 | |
| 0 | IO_L03P_0/VRN_0 | C27 | |
| 0 | IO_L04N_0/VREF_0 | F24 | |
| 0 | IO_L04P_0 | F23 | |
| 0 | IO_L05N_0 | D26 | |
| 0 | IO_L05P_0 | D25 | |
| 0 | IO_L06N_0 | A28 | |
| 0 | IO_L06P_0 | A27 | |
| 0 | IO_L19N_0 | J22 | |
| 0 | IO_L19P_0 | J21 | |
| 0 | IO_L20N_0 | G23 | |
| 0 | IO_L20P_0 | G22 | |
| 0 | IO_L21N_0 | B27 | |
| 0 | IO_L21P_0/VREF_0 | B26 | |
| 0 | IO_L22N_0 | K20 | |
| 0 | IO_L22P_0 | K19 | |
| 0 | IO_L23N_0 | C26 | |
| 0 | IO_L23P_0 | C24 | |
| 0 | IO_L24N_0 | D24 | |
| 0 | IO_L24P_0 | D23 | |
| 0 | IO_L25N_0 | E24 | NC |
| 0 | IO_L25P_0 | E23 | NC |
| 0 | IO_L26N_0 | G21 | NC |
| 0 | IO_L26P_0 | G20 | NC |
| 0 | IO_L27N_0 | A26 | NC |
| 0 | IO_L27P_0/VREF_0 | A25 | NC |
| 0 | IO_L29N_0 | H21 | NC |
| 0 | IO_L29P_0 | H20 | NC |
| 0 | IO_L30N_0 | B25 | NC |
| 0 | IO_L30P_0 | B23 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 0 | IO_L49N_0 | C23 | |
| 0 | IO_L49P_0 | C22 | |
| 0 | IO_L50N_0 | E22 | |
| 0 | IO_L50P_0 | E21 | |
| 0 | IO_L51N_0 | F21 | |
| 0 | IO_L51P_0/VREF_0 | F20 | |
| 0 | IO_L52N_0 | A24 | |
| 0 | IO_L52P_0 | A23 | |
| 0 | IO_L53N_0 | E20 | |
| 0 | IO_L53P_0 | E19 | |
| 0 | IO_L54N_0 | B22 | |
| 0 | IO_L54P_0 | B21 | |
| 0 | IO_L67N_0 | D21 | |
| 0 | IO_L67P_0 | D20 | |
| 0 | IO_L68N_0 | J20 | |
| 0 | IO_L68P_0 | J19 | |
| 0 | IO_L69N_0 | F19 | |
| 0 | IO_L69P_0/VREF_0 | F18 | |
| 0 | IO_L70N_0 | A22 | |
| 0 | IO_L70P_0 | A21 | |
| 0 | IO_L71N_0 | H19 | |
| 0 | IO_L71P_0 | H17 | |
| 0 | IO_L72N_0 | C21 | |
| 0 | IO_L72P_0 | C20 | |
| 0 | IO_L73N_0 | B20 | |
| 0 | IO_L73P_0 | B19 | |
| 0 | IO_L74N_0 | G18 | |
| 0 | IO_L74P_0 | G17 | |
| 0 | IO_L75N_0 | E18 | |
| 0 | IO_L75P_0/VREF_0 | D17 | |
| 0 | IO_L76N_0 | A20 | |
| 0 | IO_L76P_0 | A19 | |
| 0 | IO_L77N_0 | D19 | |
| 0 | IO_L77P_0 | D18 | |
| 0 | IO_L78N_0 | C19 | |
| 0 | IO_L78P_0 | C17 | |
| 0 | IO_L91N_0/VREF_0 | K18 | |
| 0 | IO_L91P_0 | J18 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 0 | IO_L92N_0 | F17 | |
| 0 | IO_L92P_0 | F16 | |
| 0 | IO_L93N_0 | B18 | |
| 0 | IO_L93P_0 | B17 | |
| 0 | IO_L94N_0/VREF_0 | J17 | |
| 0 | IO_L94P_0 | J16 | |
| 0 | IO_L95N_0/GCLK7P | E17 | |
| 0 | IO_L95P_0/GCLK6S | E16 | |
| 0 | IO_L96N_0/GCLK5P | A18 | |
| 0 | IO_L96P_0/GCLK4S | A17 | |
| | | | |
| 1 | IO_L96N_1/GCLK3P | C16 | |
| 1 | IO_L96P_1/GCLK2S | C15 | |
| 1 | IO_L95N_1/GCLK1P | H16 | |
| 1 | IO_L95P_1/GCLK0S | H15 | |
| 1 | IO_L94N_1 | A15 | |
| 1 | IO_L94P_1/VREF_1 | A14 | |
| 1 | IO_L93N_1 | F15 | |
| 1 | IO_L93P_1 | F14 | |
| 1 | IO_L92N_1 | G15 | |
| 1 | IO_L92P_1 | G14 | |
| 1 | IO_L91N_1 | B15 | |
| 1 | IO_L91P_1/VREF_1 | B14 | |
| 1 | IO_L78N_1 | D15 | |
| 1 | IO_L78P_1 | E15 | |
| 1 | IO_L77N_1 | J15 | |
| 1 | IO_L77P_1 | K14 | |
| 1 | IO_L76N_1 | D14 | |
| 1 | IO_L76P_1 | D13 | |
| 1 | IO_L75N_1/VREF_1 | E14 | |
| 1 | IO_L75P_1 | E13 | |
| 1 | IO_L74N_1 | A13 | |
| 1 | IO_L74P_1 | A12 | |
| 1 | IO_L73N_1 | F13 | |
| 1 | IO_L73P_1 | F12 | |
| 1 | IO_L72N_1 | J14 | |
| 1 | IO_L72P_1 | J13 | |
| 1 | IO_L71N_1 | B13 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 1 | IO_L71P_1 | B12 | |
| 1 | IO_L70N_1 | C13 | |
| 1 | IO_L70P_1 | C12 | |
| 1 | IO_L69N_1/VREF_1 | H13 | |
| 1 | IO_L69P_1 | H12 | |
| 1 | IO_L68N_1 | D12 | |
| 1 | IO_L68P_1 | D11 | |
| 1 | IO_L67N_1 | B11 | |
| 1 | IO_L67P_1 | B10 | |
| 1 | IO_L54N_1 | E12 | |
| 1 | IO_L54P_1 | E11 | |
| 1 | IO_L53N_1 | A11 | |
| 1 | IO_L53P_1 | A10 | |
| 1 | IO_L52N_1 | G12 | |
| 1 | IO_L52P_1 | G11 | |
| 1 | IO_L51N_1/VREF_1 | K13 | |
| 1 | IO_L51P_1 | K12 | |
| 1 | IO_L50N_1 | C11 | |
| 1 | IO_L50P_1 | C10 | |
| 1 | IO_L49N_1 | B9 | |
| 1 | IO_L49P_1 | B7 | |
| 1 | IO_L30N_1 | F11 | NC |
| 1 | IO_L30P_1 | F9 | NC |
| 1 | IO_L29N_1 | A9 | NC |
| 1 | IO_L29P_1 | A8 | NC |
| 1 | IO_L27N_1/VREF_1 | D9 | NC |
| 1 | IO_L27P_1 | D8 | NC |
| 1 | IO_L26N_1 | J12 | NC |
| 1 | IO_L26P_1 | J11 | NC |
| 1 | IO_L25N_1 | C9 | NC |
| 1 | IO_L25P_1 | C8 | NC |
| 1 | IO_L24N_1 | E10 | |
| 1 | IO_L24P_1 | E9 | |
| 1 | IO_L23N_1 | H11 | |
| 1 | IO_L23P_1 | H10 | |
| 1 | IO_L22N_1 | A7 | |
| 1 | IO_L22P_1 | A6 | |
| 1 | IO_L21N_1/VREF_1 | A5 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 1 | IO_L21P_1 | A4 | |
| 1 | IO_L20N_1 | G10 | |
| 1 | IO_L20P_1 | G9 | |
| 1 | IO_L19N_1 | B6 | |
| 1 | IO_L19P_1 | C5 | |
| 1 | IO_L06N_1 | C6 | |
| 1 | IO_L06P_1 | D6 | |
| 1 | IO_L05N_1 | H9 | |
| 1 | IO_L05P_1 | G8 | |
| 1 | IO_L04N_1 | D7 | |
| 1 | IO_L04P_1/VREF_1 | E6 | |
| 1 | IO_L03N_1/VRP_1 | E8 | |
| 1 | IO_L03P_1/VRN_1 | E7 | |
| 1 | IO_L02N_1 | F8 | |
| 1 | IO_L02P_1 | F7 | |
| 1 | IO_L01N_1 | B5 | |
| 1 | IO_L01P_1 | B3 | |
| | | | |
| 2 | IO_L01N_2 | F5 | |
| 2 | IO_L01P_2 | G4 | |
| 2 | IO_L02N_2/VRP_2 | G6 | |
| 2 | IO_L02P_2/VRN_2 | H6 | |
| 2 | IO_L03N_2 | D3 | |
| 2 | IO_L03P_2/VREF_2 | E4 | |
| 2 | IO_L04N_2 | K10 | |
| 2 | IO_L04P_2 | K9 | |
| 2 | IO_L05N_2 | D2 | |
| 2 | IO_L05P_2 | E3 | |
| 2 | IO_L06N_2 | F4 | |
| 2 | IO_L06P_2 | F3 | |
| 2 | IO_L19N_2 | L10 | |
| 2 | IO_L19P_2 | M10 | |
| 2 | IO_L20N_2 | H7 | |
| 2 | IO_L20P_2 | J8 | |
| 2 | IO_L21N_2 | D1 | |
| 2 | IO_L21P_2/VREF_2 | E1 | |
| 2 | IO_L22N_2 | G5 | |
| 2 | IO_L22P_2 | H5 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 2 | IO_L23N_2 | E2 | |
| 2 | IO_L23P_2 | F2 | |
| 2 | IO_L24N_2 | H4 | |
| 2 | IO_L24P_2 | J4 | |
| 2 | IO_L25N_2 | K8 | NC |
| 2 | IO_L25P_2 | L8 | NC |
| 2 | IO_L27N_2 | J7 | NC |
| 2 | IO_L27P_2/VREF_2 | K7 | NC |
| 2 | IO_L43N_2 | F1 | |
| 2 | IO_L43P_2 | G1 | |
| 2 | IO_L44N_2 | L9 | |
| 2 | IO_L44P_2 | M9 | |
| 2 | IO_L45N_2 | G2 | |
| 2 | IO_L45P_2/VREF_2 | J2 | |
| 2 | IO_L46N_2 | H3 | |
| 2 | IO_L46P_2 | J3 | |
| 2 | IO_L47N_2 | J6 | |
| 2 | IO_L47P_2 | L6 | |
| 2 | IO_L48N_2 | J5 | |
| 2 | IO_L48P_2 | K5 | |
| 2 | IO_L49N_2 | H1 | |
| 2 | IO_L49P_2 | J1 | |
| 2 | IO_L50N_2 | N10 | |
| 2 | IO_L50P_2 | P10 | |
| 2 | IO_L51N_2 | L7 | |
| 2 | IO_L51P_2/VREF_2 | M7 | |
| 2 | IO_L52N_2 | K3 | |
| 2 | IO_L52P_2 | L3 | |
| 2 | IO_L53N_2 | M8 | |
| 2 | IO_L53P_2 | N8 | |
| 2 | IO_L54N_2 | L5 | |
| 2 | IO_L54P_2 | M5 | |
| 2 | IO_L67N_2 | K2 | |
| 2 | IO_L67P_2 | L2 | |
| 2 | IO_L68N_2 | M6 | |
| 2 | IO_L68P_2 | N6 | |
| 2 | IO_L69N_2 | L4 | |
| 2 | IO_L69P_2/VREF_2 | M4 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 2 | IO_L70N_2 | K1 | |
| 2 | IO_L70P_2 | L1 | |
| 2 | IO_L71N_2 | N9 | |
| 2 | IO_L71P_2 | P9 | |
| 2 | IO_L72N_2 | N5 | |
| 2 | IO_L72P_2 | P5 | |
| 2 | IO_L73N_2 | M3 | |
| 2 | IO_L73P_2 | N3 | |
| 2 | IO_L74N_2 | R8 | |
| 2 | IO_L74P_2 | R9 | |
| 2 | IO_L75N_2 | M2 | |
| 2 | IO_L75P_2/VREF_2 | N2 | |
| 2 | IO_L76N_2 | M1 | |
| 2 | IO_L76P_2 | N1 | |
| 2 | IO_L77N_2 | P7 | |
| 2 | IO_L77P_2 | R7 | |
| 2 | IO_L78N_2 | N4 | |
| 2 | IO_L78P_2 | P4 | |
| 2 | IO_L91N_2 | T8 | |
| 2 | IO_L91P_2 | T9 | |
| 2 | IO_L92N_2 | P6 | |
| 2 | IO_L92P_2 | R6 | |
| 2 | IO_L93N_2 | P2 | |
| 2 | IO_L93P_2/VREF_2 | R2 | |
| 2 | IO_L94N_2 | R5 | |
| 2 | IO_L94P_2 | T5 | |
| 2 | IO_L95N_2 | P1 | |
| 2 | IO_L95P_2 | R1 | |
| 2 | IO_L96N_2 | R4 | |
| 2 | IO_L96P_2 | R3 | |
| | | | |
| 3 | IO_L96N_3 | T6 | |
| 3 | IO_L96P_3 | U5 | |
| 3 | IO_L95N_3 | U6 | |
| 3 | IO_L95P_3 | V6 | |
| 3 | IO_L94N_3 | T3 | |
| 3 | IO_L94P_3 | U3 | |
| 3 | IO_L93N_3/VREF_3 | U1 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 3 | IO_L93P_3 | V1 | |
| 3 | IO_L92N_3 | U8 | |
| 3 | IO_L92P_3 | W8 | |
| 3 | IO_L91N_3 | U2 | |
| 3 | IO_L91P_3 | V2 | |
| 3 | IO_L78N_3 | U7 | |
| 3 | IO_L78P_3 | V7 | |
| 3 | IO_L77N_3 | U4 | |
| 3 | IO_L77P_3 | V4 | |
| 3 | IO_L76N_3 | W1 | |
| 3 | IO_L76P_3 | Y1 | |
| 3 | IO_L75N_3/VREF_3 | V5 | |
| 3 | IO_L75P_3 | W5 | |
| 3 | IO_L74N_3 | W2 | |
| 3 | IO_L74P_3 | Y2 | |
| 3 | IO_L73N_3 | W6 | |
| 3 | IO_L73P_3 | Y6 | |
| 3 | IO_L72N_3 | Y5 | |
| 3 | IO_L72P_3 | AA5 | |
| 3 | IO_L71N_3 | W3 | |
| 3 | IO_L71P_3 | Y3 | |
| 3 | IO_L70N_3 | W4 | |
| 3 | IO_L70P_3 | Y4 | |
| 3 | IO_L69N_3/VREF_3 | U9 | |
| 3 | IO_L69P_3 | V9 | |
| 3 | IO_L68N_3 | AA1 | |
| 3 | IO_L68P_3 | AB1 | |
| 3 | IO_L67N_3 | Y7 | |
| 3 | IO_L67P_3 | AA7 | |
| 3 | IO_L54N_3 | AA6 | |
| 3 | IO_L54P_3 | AC6 | |
| 3 | IO_L53N_3 | AA2 | |
| 3 | IO_L53P_3 | AB2 | |
| 3 | IO_L52N_3 | AA4 | |
| 3 | IO_L52P_3 | AC4 | |
| 3 | IO_L51N_3/VREF_3 | V10 | |
| 3 | IO_L51P_3 | W10 | |
| 3 | IO_L50N_3 | AA3 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 3 | IO_L50P_3 | AB3 | |
| 3 | IO_L49N_3 | AB5 | |
| 3 | IO_L49P_3 | AC5 | |
| 3 | IO_L48N_3 | W9 | |
| 3 | IO_L48P_3 | Y9 | |
| 3 | IO_L47N_3 | AC1 | |
| 3 | IO_L47P_3 | AD1 | |
| 3 | IO_L46N_3 | AC3 | |
| 3 | IO_L46P_3 | AD3 | |
| 3 | IO_L45N_3/VREF_3 | Y8 | |
| 3 | IO_L45P_3 | AA8 | |
| 3 | IO_L44N_3 | AC2 | |
| 3 | IO_L44P_3 | AE2 | |
| 3 | IO_L43N_3 | AB7 | |
| 3 | IO_L43P_3 | AC7 | |
| 3 | IO_L27N_3/VREF_3 | Y10 | NC |
| 3 | IO_L27P_3 | AA10 | NC |
| 3 | IO_L25N_3 | AE1 | NC |
| 3 | IO_L25P_3 | AF1 | NC |
| 3 | IO_L24N_3 | AF2 | |
| 3 | IO_L24P_3 | AG2 | |
| 3 | IO_L23N_3 | AA9 | |
| 3 | IO_L23P_3 | AB9 | |
| 3 | IO_L22N_3 | AD4 | |
| 3 | IO_L22P_3 | AE4 | |
| 3 | IO_L21N_3/VREF_3 | AD5 | |
| 3 | IO_L21P_3 | AE5 | |
| 3 | IO_L20N_3 | AB8 | |
| 3 | IO_L20P_3 | AC8 | |
| 3 | IO_L19N_3 | AG1 | |
| 3 | IO_L19P_3 | AH1 | |
| 3 | IO_L06N_3 | AF4 | |
| 3 | IO_L06P_3 | AG4 | |
| 3 | IO_L05N_3 | AB10 | |
| 3 | IO_L05P_3 | AB11 | |
| 3 | IO_L04N_3 | AF3 | |
| 3 | IO_L04P_3 | AG3 | |
| 3 | IO_L03N_3/VREF_3 | AD6 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 3 | IO_L03P_3 | AD7 | |
| 3 | IO_L02N_3/VRP_3 | AE6 | |
| 3 | IO_L02P_3/VRN_3 | AF5 | |
| 3 | IO_L01N_3 | AH2 | |
| 3 | IO_L01P_3 | AH3 | |
| | | | |
| 4 | IO_L01N_4/BUSY/DOUT(1) | AD9 | |
| 4 | IO_L01P_4/INIT_B | AD10 | |
| 4 | IO_L02N_4/D0/DIN(1) | AF7 | |
| 4 | IO_L02P_4/D1 | AG7 | |
| 4 | IO_L03N_4/D2/ALT_VRP_4 | AK3 | |
| 4 | IO_L03P_4/D3/ALT_VRN_4 | AJ5 | |
| 4 | IO_L04N_4/VREF_4 | AE8 | |
| 4 | IO_L04P_4 | AF8 | |
| 4 | IO_L05N_4/VRP_4 | AK4 | |
| 4 | IO_L05P_4/VRN_4 | AK5 | |
| 4 | IO_L06N_4 | AH6 | |
| 4 | IO_L06P_4 | AH7 | |
| 4 | IO_L19N_4 | AC10 | |
| 4 | IO_L19P_4 | AC11 | |
| 4 | IO_L20N_4 | AE9 | |
| 4 | IO_L20P_4 | AE10 | |
| 4 | IO_L21N_4 | AL4 | |
| 4 | IO_L21P_4/VREF_4 | AL5 | |
| 4 | IO_L22N_4 | AB12 | |
| 4 | IO_L22P_4 | AB13 | |
| 4 | IO_L23N_4 | AJ6 | |
| 4 | IO_L23P_4 | AJ8 | |
| 4 | IO_L24N_4 | AK6 | |
| 4 | IO_L24P_4 | AK7 | |
| 4 | IO_L25N_4 | AG8 | NC |
| 4 | IO_L25P_4 | AG9 | NC |
| 4 | IO_L26N_4 | AF9 | NC |
| 4 | IO_L26P_4 | AF11 | NC |
| 4 | IO_L27N_4 | AH8 | NC |
| 4 | IO_L27P_4/VREF_4 | AH9 | NC |
| 4 | IO_L28N_4 | AD11 | NC |
| 4 | IO_L28P_4 | AD12 | NC |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 4 | IO_L29N_4 | AL6 | NC |
| 4 | IO_L29P_4 | AL7 | NC |
| 4 | IO_L30N_4 | AJ9 | NC |
| 4 | IO_L30P_4 | AJ10 | NC |
| 4 | IO_L49N_4 | AE11 | |
| 4 | IO_L49P_4 | AE12 | |
| 4 | IO_L50N_4 | AG10 | |
| 4 | IO_L50P_4 | AG11 | |
| 4 | IO_L51N_4 | AL8 | |
| 4 | IO_L51P_4/VREF_4 | AL9 | |
| 4 | IO_L52N_4 | AF12 | |
| 4 | IO_L52P_4 | AF13 | |
| 4 | IO_L53N_4 | AK9 | |
| 4 | IO_L53P_4 | AK10 | |
| 4 | IO_L54N_4 | AH11 | |
| 4 | IO_L54P_4 | AH12 | |
| 4 | IO_L67N_4 | AC12 | |
| 4 | IO_L67P_4 | AC13 | |
| 4 | IO_L68N_4 | AG12 | |
| 4 | IO_L68P_4 | AG13 | |
| 4 | IO_L69N_4 | AL10 | |
| 4 | IO_L69P_4/VREF_4 | AL11 | |
| 4 | IO_L70N_4 | AD13 | |
| 4 | IO_L70P_4 | AD15 | |
| 4 | IO_L71N_4 | AJ11 | |
| 4 | IO_L71P_4 | AJ12 | |
| 4 | IO_L72N_4 | AK11 | |
| 4 | IO_L72P_4 | AK12 | |
| 4 | IO_L73N_4 | AE14 | |
| 4 | IO_L73P_4 | AE15 | |
| 4 | IO_L74N_4 | AF14 | |
| 4 | IO_L74P_4 | AF15 | |
| 4 | IO_L75N_4 | AL12 | |
| 4 | IO_L75P_4/VREF_4 | AL13 | |
| 4 | IO_L76N_4 | AB14 | |
| 4 | IO_L76P_4 | AC14 | |
| 4 | IO_L77N_4 | AH13 | |
| 4 | IO_L77P_4 | AH14 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 4 | IO_L78N_4 | AJ13 | |
| 4 | IO_L78P_4 | AK13 | |
| 4 | IO_L91N_4/VREF_4 | AC15 | |
| 4 | IO_L91P_4 | AC16 | |
| 4 | IO_L92N_4 | AG14 | |
| 4 | IO_L92P_4 | AG15 | |
| 4 | IO_L93N_4 | AK14 | |
| 4 | IO_L93P_4 | AK15 | |
| 4 | IO_L94N_4/VREF_4 | AF16 | |
| 4 | IO_L94P_4 | AG16 | |
| 4 | IO_L95N_4/GCLK3S | AL14 | |
| 4 | IO_L95P_4/GCLK2P | AL15 | |
| 4 | IO_L96N_4/GCLK1S | AH15 | |
| 4 | IO_L96P_4/GCLK0P | AJ15 | |
| | | | |
| 5 | IO_L96N_5/GCLK7S | AJ16 | |
| 5 | IO_L96P_5/GCLK6P | AH17 | |
| 5 | IO_L95N_5/GCLK5S | AD16 | |
| 5 | IO_L95P_5/GCLK4P | AD17 | |
| 5 | IO_L94N_5 | AL17 | |
| 5 | IO_L94P_5/VREF_5 | AL18 | |
| 5 | IO_L93N_5 | AG17 | |
| 5 | IO_L93P_5 | AF17 | |
| 5 | IO_L92N_5 | AE17 | |
| 5 | IO_L92P_5 | AE18 | |
| 5 | IO_L91N_5 | AK17 | |
| 5 | IO_L91P_5/VREF_5 | AJ17 | |
| 5 | IO_L78N_5 | AK18 | |
| 5 | IO_L78P_5 | AK19 | |
| 5 | IO_L77N_5 | AC17 | |
| 5 | IO_L77P_5 | AB18 | |
| 5 | IO_L76N_5 | AH18 | |
| 5 | IO_L76P_5 | AH19 | |
| 5 | IO_L75N_5/VREF_5 | AL19 | |
| 5 | IO_L75P_5 | AL20 | |
| 5 | IO_L74N_5 | AC18 | |
| 5 | IO_L74P_5 | AC19 | |
| 5 | IO_L73N_5 | AJ19 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 5 | IO_L73P_5 | AJ20 | |
| 5 | IO_L72N_5 | AG18 | |
| 5 | IO_L72P_5 | AG19 | |
| 5 | IO_L71N_5 | AF18 | |
| 5 | IO_L71P_5 | AF19 | |
| 5 | IO_L70N_5 | AK20 | |
| 5 | IO_L70P_5 | AK21 | |
| 5 | IO_L69N_5/VREF_5 | AH20 | |
| 5 | IO_L69P_5 | AH21 | |
| 5 | IO_L68N_5 | AD19 | |
| 5 | IO_L68P_5 | AD20 | |
| 5 | IO_L67N_5 | AL21 | |
| 5 | IO_L67P_5 | AL22 | |
| 5 | IO_L54N_5 | AG20 | |
| 5 | IO_L54P_5 | AG21 | |
| 5 | IO_L53N_5 | AB19 | |
| 5 | IO_L53P_5 | AB20 | |
| 5 | IO_L52N_5 | AJ21 | |
| 5 | IO_L52P_5 | AJ22 | |
| 5 | IO_L51N_5/VREF_5 | AF20 | |
| 5 | IO_L51P_5 | AF21 | |
| 5 | IO_L50N_5 | AE20 | |
| 5 | IO_L50P_5 | AE21 | |
| 5 | IO_L49N_5 | AK22 | |
| 5 | IO_L49P_5 | AK23 | |
| 5 | IO_L30N_5 | AJ23 | NC |
| 5 | IO_L30P_5 | AJ24 | NC |
| 5 | IO_L29N_5 | AC20 | NC |
| 5 | IO_L29P_5 | AC21 | NC |
| 5 | IO_L28N_5 | AL23 | NC |
| 5 | IO_L28P_5 | AL24 | NC |
| 5 | IO_L27N_5/VREF_5 | AL25 | NC |
| 5 | IO_L27P_5 | AL26 | NC |
| 5 | IO_L26N_5 | AD21 | NC |
| 5 | IO_L26P_5 | AD22 | NC |
| 5 | IO_L25N_5 | AH23 | NC |
| 5 | IO_L25P_5 | AH24 | NC |
| 5 | IO_L24N_5 | AG22 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 5 | IO_L24P_5 | AG23 | |
| 5 | IO_L23N_5 | AE22 | |
| 5 | IO_L23P_5 | AE23 | |
| 5 | IO_L22N_5 | AK25 | |
| 5 | IO_L22P_5 | AK26 | |
| 5 | IO_L21N_5/VREF_5 | AH25 | |
| 5 | IO_L21P_5 | AG25 | |
| 5 | IO_L20N_5 | AB21 | |
| 5 | IO_L20P_5 | AC22 | |
| 5 | IO_L19N_5 | AL27 | |
| 5 | IO_L19P_5 | AL28 | |
| 5 | IO_L06N_5 | AK27 | |
| 5 | IO_L06P_5 | AJ27 | |
| 5 | IO_L05N_5/VRP_5 | AD23 | |
| 5 | IO_L05P_5/VRN_5 | AE24 | |
| 5 | IO_L04N_5 | AJ26 | |
| 5 | IO_L04P_5/VREF_5 | AH26 | |
| 5 | IO_L03N_5/D4/ALT_VRP_5 | AF23 | |
| 5 | IO_L03P_5/D5/ALT_VRN_5 | AF24 | |
| 5 | IO_L02N_5/D6 | AG24 | |
| 5 | IO_L02P_5/D7 | AF25 | |
| 5 | IO_L01N_5/RDWR_B | AK28 | |
| 5 | IO_L01P_5/CS_B | AK29 | |
| | | | |
| 6 | IO_L01P_6 | AF27 | |
| 6 | IO_L01N_6 | AF28 | |
| 6 | IO_L02P_6/VRN_6 | AE26 | |
| 6 | IO_L02N_6/VRP_6 | AE27 | |
| 6 | IO_L03P_6 | AH29 | |
| 6 | IO_L03N_6/VREF_6 | AH30 | |
| 6 | IO_L04P_6 | AB22 | |
| 6 | IO_L04N_6 | AB23 | |
| 6 | IO_L05P_6 | AG28 | |
| 6 | IO_L05N_6 | AG29 | |
| 6 | IO_L06P_6 | AH31 | |
| 6 | IO_L06N_6 | AG31 | |
| 6 | IO_L19P_6 | AA22 | |
| 6 | IO_L19N_6 | Y22 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 6 | IO_L20P_6 | AD25 | |
| 6 | IO_L20N_6 | AC24 | |
| 6 | IO_L21P_6 | AG30 | |
| 6 | IO_L21N_6/VREF_6 | AF30 | |
| 6 | IO_L22P_6 | AD26 | |
| 6 | IO_L22N_6 | AC26 | |
| 6 | IO_L23P_6 | AF29 | |
| 6 | IO_L23N_6 | AD29 | |
| 6 | IO_L24P_6 | AE28 | |
| 6 | IO_L24N_6 | AD28 | |
| 6 | IO_L25P_6 | AB24 | NC |
| 6 | IO_L25N_6 | AA24 | NC |
| 6 | IO_L27P_6 | AC25 | NC |
| 6 | IO_L27N_6/VREF_6 | AB25 | NC |
| 6 | IO_L43P_6 | AF31 | |
| 6 | IO_L43N_6 | AE31 | |
| 6 | IO_L44P_6 | AA23 | |
| 6 | IO_L44N_6 | Y23 | |
| 6 | IO_L45P_6 | AE30 | |
| 6 | IO_L45N_6/VREF_6 | AC30 | |
| 6 | IO_L46P_6 | AC28 | |
| 6 | IO_L46N_6 | AA28 | |
| 6 | IO_L47P_6 | AD27 | |
| 6 | IO_L47N_6 | AC27 | |
| 6 | IO_L48P_6 | AA25 | |
| 6 | IO_L48N_6 | Y25 | |
| 6 | IO_L49P_6 | AC29 | |
| 6 | IO_L49N_6 | AB29 | |
| 6 | IO_L50P_6 | AB27 | |
| 6 | IO_L50N_6 | AA27 | |
| 6 | IO_L51P_6 | AA26 | |
| 6 | IO_L51N_6/VREF_6 | Y26 | |
| 6 | IO_L52P_6 | AD31 | |
| 6 | IO_L52N_6 | AC31 | |
| 6 | IO_L53P_6 | W22 | |
| 6 | IO_L53N_6 | V22 | |
| 6 | IO_L54P_6 | Y27 | |
| 6 | IO_L54N_6 | W27 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 6 | IO_L67P_6 | AB30 | |
| 6 | IO_L67N_6 | AA30 | |
| 6 | IO_L68P_6 | W26 | |
| 6 | IO_L68N_6 | V26 | |
| 6 | IO_L69P_6 | AB31 | |
| 6 | IO_L69N_6/VREF_6 | AA31 | |
| 6 | IO_L70P_6 | AA29 | |
| 6 | IO_L70N_6 | Y29 | |
| 6 | IO_L71P_6 | Y24 | |
| 6 | IO_L71N_6 | W24 | |
| 6 | IO_L72P_6 | V25 | |
| 6 | IO_L72N_6 | U25 | |
| 6 | IO_L73P_6 | Y28 | |
| 6 | IO_L73N_6 | W28 | |
| 6 | IO_L74P_6 | W23 | |
| 6 | IO_L74N_6 | V23 | |
| 6 | IO_L75P_6 | Y30 | |
| 6 | IO_L75N_6/VREF_6 | W30 | |
| 6 | IO_L76P_6 | Y31 | |
| 6 | IO_L76N_6 | W31 | |
| 6 | IO_L77P_6 | V27 | |
| 6 | IO_L77N_6 | U27 | |
| 6 | IO_L78P_6 | W29 | |
| 6 | IO_L78N_6 | U29 | |
| 6 | IO_L91P_6 | U23 | |
| 6 | IO_L91N_6 | T23 | |
| 6 | IO_L92P_6 | U26 | |
| 6 | IO_L92N_6 | T26 | |
| 6 | IO_L93P_6 | V28 | |
| 6 | IO_L93N_6/VREF_6 | U28 | |
| 6 | IO_L94P_6 | U24 | |
| 6 | IO_L94N_6 | T24 | |
| 6 | IO_L95P_6 | V30 | |
| 6 | IO_L95N_6 | U30 | |
| 6 | IO_L96P_6 | V31 | |
| 6 | IO_L96N_6 | U31 | |
| | | | |
| 7 | IO_L96P_7 | T27 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 7 | IO_L96N_7 | R27 | |
| 7 | IO_L95P_7 | R24 | |
| 7 | IO_L95N_7 | N24 | |
| 7 | IO_L94P_7 | T29 | |
| 7 | IO_L94N_7 | R29 | |
| 7 | IO_L93P_7/VREF_7 | R31 | |
| 7 | IO_L93N_7 | P31 | |
| 7 | IO_L92P_7 | R26 | |
| 7 | IO_L92N_7 | P26 | |
| 7 | IO_L91P_7 | R30 | |
| 7 | IO_L91N_7 | P30 | |
| 7 | IO_L78P_7 | R25 | |
| 7 | IO_L78N_7 | P25 | |
| 7 | IO_L77P_7 | R28 | |
| 7 | IO_L77N_7 | P28 | |
| 7 | IO_L76P_7 | N31 | |
| 7 | IO_L76N_7 | M31 | |
| 7 | IO_L75P_7/VREF_7 | R23 | |
| 7 | IO_L75N_7 | P23 | |
| 7 | IO_L74P_7 | N30 | |
| 7 | IO_L74N_7 | M30 | |
| 7 | IO_L73P_7 | P27 | |
| 7 | IO_L73N_7 | N27 | |
| 7 | IO_L72P_7 | P22 | |
| 7 | IO_L72N_7 | N22 | |
| 7 | IO_L71P_7 | N29 | |
| 7 | IO_L71N_7 | M29 | |
| 7 | IO_L70P_7 | N28 | |
| 7 | IO_L70N_7 | M28 | |
| 7 | IO_L69P_7/VREF_7 | N26 | |
| 7 | IO_L69N_7 | M26 | |
| 7 | IO_L68P_7 | L31 | |
| 7 | IO_L68N_7 | K31 | |
| 7 | IO_L67P_7 | M27 | |
| 7 | IO_L67N_7 | L27 | |
| 7 | IO_L54P_7 | N23 | |
| 7 | IO_L54N_7 | M23 | |
| 7 | IO_L53P_7 | L30 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 7 | IO_L53N_7 | K30 | |
| 7 | IO_L52P_7 | L28 | |
| 7 | IO_L52N_7 | J28 | |
| 7 | IO_L51P_7/VREF_7 | M24 | |
| 7 | IO_L51N_7 | L24 | |
| 7 | IO_L50P_7 | L29 | |
| 7 | IO_L50N_7 | K29 | |
| 7 | IO_L49P_7 | M25 | |
| 7 | IO_L49N_7 | L25 | |
| 7 | IO_L48P_7 | L26 | |
| 7 | IO_L48N_7 | J26 | |
| 7 | IO_L47P_7 | J31 | |
| 7 | IO_L47N_7 | H31 | |
| 7 | IO_L46P_7 | J29 | |
| 7 | IO_L46N_7 | H29 | |
| 7 | IO_L45P_7/VREF_7 | M22 | |
| 7 | IO_L45N_7 | L22 | |
| 7 | IO_L44P_7 | J30 | |
| 7 | IO_L44N_7 | G30 | |
| 7 | IO_L43P_7 | K27 | |
| 7 | IO_L43N_7 | J27 | |
| 7 | IO_L27P_7/VREF_7 | L23 | NC |
| 7 | IO_L27N_7 | K23 | NC |
| 7 | IO_L25P_7 | G31 | NC |
| 7 | IO_L25N_7 | F31 | NC |
| 7 | IO_L24P_7 | F30 | |
| 7 | IO_L24N_7 | E30 | |
| 7 | IO_L23P_7 | K25 | |
| 7 | IO_L23N_7 | J25 | |
| 7 | IO_L22P_7 | H28 | |
| 7 | IO_L22N_7 | G28 | |
| 7 | IO_L21P_7/VREF_7 | H27 | |
| 7 | IO_L21N_7 | G27 | |
| 7 | IO_L20P_7 | K24 | |
| 7 | IO_L20N_7 | J24 | |
| 7 | IO_L19P_7 | E31 | |
| 7 | IO_L19N_7 | D31 | |
| 7 | IO_L06P_7 | F28 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 7 | IO_L06N_7 | E28 | |
| 7 | IO_L05P_7 | K22 | |
| 7 | IO_L05N_7 | K21 | |
| 7 | IO_L04P_7 | F29 | |
| 7 | IO_L04N_7 | E29 | |
| 7 | IO_L03P_7/VREF_7 | H26 | |
| 7 | IO_L03N_7 | H25 | |
| 7 | IO_L02P_7/VRN_7 | G26 | |
| 7 | IO_L02N_7/VRP_7 | F27 | |
| 7 | IO_L01P_7 | D30 | |
| 7 | IO_L01N_7 | D29 | |
| | | | |
| 0 | VCCO_0 | C18 | |
| 0 | VCCO_0 | C25 | |
| 0 | VCCO_0 | F22 | |
| 0 | VCCO_0 | H18 | |
| 0 | VCCO_0 | L17 | |
| 0 | VCCO_0 | L18 | |
| 0 | VCCO_0 | L19 | |
| 0 | VCCO_0 | L20 | |
| 0 | VCCO_0 | M17 | |
| 0 | VCCO_0 | M18 | |
| 0 | VCCO_0 | M19 | |
| 1 | VCCO_1 | C7 | |
| 1 | VCCO_1 | C14 | |
| 1 | VCCO_1 | F10 | |
| 1 | VCCO_1 | H14 | |
| 1 | VCCO_1 | L12 | |
| 1 | VCCO_1 | L13 | |
| 1 | VCCO_1 | L14 | |
| 1 | VCCO_1 | L15 | |
| 1 | VCCO_1 | M13 | |
| 1 | VCCO_1 | M14 | |
| 1 | VCCO_1 | M15 | |
| 2 | VCCO_2 | G3 | |
| 2 | VCCO_2 | K6 | |
| 2 | VCCO_2 | M11 | |
| 2 | VCCO_2 | N11 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 2 | VCCO_2 | N12 | |
| 2 | VCCO_2 | P3 | |
| 2 | VCCO_2 | P8 | |
| 2 | VCCO_2 | P11 | |
| 2 | VCCO_2 | P12 | |
| 2 | VCCO_2 | R11 | |
| 2 | VCCO_2 | R12 | |
| 3 | VCCO_3 | U11 | |
| 3 | VCCO_3 | U12 | |
| 3 | VCCO_3 | V3 | |
| 3 | VCCO_3 | V8 | |
| 3 | VCCO_3 | V11 | |
| 3 | VCCO_3 | V12 | |
| 3 | VCCO_3 | W11 | |
| 3 | VCCO_3 | W12 | |
| 3 | VCCO_3 | Y11 | |
| 3 | VCCO_3 | AB6 | |
| 3 | VCCO_3 | AE3 | |
| 4 | VCCO_4 | Y13 | |
| 4 | VCCO_4 | Y14 | |
| 4 | VCCO_4 | Y15 | |
| 4 | VCCO_4 | AA12 | |
| 4 | VCCO_4 | AA13 | |
| 4 | VCCO_4 | AA14 | |
| 4 | VCCO_4 | AA15 | |
| 4 | VCCO_4 | AD14 | |
| 4 | VCCO_4 | AF10 | |
| 4 | VCCO_4 | AJ7 | |
| 4 | VCCO_4 | AJ14 | |
| 5 | VCCO_5 | Y17 | |
| 5 | VCCO_5 | Y18 | |
| 5 | VCCO_5 | Y19 | |
| 5 | VCCO_5 | AA17 | |
| 5 | VCCO_5 | AA18 | |
| 5 | VCCO_5 | AA19 | |
| 5 | VCCO_5 | AA20 | |
| 5 | VCCO_5 | AD18 | |
| 5 | VCCO_5 | AF22 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| 5 | VCCO_5 | AJ18 | |
| 5 | VCCO_5 | AJ25 | |
| 6 | VCCO_6 | U20 | |
| 6 | VCCO_6 | U21 | |
| 6 | VCCO_6 | V20 | |
| 6 | VCCO_6 | V21 | |
| 6 | VCCO_6 | V24 | |
| 6 | VCCO_6 | V29 | |
| 6 | VCCO_6 | W20 | |
| 6 | VCCO_6 | W21 | |
| 6 | VCCO_6 | Y21 | |
| 6 | VCCO_6 | AB26 | |
| 6 | VCCO_6 | AE29 | |
| 7 | VCCO_7 | G29 | |
| 7 | VCCO_7 | K26 | |
| 7 | VCCO_7 | M21 | |
| 7 | VCCO_7 | N20 | |
| 7 | VCCO_7 | N21 | |
| 7 | VCCO_7 | P20 | |
| 7 | VCCO_7 | P21 | |
| 7 | VCCO_7 | P24 | |
| 7 | VCCO_7 | P29 | |
| 7 | VCCO_7 | R20 | |
| 7 | VCCO_7 | R21 | |
| | | | |
| NA | CCLK | AJ4 | |
| NA | PROG_B | D27 | |
| NA | DONE | AG6 | |
| NA | M0 | AH27 | |
| NA | M1 | AJ28 | |
| NA | M2 | AG26 | |
| NA | HSWAP_EN | E26 | |
| NA | TCK | K11 | |
| NA | TDI | C28 | |
| NA | TDO | C4 | |
| NA | TMS | J10 | |
| NA | PWRDWN_B | AH5 | |
| NA | DXN | F25 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| NA | DXP | B28 | |
| NA | VBATT | D5 | |
| NA | RSVD | B4 | |
| | | | |
| NA | VCCAUX | B16 | |
| NA | VCCAUX | C2 | |
| NA | VCCAUX | C30 | |
| NA | VCCAUX | T2 | |
| NA | VCCAUX | T30 | |
| NA | VCCAUX | AJ2 | |
| NA | VCCAUX | AJ30 | |
| NA | VCCAUX | AK16 | |
| NA | VCCINT | K15 | |
| NA | VCCINT | K17 | |
| NA | VCCINT | L11 | |
| NA | VCCINT | L16 | |
| NA | VCCINT | L21 | |
| NA | VCCINT | M12 | |
| NA | VCCINT | M16 | |
| NA | VCCINT | M20 | |
| NA | VCCINT | N13 | |
| NA | VCCINT | N14 | |
| NA | VCCINT | N15 | |
| NA | VCCINT | N16 | |
| NA | VCCINT | N17 | |
| NA | VCCINT | N18 | |
| NA | VCCINT | N19 | |
| NA | VCCINT | P13 | |
| NA | VCCINT | P19 | |
| NA | VCCINT | R10 | |
| NA | VCCINT | R13 | |
| NA | VCCINT | R19 | |
| NA | VCCINT | R22 | |
| NA | VCCINT | T11 | |
| NA | VCCINT | T12 | |
| NA | VCCINT | T13 | |
| NA | VCCINT | T19 | |
| NA | VCCINT | T20 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| NA | VCCINT | T21 | |
| NA | VCCINT | U10 | |
| NA | VCCINT | U13 | |
| NA | VCCINT | U19 | |
| NA | VCCINT | U22 | |
| NA | VCCINT | V13 | |
| NA | VCCINT | V19 | |
| NA | VCCINT | W13 | |
| NA | VCCINT | W14 | |
| NA | VCCINT | W15 | |
| NA | VCCINT | W16 | |
| NA | VCCINT | W17 | |
| NA | VCCINT | W18 | |
| NA | VCCINT | W19 | |
| NA | VCCINT | Y12 | |
| NA | VCCINT | Y16 | |
| NA | VCCINT | Y20 | |
| NA | VCCINT | AA11 | |
| NA | VCCINT | AA16 | |
| NA | VCCINT | AA21 | |
| NA | VCCINT | AB15 | |
| NA | VCCINT | AB17 | |
| NA | GND | A2 | |
| NA | GND | A3 | |
| NA | GND | A16 | |
| NA | GND | A29 | |
| NA | GND | A30 | |
| NA | GND | B1 | |
| NA | GND | B2 | |
| NA | GND | B8 | |
| NA | GND | B24 | |
| NA | GND | B30 | |
| NA | GND | B31 | |
| NA | GND | C1 | |
| NA | GND | C3 | |
| NA | GND | C29 | |
| NA | GND | C31 | |
| NA | GND | D4 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| NA | GND | D10 | |
| NA | GND | D16 | |
| NA | GND | D22 | |
| NA | GND | D28 | |
| NA | GND | E5 | |
| NA | GND | E27 | |
| NA | GND | F6 | |
| NA | GND | F26 | |
| NA | GND | G7 | |
| NA | GND | G13 | |
| NA | GND | G16 | |
| NA | GND | G19 | |
| NA | GND | G25 | |
| NA | GND | H2 | |
| NA | GND | H8 | |
| NA | GND | H24 | |
| NA | GND | H30 | |
| NA | GND | J9 | |
| NA | GND | J23 | |
| NA | GND | K4 | |
| NA | GND | K16 | |
| NA | GND | K28 | |
| NA | GND | N7 | |
| NA | GND | N25 | |
| NA | GND | P14 | |
| NA | GND | P15 | |
| NA | GND | P16 | |
| NA | GND | P17 | |
| NA | GND | P18 | |
| NA | GND | R14 | |
| NA | GND | R15 | |
| NA | GND | R16 | |
| NA | GND | R17 | |
| NA | GND | R18 | |
| NA | GND | T1 | |
| NA | GND | T4 | |
| NA | GND | T7 | |
| NA | GND | T10 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| NA | GND | T14 | |
| NA | GND | T15 | |
| NA | GND | T16 | |
| NA | GND | T17 | |
| NA | GND | T18 | |
| NA | GND | T22 | |
| NA | GND | T25 | |
| NA | GND | T28 | |
| NA | GND | T31 | |
| NA | GND | U14 | |
| NA | GND | U15 | |
| NA | GND | U16 | |
| NA | GND | U17 | |
| NA | GND | U18 | |
| NA | GND | V14 | |
| NA | GND | V15 | |
| NA | GND | V16 | |
| NA | GND | V17 | |
| NA | GND | V18 | |
| NA | GND | W7 | |
| NA | GND | W25 | |
| NA | GND | AB4 | |
| NA | GND | AB16 | |
| NA | GND | AB28 | |
| NA | GND | AC9 | |
| NA | GND | AC23 | |
| NA | GND | AD2 | |
| NA | GND | AD8 | |
| NA | GND | AD24 | |
| NA | GND | AD30 | |
| NA | GND | AE7 | |
| NA | GND | AE13 | |
| NA | GND | AE16 | |
| NA | GND | AE19 | |
| NA | GND | AE25 | |
| NA | GND | AF6 | |
| NA | GND | AF26 | |
| NA | GND | AG5 | |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA

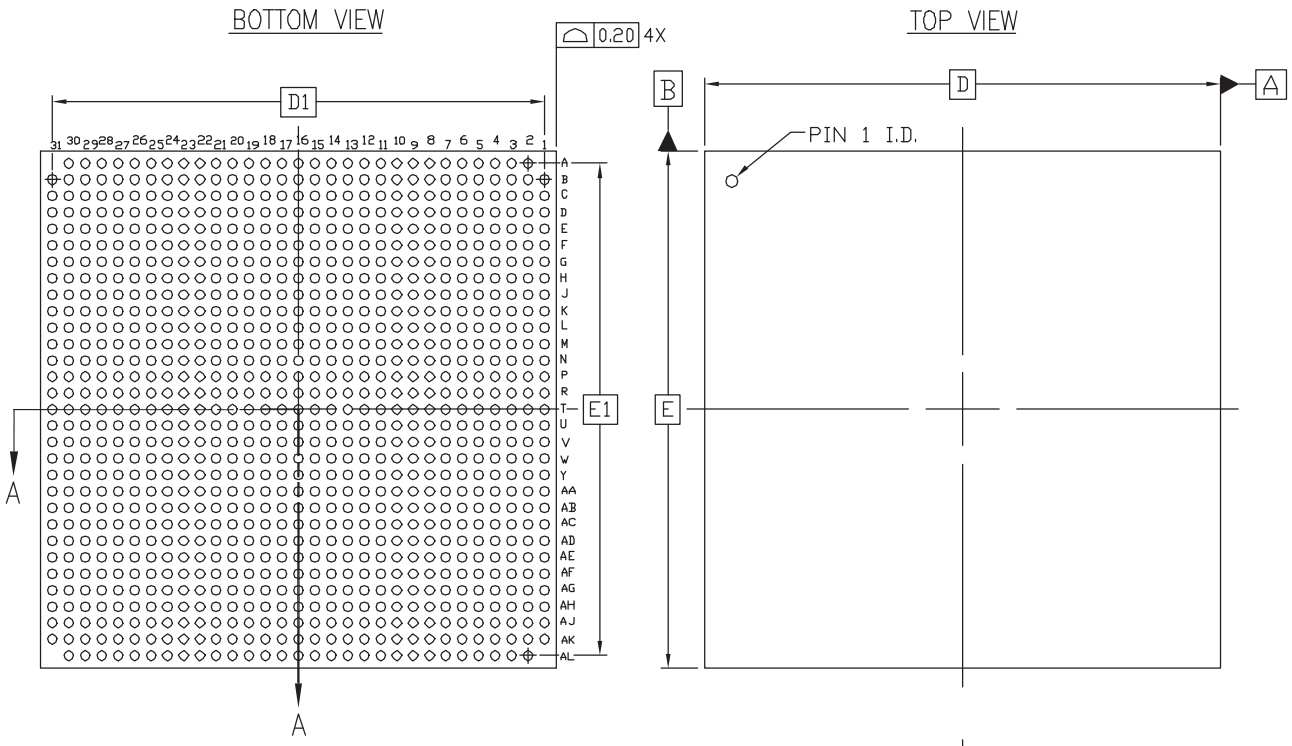

*Table 14:* **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

| Bank | Pin Description | Pin Number | No Connect in XC2V2000 |
|---|---|---|---|
| NA | GND | AG27 | |
| NA | GND | AH4 | |
| NA | GND | AH10 | |
| NA | GND | AH16 | |
| NA | GND | AH22 | |
| NA | GND | AH28 | |
| NA | GND | AJ1 | |
| NA | GND | AJ3 | |
| NA | GND | AJ29 | |
| NA | GND | AJ31 | |
| NA | GND | AK1 | |
| NA | GND | AK2 | |
| NA | GND | AK8 | |
| NA | GND | AK24 | |
| NA | GND | AK30 | |
| NA | GND | AK31 | |
| NA | GND | AL2 | |
| NA | GND | AL3 | |
| NA | GND | AL16 | |
| NA | GND | AL29 | |
| NA | GND | AL30 | |

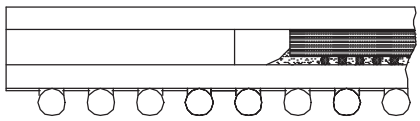
**Notes:**
1. See Table 4 for an explanation of the signals available on this pin.

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## BF957 Flip-Chip BGA Package Specifications (1.27mm pitch)




| SYMBOL | MILLIMETERS | | | NOTE |
|---|---|---|---|---|
| | MIN. | NOM. | MAX. | |
| A | --- | 3.25 | 3.50 | |
| $A_1$ | 0.50 | 0.60 | 0.70 | |
| $A_2$ | --- | --- | 2.80 | |
| $A_3$ | 0.20 | --- | --- | |
| D/E | 40.00 BSC | | | |
| $D_1/E_1$ | 38.10 REF. | | | |
| e | 1.27 BSC | | | |
| øb | 0.60 | 0.75 | 0.90 | |
| aaa | --- | --- | 0.20 | |
| bbb | --- | --- | 0.25 | |
| ccc | --- | --- | 0.15 | |
| ddd | --- | --- | 0.30 | |
| M | 31 | | | |



SECTION A–A
(NOT TO SCALE)

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M–1994
2. SYMBOL "M" IS THE PIN MATRIX SIZE.
3. CONFORMS TO JEDEC MS–034–BAU–1 (DEPOPULATED)

*Figure 10:* **BF957 Flip-Chip BGA Package Specifications**

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Revision History

This section records the change history for this module of the data sheet.

| Date | Version | Revision |
|---|---|---|
| 11/07/2000 | 1.0 | Early access draft. |
| 11/22/2000 | 1.1 | Initial Xilinx release. Made the following corrections:<br>CS144 package - Table 5, page 5:<br>• Added missing pin D10 in Bank 1.<br>• Changed dedicated pins A2 and B2 to RSVD (from DXN and DXP).<br>FG256 package - Table 6, page 10:<br>• Changed dedicated pins A3 and A4 to RSVD (from DXN and DXP).<br>FG896 package - Table 11, page 95:<br>• Corrected pin AG1 in Bank 4 to be AG12.<br>FF1152 package - Table 12, page 121:<br>• Corrected pin Y3 in Bank 6 to be Y32. |
| 12/19/2000 | 1.2 | Reverse designations were fixed for pins in every package. |
| 01/25/2001 | 1.3 | Data sheet divided into four modules (per current style standard). DXN and DXP pin information added for CS144 package (Table 5) and FG256 package (Table 6). |
| 02/07/2001 | 1.4 | DXN and DXP pin information was changed back to RSVD for the CS144 package (Table 5) and the FG256 package (Table 6). |
| 04/02/2001 | 1.5 | • ALT_VRN and ALT_VRP pin information was added for each package.<br>• Table 8, page 34 – added No Connect designations for the XC2V1500 device in the FG676 package.<br>• Reverted to traditional double-column format. |
| 11/07/2001 | 1.6 | • Updated list of devices supported in the FF1152, FF1517, and BF957 packages. |
| 09/26/2002 | 1.7 | • Updated Table 3 to reflect devices supported in the BG728 and BF957 packages.<br>• Added mention of LVPECL to pin definition in Table 4. |
| 10/07/2002 | 1.8 | • Corrected Table 10 heading to reflect supported devices in the BG728 package. |
| 12/06/2002 | 1.8.1 | • Enhanced the description of the PWRDWN_B pin in Table 4. |
| 05/07/2003 | 1.8.2 | • Added clarification to Table 4 and all device pinout tables regarding the dual-use nature of pins D0/DIN and BUSY/DOUT during configuration. |
| 06/19/2003 | 1.8.3 | • The final GND pin in each of five pinout tables was inadvertently deleted in v1.8.2. This revision restores the deleted GND pins as follows:<br>- Pin C5, Table 5, page 5 (CS144)<br>- Pin A1, Table 6, page 10 (FG256)<br>- Pin A2, Table 10, page 72 (BG728)<br>- Pin A2, Table 12, page 121 (FF1152)<br>- Pin AL30, Table 14, page 199 (BF957) |
| 08/01/2003 | 2.0 | All Virtex-II devices and speed grades now Production. See Table 13, Module 3. |
| 03/29/2004 | 2.0.1 | Recompiled for backward compatibility with Acrobat 4 and above. |
| 06/24/2004 | 3.3 | Added references to, and new package drawings for, Pb-free wire-bond packages CSG, FGG, and BGG. (Revision number advanced to level of complete data sheet.) |
| 03/01/2005 | 3.4 | Table 4: Changed Direction for User I/O pins (IO_LXXY_#) from “Input/Output” to “Input/Output/Bidirectional”. Added requirement to $V_{BATT}$ to connect pin to $V_{CCAUX}$ or GND if battery is not used. |
| 11/05/2007 | 3.5 | Updated copyright notice and legal disclaimer. |
| 04/07/2014 | 4.0 | This product is obsolete/discontinued per XCN11003 and XCN12026. |

— OBSOLETE — OBSOLETE — OBSOLETE — OBSOLETE —
XC2V1000-5FG256I Xilinx Inc. IC FPGA 172 I/O 256FBGA


## Notice of Disclaimer

THE XILINX HARDWARE FPGA AND CPLD DEVICES REFERRED TO HEREIN (“PRODUCTS”) ARE SUBJECT TO THE TERMS AND CONDITIONS OF THE XILINX LIMITED WARRANTY WHICH CAN BE VIEWED AT http://www.xilinx.com/warranty.htm. THIS LIMITED WARRANTY DOES NOT EXTEND TO ANY USE OF PRODUCTS IN AN APPLICATION OR ENVIRONMENT THAT IS NOT WITHIN THE SPECIFICATIONS STATED IN THE XILINX DATA SHEET. ALL SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, OR ANY OTHER APPLICATION THAT INVOKES THE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR PROPERTY OR ENVIRONMENTAL DAMAGE (“CRITICAL APPLICATIONS”). USE OF PRODUCTS IN CRITICAL APPLICATIONS IS AT THE SOLE RISK OF CUSTOMER, SUBJECT TO APPLICABLE LAWS AND REGULATIONS.

## Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

FPGAMALL
Authorized Distributor

## OUR CERTIFICATE

A long-term cooperative relationship can be built between global customers and us by providing excellent products

| | |
|---|---|
| Business Type | Trading Company, Distributor/Wholesaler |
| Main Products | Electronic Integrated Circuit |
| Certifications | ISO9001 |
| Total Annual Revenue | US$2.5 Million - US$5 Million |
| Country / Region | Hongkong, China |
| Total Employees | 100 - 200 People |
| Year Established | 2018 |
| Main Markets | North America<br>South Asia<br>Western Europe |

sales@fpgamall.com +00852-56428680